





ADS131B26-Q1

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## ADS131B26-Q1 Automotive High-Voltage Battery Pack Monitor With SPI and 6 ADC Channels for Voltage, Current, and Temperature Sensing

## 1 Features

TEXAS

INSTRUMENTS

- AEC-Q100 qualified for automotive applications – Temperature grade 1: –40°C to +125°C, T<sub>▲</sub>
- **Functional Safety-Compliant** 
  - Developed for functional safety applications
  - Documentation available to aid ISO 26262 functional safety system design up to ASIL D
  - Systematic capability up to ASIL D
  - Hardware capability up to ASIL D
- Two simultaneous-sampling, 24-bit ADCs (ADC1A, ADC1B) for current-shunt measurements:
  - Programmable full-scale range:
    - ±39 mV to ±312.5 mV
    - Supports a wide range of shunt resistor values and current-measurement ranges
  - Achieve high-accuracy current-shunt measurements with:
    - Offset error: ±1.5 µV (max)
    - Gain drift: 20 ppm/°C (max)
  - Programmable data rate: 500 SPS to 64 kSPS
  - Digital overcurrent comparator per ADC with programmable thresholds for fast overcurrent detection
- Two simultaneous-sampling, 24-bit ADCs (ADC3A, ADC3B) for voltage measurements:
  - Programmable data rate: 500 SPS to 64 kSPS
  - Programmable full-scale range: ±312.5 mV to ±1.25 V

- Two multiplexed, 16-bit ADCs (ADC2A, ADC2B) for voltage and temperature measurements:
  - 8 analog inputs per ADC
  - Programmable full-scale range: ±312.5 mV to ±1.25 V
  - Channel sequencer
- Monitoring and diagnostic features to mitigate and detect random hardware faults
- Supply-voltage range: 2.9 V to 16 V
- SPI-compatible interface
- 9 GPIOs with PWM capability

## 2 Applications

- Automotive battery management systems (BMS):
  - Current-shunt measurements
  - Voltage measurements using external resistor dividers
  - Temperature measurements using thermistors or analog output temperature sensors

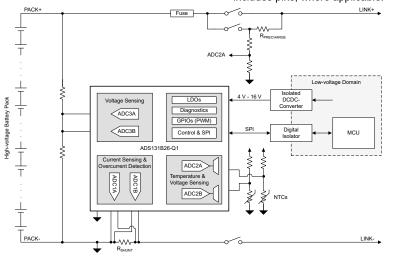
## **3 Description**

The ADS131B26-Q1 is a fully integrated, high-voltage battery pack monitor for automotive electrical vehicle (EV) battery management systems (BMS).

#### **Package Information**

PART NUMBER	PACKAGE <sup>(1)</sup>	PACKAGE SIZE <sup>(2)</sup>
ADS131B26-Q1	PHP (HTQFP, 48)	9 mm × 9 mm

- For all available packages, see the orderable addendum at (1) the end of the data sheet.
- The package size (length × width) is a nominal value and (2) includes pins, where applicable.



#### EV BMS Battery Pack Monitor System Block Diagram

An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.





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## **4 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### Changes from Revision \* (September 2022) to Revision A (July 2023)



## **5** Description (continued)

The ADS131B26-Q1 integrates two simultaneous-sampling, high-precision, 24-bit analog-to-digital converter (ADC) channels (ADC1A, ADC1B) to redundantly measure battery current with high resolution and accuracy using an external shunt resistor. Two independent digital comparators enable fast overcurrent detection in parallel with the two ADCs.

Another set of two simultaneous-sampling, 24-bit ADCs (ADC3A, ADC3B) are integrated to measure battery pack voltage using external high-voltage resistor dividers synchronously to the battery current for accurate battery state-of-charge and state-of-health calculations.

Additionally, two multiplexed, 16-bit ADC channels (ADC2A, ADC2B) are available to measure shunt temperature and other voltages in the system, such as battery-pack voltage, using external high-voltage resistor dividers. Shunt temperature is measured using an external temperature sensor, such as a thermistor or an analog output temperature sensor. Each ADC is equipped with a channel sequencer that automatically steps through the configured multiplexer inputs to reduce communication on the SPI.

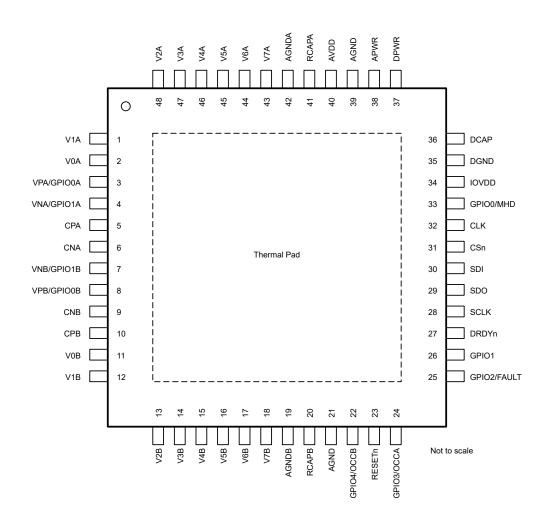
The device integrates many monitoring and diagnostic features to mitigate and detect random hardware faults to aid in the development of functional safety BMS.

Internal linear regulators with input ranges up to 16 V support powering the device with unregulated DC/DC converters.

The ADS131B26-Q1 is offered in a 48-pin HTQFP package and is specified over the automotive temperature range of –40°C to +105°C.



## **6** Pin Configuration and Functions



#### Figure 6-1. PHP Package, 48-Pin HTQFP (Top View)

#### **Table 6-1. Pin Functions**

PIN		ТҮРЕ	DESCRIPTION <sup>(1)</sup>	
NAME	NO.			
AGND	39	Analog supply	Analog ground.	
AGND	21	Analog supply	Analog ground.	
AGNDA	42	Analog supply	Section A analog ground. Connect to AGND.	
AGNDB	19	Analog supply	Section B analog ground. Connect to AGND.	
APWR	38	Analog supply	Analog power supply. Connect a 1-μF capacitor to AGND.	
AVDD	40	Analog supply	Analog supply. Connect a 1-μF capacitor to AGND. Sets the logic levels for GPIO0A, GPIO1A, GPIO0B, and GPIO1B.	
CLK	32	Digital I/O	Main clock input. <sup>(4)</sup>	
CNA	6	Analog input	ADC1A negative analog input.	
CNB	9	Analog input	ADC1B negative analog input.	
СРА	5	Analog input	ADC1A positive analog input.	
СРВ	10	Analog input	ADC1B positive analog input.	
CSn	31	Digital input	Chip-select input; active low. Internal pullup resistor to IOVDD. <sup>(4)</sup>	



#### Table 6-1. Pin Functions (continued)

PIN					
NAME	NO.	TYPE	DESCRIPTION <sup>(1)</sup>		
DCAP	36	Digital supply	DVDD LDO output. Connect a 220-nF capacitor to DGND.		
DGND	35	Digital supply	Digital ground.		
DPWR	37	Digital supply	Digital power supply. Connect a 1-µF capacitor to DGND.		
DRDYn	27	Digital output	Data-ready output; active low. <sup>(2) (4)</sup>		
GPIO0/MHD	33	Digital I/O	General-purpose digital input/output 0. <sup>(2) (4)</sup> Missing host detect output. <sup>(2) (4)</sup>		
GPIO1	26	Digital I/O	General-purpose digital input/output 1. <sup>(2) (4)</sup>		
GPIO2/FAULT	25	Digital I/O	General-purpose digital input/output 2. <sup>(2) (4)</sup> Fault output. <sup>(2) (4)</sup>		
GPIO3/OCCA	24	Digital I/O	General-purpose digital input/output 3. <sup>(2) (4)</sup> Overcurrent comparator A output. <sup>(2) (4)</sup>		
GPIO4/OCCB	22	Digital I/O	General-purpose digital input/output 4. <sup>(2) (4)</sup> Overcurrent comparator B output. <sup>(2) (4)</sup>		
IOVDD	34	Digital supply	Digital I/O supply. Connect a 1-µF capacitor to DGND. Sets the logic levels for the digital I/Os, except for GPIO0A, GPIO1A, GPIO0B, and GPIO1B.		
RCAPA	41	Analog output	REFA voltage reference output. Connect a 1-µF capacitor to AGNDA.		
RCAPB	20	Analog output	REFB voltage reference output. Connect a 1-µF capacitor to AGNDB.		
RESETn	23	Digital input	Reset input; active low. Internal pulldown resistor to DGND.		
SCLK	28	Digital input	Serial data clock input. <sup>(4)</sup>		
SDI	30	Digital input	Serial data input. <sup>(4)</sup>		
SDO	29	Digital output	Serial data output. <sup>(2) (4)</sup>		
V0A	2	Analog input	ADC2A analog input 0A.		
V0B	11	Analog input	ADC2B analog input 0B.		
V1A	1	Analog input	ADC2A analog input 1A.		
V1B	12	Analog input	ADC2B analog input 1B.		
V2A	48	Analog input	ADC2A analog input 2A.		
V2B	13	Analog input	ADC2B analog input 2B.		
V3A	47	Analog input	ADC2A analog input 3A.		
V3B	14	Analog input	ADC2B analog input 3B.		
V4A	46	Analog input	ADC2A analog input 4A.		
V4B	15	Analog input	ADC2B analog input 4B.		
V5A	45	Analog input	ADC2A analog input 5A.		
V5B	16	Analog input	ADC2B analog input 5B.		
V6A	44	Analog input	ADC2A analog input 6A.		
V6B	17	Analog input	ADC2B analog input 6B.		
V7A	43	Analog input	ADC2A analog input 7A.		
V7B	18	Analog input	ADC2B analog input 7B.		
VNA/GPIO1A	4	Analog input/ digital I/O	ADC3A negative analog input. General-purpose digital input/output 1A. <sup>(2) (3)</sup>		
VNB/GPIO1B	7	Analog input/ digital I/O	ADC3B negative analog input. General-purpose digital input/output 1B. <sup>(2) (3)</sup>		
VPA/GPIO0A	3	Analog input/ digital I/O	ADC3A positive analog input. General-purpose digital input/output 0A. <sup>(2) (3)</sup>		
VPB/GPIO0B	8	Analog input/ digital I/O	ADC3B negative analog input. General-purpose digital input/output 0B. <sup>(2) (3)</sup>		
Thermal Pad	Pad	_	Thermal power pad. Connect to AGND.		

(1) See the Unused Inputs and Outputs section for details on how to connect unused pins.

(2) Push-pull output.(3) Logic levels referenced to AVDD.

(4) Logic levels referenced to IOVDD.



## 7 Specifications

## 7.1 Absolute Maximum Ratings

see (1)

		MIN	MAX	UNIT
	APWR to AGND	-0.3	20	
	DPWR to DGND	-0.3	20	
	AGND, AGNDy to DGND	-0.3	0.3	
Power-supply voltage	AVDD to AGND	-0.3	4	V
	IOVDD to DGND	-0.3	7	
	DCAP to DGND	-0.3	2.2	
	RCAPy to AGND	-0.3	2.2	
Analog input voltage	CPy, CNy, VPy, VNy, Vxy	AGND – 1.6	AVDD + 0.3	V
	CSn, SCLK, SDI, SDO, RESETn, DRDYn, CLK, GPIO0/MHD, GPIO1, GPIO2/FAULT, GPIO3/OCCA, GPIO4/OCCB	DGND – 0.3	IOVDD + 0.3	
Digital input voltage	GPIO0A, GPIO1A	AGNDA – 0.3	AVDD + 0.3	V
	GPIO0B, GPIO1B	AGNDB – 0.3	AVDD + 0.3	
Input current	Continuous, all pins except power-supply pins	-10	10	mA
Tomporatura	Junction, T <sub>J</sub>		150	°C
Analog input voltage Digital input voltage	Storage, T <sub>stg</sub>	-60	150	C

(1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If briefly operating outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not sustain damage, but it may not be fully functional – this may affect device reliability, functionality, performance, and shorten the device lifetime.

#### 7.2 ESD Ratings

				VALUE	UNIT	
V	Electrostatic discharge	Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup> HBM ESD classification level 2		±2000		
V <sub>(ESD)</sub>		Charged-device model (CDM),	Corner pins	±750	v	
		per AEC Q100-011 CDM ESD classification level C4B	All other non-corner pins	±500		

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.



## 7.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

			MIN	NOM	MAX	UNIT
POWER SUP	PPLY					
		APWR to AGND	4		16	
		APWR = AVDD to AGND (APWR shorted to AVDD, AVDD LDO bypassed)	2.9	3.3	3.6	
	Power supply	DPWR to DGND	4		16	V
		DPWR = IOVDD to DGND (DPWR shorted to IOVDD, IOVDD LDO bypassed)	2.9	3.3	5.5	
		AGND, AGNDy to DGND	-0.2	0	0.2	
ANALOG INI	PUTS ADC1A, ADC1B <sup>(1)</sup>					
V <sub>CPy</sub> , V <sub>CNy</sub>	Absolute input voltage	Gain = 4, 8, 16, 32	AGND – 0.3125		AVDD – 2.4	V
V <sub>IN1y</sub>	Differential input voltage	$V_{IN1y} = V_{CPy} - V_{CNy}$	–V <sub>REFy</sub> / Gain		V <sub>REFy</sub> / Gain	V
ANALOG INI	PUTS ADC2A, ADC2B (1)				· · · ·	
		Gain = 1, 2	AGND - 0.1		AVDD – 1.2	Ň
V <sub>Vxy</sub>	Absolute input voltage	Gain = 4	AGND – 0.3125		AVDD - 2.4	V
V <sub>IN2y</sub>	Differential input voltage		–V <sub>REFy</sub> / Gain		V <sub>REFy</sub> / Gain	V
ANALOG INI	PUTS ADC3A, ADC3B <sup>(1)</sup>					
V <sub>VPy</sub> , V <sub>VNy</sub>	Absolute input voltage	Gain = 1, 2	AGND – 0.1		AVDD – 1.2	V
v <sub>VPy</sub> , v <sub>VNy</sub>	Absolute input voltage	Gain = 4	AGND – 0.3125		AVDD – 2.4	V
V <sub>IN3y</sub>	Differential input voltage	$V_{IN3y} = V_{VPy} - V_{VNy}$	–V <sub>REFy</sub> / Gain		V <sub>REFy</sub> / Gain	V
EXTERNAL	CLOCK SOURCE <sup>(2)</sup>	•	·			
f <sub>CLK</sub>	External clock frequency		7.8	8.192	8.4	MHz
	Duty cycle		40%	50%	60%	
DIGITAL INP	uts	-	1			
	Input voltage	CSn, SCLK, SDI, SDO, RESETn, DRDYn, CLK, GPIO0/MHD, GPIO1, GPIO2/FAULT, GPIO3/OCCA, GPIO4/OCCB	DGND		IOVDD	V
	input voltage	GPIO0A, GPIO1A	AGNDA		AVDD	v
		GPIO0B, GPIO1B	AGNDB		AVDD	
EXTERNAL	CAPACITORS		1			
		APWR, DPWR		1		
		AVDD, IOVDD	0.5	1	2	μF
	Capacitor value <sup>(3)</sup>	RCAPA, RCAPB	0.5	1	1.4	
		DCAP		220		nF
TEMPERATU	JRE RANGE	1	1			
_	Specified ambient temperature		-40		105	
T <sub>A</sub>	Operating ambient temperature		-45		125	°C

(1) The subscript y refers to section A or section B.

The subscript *x* refers to analog input channel *x* on ADC2y.

(2) An external clock is not required when the internal oscillator is used.

(3) Capacitor values that need to be met over temperature and lifetime. See the *Power-Supply Decoupling* section for additional information.



## 7.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>	TQFP (PHP)	UNIT
		48 PINS	
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	23.7	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	15.3	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	7.8	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	0.2	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	7.7	°C/W
R <sub>θJC(bot)</sub>	Junction-to-case (bottom) thermal resistance	1.3	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

## 7.5 Electrical Characteristics

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
CURRENT I	MEASUREMENT ADCS (ADC1A, AD	DC1B)				
	Resolution		24			Bits
	Gain settings			4, 8, 16, 32		V/V
f <sub>DATA</sub>	Output data rate	f <sub>CLK</sub> = 8.192 MHz	500		64k	SPS
	Absolute input current	All data rates, all gains, global-chop enabled or disabled, $V_{CPy} = V_{CNy} = 0 V$		±0.5		nA
	Differential input current	All data rates, all gains, global-chop enabled or disabled, $V_{CPy} = V_{CNy} = 0 V$	-5	±1	5	nA
	Differential input impedance	All data rates, all gains, global-chop enabled or disabled		1.8		MΩ
		Gain = 4, global-chop disabled		±1		
	Offset error (input referred)	Gain = 8 to 32, global-chop disabled		±15		μV
		All gains, global-chop enabled	-1.5	±0.5	1.5	
	Offset drift	All gains, global-chop disabled		20	100	nV/°C
	Onset difft	All gains, global-chop enabled		1	7	IIV/ C
	Gain error	$\rm T_A$ = 25°C, all gains, single-ended operation with CNy held at AGNDy, including initial accuracy of REFy	-0.15%	±0.05%	0.15%	
	Gain drift	All gains, single-ended operation with CNy held at AGNDy, including drift of REFy		5	20	ppm/°C
	Gain long-term drift	1000 hours at 85°C, all gains, including long-term drift of REFy		±100		ppm
	Gain match	Between gain settings	-0.12%	±0.03%	0.12%	
	Noise (input referred)	Gain = 8, f <sub>DATA</sub> = 1 kSPS		0.65		$\mu V_{RMS}$
CMRR	Common-mode rejection ratio	At DC, global-chop disabled		110		dB
CIVIER		At DC, global-chop enabled		113		uВ
		APWR at DC, global-chop enabled or disabled		133		
PSRR	Power-supply rejection ratio	DPWR at DC, global-chop enabled or disabled		133		dB
		AVDD at DC, global-chop enabled or disabled		115		чь
		IOVDD at DC, global-chop enabled or disabled		131		



	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VOLTAGE A		NT ADCS (ADC2A, ADC2B)				
	Resolution		16			Bits
	Gain settings			1, 2, 4		V/V
	Absolute input current	$OSR2y = 64$ , all gains, $V_{Vxy} = 0 V$		±0.2		nA
	Differential input current	$OSR2y = 64$ , all gains, $V_{Vxy} = 0 V$		±0.4		nA
		OSR2y = 64, all gains		15		
	Differential input impedance	OSR2y = 128, all gains		30		MΩ
		OSR2y = 256, all gains		60		
		OSR2y = 512, all gains		120		
	Offset error (input referred)	Gain = 1	-350	±85	350	μV
		Gain = 2 and 4	-25	±5	25	
	Offset drift	Gain = 1		60	300	nV/°C
		Gain = 2 and 4		30	150	
	Gain error	T <sub>A</sub> = 25°C, all gains, including initial accuracy of REFy	-0.3%	±0.1%	0.3%	
	Gain drift	All gains, including drift of REFy		5	20	ppm/°C
	Gain long-term drift	1000 hours at 85°C, all gains, including long-term drift of REFy		±100		ppm
	Gain match	Between gain settings	-0.15%	±0.06%	0.15%	
CMRR	Common-mode rejection ratio	At DC		95		dB
	Power-supply rejection ratio	APWR at DC		103		dB
		DPWR at DC		103		
PSRR		AVDD at DC		91		uВ
		IOVDD at DC		96		
BATTERY V	OLTAGE MEASUREMENT ADCS (A	ADC3A, ADC3B)				
	Resolution		24			Bits
	Gain settings			1, 2, 4		V/V
DATA	Output data rate	f <sub>CLK</sub> = 8.192 MHz	500		64k	SPS
	Absolute input current	$f_{\text{DATA}}$ = 1 kSPS, all gains, global-chop enabled or disabled, $V_{\text{VPy}}$ = $V_{\text{VNy}}$ = 0 V		±0.1		nA
	Differential input current	$f_{DATA}$ = 1 kSPS, all gains, global-chop enabled or disabled, $V_{VPy}$ = $V_{VNy}$ = 0 V	-2	±0.1	2	nA
		$f_{DATA}$ = 64 kSPS, all gains, global-chop enabled or disabled		15		
	Differential input impedance	f <sub>DATA</sub> = 16 kSPS, all gains, global-chop enabled or disabled		60		мо
	Differential input impedance	$f_{DATA}$ = 4 kSPS, all gains, global-chop enabled or disabled		250		MΩ
		$f_{DATA}$ = 1 kSPS, all gains, global-chop enabled or disabled		1000		
	Offset error (input referred)	All gains, global-chop disabled	-400	±80	400	μV
		All gains, global-chop enabled	-10	±3	10	μv
		All gains, global-chop disabled		50	300	nV/°C
	Offset drift	All gaills, global-chop disabled				1147 0
	Offset drift	All gains, global-chop enabled		4	15	
	Offset drift Gain error		-0.3%	4 ±0.1%	15 0.3%	
		All gains, global-chop enabled $T_A = 25^{\circ}$ C, all gains, single-ended operation with VNy held at AGNDy, including initial accuracy of	-0.3%			ppm/°C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	Gain match	Between gain settings	-0.18%	±0.06%	0.18%	
	Noise (input referred)	Gain = 4, f <sub>DATA</sub> = 1 kSPS		3		μV <sub>RMS</sub>
		At DC, global-chop disabled		114		
CMRR	Common-mode rejection ratio	At DC, global-chop enabled		120		dB
		APWR at DC, global-chop enabled or disabled		123		
		DPWR at DC, global-chop enabled or disabled		123		
PSRR	Power-supply rejection ratio	AVDD at DC, global-chop enabled or disabled		93		dB
		IOVDD at DC, global-chop enabled or disabled		113		
PRECISION V	OLTAGE REFERENCES (REFA, F	REFB)				
V <sub>REFA</sub> , V <sub>REFB</sub>	Reference voltage			1.25		V
	Accuracy	T <sub>A</sub> = 25°C	-0.15%	±0.05%	0.15%	
	Temperature drift			3	15	ppm/°C
	Output current	Source only, available for external loads on RCAPy pin			250	μA
	Short-circuit current limit	Sink or source	-10		10	mA
	Start-up time	1-μF capacitor on RCAPy, 0.01% settling		8		ms
MAIN OSCILL	ATOR (OSCM)					
f <sub>OSCM</sub>	Frequency			8.192		MHz
	Accuracy		-2.5%		2.5%	
DIAGNOSTIC	OSCILLATOR (OSCD)					
f <sub>OSCD</sub>	Frequency			8.192		MHz
	Accuracy		-2.5%		2.5%	
OVERCURRE	NT COMPARATORS (OCCA, OCC	CB)				
	Offset error (input referred)	All gains	-500	±20	500	μV
	Gain error	All gains, including error of REFy	-0.5%	±0.2%	0.5%	
TEMPERATU	RE SENSORS (TSA, TSB)					
TS <sub>Offset</sub>	Output voltage	T <sub>A</sub> = 25°C		118.4		mV
TS <sub>TC</sub>	Temperature coefficient			410		µV/°C
COMMON-MC	DDE OUTPUT BUFFERS (VCMA, V	/СМВ)				
V <sub>CMA</sub> , V <sub>CMB</sub>	Common-mode output voltage		0.75	0.78	0.81	V
	Output current	Sink or source	-1		1	mA
	Short-circuit current limit	Sink or source	-5		5	mA
	Capacitive load				100	pF
TEST DACS (	TDACA, TDACB)					
	Output voltage settings			$\begin{array}{c} 1 \times V_{REFy} / 40 \\ 2 \times V_{REFy} / 40 \\ 4 \times V_{REFy} / 40 \\ 9 \times V_{REFy} / 40 \\ 18 \times V_{REFy} / 40 \\ 36 \times V_{REFy} / 40 \\ -4 \times V_{REFy} / 40 \\ -9 \times V_{REFy} / 40 \end{array}$		V
	Accuracy			±0.3%		
		Positive output voltages		6	35	
	Drift	Negative output voltages		12	80	ppm/°C



	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
OPEN-WIF	RE DETECTION CURRENT SOURC	ES AND SINKS (OWD1A, OWD1B, OWD	2A, OWD2B, OWD3A, OWD3	3B)	I	
	Current source settings			4, 40, 240		μA
	Current sink settings			4, 40, 240		μA
	Current source accuracy			±8%		
	Current sink accuracy			±8%		
DIGITAL I	NPUTS/OUTPUTS (GPIO0A, GPIO1	A, GPIO0B, GPIO1B)	1		I	
V <sub>IL</sub>	Logic input level, low		AGNDy	(	).3 AVDD	V
V <sub>IH</sub>	Logic input level, high		0.7 AVDD		AVDD	V
V <sub>OL</sub>	Logic output level, low	I <sub>OL</sub> = -100 μA		(	).2 AVDD	V
V <sub>OH</sub>	Logic output level, high	I <sub>OH</sub> = 100 μA	0.8 AVDD			V
I <sub>IN</sub>	Input current	AGNDy < V <sub>Digital Input</sub> < AVDD	-1		1	μA
	Short-circuit current limit	Sink or source	-8		8	mA
DIGITAL I	NPUTS/OUTPUTS (CSn, SCLK, SD	I, SDO, RESETn, DRDYn, CLK, GPIO0/M	HD, GPIO1, GPIO2/FAULT, G	PIO3/OCCA, GPIO	4/OCCB)	
V <sub>IL</sub>	Logic input level, low		DGND	0.	3 IOVDD	V
V <sub>IH</sub>	Logic input level, high		0.7 IOVDD		IOVDD	V
V <sub>OL</sub>	Logic output level, low	I <sub>OL</sub> = -1 mA		0.	2 IOVDD	V
V <sub>OH</sub>	Logic output level, high	I <sub>OH</sub> = 1 mA	0.8 IOVDD			V
I <sub>IN</sub>	Input current	DGND < V <sub>Digital Input</sub> < IOVDD	-1		1	μA
	Short-circuit current limit	Sink or source	-80		80	mA



	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
CLOCK MONITO	RS	· · · · · · · · · · · · · · · · · · ·				
f <sub>MCLK_WD_TH</sub>	Main clock (MCLK) watchdog frequency threshold	Watchdog indicates a fault when MCLK frequency drops below frequency threshold			300	kHz
foscd_wd_th	Diagnostic oscillator (OSCD) watchdog frequency threshold	Watchdog indicates a fault when OSCD frequency drops below frequency threshold			300	kHz
MCLK_FAULT_ TH	Main clock fault detection frequency threshold	Difference in clock frequencies between MCLK and OSCD to generate a fault		10%		
POWER SUPPLY	MONITORS					
AVDD_UV_TH	AVDD undervoltage threshold		2.9	2.95	3.0	V
AVDD_OV_TH	AVDD overvoltage threshold		3.8	3.9	4.0	V
		IOVDD_UV_TH = 1b	2.9	2.95	3.0	V
IOVDD_UV_TH	IOVDD undervoltage threshold	IOVDD_UV_TH = 0b	4.2	4.3	4.4	
		IOVDD_OV_TH = 1b	3.8	3.9	4.0	V
IOVDD_OV_TH	IOVDD overvoltage threshold	IOVDD_OV_TH = 0b	5.6	5.75		
DVDD_UV_TH	DVDD undervoltage threshold		1.55	1.6	1.65	V
DVDD_OV_TH	DVDD overvoltage threshold		1.90	1.95	2.0	V
AVDD_OSC_MA G	AVDD oscillation detection magnitude	Amplitude required to generate fault	500	1.00	2.0	mV <sub>pp</sub>
AVDD_OSC_FR EQ	AVDD oscillation detection input frequency	Oscillation frequency range to generate fault	2		500	kHz
IOVDD_OSC_M AG	IOVDD oscillation detection magnitude	Amplitude required to generate fault	500			mV <sub>pp</sub>
IOVDD_OSC_F REQ	IOVDD oscillation detection input frequency	Oscillation frequency range to generate fault	2		500	kHz
DVDD_OSC_M AG	DVDD oscillation detection magnitude	Amplitude required to generate fault	500			mV <sub>pp</sub>
DVDD_OSC_FR EQ	DVDD oscillation detection input frequency	Oscillation frequency range to generate fault	2		500	kHz
AVDD_OTW_TH	AVDD overtemperature warning thresholds			-60 100 120 140		°C
	AVDD overtemperature warning threshold accuracy			±2		°C
IOVDD_OTW_T H	IOVDD overtemperature warning thresholds			-60 100 120 140		°C
	IOVDD overtemperature warning threshold accuracy			±2		°C
		APWR		103		
		DPWR		103		
	ADC2y power-supply readback attenuation factor	AVDD		4		
		IOVDD		4		
		DVDD		2		
	ADC2y power-supply readback accuracy	OSR2y = 128, MUX2y_DELAY ≥ 256 × t <sub>MCLK</sub>		±1%		
AVDD_POR_TH	AVDD POR release threshold		2.6	2.7	2.85	V
IOVDD_POR_T H	IOVDD POR release threshold		2.6	2.7	2.85	V
	DVDD POR release threshold		1.4	1.5	1.6	V



	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
FAULT MONITO	R RESPONSE TIMES					
t <sub>p(AVDD_OV)</sub>	AVDD overvoltage detection response time	Delay time from AVDD exceeding AVDD overvoltage threshold to FAULT pin active			4	μs
t <sub>p(IOVDD_OV)</sub>	IOVDD overvoltage detection response time	Delay time from IOVDD exceeding IOVDD overvoltage threshold to FAULT pin active			4	μs
t <sub>p(DVDD_OV)</sub>	DVDD overvoltage detection response time	Delay time from DVDD exceeding DVDD overvoltage threshold to FAULT pin active			4	μs
t <sub>p(AVDD_UV)</sub>	AVDD undervoltage detection response time	Delay time from AVDD dropping below AVDD undervoltage threshold to FAULT pin active			4	μs
t <sub>p(IOVDD_UV)</sub>	IOVDD undervoltage detection response time	Delay time from IOVDD dropping below IOVDD undervoltage threshold to FAULT pin active			4	μs
t <sub>p(DVDD_UV)</sub>	DVDD undervoltage detection response time	Delay time from DVDD dropping below DVDD undervoltage threshold to FAULT pin active			4	μs
t <sub>p(AVDD_OSC)</sub>	AVDD oscillation detection response time	Delay time from AVDD oscillations exceeding AVDD oscillation threshold to FAULT pin active			30	μs
t <sub>p(IOVDD_OSC)</sub>	IOVDD oscillation detection response time	Delay time from IOVDD oscillations exceeding IOVDD oscillation threshold to FAULT pin active			30	μs
t <sub>p(DVDD_</sub> OSC)	DVDD oscillation detection response time	Delay time from DVDD oscillations exceeding DVDD oscillation threshold to FAULT pin active			30	μs
t <sub>p(AVDD_CL)</sub>	AVDD current limit detection response time	Delay time from AVDD exceeding AVDD current limit threshold to FAULT pin active			40	μs
t <sub>p(IOVDD_CL)</sub>	IOVDD current limit detection response time	Delay time from IOVDD exceeding IOVDD current limit threshold to FAULT pin active			40	μs
t <sub>p(AVDD_OTW)</sub>	AVDD overtemperature warning response time	Delay time from AVDD exceeding AVDD overtemperature warning threshold to FAULT pin active			300	μs
t <sub>p(IOVDD_OTW)</sub>	IOVDD overtemperature warning response time	Delay time from IOVDD exceeding IOVDD overtemperature warning threshold to FAULT pin active			300	μs
t <sub>p(AVDD_POR)</sub>	AVDD POR detection response time	Delay time from AVDD dropping below AVDD POR threshold to FAULT pin active			30	μs
t <sub>p(IOVDD_POR)</sub>	IOVDD POR detection response time	Delay time from IOVDD dropping below IOVDD POR threshold to FAULT pin active			30	μs
t <sub>p(DVDD_POR)</sub>	DVDD POR detection response time	Delay time from DVDD dropping below DVDD POR threshold to FAULT pin active			30	μs
t <sub>p(DGND_OPEN)</sub>	DGND open detection response time	Delay time from DGND pin disconnected to FAULT pin active			4	μs
t <sub>p(AGNDy_OPEN)</sub>	AGNDy open detection response time	Delay time from AGNDy pin disconnected to FAULT pin active			4	μs
t <sub>p(MEM_MAP_CRC)</sub>	Memory map CRC fault detection response time	Delay time from bit flip occurence in memory map to FAULT pin active		69	138	t <sub>OSCD</sub>
t <sub>p(REG_MAP_CRC)</sub>	Register map CRC fault detection response time	Delay time from bit flip occurence in register map to FAULT pin active		1024	2048	tosco
t <sub>p(MCLK_WD)</sub>	Main clock watchdog response time	Delay time from main clock watchdog timeout to FAULT pin active			2	μs
t <sub>p(OSCD_WD)</sub>	Diagnostic oscillator watchdog response time	Delay time from diagnostic oscillator watchdog timeout to FAULT pin active			2	μs
t <sub>p(MCLK_FAULT)</sub>	Main clock fault detection response time	Delay time from main clock fault detection to FAULT pin active			4096	t <sub>MCLK</sub>



minimum and maximum specifications apply from  $T_A = -40^{\circ}$ C to +105°C; typical specifications are at  $T_A = 25^{\circ}$ C; all specifications are at APWR = 5 V, DPWR = 5 V, IOVDD = 3.3 V, external clock,  $f_{CLK} = 8.192$  MHz, global-chop mode disabled, ADC1y and ADC3y data rate = 1 kSPS (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
AVDD LDO						
AVDD	Output voltage		3.1	3.3	3.5	V
	Load current	Available to external circuitry on the AVDD pin			20	mA
	Short-circuit current limit				60	mA
	Load regulation			1		mV/mA
IOVDD LDO						
IOVDD	Output voltage		3.1	3.3	3.5	V
	Load current	Available to external circuitry on the IOVDD pin			20	mA
	Short-circuit current limit				60	mA
	Load regulation			1		mV/mA
SUPPLY CU	RRENTS					
		Power-down mode		0.01		
		Standby mode		0.46		
	APWR supply current	Active mode, all ADCs disabled		0.8		
		Active mode, all ADCs enabled and converting (all features enabled, no external load on AVDD LDO)		6.3	7.7	mA
I <sub>APWR</sub>	APWR supply current per individual ADC	ADC1y enabled and converting, all gains, all data rates		1.75		
		ADC2y enabled and converting, all gains, all data rates		0.5		
		ADC3y enabled and converting, all gains, all data rates		0.5		
		Power-down mode		0.01		
		Standby mode		0.4		
	DPWR supply current <sup>(1)</sup>	Active mode, all ADCs disabled		0.8		
I <sub>DPWR</sub>		Active mode, all ADCs enabled and converting (all features enabled, no external load on IOVDD LDO)		1.1	1.7	mA
		ADC1y enabled and converting, all data rates		0.06		
	DPWR supply current per individual ADC <sup>(1)</sup>	ADC2y enabled and converting, all data rates		0.06		
		ADC3y enabled and converting, all data rates		0.06		
I <sub>AVDD</sub>	AVDD supply current	APWR shorted to AVDD, i.e. AVDD LDO bypassed. Active mode, all ADCs enabled and converting (all features enabled)		6.3		mA
IIOVDD	IOVDD supply current <sup>(1)</sup>	DPWR shorted to IOVDD, i.e. IOVDD LDO bypassed. Active mode, all ADCs enabled and converting (all features enabled)		1.1		mA
P <sub>D</sub>	Power dissipation	Active mode, all ADCs enabled and converting (all features enabled, no external load on IOVDD LDO)		37		mW

(1) Currents measured with SPI idle.



### 7.6 Timing Requirements

over operating ambient temperature range, SDO load: 20 pF || 100 k $\Omega$  (unless otherwise noted)

		MIN M.	AX UNIT
3.0 V ≤ IOV	/DD ≤ 3.6 V		
w(CLH)	Pulse duration, CLK high	49	ns
w(CLL)	Pulse duration, CLK low	49	ns
c(SC)	SCLK period	64	ns
w(SCL)	Pulse duration, SCLK low	32	ns
w(SCH)	Pulse duration, SCLK high	32	ns
d(CSSC)	Delay time, first SCLK rising edge after CSn falling edge	16	ns
d(SCCS)	Delay time, CSn rising edge after final SCLK falling edge	10	ns
w(CSH)	Pulse duration, CSn high	20	ns
su(DI)	Setup time, SDI valid before SCLK falling egde	5	ns
h(DI)	Hold time, SDI valid after SCLK falling edge	8	ns
w(RSL)	Pulse duration, RESETn low to generate device reset	500	ns
4.5 V ≤ IOV	/DD ≤ 5.5 V		
w(CLL)	Pulse duration, CLK low	49	ns
w(CLH)	Pulse duration, CLK high	49	ns
c(SC)	SCLK period	50	ns
w(SCL)	Pulse duration, SCLK low	25	ns
w(SCH)	Pulse duration, SCLK high	25	ns
d(CSSC)	Delay time, first SCLK rising edge after CSn falling edge	16	ns
d(SCCS)	Delay time, CSn rising edge after final SCLK falling edge	10	ns
w(CSH)	Pulse duration, CSn high	15	ns
su(DI)	Setup time, SDI valid before SCLK falling egde	5	ns
h(DI)	Hold time, SDI valid after SCLK falling edge	8	ns
w(RSL)	Pulse duration, RESETn low to generate device reset	500	ns

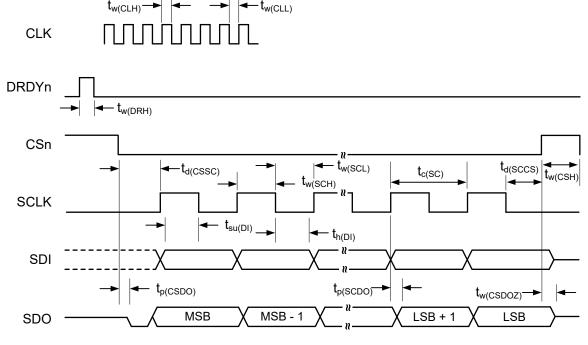


## 7.7 Switching Characteristics

over operating ambient temperature range, SDO load: 20 pF || 100 kΩ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
3.0 V ≤ IO\	/DD ≤ 3.6 V	1				
t <sub>p(CSDO)</sub>	Propagation delay time, CSn falling edge to SDO driven				50	ns
t <sub>p(CSDOZ)</sub>	Propagation delay time, CSn rising edge to SDO high impedance				75	ns
t <sub>p(SCDO)</sub>	Progapation delay time, SCLK rising edge to valid new SDO				32	ns
t <sub>w(DRH)</sub>	Pulse duration, DRDYn high			4		t <sub>MCLK</sub>
t <sub>TIMEOUT</sub>	SPI timeout		16385			t <sub>OSCD</sub>
t <sub>POR</sub>	Power-on-reset time	Measured from supplies crossing POR threshold to DRDYn rising edge		250		μs
t <sub>REGACQ</sub>	Register default value acquisition time	Measured from RESETn rising edge to DRDYn rising edge		44	114	μs
4.5 V ≤ IO\	/DD ≤ 5.5 V					
t <sub>p(CSDO)</sub>	Propagation delay time, CSn falling edge to SDO driven				50	ns
t <sub>p(SCDO)</sub>	Progapation delay time, SCLK rising edge to valid new SDO				20	ns
t <sub>p(CSDOZ)</sub>	Propagation delay time, CSn rising edge to SDO high impedance				75	ns
t <sub>w(DRH)</sub>	Pulse duration, DRDYn high			4		t <sub>MCLK</sub>
t <sub>TIMEOUT</sub>	SPI timeout		16385			t <sub>OSCD</sub>
t <sub>POR</sub>	Power-on-reset time	Measured from supplies crossing POR threshold to DRDYn rising edge		250		μs
t <sub>REGACQ</sub>	Register default value acquisition time	Measured from RESETn rising edge to DRDYn rising edge		44	114	μs

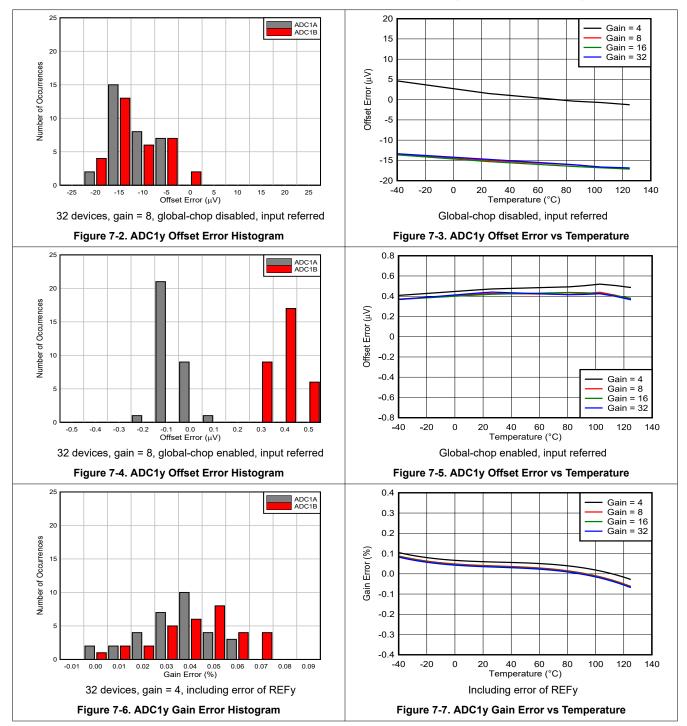
#### 7.8 Timing Diagram



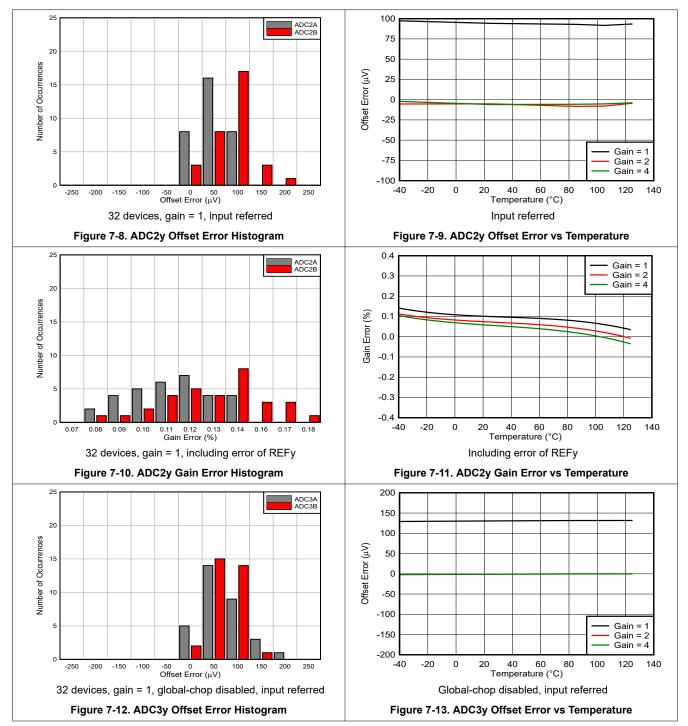




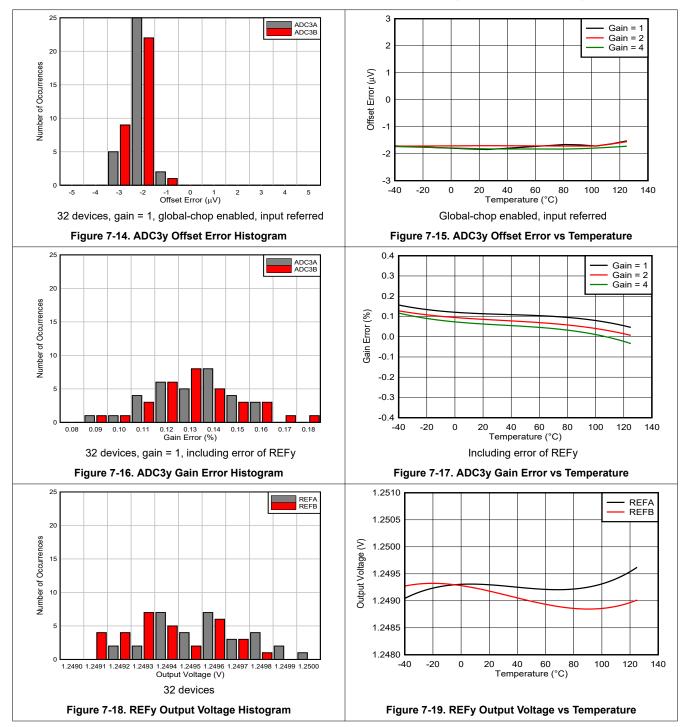
## 7.9 Typical Characteristics



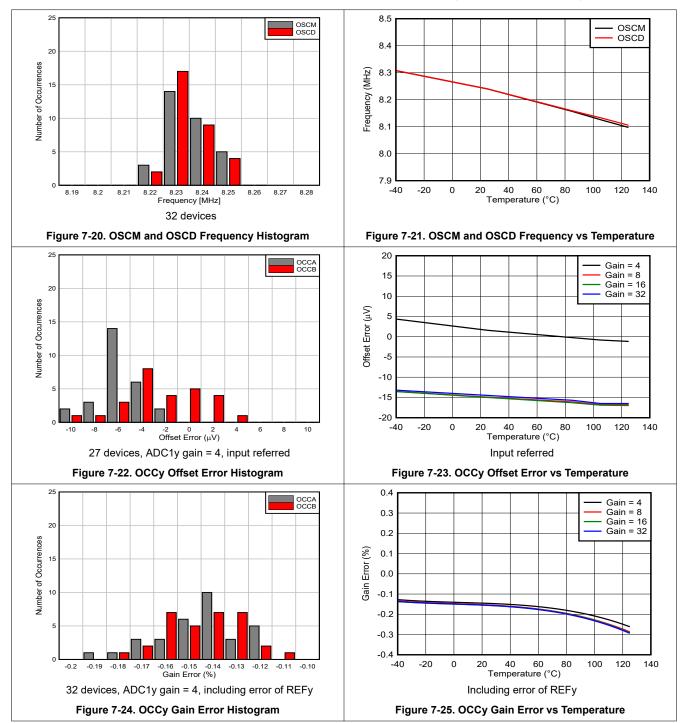




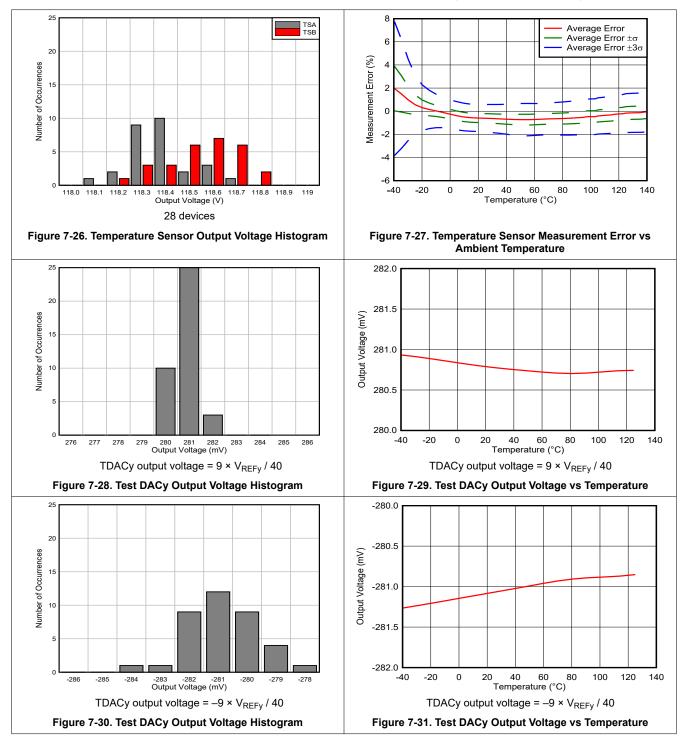




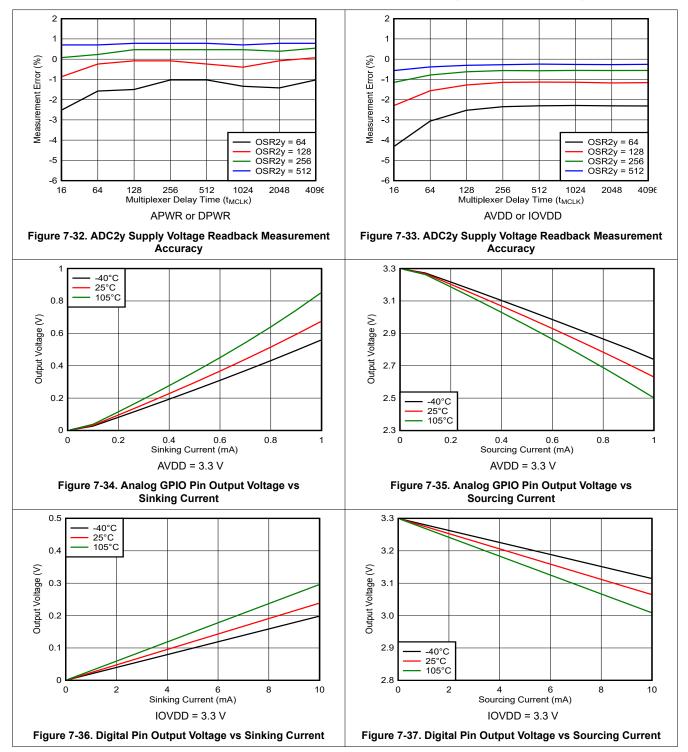




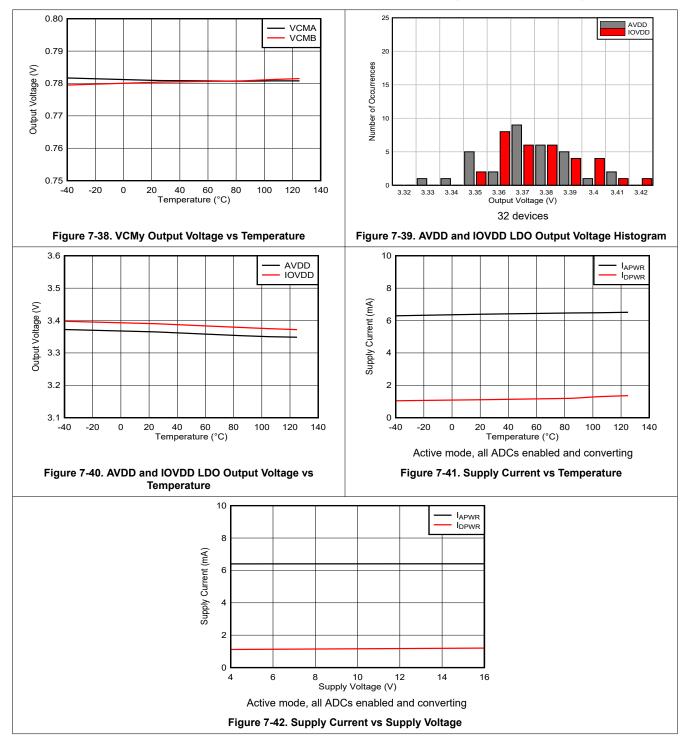














#### 8 Parameter Measurement Information

#### 8.1 Offset Drift Measurement

Offset drift is defined as the change in offset voltage over the specified temperature range. Offset drift is calculated using the *box method* in which a box is formed over the maximum and minimum offset voltages and over the specified temperature range. The box method specifies limits for the temperature error but does not specify the exact shape and slope of the device under test. For that reason, offset drift is specified as a positive number only, even though the drift can possibly be negative. Equation 1 shows the offset drift calculation using the box method:

Offset Drift (nV/°C) = 
$$10^9 \times (V_{OFSMAX} - V_{OFSMIN}) / (T_{MAX} - T_{MIN})$$
 (1)

where:

- V<sub>OFSMIN</sub> and V<sub>OFSMAX</sub> = Minimum and maximum offset voltages over the specified temperature range
- T<sub>MIN</sub> and T<sub>MAX</sub> = Minimum and maximum temperatures

#### 8.2 Gain Drift Measurement

Gain drift is defined as the change of gain error over the specified temperature range. Gain drift is calculated using the *box method* in which a box is formed over the maximum and minimum gain errors and over the specified temperature range. The box method specifies limits for the temperature error but does not specify the exact shape and slope of the device under test. For that reason, gain drift is specified as a positive number only, even though the drift can possibly be negative. Equation 2 describes the gain drift calculation using the box method.

Gain Drift (ppm/°C) = 
$$(GE_{MAX} - GE_{MIN}) / (T_{MAX} - T_{MIN})$$

(2)

#### where:

- GE<sub>MIN</sub> and GE<sub>MAX</sub> = Minimum and maximum gain errors over the specified temperature range
- T<sub>MIN</sub> and T<sub>MAX</sub> = Minimum and maximum temperatures



#### 8.3 Noise Performance

Adjust the data rate and gain to optimize the noise performance of the individual ADCs. When reducing the data rate by increasing the oversampling ratio (OSR), averaging is increased and results in lower noise. Table 8-1 to Table 8-3 summarize the noise performance of ADC1y, ADC2y, and ADC3y. The data are representative of typical noise performance at  $T_A = 25^{\circ}$ C using  $f_{MCLK} = 8.192$  MHz. The data shown are typical input-referred noise results in units of  $\mu V_{RMS}$  with the analog inputs shorted together and averaging data across a 1-ms period. Use Equation 3 to calculate effective resolution from the provided  $\mu V_{RMS}$  numbers.

Effective Resolution =  $ln[(2 \times V_{REFy} / Gain) / V_{RMS-Noise}] / ln(2)$ 

(3)

The noise performance of ADC1y and ADC3y improves by a factor of  $\sqrt{2}$  in global-chop mode.

Table 6-1. ADC Ty Noise Performance ( $\mu v_{RMS}$ ) at T <sub>A</sub> = 25 C							
00004	DATA RATE,		GA	AIN			
OSR1y	f <sub>MCLK</sub> = 8.192 MHz	4	8	16	32		
64	64 kSPS	20.7	10.8	10.8	10.8		
128	32 kSPS	6.19	3.96	3.96	3.96		
256	16 kSPS	3.70	2.51	2.51	2.51		
512	8 kSPS	2.61	1.78	1.78	1.78		
1024	4 kSPS	1.88	1.28	1.28	1.28		
2048	2 kSPS	1.46	0.91	0.91	0.91		
4096	1 kSPS	1.15	0.65	0.65	0.65		
8192	0.5 kSPS	0.88	0.44	0.44	0.44		

#### Table 8-1. ADC1y Noise Performance ( $\mu V_{RMS}$ ) at T<sub>A</sub> = 25°C

OSR2y	CONVERSION TIME,		GAIN	
USKZY	f <sub>MCLK</sub> = 8.192 MHz	1	2	4
64	46.87 μs	93.4	48.3	48.3
128	62.50 µs	48.4	26.5	26.5
256	93.75 μs	31.9	17.5	17.5
512	156.25 µs	22.4	12.1	12.1

#### Table 8-3. ADC3y Noise Performance ( $\mu V_{RMS}$ ) at T<sub>A</sub> = 25°C

0000	DATA RATE,		GAIN				
OSR3y	f <sub>MCLK</sub> = 8.192 MHz	1	2	4			
64	64 kSPS	93.4	48.3	48.3			
128	32 kSPS	35.1	19.8	19.8			
256	16 kSPS	21.2	12.6	12.6			
512	8 kSPS	14.4	8.73	8.73			
1024	4 kSPS	10.3	6.21	6.21			
2048	2 kSPS	7.37	4.29	4.29			
4096	1 kSPS	5.39	3.01	3.01			
8192	0.5 kSPS	3.52	2.05	2.05			
8192	0.5 KSPS	3.52	2.05	2.05			



## 9 Detailed Description

#### 9.1 Overview

The ADS131B26-Q1 is a fully integrated, high-voltage battery pack monitor for automotive electrical vehicle (EV) battery management systems (BMS) that integrates two simultaneous-sampling, high-precision, 24-bit ADC channels (ADC1A, ADC1B) to redundantly measure battery current with high resolution and accuracy using an external shunt resistor. Two independent digital overcurrent detection comparators (OCCA, OCCB) work in parallel to the two ADCs for fast overcurrent detection.

Another set of two simultaneous-sampling, 24-bit ADCs (ADC3A, ADC3B) are integrated to measure battery pack voltage using external high-voltage resistor dividers synchronously to the battery current for accurate battery state-of-charge and state-of-health calculations.

Additionally, two multiplexed, 16-bit ADC channels (ADC2A, ADC2B) are available to measure shunt temperature using external temperature sensors, such as thermistors or analog output temperature sensors, and other voltages in the system. ADC2A and ADC2B are equipped with channel sequencers that automatically step through the configured multiplexer inputs, select them for measurement, and start ADC conversions.

The device is partitioned into two sections, A and B. The circuitry in section A is independent from the circuitry in section B. However, both sections are powered from the same supply, derive their respective clocks from the same main clock source, and share the same digital control and serial interface.

Besides the various ADC channels, each section provides:

- A precision, low-drift, 1.25-V voltage reference (REFA, REFB) that feeds the ADCs in each section
- A negative charge pump (NCPA, NCPB) that provides a negative supply voltage for the gain stages in front of each ADC to allow signal measurements below ground
- A temperature sensor (TSA, TSB) to measure die temperature through ADC2A and ADC2B, respectively
- A Test DAC (Test DAC A, Test DAC B), which generates precision test voltages that can be routed for measurement to the ADCs in the other section
- Two GPIOs (GPIO0A, GPIO1A and GPIO0B, GPIO1B) with logic levels based on AVDD

In many BMS applications, the pack monitor is powered from an unregulated isolated DC/DC converter. For that reason, the ADS131B26-Q1 integrates linear regulators (AVDD and IOVDD LDOs) that accept voltages between 4 V and 16 V and provide regulated 3.3-V analog and digital supply rails for the internal circuitry. The two low-dropout regulators (LDOs) can also provide a limited amount of current to external circuitry. A common use case is to power the primary side of a digital isolator, which isolates the SPI communication to a host microcontroller, with the IOVDD LDO output; see the *ADS131B26Q1EVM-PDK Evaluation Module* user guide.

The main clock for the ADS131B26-Q1 is either provided by the internal 8.192-MHz oscillator or by an external clock provided at the CLK pin.

A multitude of monitoring and diagnostic features are integrated in the device to mitigate and detect random hardware faults to aid in the development of functional safety BMS, such as:

- Supply undervoltage, overvoltage, overtemperature, and oscillation monitors
- Supply-voltage readback capability through ADC2A and ADC2B
- · A set of open-wire detection current sources and sinks per ADC
- Clock monitors
- Cyclic redundancy check (CRC), timeout monitor, and SCLK counter on the SPI to achieve high data integrity for the communication
- Register and memory map CRC
- ADC conversion and sequence counters

The device offers five GPIOs (GPIO0 through GPIO4) with logic levels based on IOVDD and optional pulsewidth modulation (PWM) input and output capability. GPIO2 can alternatively be configured as a FAULT output, and GPIO3 and GPIO4 can be configured as overcurrent comparator outputs.

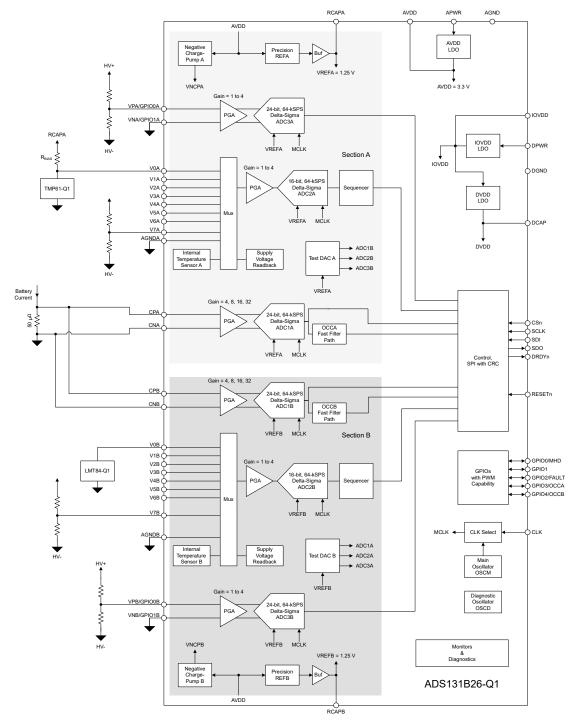


As shown in Table 9-1, the ADS131B2x-Q1 family consists of three devices that differ in the amount of integrated ADC channels.

DEVICE	ADC1A, ADC1B	ADC2A	ADC2B	ADC3A, ADC3B
ADS131B23-Q1	Yes	Yes	No	No
ADS131B24-Q1	Yes	Yes	Yes	No
ADS131B26-Q1	Yes	Yes	Yes	Yes

#### Table 9-1. ADS131B2x-Q1 Device Family Comparison by Available ADC Channels

#### 9.2 Functional Block Diagram





## 9.3 Feature Description

#### 9.3.1 Naming Conventions

Throughout this document, suffixes *x* and *y* refer to certain elements of the device:

- Suffix y refers to elements in both sections A and B.
   For example, ADC1y refers to ADC1A as well as to ADC1B.
- Suffix x either refers to all ADCs in one section or to all analog inputs of ADC2y.
- For example, ADCxA refers to ADC1A, ADC2A, and ADC3A, and VxA refers to analog inputs V0A to V7A of ADC2A.

#### 9.3.2 Precision Voltage References (REFA, REFB)

The ADS131B26-Q1 integrates two precision, low-drift, band-gap voltage references (REFA and REFB), one for each section of the device. The references have a nominal voltage of 1.25 V. No external voltage reference can be provided to the device. All ADCs in section A use REFA and, correspondingly, all ADCs in section B use REFB. The RCAPA and RCAPB pins are outputs of the voltage references. Decouple the RCAPA pin with a 1- $\mu$ F capacitor to AGNDA and the RCAPB pin with a 1- $\mu$ F capacitor to AGNDB. The voltage references are buffered and can source external circuitry with a limited amount of current out of the RCAPy pins. The buffers cannot sink any current. See the *Electrical Characteristics* table for details.

#### 9.3.3 Clocking (MCLK, OSCM, OSCD)

The ADS131B26-Q1 requires a main clock (MCLK) to operate. As shown in Figure 9-1, the main clock to the ADS131B26-Q1 is provided in one of two ways:

- By the internal 8.192-MHz main oscillator (OSCM) or
- By an external clock on the CLK pin

The CLK\_SOURCE bit selects the according main clock source for the device. At device power-up or after device reset, the internal main oscillator is selected as the MCLK source by default.

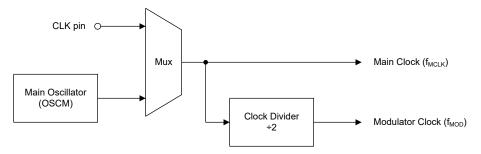


Figure 9-1. Main Clock Selection Diagram

The modulator clock of the various delta-sigma ADCs is derived from the common main clock. A clock divider divides the main clock frequency ( $f_{MCLK}$ ) by a factor of two to create the modulator frequency ( $f_{MOD} = f_{MCLK} / 2$ ) with a duty cycle of 50%.

Before changing the clock source using the CLK\_SOURCE bit, disable all ADCs using the respective ADC enable bits or set the device in standby mode to prevent clock glitching during the clock switchover. When switching from an external clock source to the internal main oscillator, keep the external clock running until after the device switched over to the internal main oscillator.

The ADS131B26-Q1 integrates a second internal oscillator, called the *diagnostic oscillator (OSCD)*, which is used for various monitoring and diagnostic functions.



#### 9.3.4 ADC1y

The primary purpose of the 24-bit ADC1A and ADC1B is to redundantly measure battery current across an external low-side, GND-referenced shunt resistor.

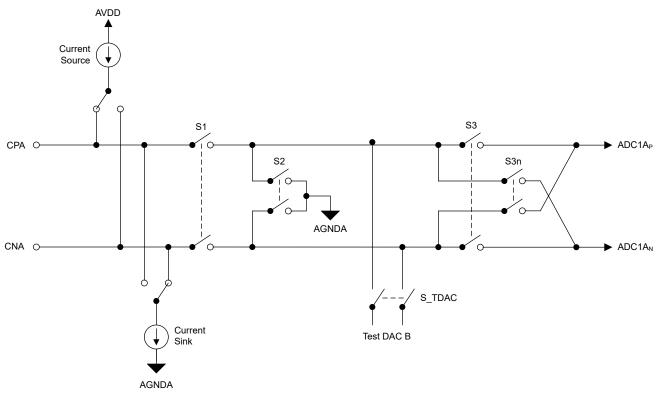
The ADC1y channel signal chain consists of two differential analog inputs (CPy, CNy), an input multiplexer followed by a programmable gain amplifier (PGA), a delta-sigma modulator and digital filter, and the global-chop and calibration logic.

#### 9.3.4.1 ADC1y Input Multiplexer

The input multiplexer controls which signals are routed to the PGA of the ADC1y channel. Configure the input multiplexer using the MUX1y[1:0] bits. The input multiplexer allows the following inputs to be connected to the PGA:

- The differential analog signal between the CPy and CNy inputs.
- The inverse differential analog signal between the CPy and CNy inputs.
- Internal short to AGNDy. The analog inputs CPy and CNy are disconnected from the PGA in this case. Use this setting for self-offset calibration of the ADC1y channel.
- DC test signal provided by the Test DAC of the other section.

Figure 9-2 shows a diagram of the ADC1A input multiplexer and Table 9-2 lists the according switch positions depending on the MUX1A[1:0] bit settings.



#### Figure 9-2. ADC1A Input Multiplexer

MUX1A[1:0] SETTING	S1	S2	S3	S3n	S_TDAC
00b	Closed	Open	Closed	Open	Open
01b	Closed	Open	Open	Closed	Open
10b	Open	Closed	Closed	Open	Open
11b	Open	Open	Closed	Open	Closed



30

#### 9.3.4.2 ADC1y Programmable Gain Amplifier (PGA)

ADC1y features an integrated programmable gain amplifier (PGA) that provides gains of 4, 8, 16, and 32. Select the gain setting using the GAIN1y[1:0] bits.

Varying the PGA gain scales the differential full-scale input voltage range (FSR) of ADC1y. Equation 4 describes the relationship between FSR and gain. Equation 4 uses the internal reference voltage, 1.25 V, as the scaling factor without accounting for gain error caused by tolerance in the reference voltage.

FSR = ±1.25 V / Gain

Table 9-3 shows the corresponding full-scale ranges for each gain setting.

Table 9-3. ADC1y Full-Scale Range		
GAIN SETTING	FSR	
4	±312.5 mV	
8	±156.25 mV	
16	±78.125 mV	
32	±39.063 mV	

Table 9-3. ADC1y Full-Scale Range

To measure bidirectional currents across a shunt resistor that is GND referenced, the PGA must accept voltages below GND. For that reason, the negative supply of the PGA is provided by an internal negative charge pump (NCPy). This provision allows the PGA to accept absolute input voltages on each input below GND.

The input impedance of the ADC1y channel is independent of the gain, OSR, and global-chop mode settings. The input impedance does, however, scale indirectly proportional with the MCLK frequency.

#### 9.3.4.3 ADC1y $\Delta\Sigma$ Modulator

ADC1y uses a second-order delta-sigma ( $\Delta\Sigma$ ) modulator to convert the analog input signal to a 1's density modulated digital bit-stream. The  $\Delta\Sigma$  modulator oversamples the input signal at a frequency many times greater than the output data rate. The modulator frequency, f<sub>MOD</sub>, of ADC1y is equal to half the main clock frequency (that is, f<sub>MOD</sub> = f<sub>MCLK</sub> / 2).

#### 9.3.4.4 ADC1y Digital Filter

The ADC1y  $\Delta\Sigma$  modulator bitstream feeds into a digital filter. The digital filter is a linear phase, finite impulse response (FIR), low-pass sinc3 filter that attenuates the out-of-band quantization noise of the  $\Delta\Sigma$  modulator. The low-resolution, high-speed modulator output is decimated and downsampled by the digital filter to produce high-resolution ADC data at an output data rate of f<sub>DATA</sub>. The decimation factor, defined as per Equation 5, is called the *oversampling ratio* (*OSR*).

$$OSR = f_{MOD} / f_{DATA}$$

The OSR determines the amount of averaging that is applied to the modulator output in the digital filter and, therefore, the filter bandwidth and conversion noise. Higher OSRs lead to lower filter bandwidth and better noise performance.

The OSR is programmable within a range of 64 and 8192 using the OSR13y[2:0] bits. Table 9-4 lists the OSR settings for ADC1y together with the corresponding output data rates and –3-dB frequencies of the sinc3 filter for a nominal MCLK frequency of 8.192 MHz.



(4)

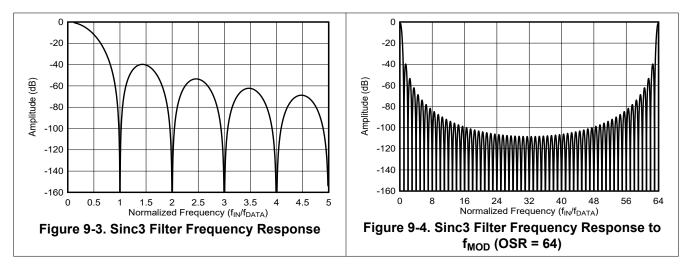
(5)

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OSR	OUTPUT DATA RATE (f <sub>DATA</sub> )	-3-dB FREQUENCY		
64	64 kSPS	16.8 kHz		
128	32 kSPS	8.4 kHz		
256	16 kSPS	4.2 kHz		
512	8 kSPS	2.1 kHz		
1024	4 kSPS	1.0 kHz		
2048	2 kSPS	524 Hz		
4096	1 kSPS	262 Hz		
8192	500 SPS	131 Hz		

Table 9-4. ADC1y OSR Settings,	Output Data Rates and –3-dB Frequencies for			

Figure 9-3 and Figure 9-4 show the filter frequency response of the sinc3 filter. The sinc3 filter has infinite attenuation at integer multiples of the output data rate except for integer multiples of  $f_{MOD}$ . As with all digital filters, the digital filter response repeats at integer multiples of the modulator frequency,  $f_{MOD}$ . The data rate and filter notch frequencies scale with  $f_{MOD}$ .



#### 9.3.4.5 ADC1y Offset and Gain Calibration

ADC1y provides the ability to compute offset and gain corrected conversion data using user-programmable offset and gain correction registers. As shown in Figure 9-5, the 24-bit offset correction value (OCAL1y[23:0]) is subtracted from the conversion data before being multiplied by the 16-bit gain correction factor (GCAL1y[15:0]). Output data are rounded to the final resolution and clipped to +FS and -FS code values after the scaling operation. The offset and gain calibration coefficients must be stored in external nonvolatile memory and programmed into the offset and gain calibration registers each time the device powers up or resets because the ADS131B26-Q1 registers are volatile.

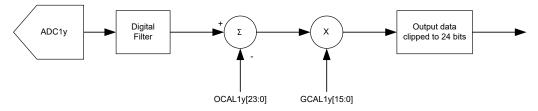


Figure 9-5. Calibration Logic Block Diagram



The 24-bit offset calibration value is provided in two's-complement format and programmed into the OCAL1y[23:0] bit field that spans across the ADC1y OCAL MSB and ADC1y OCAL LSB registers. Table 9-5 shows example offset calibration values. The LSB size of the offset calibration value is calculated using Equation 6.

LSB size =  $(2 \times V_{REFy}) / (GAIN1y \times 2^{24})$ 

(6)

Table 9-5. Offset Calibration Value Examples			
OCAL1y[23:0] VALUE	APPLIED OFFSET CORRECTION		
000010h	-16 LSB		
000001h	–1 LSB		
FFFFFh	1 LSB		
FFFF0h	16 LSB		

The 16-bit gain calibration value is provided in two's-complement format and programmed into the GCAL1y[15:0] bit field. One LSB of the gain calibration value equals a gain correction factor of 1/2<sup>16</sup> = 0.000015. Table 9-6 shows example gain calibration values.

GCAL1y[15:0] VALUE	APPLIED GAIN CORRECTION			
7FFFh	1.499985			
0001h	1.000015			
0000h	1			
FFFFh	0.999985			
8000h	0.5			

Table 9-6.	Gain	Calibration	Value	Examples
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The recommended calibration procedure is as follows:

- 1. Preset the offset and gain calibration registers to OCAL1v[23:0] = 000000h and GCAL1v[15:0] = 0000h, respectively.
- 2. Perform an offset calibration by shorting the ADC1y inputs internally using the respective input multiplexer setting (MUX1y[1:0] = 10b), or short the inputs externally at the system level to include the offset error of the external filter stages. Acquire multiple conversion data and write the average value of the data into the offset calibration registers. Averaging the data reduces conversion noise to improve calibration accuracy.
- 3. Perform a gain calibration by applying a precision calibration signal to the ADC1y inputs or at the system level to include the gain error of the external filter stages. Choose the calibration voltage to be less than the full-scale input range to avoid clipping the output code. Clipped output codes result in inaccurate calibration. For example, use a 150-mV calibration signal when using gain = 8. Acquire multiple conversion data and average the results. Use Equation 7 to calculate the gain calibration value.

Gain Calibration Value = (expected output code / actual output code)

(7)

The expected output code for a 150-mV calibration voltage using gain = 8 is: (150 mV / LSB size) = 7AE148h, where LSB size =  $(2 \times 1.25 \text{ V}) / (8 \times 2^{24})$ . If the actual measured output code is 6FB587h for example, then the gain calibration factor calculates to 1.1. The resulting gain calibration value to write into the GCAL1y[15:0] bit field is:  $(1.1 - 1) / (1 / 2^{16}) = 199$ Ah.



#### 9.3.4.6 ADC1y Conversion Data

Conversion data for ADC1A and ADC1B are 24 bits and are automatically output on SDO as part of the SPI frame, unless register data are output following a register read command.

Data are provided in binary two's-complement format. Use Equation 8 to calculate the size of one code (LSB).

$$1 \text{ LSB} = (2 \times V_{\text{REFv}} / \text{Gain}) / 2^{24} = +\text{FSR} / 2^{23}$$

(8)

A positive full-scale input  $V_{IN} \ge +FSR - 1 LSB = V_{REFy} / Gain - 1 LSB produces an output code of 7FFFFh and a negative full-scale input (<math>V_{IN} \le -FSR = -V_{REFy} / Gain$ ) produces an output code of 800000h. The output clips at these codes for signals that exceed full-scale.

Table 9-7 summarizes the ideal output codes for different input signals.

(24-Bit Conversion Data)			
INPUT SIGNAL (V <sub>IN</sub> = V <sub>AINP</sub> – V <sub>AINN</sub> )	IDEAL OUTPUT CODE		
≥ FSR (2 <sup>23</sup> – 1) / 2 <sup>23</sup>	7FFFFh		
FSR / 2 <sup>23</sup>	000001h		
0	000000h		
–FSR / 2 <sup>23</sup>	FFFFFh		
≤ <i>–</i> FSR	800000h		

# Table 9-7. Ideal Output Code versus Input Signal(24-Bit Conversion Data)

Figure 9-6 shows the mapping of the analog input signal to the output codes.

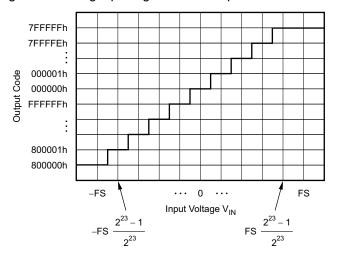


Figure 9-6. Code Transition Diagram (24-Bit Conversion Data)



#### 9.3.5 ADC2y

The purpose of the multiplexed, 16-bit ADC2A and ADC2B is to measure shunt temperature using external thermistors or analog output temperature sensors, and any other voltages that must be measured in the BMS.

The ADC2y channel signal chain consists of eight analog inputs (V0y to V7y), an input multiplexer followed by a programmable gain amplifier (PGA), a delta-sigma modulator and digital filter, calibration logic, and a channel sequencer.

#### 9.3.5.1 ADC2y Input Multiplexer

The input multiplexer controls which signals are routed to the positive and negative PGA inputs of the ADC2y channel in each sequence step. Configure the input multiplexer using the SEQ2y\_STEPn\_CH\_P[3:0] and SEQ2y\_STEPn\_CH\_N bits.

The input multiplexer allows the following inputs to be connected to the PGA:

- Any of the eight analog inputs, V0y to V7y, in single-ended measurement configuration when AGNDy is selected as the negative multiplexer channel.
- Any of the seven analog inputs, V0y to V6y, in single-ended measurement configuration when V7y is selected as the negative multiplexer channel and connected to AGNDy externally.
- Any of the seven analog inputs, V0y to V6y, in pseudo-differential measurement configuration when V7y is selected as the negative multiplexer channel. Connect a positive bias voltage to V7y in this case, either using an external bias voltage or the internal common-mode voltage of the VCMy buffer.
- Internal temperature sensor, TSy.
- Internal short to AGNDy. Use this setting for self-offset calibration of the ADC2y channel.
- DC test signal provided by the Test DAC of the other section.
- Attenuated signals of the various supply voltages (APWR, DPWR, AVDD, IOVDD, and DVDD).

Whenever a signal other than an analog input is selected as the positive multiplexer input, the analog inputs are disconnected from the PGA and AGNDy is selected automatically as the negative multiplexer input. Figure 9-7 illustrates a diagram of the ADC2A input multiplexer.



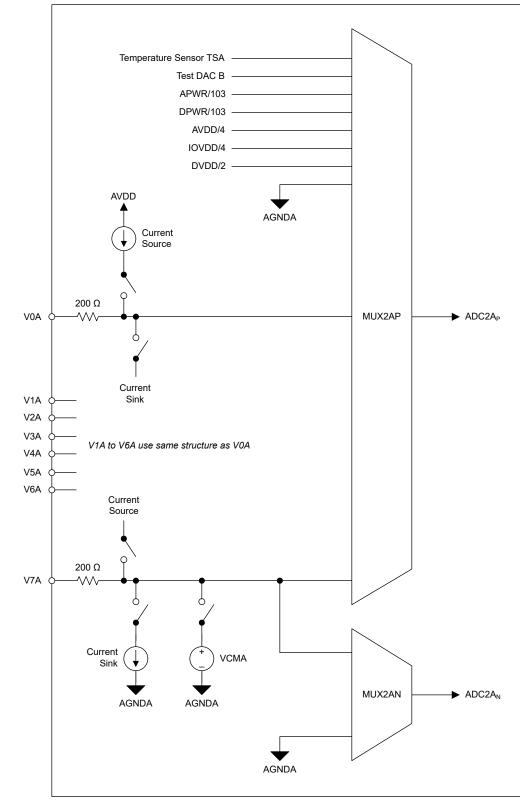


Figure 9-7. ADC2A Input Multiplexer

ADC2y features an integrated programmable gain amplifier (PGA) that provides gains of 1, 2, and 4. Select the gain setting using the SEQ2y STEPn GAIN[1:0] bits.

Varying the PGA gain scales the differential full-scale input voltage range (FSR) of ADC2y. Equation 9 describes the relationship between FSR and gain. Equation 9 uses the internal reference voltage, 1.25 V, as the scaling factor without accounting for gain error caused by tolerance in the reference voltage.

FSR = ±1.25 V / Gain

ADS131B26-Q1

Table 9-8 shows the corresponding full-scale ranges for each gain setting.

Table 9-8. ADC2y Full-Scale Range			
GAIN SETTING	FSR		
1	±1.25 V		
2	±625 mV		
4	±312.5 mV		

Table 9-8.	ADC2v	Full-Scale	Range

When performing single-ended measurements (that is, AGNDy is selected as the negative multiplexer channel for ADC2y), gain settings of 1 and 2 only allow for unipolar measurements, whereas gain setting of 4 allows for both unipolar and bipolar input voltage measurements. See the absolute input voltage range specification of ADC2y in the Recommended Operating Conditions table for details and the ADC2y Measurement Configurations section for example input configurations. Unipolar measurements only use the positive code range from approximately 0000h to 7FFFh, which maps to an input voltage range from approximately 0 V to +FS.

The input impedance of the ADC2y channel depends on two factors: the main clock frequency (f<sub>MCLK</sub>) and the selected OSR setting. The *Electrical Characteristics* table lists typical input impedance values for f<sub>MCLK</sub> = 8.192 MHz at the various OSR settings. Increasing the OSR by twice the value effectively doubles the input impedance. The input impedance scales indirectly proportional with the MCLK frequency.

#### 9.3.5.3 ADC2v $\Delta\Sigma$ Modulator

ADC2y uses a second-order, delta-sigma ( $\Delta\Sigma$ ) modulator to convert the analog input signal to a 1's density modulated digital bitstream. The  $\Delta\Sigma$  modulator oversamples the input signal at a frequency many times greater than the output data rate. The modulator frequency, f<sub>MOD</sub>, of ADC2y is equal to half the main clock frequency (that is,  $f_{MOD} = f_{MCLK} / 2$ ).

#### 9.3.5.4 ADC2y Digital Filter

The ADC2y ΔΣ modulator bitstream feeds into a digital filter. The digital filter is a linear phase, finite impulse response (FIR), low-pass sinc filter that attenuates the out-of-band quantization noise of the  $\Delta\Sigma$  modulator.

In contrast to ADC1y, ADC2y always operates in a single-shot conversion mode fashion. The ADC2y sequencer triggers the individual conversions. The digital filter resets at the start of every conversion and must completely settle for every conversion. ADC2y only outputs settled conversion results, assuming that the input signal settled before the conversion started.

Use the OSR2y[1:0] bits to select the conversion time for ADC2y. For an OSR = 64, the filter is comprised of a pure sinc3 filter. A sinc3 filter takes three cycles to settle. Therefore, the conversion time for an OSR = 64 equals  $(3 \times 64 / f_{MOD} = 192 t_{MOD} = 384 t_{MCLK})$ . For higher OSR settings the sinc3 filter is followed by a sinc1 filter.

Table 9-9 lists an overview of the OSR settings and the corresponding conversion times for ADC2y based on a nominal MCLK frequency of 8.192 MHz.





OSR		CONVERSION TIME		
OVERALL	SINC3	SINC1	t <sub>MCLK</sub>	μs
64	64	1	384 t <sub>MCLK</sub>	46.87 µs
128	64	2	512 t <sub>MCLK</sub>	62.50 μs
256	64	4	768 t <sub>MCLK</sub>	93.75 μs
512	64	8	1280 t <sub>MCLK</sub>	156.25 µs

## Table 9-9. ADC2y OSR Settings and Conversion Times for f<sub>MCLK</sub> = 8.192 MHz

# 9.3.5.5 ADC2y Offset and Gain Calibration

ADC2y provides the ability to compute offset and gain corrected conversion data using user-programmable offset and gain correction registers. The same calibration values are used for all sequence steps, however, the offset and gain correction factors are not applied when the internal temperature sensor is selected for measurement by MUX2y. As shown in Figure 9-8, the 16-bit offset correction value (OCAL2y[15:0]) is subtracted from the conversion data before being multiplied by the 16-bit gain correction factor (GCAL2y15:0]). Output data are rounded to the final resolution and clipped to +FS and -FS code values after the scaling operation. The offset and gain calibration coefficients must be stored in external nonvolatile memory and programmed into the offset and gain calibration registers each time the device powers up or resets because the ADS131B26-Q1 registers are volatile.

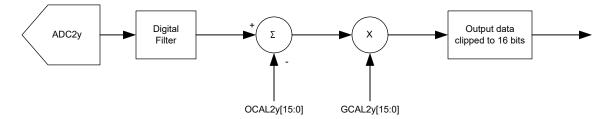


Figure 9-8. Calibration Logic Block Diagram

The 16-bit offset calibration value is provided in two's-complement format and programmed into the OCAL2y[15:0] bit field. Table 9-10 shows example offset calibration values. The LSB size of the offset calibration value is calculated using Equation 10 and Equation 11 depending on the selected gain setting.

GAIN2y = 1: LSB size = 
$$V_{REFy} / 2^{15}$$

(10)

GAIN2y = 2 or 4: LSB size =  $V_{REFv}$  / (2 × 2<sup>15</sup>)

Table 9-10. Offset Calibration Value Examples

OCAL2y[15:0] VALUE	APPLIED OFFSET CORRECTION
0010h	-16 LSB
0001h	–1 LSB
FFFFh	1 LSB
FFF0h	16 LSB

The 16-bit gain calibration value is provided in two's-complement format and programmed into the GCAL2y[15:0] bit field. One LSB of the gain calibration value equals a gain correction factor of 1/2<sup>16</sup> = 0.000015. Table 9-11 shows example gain calibration values.

Tuble 9 11. Guill Guilbrution Value Examples			
GCAL2y[15:0] VALUE	APPLIED GAIN CORRECTION		
7FFFh	1.499985		
0001h	1.000015		
0000h	1		
FFFFh	0.999985		
8000h	0.5		

Table 9-11. Gain Calibration	Value Examples
------------------------------	----------------

(11)



The recommended calibration procedure is as follows:

- 1. Preset the offset and gain calibration registers to OCAL2y[15:0] = 0000h and GCAL2y[15:0] = 0000h, respectively.
- 2. Perform an offset calibration by shorting the ADC2y input in one or multiple sequence steps internally to AGNDy using the respective input multiplexer setting (SEQ2y\_STEPn\_CH\_P[3:0] = 1001b), or short one of the ADC2y inputs externally at the system level to include the offset error of the external filter stages. Set the gain for the respective sequence step to 1 or 2. Acquire multiple conversion data and write the average value of the data into the offset calibration registers. Averaging the data reduces conversion noise to improve calibration accuracy.
- 3. Perform a gain calibration by applying a precision calibration signal to one of the ADC2y inputs or at the system level to include the gain error of the external filter stages. Choose the calibration voltage to be less than the full-scale input range to avoid clipping the output code. Clipped output codes result in inaccurate calibration. For example, use a 1.2-V calibration signal when using gain = 1. Acquire multiple conversion data and average the results. Use Equation 12 to calculate the gain calibration value.

Gain Calibration Value = (expected output code / actual output code)

(12)

The expected output code for a 1.2-V calibration voltage using gain = 1 is: (1.2 V / LSB size) = 7AE1h, where LSB size =  $(1.25 \text{ V} / 2^{15})$ . If the actual measured output code is 6FB6h for example, then the gain calibration factor calculates to 1.1. The resulting gain calibration value to write into the GCAL2y[15:0] bit field is:  $(1.1 - 1) / (1 / 2^{16}) = 199$ Ah.

# 9.3.5.6 ADC2y Sequencer

See the ADC2y Sequencer Operation and Sequence Modes section for details.

## 9.3.5.7 VCMy Buffers

The ADC2y signal chain includes a bias voltage generator of typically 0.78 V followed by a common-mode buffer, VCMy. When the VCMy\_EN bit is set, the output of the VCMy buffer is internally connected to the V7y multiplexer channel to provide the bias voltage to V7y. Use the VCMy buffer to implement pseudo-differential measurements, where V7y is selected as the negative multiplexer channel of ADC2y.

When the VCMy buffer is enabled, the capacitive load from V7y to AGNDy must be limited to less than 100 pF.

# 9.3.5.8 ADC2y Measurement Configurations

ADC2y allows measurements of input voltages in three different configurations, as summarized in Table 9-12, Figure 9-9, Figure 9-10, and Figure 9-11.

INPUT CONFIGURATION	POSITIVE MUX CHANNEL	NEGATIVE MUX CHANNEL	GAIN	INPUT RANGE	ABSOLUTE INPUT VOLTAGE	FIGURE
Single-ended	V0y to V7y	AGNDy	1, 2, or 4	Unipolar	0 V to +FS = VREFy / Gain	Figure 9-9
Single-ended	V0y to V7y	AGNDy	4	Bipolar	–0.3125 V to 0.3125 V	Figure 9-10
Pseudo-differential	V0y to V6y	V7y	1, 2, or 4	Bipolar	V <sub>V7y</sub> ±FS <sup>(1)</sup>	Figure 9-11

## Table 9-12. Overview of Possible Measurement Configurations for ADC2y

(1) Actual input range limited by absolute input voltage range specification in the *Recommended Operating Conditions* table.



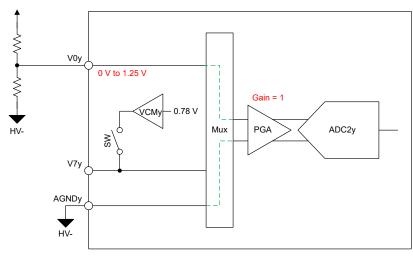


Figure 9-9. Single-Ended Input, Unipolar Voltage Measurement (Gain = 1)

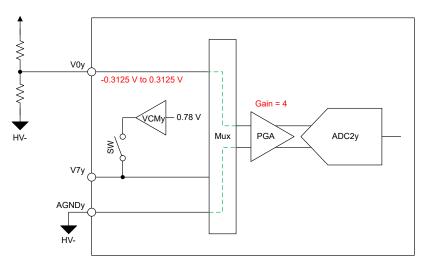


Figure 9-10. Single-Ended Input, Bipolar Voltage Measurement (Gain = 4)

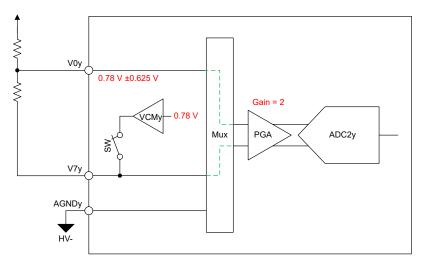


Figure 9-11. Pseudo-Differential Input, Bipolar Voltage Measurement (Gain = 2, Using Internal Bias Voltage)



# 9.3.5.9 ADC2y Conversion Data

Conversion data for the sequence steps of ADC2y are 16 bits and (in contrast to ADC1y and ADC3y conversion data) stored in the user register space (register addresses 10h to 2Fh). Read ADC2y conversion data using the register read command.

Data are provided in binary two's-complement format. Use Equation 13 to calculate the size of one code (LSB).

$$1 \text{ LSB} = (2 \times V_{\text{REFy}} / \text{Gain}) / 2^{16} = +\text{FSR} / 2^{15}$$

(13)

A positive full-scale input V<sub>IN</sub> ≥ +FSR – 1 LSB = V<sub>REFv</sub> / Gain – 1 LSB produces an output code of 7FFFh and a negative full-scale input (V<sub>IN</sub> ≤ -FSR = -V<sub>REFy</sub> / Gain) produces an output code of 8000h. The output clips at these codes for signals that exceed full-scale.

Table 9-13 summarizes the ideal output codes for different input signals.

(16-Bit Conversion Data)			
$\begin{array}{l} \text{INPUT SIGNAL} \\ (\text{V}_{\text{IN}} = \text{V}_{\text{AINP}} - \text{V}_{\text{AINN}}) \end{array}$	IDEAL OUTPUT CODE		
≥ FSR (2 <sup>15</sup> – 1) / 2 <sup>15</sup>	7FFFh		
FSR / 2 <sup>15</sup>	0001h		
0	0000h		
-FSR / 2 <sup>15</sup>	FFFFh		
≤ –FSR	8000h		

# Table 9-13. Ideal Output Code versus Input Signal

Figure 9-12 shows the mapping of the analog input signal to the output codes.

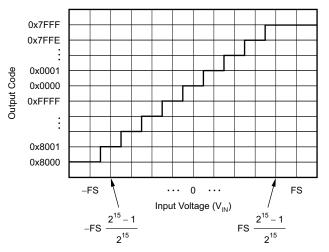


Figure 9-12. Code Transition Diagram (16-Bit Conversion Data)



## 9.3.6 ADC3y

The primary purpose of ADC3A and ADC3B is to redundantly measure battery pack voltage using external high-voltage resistor dividers simultaneously with the battery current of ADC1A and ADC1B. However any other signal measurements can be implemented with ADC3y as well.

ADC3y leverages the same circuit implementations for the input multiplexer,  $\Delta\Sigma$ -modulator, digital filter and calibration function as ADC1y. Please refer to the respective ADC1y sections for details. The PGA however leverages the circuit implementation of ADC2y because ADC3y is also primarily meant for voltage measurements.



# 9.3.7 General-Purpose Digital Inputs and Outputs (GPIO0 to GPIO4)

The ADS131B26-Q1 offers five GPIO pins (GPIO0 to GPIO4) that use logic levels based on the IOVDD supply. See the *Electrical Characteristics* table for details regarding the logic high and low levels. The GPIOs offer a multitude of configuration options:

- Configure the individual GPIOs as either digital inputs or digital outputs using the respective GPIOx\_DIR bits (x = 0, 1, 2, 3, or 4).
- Configure the input and output format of the individual GPIOs as either static logic levels or PWM using the respective GPIOx\_FMT bits. See the GPIOx PWM Output Configuration section for details on how to configure the PWM period and duty cycle for a specific GPIO.
- Four of the GPIO pins can be configured with a special output function (FAULT, MHD, OCCA, and OCCB)
  using the respective GPIOx\_SRC bits. Configure GPIOx as a digital output using the GPIOx\_DIR bit when
  selecting the special output function for GPIOx.

Use the GPOx\_DAT bit to drive a logic high or low level on the respective GPIO pin when GPIOx is configured as a digital output. The GPIO outputs are push-pull. GPIOx ignores the value written to the GPOx\_DAT bit when configured for a special output function.

The device always reads back the value of the GPIOs and provides the detected logic level in the GPIx\_DAT[1:0] bit fields, no matter if GPIOx is configured as digital input or output. See the GPIx\_DAT[1:0] bit field descriptions for details on how the device decodes PWM signals.

The GPIOs are configured as inputs when the device is held in reset.

## 9.3.7.1 GPIOx PWM Output Configuration

When GPIOx is configured for PWM format using the GPIOx\_FMT bit, the PWM period and duty cycle can be independently configured for a logic high and low level with fine granularity. The GPIOx\_LL\_PWM\_LC[6:0] (GPIOx logic low level PWM low counter value) and GPIOx\_LL\_PWM\_HC[6:0] (GPIOx logic low level PWM high counter value) bits together with the GPIOx\_PWM\_TB[1:0] (GPIOx PWM time base) bits determine the PWM period and duty cycle when a logic low level is driven as per the GPOx\_DAT bit. Similarly, the GPIOx\_LH\_PWM\_LC[6:0] (GPIOx logic high level PWM low counter value) and GPIOx\_LH\_PWM\_LC[6:0] (GPIOx logic high level PWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level PWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) and GPIOx\_LH\_PWM\_HC[6:0] (GPIOx logic high level pWM low counter value) bits together with the GPIOx\_DAT bit.

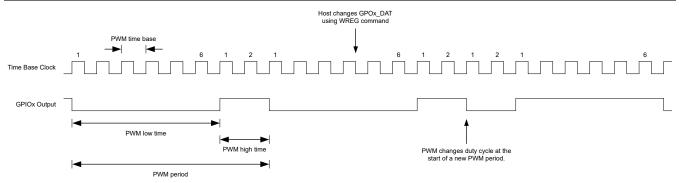
The following equations specify the PWM period and duty cycle:

PWM period = (PWM high counter value + PWM low counter value) × PWM time base	(14)
PWM low time = (PWM low counter value × PWM time base)	(15)
PWM high time = (PWM high counter value × PWM time base)	(16)
PWM duty cycle = PWM high time / (PWM high time + PWM low time)	(17)

Figure 9-13 depicts a visual representation of how the various configuration values produce a certain PWM output. The PWM period always starts with the PWM low time. Changes to the PWM period and duty cycle based on the GPOx\_DAT bit only take effect at the start of a new PWM period.

Table 9-14 provides example configuration values for GPIO1 where the logic high level is configured for 75% duty cycle using a 1-ms period and the logic low level for a 25% duty cycle using the same 1-ms period. The PWM time base is chosen as 8.192 MHz / 1024 = 125  $\mu$ s, assuming an f<sub>MCLK</sub> = 8.192 MHz is used. The sum of the high and low counter must be eight in this case to yield a PWM period of 8 × 125  $\mu$ s = 1 ms. Changing the GPIO1\_LL\_PWM\_LC[6:0] = 3Ch = 60 and the GPIO1\_LL\_PWM\_HC[6:0] = 14h = 20 (for example) results in the same 25% duty cycle, but at a PWM period of 80 × 125  $\mu$ s = 10 ms.





# Figure 9-13. GPIOx PWM Output Timing Diagram

Table 9-14. GPIO1 PWM Configuration Example

BIT FIELD	BIT FIELD SETTING	VALUE	CORRESPONDING TIME (BASED ON f <sub>MCLK</sub> = 8.192 MHz)
GPIO1_PWM_TB[1:0]	3h	1024 × t <sub>MCLK</sub>	125 µs
GPIO1_LL_PWM_LC[6:0]	06h	6	750 μs
GPIO1_LL_PWM_HC[6:0]	02h	2	250 µs
GPIO1_LH_PWM_LC[6:0]	02h	2	250 µs
GPIO1_LH_PWM_HC[6:0]	06h	6	750 µs

# 9.3.7.2 GPIOx PWM Input Readback

For GPIOx to decode PWM input signals, configure the GPIOx\_FMT bit for PWM decoding. GPIOx uses the time base configured in the GPIOx\_PWM\_TB[1:0] bits for PWM decoding. The decoded input value is provided in the GPIx\_DAT[1:0] bit field. The GPIOs decode PWM signals with four different levels as specified in the GPI\_DAT[1:0] bit field description.

The GPIx\_DAT[1:0] bits need up to two PWM cycles to indicate the correct logic level after the PWM period or duty cycle applied to GPIOx changed.

# 9.3.8 General-Purpose Digital Inputs and Outputs (GPIO0A, GPIO1A, GPIO0B, GPIO1B)

The ADS131B26-Q1 offers four additional GPIO pins (GPIO0A, GPIO1A, GPIO0B, and GPIO1B) that use logic levels based on the AVDD supply. See the *Electrical Characteristics* table for details regarding the logic high and low levels. The GPIOs offer a multitude of configuration options:

- Configure the individual GPIOs as either digital inputs or digital outputs using the respective GPIOxy\_DIR bits (x = 0 or 1, y = A or B).
- Configure the input format of the individual GPIOs for either static logic level or PWM inputs using the
  respective GPIOxy\_FMT bits. In contrast to GPIO0 to GPIO4, the GPIOxy do not offer PWM output capability.
  Select the appropriate PWM timebase for each GPIO PWM decoder using the GPIOxy\_PWM\_TB[1:0] bits.
  The timebase of the source driving the GPIOxy input must be equal to or slower than the timebase of the
  GPIOxy input decoder, otherwise the logic levels are not correctly decoded. GPIOxy always uses static logic
  levels when configured as a digital output.
- GPIOxy are shared with analog inputs VPy and VNy, respectively. Disable ADC3y (ADC3y\_EN = 0b) and set GPIOy\_PIN\_CFG = 1b to configure the pins as GPIOs. The setting of the GPIOy\_PIN\_CFG bit is ignored and the inputs are forced to analog inputs when ADC3y\_EN = 1b.

Use the GPOxy\_DAT bit to drive a logic high or low level on the respective GPIO pin when GPIOxy is configured as a digital output. The GPIO outputs are push-pull.

The device always reads back the value of the GPIOs and provides the detected logic level in the GPIxy\_DAT[1:0] bit fields, regardless if GPIOxy is configured as a digital input or output. See the GPIxy\_DAT[1:0] bit field descriptions for details on how the device decodes PWM signals. The GPIxy\_DAT[1:0] bit field reads back 00b when GPIOxy is configured as an analog input.

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## 9.3.9 Monitors and Diagnostics

The ADS131B26-Q1 integrates many monitor and diagnostic circuits to aid in the design of functional safety systems. *Monitors* detect faults in the device, such as a supply undervoltage condition, whereas *diagnostics* detect faults within the monitoring circuit to check if the monitor is still working as intended.

Table 9-15 provides an overview of all available monitors and diagnostics. Most monitors can be enabled or disabled as required using a dedicated monitor enable bit. If a monitor detects a fault, the according low-active fault flag is set to 0b. Except for the communication-related monitor fault flags, the fault flags must be cleared to 1b by the host after the fault condition is removed. The communication-related monitor fault flags reset to 1b automatically in the SPI frame following a frame where no communication fault occurred.

The monitors that have a dedicated diagnostic circuit to check the integrity of the monitor show the respective diagnostic enable bit in Table 9-15. Monitors that do not show a dedicated diagnostic enable bit are diagnosed through other means, as explained in the Safety Manual.

The monitors have individual fault response times, which is the time from fault occurrence to fault flag indication, as specified in the *Electrical Characteristics* table.

Table 9-15. Monitor and Diagnostic Overview						
MONITOR NAME	MONITOR ENABLE BIT	MONITOR FAULT FLAG	DIAGNOSTIC ENABLE BIT	FAULT FLAG REGISTER LOCATION		
SUPPLY MONITORS AND	SUPPLY MONITORS AND DIAGNOSTICS					
Reset	N/A	RESETn	See Safety Manual	STATUS_MSB		
AVDD overvoltage	AVDD_OV_EN	AVDD_OVn	AVDD_OV_DIAG_EN	SUPPLY_STATUS		
AVDD undervoltage	AVDD_UV_EN	AVDD_UVn	AVDD_UV_DIAG_EN	SUPPLY_STATUS		
IOVDD overvoltage	IOVDD_OV_EN	IOVDD_OVn	IOVDD_OV_DIAG_EN	SUPPLY_STATUS		
IOVDD undervoltage	IOVDD_UV_EN	IOVDD_UVn	IOVDD_UV_DIAG_EN	SUPPLY_STATUS		
DVDD overvoltage	DVDD_OV_EN	DVDD_OVn	DVDD_OV_DIAG_EN	SUPPLY_STATUS		
DVDD undervoltage	DVDD_UV_EN	DVDD_UVn	DVDD_UV_DIAG_EN	SUPPLY_STATUS		
AVDD oscillation	AVDD_OSC_EN	AVDD_OSCn	AVDD_OSC_DIAG_EN	SUPPLY_STATUS		
IOVDD oscillation	IOVDD_OSC_EN	IOVDD_OSCn	IOVDD_OSC_DIAG_EN	SUPPLY_STATUS		
DVDD oscillation	DVDD_OSC_EN	DVDD_OSCn	DVDD_OSC_DIAG_EN	SUPPLY_STATUS		
AVDD LDO overtemperature warning	AVDD_OTW_EN	AVDD_OTWn	See Safety Manual	SUPPLY_STATUS		
IOVDD LDO overtemperature warning	IOVDD_OTW_EN	IOVDD_OTWn	See Safety Manual	SUPPLY_STATUS		
AVDD LDO output current limit	AVDD_CL_EN	AVDD_CLn	N/A	SUPPLY_STATUS		
IOVDD LDO output current limit	IOVDD_CL_EN	IOVDD_CLn	N/A	SUPPLY_STATUS		
AGNDA pin disconnect	AGNDA_DISC_EN	AGNDA_DISCn	AGNDA_DISC_DIAG_EN	SUPPLY_STATUS		
AGNDB pin disconnect	AGNDB_DISC_EN	AGNDB_DISCn	AGNDB_DISC_DIAG_EN	SUPPLY_STATUS		
DGND pin disconnect	DGND_DISC_EN	DGND_DISCn	DGND_DISC_DIAG_EN	SUPPLY_STATUS		
CLOCK MONITORS AND DIAGNOSTICS						
Main clock frequency	MCLK_MON_EN	MCLK_FAULTn	MCLK_HI_DIAG_EN, MCLK_LO_DIAG_EN	CLOCK_STATUS		
Diagnostic oscillator watchdog	OSCD_WD_EN	OSCD_WDn	OSCD_WD_DIAG_EN	CLOCK_STATUS		
Main clock watchdog	MCLK_WD_EN	MCLK_WDn	MCLK_WD_DIAG_EN	CLOCK_STATUS		

#### Table 9-15. Monitor and Diagnostic Overview



Table 9-15. Monitor and Diagnostic Overview (continued)							
MONITOR NAME	MONITOR ENABLE BIT	MONITOR FAULT FLAG	DIAGNOSTIC ENABLE BIT	FAULT FLAG REGISTER LOCATION			
DIGITAL MONITORS AND	DIGITAL MONITORS AND DIAGNOSTICS						
Register map section 1 CRC	REG_MAP1_CRC_EN	REG_MAP1_CRC_FAULT n	See Safety Manual	DIGITAL_STATUS			
Register map section 2 CRC	REG_MAP2_CRC_EN	REG_MAP2_CRC_FAULT n	See Safety Manual	DIGITAL_STATUS			
Register map section 3 CRC	REG_MAP3_CRC_EN	REG_MAP3_CRC_FAULT n	See Safety Manual	DIGITAL_STATUS			
Memory map CRC	N/A	MEM_MAP_CRC_FAULT	MEM_MAP_CRC_DIAG[1: 0]	DIGITAL_STATUS			
GPIOA readback	N/A	N/A	GPIOA_DIAG_EN	GPIA_GPIB_DATA			
GPIOB readback	N/A	N/A	GPIOB_DIAG_EN	GPIA_GPIB_DATA			
GPIO readback	N/A	N/A	GPIO_DIAG_EN	GPI_DATA			
COMMUNICATION MONIT	COMMUNICATION MONITORS AND DIAGNOSTICS						
SPI CRC	N/A	SPI_CRC_FAULTn	See Safety Manual	STATUS_MSB			
SPI timeout	TIMEOUT_EN	SPI_TIMEOUTn	See Safety Manual	STATUS_MSB			
SCLK counter	SCLK_COUNTER_EN	SCLK_COUNT_FAULTn	See Safety Manual	STATUS_MSB			
Register access	N/A	REG_ACCESS_FAULTn	See Safety Manual	STATUS_MSB			

# Table 9-15. Monitor and Diagnostic Overview (continued)

In addition to the monitors that detect faults in the device, the ADS131B26-Q1 also provides the indicators shown in Table 9-16, which provide feedback about the device state or behavior.

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Table 9-16. Indicator Overview				
INDICATOR NAME	INDICATOR STATUS BIT	STATUS BIT REGISTER LOCATION		
Command response	COMMAND_RESPONSE[3:0]	STATUS_MSB		
Lock state	LOCK	STATUS_MSB		
Clock source	CLOCK	STATUS_MSB		
Operating mode	MODE	STATUS_MSB		
ADC2A sequence active	SEQ2A_ACTIVE	STATUS_LSB		
ADC2B sequence active	SEQ2B_ACTIVE	STATUS_LSB		
OTP bank	OTB_BANK	DIGITAL_STATUS		

Lastly, the device provides the conversion and sequence counters shown in Table 9-17 for the individual ADCs.

#### Table 9-17. Conversion and Sequence Counter Overview

COUNTER NAME	COUNTER BITS	COUNTER BITS REGISTER LOCATION
ADC1A conversion counter	CONV1A_COUNT[1:0]	STATUS_LSB
ADC1B conversion counter	CONV1B_COUNT[1:0]	STATUS_LSB
ADC2A sequencer counter	SEQ2A_COUNT[1:0]	STATUS_LSB
ADC2B sequencer counter	SEQ2B_COUNT[1:0]	STATUS_LSB

Besides the monitors, indicators, and counters mentioned in the previous tables, the ADS131B26-Q1 offers additional means to check the integrity of the device, such as:

- Power-supply voltage readback using ADC2A or ADC2B
- Two temperature sensors, TSA and TSB
- Two test DACs, TDACA and TDACB
- Open-wire detection current sources and sinks on every ADC



## 9.3.9.1 Supply Monitors

Individual power-on reset (POR) circuits are implemented on the AVDD, IOVDD, and DVDD supplies. If any of the three supplies drop below the respective POR threshold, the device is held in reset.

The ADS131B26-Q1 monitors the outputs of the three internal LDOs (AVDD, IOVDD, and DVDD) for overvoltage (OV), undervoltage (UV), and oscillations. See the *Electrical Characteristics* table for the according monitor detection thresholds. If an OV event occurs, the respective LDO shuts down to prevent damage to the internal circuitry. The LDO turns back on after the output voltage drops below the OV threshold. The device can potentially reset if the supply voltage drops below the POR threshold before the LDO is turned on again. The LDOs do not shut down when an OV diagnostic is performed.

AVDD or IOVDD can be supplied externally when shorting APWR to AVDD or DPWR to IOVDD, respectively, thus bypassing the internal LDOs. The monitors check the externally provided supply when bypassing the internal LDO. Configure the IOVDD OV and UV monitor thresholds using the IOVDD\_OV\_TH and IOVDD\_UV\_TH bits based on the used IOVDD supply.

The AVDD and IOVDD LDOs integrate individual temperature sensors to indicate potential overtemperature events. Configure the overtemperature warning thresholds using the AVDD\_OTW\_CFG[1:0] and IOVDD\_OTW\_CFG[1:0] bits.

The AGNDA, AGNDB, and DGND pins are monitored for pin disconnections. The AGND pin is implemented redundantly and therefore does not provide a pin disconnection monitor.

The AVDD and IOVDD LDOs are designed with an output current limit to prevent excessive current draw from the LDOs. When the LDOs operate in current limit, the according fault flags are set. If more current draw is demanded from the LDOs than the current limit, then the LDO output voltage typically drops below the POR threshold and causes a POR event.

## 9.3.9.2 Clock Monitors

The ADS131B26-Q1 integrates a diagnostic oscillator (OSCD) to monitor the frequency of the selected main clock (MCLK), which is either sourced from the internal main oscillator (OSCM) or from an external clock provided at the CLK pin. The MCLK\_FAULTn flag is set to 0b when the frequencies between the main clock and the diagnostic oscillator deviate by more than the main clock fault detection frequency threshold (MCLK\_FAULT\_TH).

Additionally, individual watchdogs (MCLK\_WD and OSCD\_WD) monitor the main clock and the diagnostic oscillator to detect a missing clock signal. The MCLK\_WDn flag is set to 0b when the MCLK frequency drops below  $f_{MCLK_WD_TH}$ , and the OSCD\_WDn flag is set to 0b when the OSCD frequency drops below  $f_{OSCD_WD_TH}$ .

## 9.3.9.3 Digital Monitors

The following sections explain the available digital monitors, such as register map CRC, memory map CRC, and GPIO readback functionality.

## 9.3.9.3.1 Register Map CRC

Register map CRCs in the ADS131B26-Q1 detect unintended changes in the register map contents. The register map is divided into four sections.

Section 0 includes read-only bits that update the values based on the device state or ADC2y conversion data. Therefore, section 0 does not offer any register map CRC check.

Sections 1 to 3 include the device configuration bits and provide independent CRC checks. Enable the register map CRC for each section using the REG\_MAPx\_CRC\_EN (x = 1 to 3) bits. When the register map CRC for a section is enabled, the device constantly calculates a 16-bit CRC value across that register map section and compares the internal calculation result against the CRC value provided by the user in the REG\_MAPx\_CRC\_VALUE[15:0] bit field. If the internal calculation result and the REG\_MAPx\_CRC\_VALUE[15:0] do not match, the REG\_MAPx\_CRC\_FAULTn is set to 0b. No other action is taken by the device in the event of a register map section CRC fault.

The CRC calculation begins with the MSB of the first register in the respective register section and ends with the LSB of the last *specified* register in the respective register section using the polynomial selected in the CRC\_TYPE bit. Table 9-18 shows the exact registers that are covered by the register map CRC in each section. Two types of CRC polynomials are available: CCITT CRC and ANSI CRC (CRC-16). See the *Communication Cyclic Redundancy Check (CRC)* section for details on the CRC polynomials. The CRC calculations are initialized with the seed value of FFFFh.

REGISTER SECTION	REGISTERS COVERED BY REGISTER MAP CRC
0	N/A
1	40h to 59h
2	80h to A3h
3	C0h to E3h

#### Table 9-18. Registers Covered by Register Map CRC

The CRC calculation is implemented serially, one register map bit per OSCD period. Therefore, unintended bit changes are not indicated immediately in the REG\_MAPx\_CRC\_FAULTn fault flags, but can take up to  $t_{p(REG_MAP_CRC)}$ .

Use the following procedure to change register bits in sections 1 to 3 without accidentally causing a REG\_MAPx\_CRC\_FAULTn indication:

- Disable the register map section x CRC by setting REG\_MAPx\_CRC\_EN = 0b
- Wait the fault response time t<sub>p(REG\_MAP\_CRC)</sub>
- If the REG\_MAPx\_CRC\_FAULTn fault flag is set to 0b, clear the fault flag by writing 1b to the REG\_MAPx\_CRC\_FAULTn bit
- Optional: Verify the REG\_MAPx\_CRC\_FAULTn fault flag is cleared to 1b
- Optional: Clear the DIGITAL\_FAULTn fault flag by writing 1b to the DIGITAL\_FAULTn bit
- Change the section x register bits as needed
- Update the REG\_MAPx\_CRC\_VALUE[15:0] bits based on the new register map section x settings
- Enable the register map section x CRC by setting REG\_MAPx\_CRC\_EN = 1b

Register bits in section x can also be changed while the register map section x CRC is enabled, as discussed in the following procedure, but can cause unintended REG\_MAPx\_CRC\_FAULTn indications.

- Change the section x register bits as needed while the register map section x CRC is enabled
- Update the REG\_MAPx\_CRC\_VALUE[15:0] bits based on the new register map section x settings
- Wait the fault response time t<sub>p(REG\_MAP\_CRC)</sub>
- If the the REG\_MAPx\_CRC\_FAULTn fault flag is set to 0b, clear the fault flag by writing 1b to the REG\_MAPx\_CRC\_FAULTn bit
- Optional: Verify the REG\_MAPx\_CRC\_FAULTn fault flag is cleared to 1b
- Optional: Clear the DIGITAL\_FAULTn fault flag by writing 1b to the DIGITAL\_FAULTn bit

## 9.3.9.3.2 Memory Map CRC

Similar to the register map CRC, the device uses a memory map CRC to check the internal memory for random bit changes. Changes to the internal memory bits can cause undetermined device behavior or degraded device performance.

The memory map CRC is always enabled and constantly calculates the CRC value across the internal memory map. The device compares the calculation result against a memory map CRC value that is stored in the memory map in production. If the internal calculation result and the stored memory map CRC value do not match, the MEM\_MAP\_CRC\_FAULTn is set to 0b. No other action is taken by the device in the event of a memory map CRC fault.

The CRC calculation is implemented serially, one memory map word per OSCD period. Therefore random bit changes are not indicated immediately in the MEM\_MAP\_CRC\_FAULTn fault flag, but can take up to  $t_{p(MEM_MAP_CRC)}$ .

In case of a memory map CRC fault, write 1b to the MEM\_MAP\_CRC\_FAULTn bit to clear the fault flag to 1b. Reset the device if the fault flag continues to set to 0b.

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## 9.3.9.3.3 GPIO Readback

All available GPIOs (GPIOx, GPIOxy) in ADS131B26-Q1 provide an independent readback path when the respective GPIO is configured as digital output. That means an input receiver circuit independent from the output driver circuit detects the voltage level driven on the GPIO pin. The result of the readback is displayed in the according GPIx\_DAT[1:0] and GPIxy\_DAT[1:0] bit fields.

## 9.3.9.4 Communication Monitors

The communication related monitors (SPI CRC, SPI timeout, and SCLK counter) are explained in detail in the *Serial Interface Communication Structure* section.

In addition, the register access monitor indicates if a read or write register access was attempted to register addresses FFh or beyond. Writing to or reading from not specified register addresses within the address range from 00h to FEh does not trigger a fault indication. The data and register address returned when reading from a non-existing register is all 0s.

## 9.3.9.5 Fault Flags and Fault Masking

Every monitor in the ADS131B26-Q1 has a corresponding fault flag (see Table 9-15) that sets to 0b when the respective monitor detects a fault condition. As shown in Table 9-19, the RESETn and communication related fault flags are located in the STATUS\_MSB register, whereas the supply, clock, and digital related fault flags are grouped together in *detailed* status registers. The STATUS\_MSB register is transmitted as part of the STATUS word at the beginning of every SPI frame as described in the *STATUS Word* section. To allow immediate indication of any of the supply, clock, or digital related faults as part of the STATUS word, every detailed status register has a corresponding *combined* fault flag in the STATUS\_MSB register. That is, if any of the fault flags in the detailed status register set to 0b, then the combined fault flag sets to 0b as well.

MONITOR FAULT FLAGS FOR:	DETAILED STATUS REGISTER LOCATION	COMBINED FAULT FLAG IN STATUS_MSB REGISTER
Supply	SUPPLY_STATUS	SUPPLY_FAULTn
Clock	CLOCK_STATUS	CLOCK_FAULTn
Digital	DIGITAL_STATUS	DIGITAL_FAULTn

#### Table 9-19. Detailed Status Registers and Corresponding Combined Fault Flags

To clear a set combined fault flag to 1b, the host must first clear all set fault flags in the corresponding detailed status register. Only after all fault flags in the detailed status register are cleared to 1b can the host clear the combined fault flag by writing 1b.

The ADS131B26-Q1 allows additional *masking* of individual fault flags located in the detailed status registers from triggering the combined fault flag in the STATUS\_MSB register. The masking bits are located in the SUPPLY\_FAULT\_MASK, CLOCK\_FAULT\_MASK, and DIGITAL\_FAULT\_MASK registers. If a fault flag in a detailed status register is masked, a fault indicated by this masked fault flag does not trigger a fault indication of the combined fault flag in the STATUS\_MSB register. However, the fault is still indicated by the fault flag in the detailed status register.

The following examples for the AVDD OV monitor explain the various configuration options:

- No AVDD OV fault indication required in either SUPPLY\_STATUS (AVDD\_OVn fault flag) or STATUS\_MSB (SUPPLY\_FAULTn fault flag) register: Disable the AVDD OV monitor by setting AVDD\_OV\_EN = 0b.
- AVDD OV fault indication in SUPPLY\_STATUS, but not in STATUS\_MSB register: Enable the AVDD OV monitor by setting AVDD\_OV\_EN = 1b. Mask the AVDD\_OVn fault flag from triggering the SUPPLY\_FAULTn fault flag by setting AVDD\_OV\_MASK = 1b.
- AVDD OV fault indication in both SUPPLY\_STATUS and STATUS\_MSB register: Enable the AVDD OV monitor by setting AVDD\_OV\_EN = 1b. Unmask the AVDD\_OVn fault flag by setting AVDD\_OV\_MASK = 0b.



## 9.3.9.6 FAULT Pin

The GPIO2/FAULT pin can be configured as a FAULT indication output by setting GPIO2\_DIR = 1b and GPIO2\_SRC = 0b. The FAULT pin is *active* when any of the STATUS\_MSB[14:7] fault flags set to 0b. The FAULT pin changes to *inactive* as soon as all STATUS\_MSB[14:7] fault flags are cleared to 1b.

The actual output signal of the FAULT pin when active or inactive depends on the GPIO2 format (GPIO2\_FMT bit) and FAULT pin polarity (FAULT\_POL bit) configuration. See the respective bit descriptions and the *General-Purpose Digital Inputs and Outputs (GPIO0 to GPIO4)* section for details. Table 9-20 shows an example where the FAULT pin is configured for a static low signal in an active state, and a static high signal in an inactive state. The pin can for example also be configured for a static low signal in an active state, and a PWM output signal with 50% duty cycle in an inactive state to act as some sort of heart beat to indicate there is no fault. The configuration options are endless.

REGISTER BIT	BIT SETTING	DESCRIPTION
GPIO2_DIR	1b	GPIO2/FAULT pin configured as digital output
GPIO2_SRC	0b	FAULT selected as data source for GPIO2/FAULT pin
GPIO2_FMT	0b	GPIO2/FAULT pin configured for static output levels
FAULT_POL	0b	FAULT output is active low

#### Table 9-20. FAULT Pin Output Behavior Configuration Example

Additionally, the ADS131B26-Q1 allows *masking* of any of the eight STATUS\_MSB[14:7] fault flags from triggering the FAULT pin. Use the mask bits in the FAULT\_PIN\_MASK register to mask individual fault flags. If a fault flag is masked and the respective fault flag is set to 0b in the STATUS\_MSB register, then no fault is indicated on the FAULT pin.

## 9.3.9.7 Diagnostics and Diagnostic Procedure

Diagnostics detect faults within a monitoring circuit to check if the monitor is still working as intended. Enable a diagnostic using the respective enable bit in Table 9-15 to inject a fault condition into the monitoring circuit. When the according monitor fault flag sets to 0b within the specified monitor fault response time (see the *Electrical Characteristics* table), the diagnostic completed successfully, indicating a correctly working monitor.

Except for the main clock frequency monitor diagnostics (MCLK\_HI\_DIAG\_EN and MCLK\_LO\_DIAG\_EN), all diagnostics can be performed simultaneously to save execution time. The MCLK\_HI\_DIAG\_EN and MCLK\_LO\_DIAG\_EN diagnostics must be performed sequentially. However, either the MCLK\_HI\_DIAG\_EN or the MCLK\_LO\_DIAG\_EN can be executed together with all other diagnostics.

The following steps outline the general procedure for implementing a monitor diagnostic. An example for implementing the AVDD UV monitor diagnostic is shown in parentheses.

- Enable monitor (set AVDD\_UV\_EN = 1b)
- Wait the fault response time (wait t<sub>p(AVDD UV)</sub>)
- Clear the detailed fault flag (write 1b to AVDD\_UVn)
- Optional: Verify that the detailed fault flag is cleared to 1b (read AVDD\_UVn)
- Optional: Clear the main fault flag (write 1b to SUPPLY\_FAULTn)
- Enable diagnostic (set AVDD\_UV\_DIAG\_EN = 1b)
- Wait the fault response time (wait t<sub>p(AVDD UV)</sub>)
- Check if the detailed fault flag is set to 0b (read AVDD\_UVn)
- Disable monitor (set AVDD\_UV\_EN = 0b)
- Disable diagnostic (set AVDD\_UV\_DIAG\_EN = 0b)
- Clear the detailed fault flag (write 1b to AVDD\_UVn)
- Optional: Clear the main fault flag (write 1b to SUPPLY\_FAULTn)
- Enable monitor (set AVDD\_UV\_EN = 1b)

The memory map CRC diagnostic is a small exception. Instead of an enable bit, select any of the three bit patterns available in the MEM\_MAP\_CRC\_DIAG[1:0] bit field to inject into the memory map CRC calculation.



# 9.3.9.8 Indicators

The ADS131B26-Q1 provides a set of indicator bits inside the STATUS\_MSB and STATUS\_LSB registers that help to verify the state of the device:

- Command response: The COMMAND\_RESPONSE[3:0] bit field is transmitted in every SPI frame and provides feedback about the command that was received by the device in the previous frame. Information about which command was executed is also provided. See the COMMAND\_RESPONSE[3:0] register bit field description for details.
- Lock state: The LOCK bit indicates if the device is currently locked or unlocked. See the *Commands* section for details on how to lock and unlock the device.
- Clock source: The CLOCK bit indicates which clock source the device is using as the main clock, either the internal main oscillator (OSCM) or an external clock provided at the CLK pin.
- Operating mode: The MODE bit indicates which mode the device is currently operating in, either active, standby, or power-down mode.
- ADC2A sequence active: The SEQ2A\_ACTIVE bit indicates if a sequence on ADC2A is currently in progress.
- ADC2B sequence active: The SEQ2B\_ACTIVE bit indicates if a sequence on ADC2B is currently in progress.

An additional OTP\_BANK status bit is provided in the DIGITAL\_STATUS register. The device includes two one-time programmable (OTP) memory banks, bank 0 and bank 1. Device configuration and calibration data are stored during device production in those OTP banks. A corrupted OTP bank can cause undetermined device behavior or degraded device performance. The information in bank 0 is duplicated in bank 1 for redundancy. At device power-up or during reset, the device loads the content of OTP bank 0 into the internal memory. If the device fails to acquire the data from bank 0, then the device loads the content from OTP bank 1. The OTP\_BANK bit indicates which bank was acquired. The device performs normally even when running from OTP bank 1.

If the device fails to acquire data from OTP bank 1 as well, then the memory map CRC fault flag is set to 0b. If resetting the device does not clear the MEM\_MAP\_CRC\_FAULTn fault flag, consider the device damaged.

# 9.3.9.9 Conversion and Sequence Counters

The STATUS\_LSB register includes 2-bit conversion and sequence counters for the various ADCs (CONV1y\_COUNT[1:0], SEQ2y\_COUNT[1:0]).

The conversion counter, CONV1y\_COUNT[1:0], increments every time a new conversion on ADC1y completes. Because ADC1A and ADC3A always start converting at the same time when both ADCs are enabled, the CONV1A\_COUNT[1:0] indicates the conversion count for ADC3A as well. If ADC1A is disabled, but ADC3A is enabled, then CONV1A\_COUNT[1:0] indicates the conversion number for ADC3A. The same is true for ADC1B and ADC3B and CONV1B\_COUNT[1:0]. The counter rolls over from 11b to 00b. To reset the counter, disable ADC1y and ADC3y or place the device in standby or power-down mode. The device makes sure that the conversion counter value always matches to the ADC1y and ADC3y conversion results that are output in the same SPI frame.

The sequence counter, SEQ2y\_COUNT[1:0], increments every time a new sequence on ADC2y completes. The counter rolls over from 11b to 00b. To reset the counter, disable ADC2y or place the device in standby or power-down mode. The device makes sure that the sequence counter value always matches to the ADC2y conversion step results that are output in the same SPI frame. That means, if a new sequence completes while reading out conversion results from the ADC2y conversion step result registers (SEQxy\_STEPx\_DATA), the conversion results from the new sequence run are blocked from overwriting the conversion result registers, but are internally buffered. Only after the read command is complete do the buffered conversion results from the new sequence run update the conversion step result registers.



## 9.3.9.10 Supply Voltage Readback

In addition to the dedicated supply monitors, all supplies (APWR, DPWR, AVDD, IOVDD, and DVDD) can also be measured back internally through ADC2A or ADC2B. Resistor dividers are integrated in the device to attenuate the supply voltages to within the input voltage range of ADC2A and ADC2B. See the *Electrical Characteristics* table for the according attenuation factors. Use the SEQ2y\_STEPx\_CH\_P[3:0] bits to configure an ADC2y sequence step for any of the supply voltage measurements.

The supply voltage measurement accuracy depends on two factors:

- Multiplexer delay time (configured using the MUX2y\_DELAY[2:0] bits)
- ADC2y conversion time (configured using the OSR2y[1:0] bits)

The large resistor divider values used internally to divide the supply voltages down together with the internal filter capacitor lead to a large RC filter time constant. The input signal therefore needs considerable time to settle when the ADC2y multiplexer selects one of the supply voltage measurements. Increasing the multiplexer delay time provides more time for the input signal to settle after the multiplexer change before ADC2y starts converting. Setting the multiplexer delay time equal to or greater than  $256 \times t_{MCLK}$  provides sufficient time for the input signals to settle when measuring the supply voltages.

If increasing the multiplexer delay time is not possible, because the delay time affects all sequence steps equally, configure multiple consecutive sequence steps for the same supply voltage measurement. Then disregard the initial sequence step readings where the conversions are not settled yet.

The input impedance of ADC2y changes with the selected conversion time, see the *Electrical Characteristics* table. The impedance of the resistor divider interacts with the input impedance of ADC2y leading to a gain error. Increasing the ADC2y input impedance by increasing the ADC2y conversion time reduces the gain error for the supply voltage measurements.

See Figure 7-32 for details on how the supply voltage measurement accuracy changes with the multiplexer delay time and the ADC2y conversion time.

# 9.3.9.11 Temperature Sensors (TSA, TSB)

The ADS131B26-Q1 integrates two independent temperature sensors, TSA and TSB, one in each section of the device. Use the temperature sensors to measure the die temperature of each section. The temperature sensors output a linear voltage that is proportional to temperature. The output voltage characteristics ( $TS_{Offset}$ ,  $TS_{TC}$ ) of the temperature sensors are specified in the *Electrical Characteristics* table.

Use ADC2A to measure the output signal of TSA. To select TSA for measurement, configure any of the ADC2A sequence steps (SEQ2A\_STEPx\_CH\_P[3:0]) for TSA measurement. For best measurement performance, configure the respective sequence step for gain = 2 using the SEQ2A\_STEPx\_GAIN[1:0] bits. Correspondingly, use ADC2B to measure the output signal of TSB.

Equation 18 shows how to convert the measured temperature sensor output voltage to die temperature:

Die temperature [°C] =  $25^{\circ}$ C + (Measured voltage – TS<sub>Offset</sub>) / TS<sub>TC</sub> (18)

# 9.3.9.12 Test DACs (TDACA, TDACB)

The ADS131B26-Q1 integrates two independent Test DACs, TDACA and TDACB, one in each section of the device. TDACA uses the voltage reference in section A (REFA), and TDACB uses the voltage reference in section B (REFB). Use the TDACy\_VALUE[2:0] bits to set the Test DAC output voltage to one of eight available settings. The output voltage of Test DAC A can be applied as an input signal to any of the ADCs in section B for measurement to check the accuracy and integrity of the ADCxB signal chains, including the voltage reference (REFB). Use the respective ADCxB multiplexer configuration bits to select Test DAC A as an input signal. Correspondingly, the output voltage of Test DAC B can be applied as an input signal to any of the ADCs in section A for measurement.

Selecting the Test DAC as an input signal for multiple ADCs at the same time can degrade the measurement accuracy because of loading of the Test DAC output.



## 9.3.9.13 Open-Wire Detection

To detect potential pin fault conditions (such as open, short-to-adjacent pin, short-to-GND, or short-to-supply) on the individual ADC analog input pins, every ADC integrates a dedicated open-wire detection (OWD) current source and sink. See Figure 9-2 and Figure 9-7 for how the current sources and sinks are connected to the ADC inputs. The input path of ADC2y includes a series impedance of approximately 200  $\Omega$ , see Figure 9-7. Consider the additional voltage drop across this impedance when enabling the current source or sink on any of the ADC2y inputs.

As listed in Table 9-21, every current source and sink offers individual configuration and control.

Table 3-21. Opt	Table 3-21. Open-wire Detection Current Source and Sink Conniguration									
REGISTER BITS	FUNCTION									
OWDxy_SOURCE_VALUE[1:0]	Enables current source and selects current source value from three available settings									
OWDxy_SINK_VALUE[1:0]	Enables current sink and selects current sink value from three available settings									
OWDxy_SOURCE_MUX	Selects the input channel that the current source is routed to									
OWDxy_SINK_MUX	Selects the input channel that the current sink is routed to									

Table 9-21. Open-Wire Detection Current Source and Sink Configuration	
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## 9.3.9.14 Missing Host Detection and MHD Pin

The ADS131B26-Q1 offers a missing host detection (MHD) monitor that detects when the host is not communicating with the device anymore. A watchdog timer checks the time between two SPI frames with valid commands including valid CRCs. If a valid command with a valid CRC is not received within the watchdog time window, the host is considered missing. There is no monitor fault flag that indicates a missing host, only the MHD pin is used to detect this fault.

To use the missing host detection mode, configure the GPIO0/MHD pin as output (GPIO0\_DIR = 1b) and the GPIO0 source for missing host detection mode (GPIO0\_SRC = 0b). When the watchdog times out, the MHD pin is set *active*. Enable the missing host detection mode by setting the MHD\_CFG[1:0] bits to one of the three available watchdog timeout windows. To reset the MHD output after a missing host was detected, disable the missing host detection mode by setting MHD CFG = 00b.

The actual output signal of the MHD pin when active or inactive depends on the GPIO0 format (GPIO0\_FMT bit) and MHD pin polarity (MHD\_POL bit) configuration. See the respective bit descriptions and the *General-Purpose Digital Inputs and Outputs (GPIO0 to GPIO4)* section for details. Table 9-22 shows an example where the MHD pin is configured for a static low signal in an active state, and a static high signal in an inactive state. The pin can for example also be configured for a static low signal in an active state, and a PWM output signal with 50% duty cycle in an inactive state to act as some sort of heart beat signal as long as the device detects a valid host.

Tabi										
REGISTER BIT	BIT SETTING	DESCRIPTION								
GPIO0_DIR	1b	GPIO0/MHD pin configured as digital output								
GPIO0_SRC	0b	MHD selected as data source for GPIO0/MHD pin								
GPIO0_FMT	0b	GPIO0/MHD pin configured for static output levels								
MHD_POL	0b	MHD output is active low								

Table 9-22.	MHD Pin	Output	<b>Behavior</b>	Configuration	Example



# 9.3.9.15 Overcurrent Comparators (OCCA, OCCB)

The ADS131B26-Q1 integrates two *digital* overcurrent comparators (OCCA, OCCB), that provide a faster response to overcurrent conditions than ADC1y, especially when ADC1y is operating at low data rates. The comparators use the ADC1y  $\Delta\Sigma$  modulator (and therefore the same multiplexer and PGA settings as ADC1y) but with a separate digital fast filter that works in parallel to the main ADC1y digital filter. This fast filter is a sinc3 implementation with a fixed OSR of 64. The offset and gain calibration values (OCAL1y[23:0], GCAL1y[15:0]) for ADC1y do not affect the OCCy comparators, which means there is no user calibration of the overcurrent comparators possible.

Enable the overcurrent comparators using the OCCy\_EN bits. To use overcurrent comparator OCCy, ADC1y must be enabled (ADC1y\_EN = 1b) as well so that the ADC1y modulator is active. However, conversions on ADC1y do not need to be started to use the overcurrent comparator function. The sinc3 filter of the comparator starts operating as soon as the OCCy\_EN bit is set and runs independently of the conversion state of ADC1y.

The digital fast filter of the comparator outputs 16-bit conversion results that are internally compared against a high and low threshold, configured by the OCCy\_HIGH\_TH[15:0] and OCCy\_LOW\_TH[15:0] register bits, respectively. The comparator triggers when the conversion results exceed the high threshold or when the results fall below the low threshold. Set OCCy\_HIGH\_TH[15:0] = 7FFFh to disable the high threshold detection. Similarly, set OCCy\_LOW\_TH[15:0] = 8000h to disable the low threshold detection.

OCCy\_NUM[4:0] configures the number of conversions that the output of the digital fast filter must exceed the programmed high or low threshold before flagging an overcurrent condition in the OCCy\_HTn or OCCy\_LTn status bits, respectively. An internal counter keeps track of the number of conversions that exceed either the high or low threshold. The counter resets as soon as one conversion result drops below the threshold again or when the OCCy comparator is disabled (OCCy\_EN = 0b).

Disable the overcurrent comparator (OCCy\_EN = 0b) before changing any comparator settings in the OCCy\_CFG, OCCy\_HIGH\_THRESHOLD, or OCCy\_LOW\_THRESHOLD registers.

Similar to the detailed supply, clock, and digital status flags, the detailed status flags in the OCC\_STATUS register feed a combined OCC\_FAULTn flag in the STATUS\_MSB register. That is, if any of the fault flags in the OCC\_STATUS register set to 0b, then the OCC\_FAULTn flag sets to 0b as well.

To clear a set OCC\_FAULTn flag to 1b after the overcurrent condition is removed, the host must first clear all set fault flags in the OCC\_STATUS register. Only after all fault flags in the OCC\_STATUS register are cleared to 1b can the host clear the OCC\_FAULTn flag by writing 1b.

The ADS131B26-Q1 allows additional *masking* of the four fault flags located in the OCC\_STATUS register from triggering the combined OCC\_FAULTn flag in the STATUS\_MSB register. The masking bits are located in the OCC\_FAULT\_MASK register. If a fault flag in the OCC\_STATUS register is masked, then a fault indicated by this masked fault flag does not trigger the OCC\_FAULTn flag in the STATUS\_MSB register. However, the fault is still indicated by the fault flag in the OCC\_STATUS register.

## 9.3.9.15.1 OCCA and OCCB Pins

Each comparator can be configured to drive a dedicated overcurrent comparator fault pin (OCCA and OCCB pins) for fast overcurrent indication without SPI communication. To configure GPIO3/OCCA for overcurrent comparator output, set GPIO3\_DIR = 1b for digital output function and GPIO3\_SRC = 0b for OCCA output. Equivalently, set GPIO4\_DIR = 1b and GPIO4\_SRC = 0b to configure GPIO4/OCCB for overcurrent comparator B output.

The OCCy pins indicate a fault when either the OCCy\_HTn or OCCy\_LTn bits, or both set to 0b. The mask bits in the OCC\_FAULT\_MASK register do not affect the output of the OCCy pins.

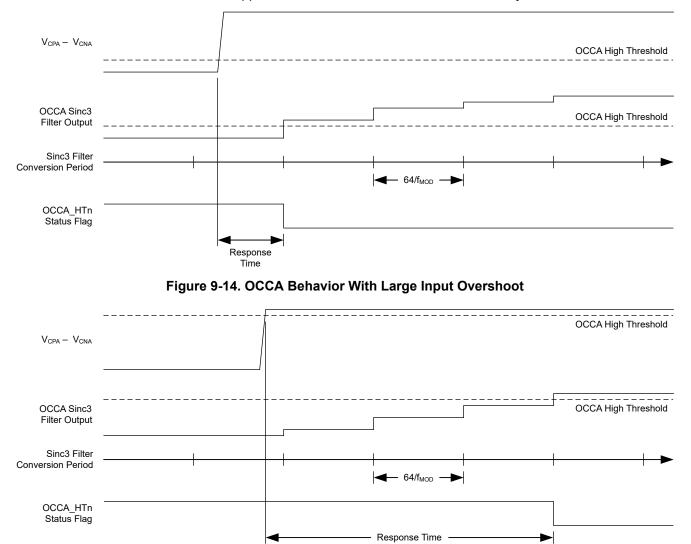
The actual output signal of the OCCy pins when active or inactive is configured in the same way as the FAULT pin. Use the GPIO3\_FMT and OCCA\_POL bits to configure the output behavior of the OCCA pin, and the GPIO4\_FMT and OCCB\_POL bits to configure the OCCB pin behavior.



#### 9.3.9.15.2 Overcurrent Indication Response Time

The fault indication response time to an overcurrent event depends on the amount of overshoot of the input signal beyond the comparator threshold. The reason for this dependency is the settling time of the sinc3 filter that is used for the digital comparator function.

Figure 9-14 and Figure 9-15 show two examples for the OCCA fault indication behavior with OCCA\_NUM[4:0] = 00000b, that is only one conversion must exceed the threshold to trigger a fault. In Figure 9-14 the comparator triggers in less than  $64/f_{MOD}$  (= 15.6 µs when using  $f_{MCLK}$  = 8.192 MHz) because the sinc3 filter already settles to a value above the set high threshold in one conversion due to the large overshoot beyond the high threshold on the input signal. Figure 9-15 shows a worst case scenario where the sinc3 filter needs even four conversion periods to settle to a value above the set high threshold because the input signal barely exceeds the high threshold and the overcurrent event happens in the middle of a fast filter conversion cycle.



#### Figure 9-15. OCCA Behavior With Small Input Overshoot

The response time changes when global-chop mode of ADC1y is enabled and ADC1y is converting. See the *Overcurrent Indication Response Time in Global-Chop Mode* section for details.



# 9.4 Device Functional Modes

## 9.4.1 Power-Up and Reset

The ADS131B26-Q1 is reset in one three ways:

- Power-on reset (POR)
- RESETn pin (hardware reset)
- RESET command (software reset)

After a reset occurs, the user registers reset to the respective default settings and the device is in active mode. All ADCs are enabled, but no conversions are started. With all three reset options, a low-to-high transition on the DRDYn pin indicates that the SPI interface is ready for communication. The device ignores any SPI communication before this point and SDO stays low.

## 9.4.1.1 Power-On Reset (POR)

Power-on reset (POR) is the reset that occurs when valid supply voltages are first applied to the device. The POR process requires  $t_{POR}$  to complete from when all supply voltages exceed the respective POR thresholds (AVDD\_POR\_TH, IOVDD\_POR\_TH, and DVDD\_POR\_TH) to allow the internal circuitry to power up. The DRDYn pin transitions from low to high immediately after  $t_{POR}$ , indicating the SPI interface is ready for communication.

## 9.4.1.2 RESETn Pin

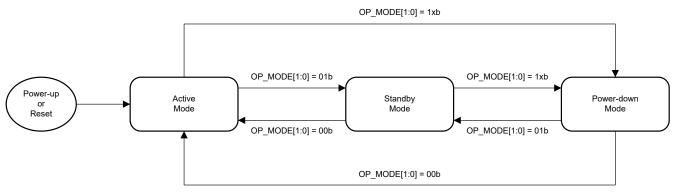
The RESETn pin is an active low pin with an internal pulldown resistor to DGND. The device resets if the pin is held low for longer than  $t_{w(RSL)}$  and maintains a reset state until the RESETn pin is returned high. The host must actively drive the pin high for the device to operate. Wait for at least  $t_{REGACQ}$  after the RESETn pin is brought high or for the DRDYn rising edge before communicating with the device.

## 9.4.1.3 RESET Command

The ADS131B26-Q1 can be reset with the SPI RESET command. See the *RESET* section for details. A device reset occurs immediately after the RESET command is latched. The host must wait for at least  $t_{REGACQ}$  or for the DRDYn rising edge before communicating with the device.

## 9.4.2 Operating Modes

The ADS131B26-Q1 offers three operating modes: active, standby, and power-down mode. The mode is programmable using the OP\_MODE[1:0] bits. Figure 9-16 shows how the device transitions between the different operating modes.



# Figure 9-16. Operating Mode State Diagram

# 9.4.2.1 Active Mode

Active mode is the default operating mode after power-up or reset. In active mode all internal circuitry is powered up. By default all ADCs are enabled, but no conversions are started. The individual ADCs can be enabled or disabled using the respective ADCxy\_EN bits. ADC conversions can only be started in active mode and when the respective ADC is enabled.

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## 9.4.2.2 Standby Mode

In standby mode all internal circuitry is powered up, but all ADCs are disabled and ongoing conversions are stopped immediately irrespective of the ADCxy\_EN bit settings. No ADC conversions can be started in standby mode. Transition the device to standby mode before changing the main clock source using the CLK\_SOURCE bit to prevent clock glitching during the clock switchover.

## 9.4.2.3 Power-Down Mode

In power-down mode, all nonessential internal circuitry (such as the ADCs, voltage references, and oscillators) is powered down. The LDOs and POR circuitry stay active. Register settings are retained in power-down mode. All ADCs are disabled and ongoing conversions are stopped immediately irrespective of the ADCxy\_EN bit settings. No conversions can be started in power-down mode. When transitioning to active mode, wait for the voltage reference start-up time before starting any conversions to allow the voltage references to power up.

## 9.4.3 ADC Conversion Modes

## 9.4.3.1 ADC1y and ADC3y Conversion Modes

The ADS131B26-Q1 offers two conversion modes for ADCs ADC1y and ADC3y: continuous-conversion and single-shot conversion mode.

The CONV\_MODE13A bit selects the conversion mode for both ADC1y and ADC3y.

Do not change the contents of the following registers while conversions on ADC1y are ongoing: ADC1y\_ADC3y\_CFG, ADC1y\_OCAL\_MSB, ADC1y\_OCAL\_LSB, and ADC1y\_GCAL. Stop conversions or disable ADC1y before making changes to these registers.

Do not change the contents of the following registers while conversions on ADC3y are ongoing: ADC1y\_ADC3y\_CFG, ADC3y\_OCAL\_MSB, ADC3y\_OCAL\_LSB, and ADC3y\_GCAL. Stop conversions or disable ADC3y before making changes to these registers.

## 9.4.3.1.1 Continuous-Conversion Mode

In continuous-conversion mode, ADC1y and ADC3y convert indefinitely until stopped by the host. Set the respective STARTy bits in the CONVERSION\_CTRL register to start conversions of the enabled ADCs, ADC1y and ADC3y. ADC1A and ADC3A start converting simultaneously when the STARTA bit is set. The same is true for ADC1B and ADC3B and the STARTB bit. However, conversions on ADCxA and ADCxB can be started at different times using the respective STARTA and STARTB bits. Setting the STARTy bit while conversions are ongoing on an ADC aborts the ongoing conversion and restarts conversions. Use the STOPy bits to stop conversions of the enabled ADCs, ADC1y and ADC3y. The currently ongoing conversion is allowed to finish after the STOPy bit is set and the digital filter is held in reset thereafter. After setting the STOPy bits, the STOPy bits read back 1b until conversions are stopped.

The STARTy bits take priority over the STOPy bits. That means if both the STARTy and STOPy bits in the CONVERSION\_CTRL register are set at the same time, then conversions are started or ongoing conversions are aborted and new conversions are started.

The last conversion result of an ADC is still available for readout after conversions are stopped. The conversion results of an ADC are only cleared after a device reset, when the ADC is disabled, when the device is in standby or power-down mode, or are overwritten when a new conversion result becomes available.

The STARTy bits take effect and conversions start at the last SCLK falling edge of the register data CRC word within the SPI frame where the CONVERSION\_CTRL register is written. See the *Serial Interface Communication Structure* section for details on the SPI frame of a register write command.

Setting the STARTy bit drives the DRDYn pin high if DRDYn was low, however the old conversion data can still be read until the new conversions become available.

ADC1y and ADC3y use a sinc3 digital filter that requires three conversion periods to settle. When conversions are started or restarted using the STARTy bits, the device hides the first two unsettled conversions and only provides a settled conversion result after the third conversion period. Use Equation 19 to calculate the time until



the first conversion after a conversion start is available. All subsequent conversions have a conversion period, as shown in Figure 9-17, of  $t_{DATA} = 1 / f_{DATA} = OSR / f_{MOD}$ .

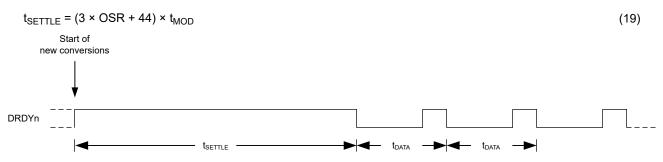


Figure 9-17. Sinc3 Filter Settling Time and Conversion Period

The ADC does not detect when a sudden step change on the analog input occurs while the ADC is continuously converting. Therefore, the ADC continues to output conversion data at the programmed output data rate. If the step change occurs concurrently with the start of a new conversion period, then settled data are output three conversion periods after the step change. However, the sinc3 filter takes four conversion periods to provide settled data, as shown in Figure 9-18, if the step change occurs in the middle of a conversion period.

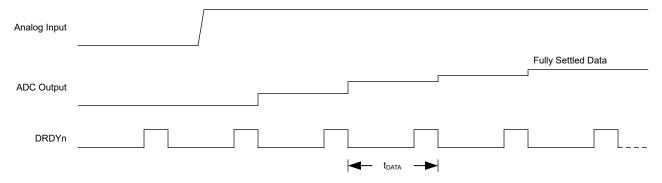


Figure 9-18. SINC3 Filter Behavior During Input Step Change

## 9.4.3.1.2 Single-Shot Conversion Mode

In single-shot conversion mode, ADCs ADC1y and ADC3y perform one single conversion after the STARTy bit is set. Setting the STARTy bit while a conversion is ongoing on an ADC aborts the ongoing conversion and restarts a single new conversion. The STOPy bits have no effect in single-shot conversion mode.

Equivalent to continuous-conversion mode, the STARTy bits take effect and conversions start at the last SCLK falling edge of the register data CRC word within the SPI frame where the CONVERSION\_CTRL register is written.

Every conversion in single-shot conversion mode is available after the first-conversion settling time as calculated by Equation 19. If an input step change occurs during the conversion process, the conversion result is not fully settled. Another subsequent single-shot conversion is required in that case to output a settled conversion result.

## 9.4.3.1.3 Global-Chop Mode

The signal chains of ADC1y and ADC3y use a very low-drift, chopper-stabilized PGA and  $\Sigma\Delta$ -modulator to provide very low offset error and offset drift. However, a small amount of offset drift remains in normal measurement. For that reason, the ADC1y and ADC3y signal chains incorporate an optional global-chop mode to reduce offset error and offset drift over both temperature and time to exceptionally low levels. When the global-chop mode is enabled by setting the GC13y\_EN bit, ADC1y and ADC3y perform two consecutive conversions with alternate input signal polarity to cancel offset error. The first conversion is taken with normal input polarity. The global-chop control logic inverts the input polarity and resets the digital filter for the second conversion. The average of the two conversions yields the final corrected result, removing the offset voltage. Figure 9-19 illustrates a block diagram of the ADC1y global-chop implementation. V<sub>OFS</sub> models the combined



(21)

PGA and ADC1y internal offset voltage. Only this device-inherent offset voltage is reduced by global-chop mode. Offset in the external circuitry connected to the analog inputs is not affected by global-chop mode. The GC13y\_EN bit enables global-chop mode for both ADC1y and ADC3y.

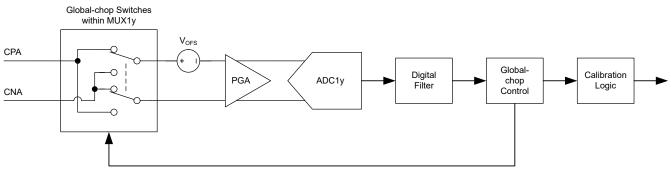


Figure 9-19. ADC1y Global-Chop Mode Control Diagram

The operational sequence of global-chop mode is as follows:

- Conversion C1: V<sub>CPA</sub> V<sub>CNA</sub> V<sub>OFS</sub>  $\rightarrow$  First conversion withheld after conversion start
- Conversion C2:  $V_{CNA} V_{CPA} V_{OFS} \rightarrow Output 1 = (V_{C1} V_{C2}) / 2 = V_{CPA} V_{CNA}$
- Conversion C3:  $V_{CPA} V_{CNA} V_{OFS} \rightarrow Output 2 = (V_{C3} V_{C2}) / 2 = V_{CPA} V_{CNA}$

• ...

The first conversion result (Output 1) after a conversion start is available after ADC1y takes two settled conversions. Because of the sinc3 filter, data of one conversion settles in three conversions cycles. Equation 20 calculates the time required to output the first conversion result after a conversion start.

In continuous-conversion mode with the global-chop mode enabled, subsequent conversions complete in  $t_{GC\_DATA}$ , as calculated by Equation 21 and shown in Figure 9-20. That means the data rate in global-chop mode is approximately  $1/3^{rd}$  the data rate in normal mode.

$$t_{GC\_SETTLE} = 2 \times (t_{GC13y\_DELAY} + 3 \times OSR \times t_{MOD}) + 44 t_{MOD}$$
(20)

 $t_{GC DATA} = t_{GC13A DELAY} + 3 \times OSR \times t_{MOD}$ ,

Before starting conversions after the input polarity is inverted, ADC1y waits the global-chop delay time, GC13y\_DELAY[2:0], to allow for the internal circuitry to settle. In some cases, the programmable global-chop delay time must be increased to allow for settling of external components.

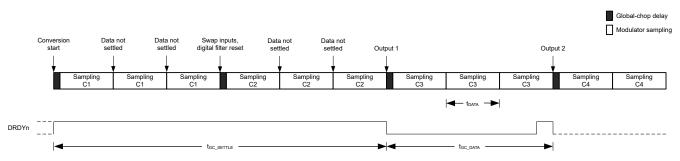


Figure 9-20. Sinc3 Filter Settling Time and Conversion Period in Global-Chop Mode

Global-chop mode reduces the ADC1y and ADC3y noise by a factor of  $\sqrt{2}$  because two conversions are averaged. Divide the input-referred noise values in Table 8-1 and Table 8-3 by  $\sqrt{2}$  to derive the noise performance when global-chop mode is enabled.

The notches of the sinc3 filter in Figure 9-3 do not change in global-chop mode. However, additional filter notches appear at multiples of  $f_{GC}$  DATA / 2.



#### 9.4.3.1.3.1 Overcurrent Indication Response Time in Global-Chop Mode

Enabling global-chop mode of ADC1y changes the overcurrent detection behavior of OCCy when ADC1y is converting. The OCCy digital fast filter resets each time ADC1y inverts the polarity of the analog inputs. After every fast filter reset, the device ignores the first two conversions of the OCCy filter because these conversions are unsettled. The device does not increment the OCCy\_NUM counter for these two conversions. Depending on the OCCy\_NUM and OSR1y settings, the overcurrent indication response time in global-chop mode can therefore be longer compared to when global-chop mode is disabled. The difference in response time is most noticeable when using large OCCy\_NUM and small OSR1y settings.

Figure 9-21 shows an example of the OCCy behavior with OSR1y = 128. The OCCy DRDYn signal indicates when conversions of the OCCy fast filter complete. This signal is internal only and is not accessible by the host. In this specific example, the OCCy\_NUM counter only manages to increment four times per ADC1y conversion period. If OCCy\_NUM = 8, up to two full ADC1y conversion periods are required before the OCCy\_NUM counter reaches 8. Which means that the overcurrent detection time increases from 8 × 64 /  $f_{MOD}$  (global-chop mode disabled) to 12 × 64 /  $f_{MOD}$  (global-chop mode enabled).

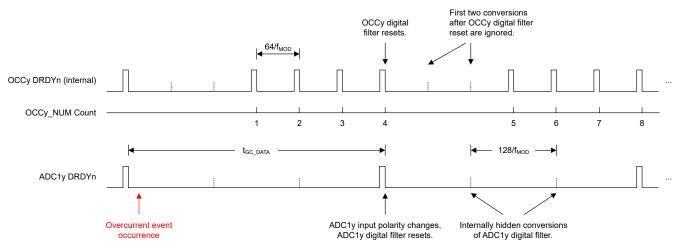


Figure 9-21. Overcurrent Detection Behavior With Global-Chop Mode Enabled (ADC1y OSR = 128)



## 9.4.3.2 ADC2y Sequencer Operation and Sequence Modes

In contrast to ADC1y and ADC3y, conversions on ADC2y are controlled by means of a channel sequencer. Figure 9-22 depicts a flow chart of the sequencer operation. The ADC2y sequencer has up to 16 sequence steps that are individually enabled or disabled using the SEQ2y\_STEPn\_EN bits (n = 0 to 15). Each sequence step corresponds to one single conversion of ADC2y, which means up to 16 different measurements can be taken in one sequence run. The SEQ2y\_STEPn\_CFG registers configure the PGA gain, and the positive and negative input for the PGA for every sequence step. When a sequence is started, the sequencer steps that are disabled. One conversion is taken by ADC2y in each step before the sequencer configures ADC2y for the next step in the sequence. After the sequencer configures ADC2y for the next sequence step, the sequencer adds a programmable delay before starting the conversion to allow for settling of the input signal. The MUX2y\_DELAY[2:0] bits select the delay time globally for all sequence steps. The time required to complete a sequence is given by Equation 22:

 $t_{SEQ} = N \times (t_{MUX\_DELAY} + t_{CONVERSION})$ 

(22)

## where:

- N is the number of enabled steps
- t<sub>MUX\_DELAY</sub> is the multiplexer delay time
- t<sub>CONVERSION</sub> is the conversion time of ADC2y

While a sequence is ongoing, the SEQ2y\_ACTIVE bit is set in the STATUS register.

Do not make any changes to registers in the address range from 0x8C to 0x9F while ADC2A is enabled, and make no changes to registers in the address range from 0xCC to 0xCF while ADC2B is enabled.

To avoid false sequencer starts, follow this procedure to configure and start the sequencer:

- 1. Disable ADC2y by setting ADC2y\_EN = 0b, or alternatively put the device into standby mode
- 2. Configure the ADC2y sequencer register bits
- 3. Enable ADC2y by setting ADC2y\_EN = 1b, or alternatively put the device back into active mode
- 4. Start the sequence by setting the SEQ2y\_START bit

Setting the SEQ2y\_START bit while ADC2y is disabled does not start a sequence.

Conversion data for the sequence steps of ADC2y are 16 bits and (in contrast to ADC1y and ADC3y conversion data) are stored in the user register space (register addresses 10h to 2Fh). The conversion data for sequence step *n* are stored in the corresponding SEQ2y\_STEPn\_DATA register. Conversion data for a sequence step that is disabled are set to 0000h. Read ADC2y conversion data using the register read command.

The conversion data of all SEQ2y\_STEPn\_DATA registers only update when a sequence run of ADC2y completes. While a sequence run is ongoing, the conversion data of the previous sequence run are read from the SEQ2y\_STEPn\_DATA registers. There is no data corruption or mix of data from two different sequence runs, even when a sequence completes while the SEQ2y\_STEPn\_DATA registers are read.

The ADC2y sequencer offers three sequence modes:

- Continuous sequence mode
- Single-shot sequence mode
- Synchronized single-shot sequence mode based on ADC1y conversion starts

The SEQ2y\_MODE[1:0] bits select the sequence mode for ADC2y.



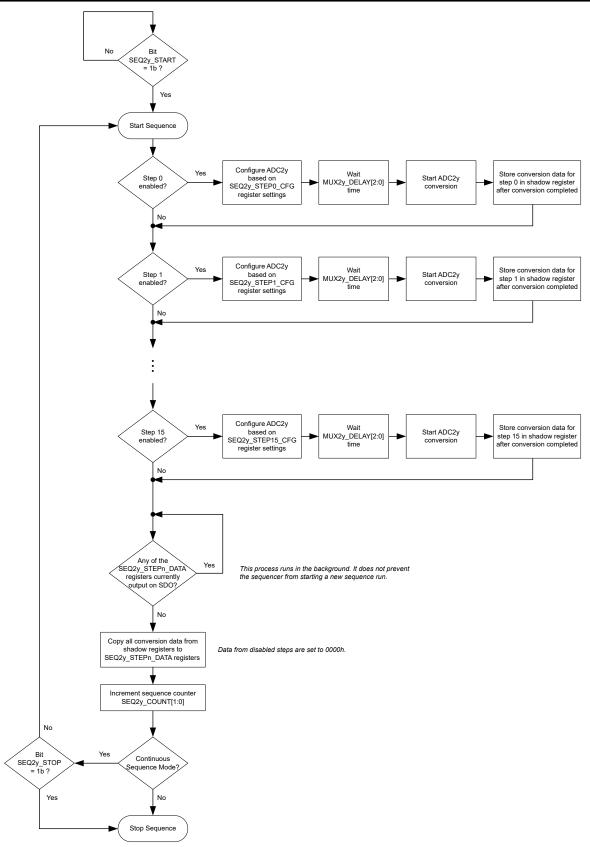


Figure 9-22. ADC2y Sequencer Flow Chart



#### 9.4.3.2.1 Continuous Sequence Mode

In continuous sequence mode, the ADC2y sequencer runs through the configured sequence over and over again until stopped by the host. Set the respective SEQ2y\_START bit in the CONVERSION\_CTRL register to start the sequencer of ADC2y. Setting the SEQ2y\_START bit while the sequencer is running aborts the ongoing sequence run and restarts a new sequence run from the beginning. Use the SEQ2y\_STOP bit to stop the sequencer of ADC2y. The currently ongoing sequence run is allowed to finish after the SEQ2y\_STOP bit is set. After setting the SEQ2y\_STOP bit, the SEQ2y\_STOP bit reads back 1b until the sequencer stopped. Disabling ADC2y or putting the device into standby or power-down mode aborts the sequence run immediately.

The SEQ2y\_START bits take priority over the SEQ2y\_STOP bits. That means if both the SEQ2y\_START and SEQ2y\_STOP bits in the CONVERSION\_CTRL register are set at the same time, then the sequencer starts a sequence run or aborts an ongoing sequence run and starts a new sequence run from the beginning.

The last conversion results of an ADC2y sequence run are still available for readout after the sequencer stopped. The conversion results of the sequencer are only cleared to 0000h after a device reset, when the ADC is disabled, when the device is in standby or power-down mode, or are overwritten when conversion results from a new sequence run become available.

#### 9.4.3.2.2 Single-Shot Sequence Mode

In single-shot sequence mode the ADC2y sequencer runs through the configured sequence one time after the SEQ2y\_START bit is set. Setting the SEQ2y\_START bit while a sequence is ongoing aborts the ongoing sequence and restarts a single new sequence run from the beginning. The SEQ2y\_STOP bit has no effect in single-shot sequence mode.

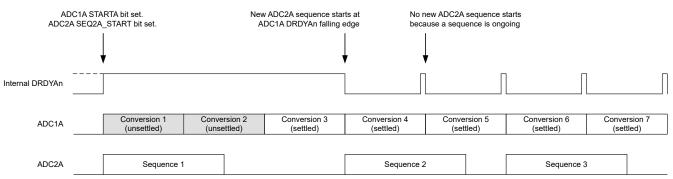
#### 9.4.3.2.3 Synchronized Single-Shot Sequence Mode Based on ADC1y Conversion Starts

The synchronized sequence mode allows the sequence starts of ADC2A to be synchronized with the conversion starts of ADC1A or the sequence starts of ADC2B to be synchronized with the conversion starts of ADC1B. In this mode a single sequence run is started on ADC2y whenever a new conversion on ADC1y starts. However, an *ongoing* sequence run on ADC2y does not abort and restart when a new conversion on ADC1y starts. This means a single new sequence run on ADC2y is only triggered by ADC1y when no sequence is currently ongoing.

## Start the ADC2y sequencer initially by setting the SEQ2y\_START bit.

The synchronized single-shot sequence mode is only useful when ADC1y is configured for continuousconversion mode. When ADC1y is configured for single-shot conversion mode, synchronize conversions of ADC1y and sequence starts of ADC2y by setting the STARTy and SEQy\_START bits at the same time.

Figure 9-23 shows an example of how ADC1A conversions and ADC2A sequence starts are synchronized. The falling edge of the internally generated DRDYAn signal in Figure 9-23 indicates when new ADC1A conversions results are available and a new ADC1A conversion starts.







# 9.5 Programming

## 9.5.1 Serial Interface

The ADS131B26-Q1 uses an SPI-compatible interface to configure the device and retrieve conversion data. The device always acts as an SPI peripheral; SCLK and CSn are inputs to the interface. The interface operates in SPI mode 1 where CPOL = 0 and CPHA = 1. In SPI mode 1, SCLK idles low and data are launched or changed only on SCLK rising edges; data are latched or read by the controller and peripheral on SCLK falling edges. The interface is full-duplex, meaning data can be sent and received simultaneously by the interface. The device includes the typical SPI signals: CSn, SCLK, SDI, and SDO. In addition, the DRDYn pin serves as a flag to the host to indicate new conversion data are available.

## 9.5.1.1 Serial Interface Signals

#### 9.5.1.1.1 Chip Select (CSn)

The CSn pin is an active low input signal that selects the device for communication. The device ignores any communication and SDO is high impedance when CSn is held high. Hold CSn low for the duration of a communication frame to ensure proper communication. The interface is reset each time CSn is taken high.

#### 9.5.1.1.2 Serial Data Clock (SCLK)

The SCLK pin is an input that serves as the serial clock for the interface. Output data on SDO transition on the rising edge of SCLK and input data on SDI are latched on the falling edge of SCLK.

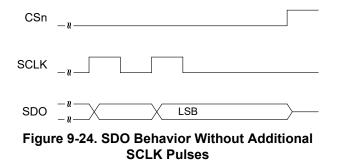
#### 9.5.1.1.3 Serial Data Input (SDI)

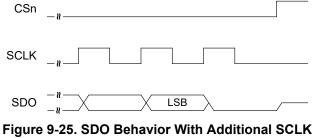
The SDI pin is the serial data input pin for the device. Serial commands are shifted in through the SDI pin by the device with each SCLK falling edge when the CSn pin is low.

#### 9.5.1.1.4 Serial Data Output (SDO)

The SDO pin is the serial data output pin for the device. The device shifts out data serially with each rising SCLK edge when the CSn pin is low. This pin assumes a high-impedance state when CSn is high. When CSn transitions low, the SDO pin drives low.

SDO stays at the level of the last bit sent if the host does not send any extra SCLK pulses after the last data is shifted out on SDO. If the host sends additional SCLK pulses after the last data is shifted out, then SDO drives low. Figure 9-24 and Figure 9-25 show timing diagrams of the SDO behavior both without and with additional SCLK pulses, respectively.





Pulses

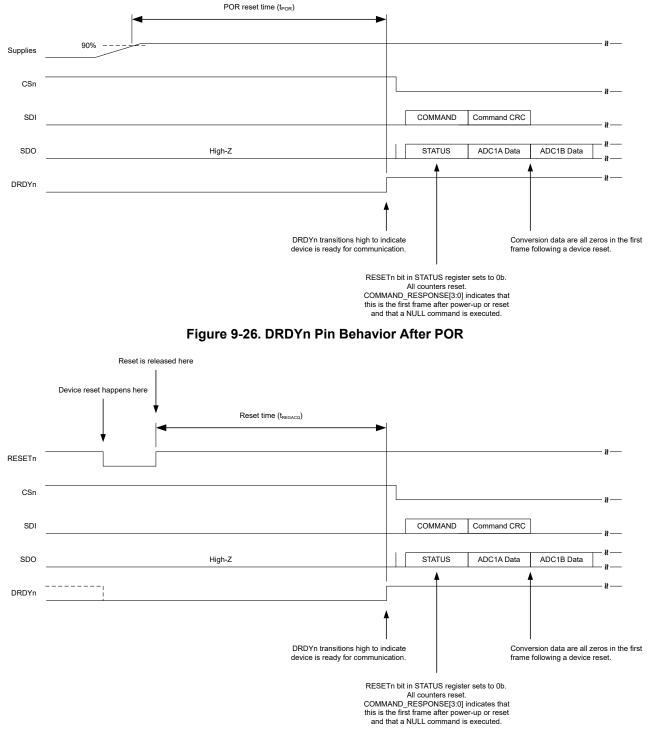
# 9.5.1.1.5 Data Ready (DRDYn)

The DRDYn pin is an active-low, push-pull output. A DRDYn falling edge indicates when new conversion data of ADC1A or ADC1B are available for readout. The DRDY\_CTRL bit selects which ADC drives the DRDYn signal, either ADC1A or ADC1B. If the host starts ADC1A and ADC1B conversions at the same time by setting both the STARTA and STARTB bits during the same CONVERSION\_CTRL register write, conversions of both ADCs complete at the same time. The period between DRDYn falling edges is the data rate period of the ADC that controls the DRDYn pin.



ADC3y converts simultaneously with ADC1y in each section. Therefore, the DRDYn pin also indicates when new conversions for ADC3y are available. If ADC3y is enabled but ADC1y is disabled, ADC3y drives the DRDYn pin.

During device power-up or while the device is held in reset, the DRDYn pin drives low. As shown in Figure 9-26 and Figure 9-27, the DRDYn pin drives high after the POR is released and the device is ready for communication.







## 9.5.1.2 Serial Interface Communication Structure

#### 9.5.1.2.1 SPI Communication Frames

SPI communication on the ADS131B26-Q1 is performed in frames. Each SPI communication frame starts with a CSn falling edge, consists of several words, and ends with a CSn rising edge. The interface is full duplex, meaning that the interface is capable of transmitting data on SDO while simultaneously receiving data on SDI. Figure 9-28 provides an overview of the general SPI frame structure and frame length for the various commands.

The input frame that the host sends on SDI always begins with a command word followed by a command CRC word. The first word on the output frame that the device transmits on SDO always begins with the STATUS word. The number of words in a frame depends on the command provided. See the *Commands* section for a list of all valid commands on the ADS131B26-Q1.

For the NULL, RESET, LOCK, UNLOCK, and RREG commands there are six words in a frame. On SDI, the host provides the command, the command CRC, and four additional words of zeros. Simultaneously on SDO, the device outputs the STATUS word, four words of ADC data (representing the data from ADC1A, ADC1B, ADC3A, and ADC3B), and an output CRC word. Figure 9-28 shows a typical communication frame structure. In the remaining sections of this document the SCLK signal is omitted in the figures for clarity.

CSn										
SCLK										
SDI			NULL	Command CRC						
SDO	High-Z		STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output C	RC	√/ √ High-Z

Figure 9-28. Typical Communication Frame

For a write register (WREG) command where more than three registers are written, the frame extends to accommodate the additional data. See the *WREG* section for more details on the WREG command.

For a read register (RREG) command, the response to the command in the following frame contains the STATUS word followed by the register data requested, which can require a shorter or longer frame depending on how many registers are read. See the *RREG* section for more details on the RREG command.



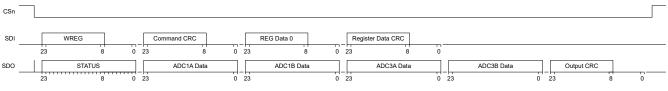
#### 9.5.1.2.2 SPI Communication Words

An SPI communication frame of the ADS131B26-Q1 is made of multiple words. The word size is configurable as either 24 bits, or 32 bits using the WORD\_LENGTH bit in the DEVICE\_CFG register. The content within each word is always most significant bit (MSB) aligned and least significant bit (LSB) padded with zeros to accommodate 24-bit or 32-bit word sizes. Table 9-23 provides an overview of all available word types and the actual unpadded data length of the respective content.

# Table 9-23. Unpadded Data Length of Individual Word Types

	······································									
DIRECTION	WORD TYPE	UNPADDED DATA LENGTH								
SDI	Command	16 bits								
SDI	Command CRC	16 bits								
SDI	Register data for WREG command	16 bits								
SDI	Register data CRC for WREG command	16 bits								
SDO	STATUS	24 bits								
SDO	ADC1A, ADC1B, ADC3A, and ADC3B conversion data	24 bits								
SDO	Register data for RREG command	16 bits register data + 8 bits register address								
SDO	Output CRC	16 bits								

Figure 9-29 and Figure 9-30 show the bit alignments and zero padding within the individual words for a WREG and RREG command, respectively.



# Figure 9-29. Bit Alignment, 24-Bit Word Size, WREG Command

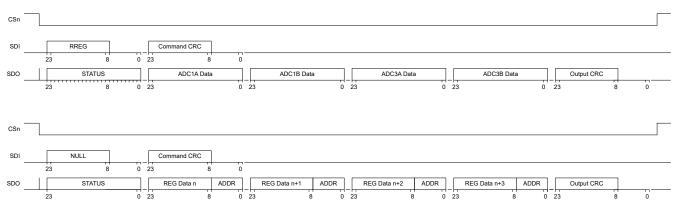


Figure 9-30. Bit Alignment, 24-Bit Word Size, RREG Command



## 9.5.1.2.3 STATUS Word

The ADS131B26-Q1 outputs a STATUS word as the first word in every frame on SDO. The 24-bit STATUS word is a concatenation of the STATUS\_MSB[15:0] and STATUS\_LSB[15:8] register bits. Fault flags, status flags, ADC1A and ADC1B conversion counters, ADC2A and ADC2B sequence counters, and the command response are all part of these bits. See the respective register bit descriptions in the *Register Map* section for details.

- Communication-related fault flags, such as the SPI\_CRC\_FAULTn, SPI\_TIMEOUTn, SCLK\_COUNT\_FAULTn, and REG\_ACCESS\_FAULTn flags, always indicate faults that occurred in the previous SPI frame. These fault flags clear automatically for the next SPI frame.
- All other device-related fault and status flags indicate the state of the device at the instance of the start of the current SPI frame.
- All fault flags, except for the communication related fault flags mentioned above, are latching. That means, these fault flags do not reset automatically to 1b when the fault condition is removed and must be cleared by the host.
- The command response indicates which command was received by the device in the previous SPI frame and was executed.
- The conversion and sequence counters indicate the count of the data which is output in the current SPI frame.

#### 9.5.1.2.4 Communication Cyclic Redundancy Check (CRC)

The ADS131B26-Q1 features a cyclic redundancy check (CRC) engine on both input and output data to detect SPI communication errors. Overall there are three different CRCs that are all 16 bits wide:

- On SDI: Command CRC and, in case of a WREG command, a register data CRC
- On SDO: Output CRC

The command CRC covers the command word (that is, the first word on SDI in every frame). The WREG command is a special case that requires an additional register data CRC. The register data CRC covers the register data words transmitted after the command CRC word. The output CRC covers all words on SDO preceding the output CRC word. The CRCs also cover all zero-padded bits.

The device checks the provided command CRC, and (in case of a WREG command) the register data CRC against the internally calculated CRCs based on the received input data. A CRC error occurs if the CRC words do not match. The device does not execute any commands if the command CRC or register data CRC checks fail. The device sets the SPI\_CRC\_FAULTn bit in the STATUS\_MSB register for all cases of a CRC error on the input data.

The response on the output in the SPI frame following a frame where a CRC error occurred is that of a NULL command, which means the STATUS word plus the conversion data for ADC1A, ADC1B, ADC3A, and ADC3B are output in the following SPI frame. The SPI\_CRC\_FAULTn bit is output as part of the STATUS word to provide immediate indication that a CRC error occurred in the previous frame. The SPI\_CRC\_FAULTn bit clears automatically in the next SPI frame.

There are two types of CRC polynomials available: CCITT CRC and ANSI CRC (CRC-16). The CRC polynomial setting determines the algorithm for all three CRCs. The CRC type is programmed using the CRC\_TYPE bit. Table 9-24 lists the details of the two CRC types.

The CRC calculation is initialized with the seed value of FFFFh to detect errors in the event that SDI or SDO are stuck low.

CRC TYPE	POLYNOMIAL	BINARY POLYNOMIAL								
CCITT CRC	$x^{16} + x^{12} + x^5 + 1$	0001 0000 0010 0001								
ANSI CRC	$x^{16} + x^{15} + x^2 + 1$	1000 0000 0000 0101								

# Table 9-24. CRC Types



# 9.5.1.2.5 Commands

Table 9-25 contains a list of all valid commands, a short description of the command functionality, and the binary command word.

COMMAND	DESCRIPTION	COMMAND WORD							
NULL	No operation	0000 0000 0000 0000ь							
RESET	Reset the device	0000 0000 0001 0001b							
LOCK	Lock the interface such that only the NULL, UNLOCK, and RREG commands are valid	0000 0101 0101 0101Ь							
UNLOCK	Unlock the interface after the interface is locked	0000 0110 0101 0101b							
WREG	Write nnn plus 1 registers beginning at address a aaaa aaa	011 <i>a aaaa aaa0 0nnn</i> b							
RREG	Read n nnnn plus 1 registers beginning at address a aaaa aaa	101 <i>a aaaa aaan nnnn</i> b							

## Table 9-25. Command Definitions

## 9.5.1.2.5.1 NULL (0000 0000 0000 0000b)

The NULL command is the *no-operation* command that results in no registers being read or written, and the state of the device remains unchanged. The intended use case for the NULL command is to read out conversion data for ADC1A, ADC1B, ADC3A, and ADC3B.

The command response in the next frame indicates if an error occurred during the transmission of the NULL command frame. However, a NULL command is executed regardless if an error occurred or not.

Figure 9-31 shows a typical NULL command frame where no faults occurred during the communication.

CSn -															
SDI		NULL	Command CRC						Command	Command CRC					
SDO		STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	T]	STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	- 7
									Ť				Ť		
								indicates	ND_RESPONSE[3: that a NULL comm ved in the previous	nand was		Conversion data for are output as	ADC1A, ADC1B, A response to a NUI		

Figure 9-31. NULL Command Frame



#### 9.5.1.2.5.2 RESET (0000 0000 0001 0001b)

The RESET command resets the device and sets all user registers to the respective default values. The command is latched by the device at the last SCLK falling edge of the output CRC word. Terminating the frame before the output CRC word is shifted out on SDO causes the RESET command to be ignored. A reset occurs immediately after the command is latched. The DRDYn pin transitions low at the same instance. The host must wait for t<sub>REGACQ</sub> after reset or for the DRDYn rising edge to make sure the device completes the reset process before communicating with the device.

The RESETn status bit and the command response in the next frame indicate if the RESET command executed successfully or if an error occurred that prevented the RESET command from executing. A NULL command is executed if the RESET command did not execute.

Figure 9-32 shows a RESET command frame where no faults occurred during the communication.

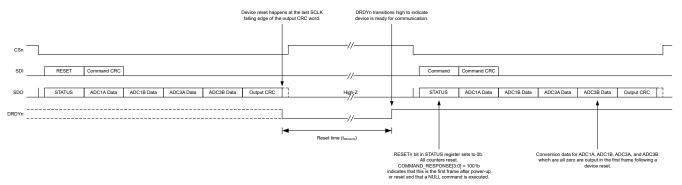


Figure 9-32. RESET Command Frame

#### 9.5.1.2.5.3 LOCK (0000 0101 0101 0101b)

The LOCK command locks the interface, preventing the device from accidentally latching unwanted commands that can change the state of the device. When the interface is locked, the device only responds to the NULL, RREG, and UNLOCK commands. The device continues to output conversion data even when locked.

The LOCK status bit and the command response in the next frame indicate if the LOCK command executed successfully or if an error occurred that prevented the LOCK command from executing. A NULL command is executed if the LOCK command did not execute.

Figure 9-33 shows a LOCK command frame where no faults occurred during the communication.

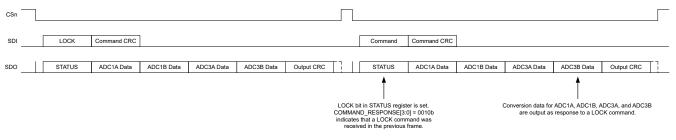


Figure 9-33. LOCK Command Frame



#### 9.5.1.2.5.4 UNLOCK (0000 0110 0101 0101b)

The UNLOCK command unlocks the interface if previously locked by the LOCK command.

The LOCK status bit and the command response in the next frame indicate if the UNLOCK command executed successfully or if an error occurred that prevented the UNLOCK command from executing. A NULL command is executed if the UNLOCK command did not execute.

Figure 9-34 shows an UNLOCK command frame where no faults occurred during the communication.

CSn -																
SDI		UNLOCK	Command CRC						Command	Command CRC						
SDO	1	STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	T]	STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	ŢŢ	
=								S register is cleared. Conversion data for ADC1A, ADC1B, ADC3A, and					B			
								COMMAND_RESPONSE[3:0] = 0011b indicates that an UNLOCK command was received in the previous frame.				are output as response to an UNLOCK command.				



#### 9.5.1.2.5.5 WREG (011a aaaa aaa0 0nnnb)

The WREG command is used to write the device registers. The binary format of the command word is 011*a aaaa aaa0 0nnn*, where *a aaaa aaa* is the binary address of the register to begin writing to and *nnn* is the unsigned binary number of consecutive registers to write minus one. Send the register data to be written immediately following the WREG command CRC word. Write the intended contents of each register into individual words, MSB aligned. Follow the register data words with the register data CRC word that covers the register data content.

The device prevents register data writes if the command CRC or register data CRC fail. The command response in the next frame indicates if the WREG command executed successfully or if an error occurred that prevented the WREG command from executing. A NULL command is executed if the WREG command did not execute.

Figure 9-35 shows a WREG command frame for a single register write where no faults occurred during the communication.

CSn _	7								ΓΓ								
SDI			WREG	Command CRC	REG Data 0	REG Data CRC					Command	Command CRC					
SDO		Г	STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	T]		STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	T]
-							 ↑										
									COMMAND_RESPONSE[3:0] = 0110b indicates that a WREG command was received in the previous frame and the register data updated.					Conversion data for ADC1A, ADC1B, ADC3A, and ADC3B are output as response to a WREG command.			

## Figure 9-35. WREG Command Frame (Single Register)

Figure 9-36 shows a WREG command frame where the number of registers to write is larger than three and, therefore, the frame extends beyond the regular six words.

CSn	7											
SDI	 WREG	Command CRC	REG Data 0	REG Data 1	REG Data 2	REG Data 3	REG Data 4	REG Data 5	REG Data CRC			
SDO	STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC						

Figure 9-36. WREG Command Frame (Six Registers)



#### 9.5.1.2.5.6 RREG (101a aaaa aaan nnnnb)

RREG is used to read the device registers. The binary format of the command word is 101*a* aaaa aaan nnnn, where *a* aaaa aaa is the binary address of the register to begin reading from and *n* nnnn is the unsigned binary number of consecutive registers to read minus one. The device outputs the requested register data sequentially in order of addresses in the following frame instead of the conversion data of ADC1A, ADC1B, ADC3A, and ADC3B. If more than four registers are read, the frame extends beyond the regular six words.

Send the NULL command in the frame following the RREG command frame to shift out the register data. No other command is accepted in the frame following the RREG command frame.

The 16-bit register data are MSB aligned within the individual words. As illustrated in Figure 9-30, the device outputs the respective 8-bit register address following the register data within each word for traceability. When reading from an invalid register address, the device responds with 0000h for the register data and 00h for the register address.

The command response in the frame following the RREG command frame indicates if the RREG command executed successfully or if an error occurred that prevented the RREG command from executing. A NULL command is executed if the RREG command did not execute.

Figure 9-37 shows a RREG command frame where no faults occurred during the communication.

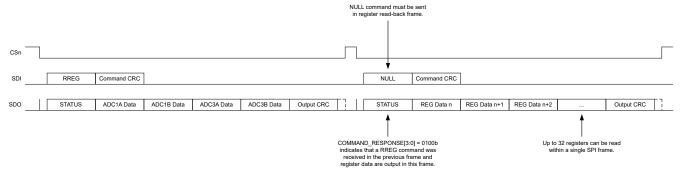


Figure 9-37. RREG Command Frame



## 9.5.1.2.6 SCLK Counter

The ADS131B26-Q1 implements an SCLK counter that counts the received SCLK pulses within a frame. If the number of received SCLK pulses does not match the number of SCLKs to complete a specific frame, then the SCLK\_COUNT\_FAULTn flag is set in the following frame. Enable or disable the SCLK counter using the SCLK\_COUNTER\_EN bit.

The device determines the number of SCLKs expected for a specific SPI frame at the end of the command CRC word. Both the expected number of words to be received on SDI and the words to be transmitted on SDO are considered in the SCLK count calculation. The larger of the two values determines the SCLK count for the frame. For example, the SCLK count in the two frames in Figure 9-35 is ( $6 \times N_{WORD\_LENGTH}$ ), while in Figure 9-36 the SCLK count for the frame is ( $9 \times N_{WORD\_LENGTH}$ ). The data word length,  $N_{WORD\_LENGTH}$ , is either 24 or 32, as configured by the WORD\\_LENGTH bit.

Sending more SCLK pulses than required to complete a frame does not impact the SPI communication, however the SCLK\_COUNT\_FAULTn does still set in that case to indicate that too many SCLKs were received.

Sending insufficient SCLK pulses to complete a frame does impact the SPI communication in certain situations:

- NULL command: No effect.
- RESET command: Does not execute until sufficient SCLK pulses are provided to clock out the complete output CRC word on SDO.
- LOCK, UNLOCK, RREG commands: Do execute if at least the command and command CRC words are received on SDI.
- WREG command: Does execute if at least the command, command CRC, register data, and register data CRC words are received on SDI.
- DRDYn pin: The DRDYn pin only transitions high after the conversion data word for ADC3B is clocked out on SDO. Otherwise, the device assumes the host did not receive the latest conversion data and the DRDYn pin stays low.

## 9.5.1.2.7 SPI Timeout

The ADS131B26-Q1 implements an SPI timeout feature that measures the time between the CSn falling and CSn rising edge within a frame. If the CSn rising edge does not occur within the SPI timeout period ( $t_{TIMEOUT}$ ) after the CSn falling edge, then the SPI\_TIMEOUTn flag is set in the following frame. When a timeout occurs, the rest of the SPI frame on SDI is ignored before the rising edge of CSn. A new SPI transaction starts at the next CSn falling edge. Enable or disable the SPI timeout using the TIMEOUT\_EN bit.

If the SPI times out after a complete frame was transmitted on SDI and SDO already, then there is no impact to the SPI communication, however the SPI\_TIMEOUTn flag does still set in that case to indicate that the CSn signal was held low for too long.

If the SPI times out before a complete frame is transmitted on SDI and SDO, then there is potential impact to the SPI communication in certain situations:

- NULL command: No effect.
- RESET command: Does not execute until the complete output CRC word is clocked out on SDO before the SPI times out.
- LOCK, UNLOCK, RREG commands: Do execute if at least the command and command CRC words are received on SDI before the SPI times out.
- WREG command: Does execute if at least the command, command CRC, register data, and register data CRC words are received on SDI before the SPI times out.
- DRDYn pin: The DRDYn pin only transitions high after the conversion data word for ADC3B is clocked out on SDO before the SPI times out. Otherwise, the device assumes the host did not receive the latest conversion data and the DRDYn pin stays low.



#### 9.5.1.2.8 Reading ADC1A, ADC1B, ADC2A, ADC2B, ADC3A, and ADC3B Conversion Data

Conversion data from all six ADCs of the ADS131B26-Q1 can be read within two SPI frames. Conversion data for ADC1A, ADC1B, ADC3A, and ADC3B are always output as the response to a NULL command in the following SPI frame. Conversion data for ADC2A and ADC2B must be read from the user registers using the RREG command. The conversion results for the various sequence steps of ADC2A and ADC2B are stored in consecutive register address locations starting at register address 10h. The RREG command allows to read up to 32 consecutive registers within one SPI frame, which is sufficient to read conversion data for all sequence steps of ADC2A and ADC2B. Figure 9-38 shows an SPI frame sequence example of how to read all ADC conversion data.

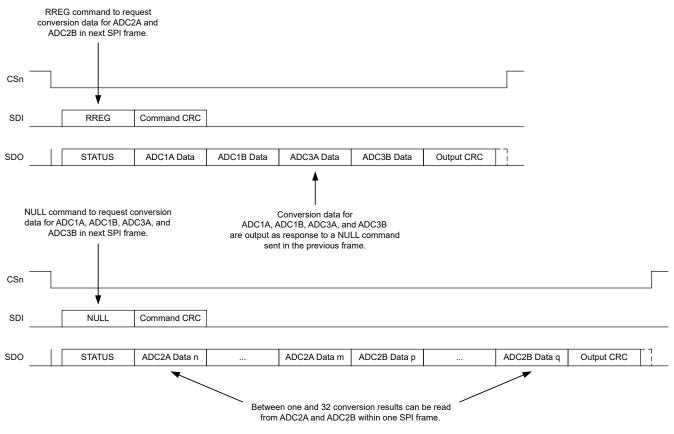


Figure 9-38. Reading Conversion Data From ADC1A, ADC1B, ADC2A, ADC2B, ADC3A, and ADC3B Within Two SPI Frames



#### 9.5.1.2.9 DRDYn Pin Behavior

This section provides details about the DRDYn pin behavior in various scenarios.

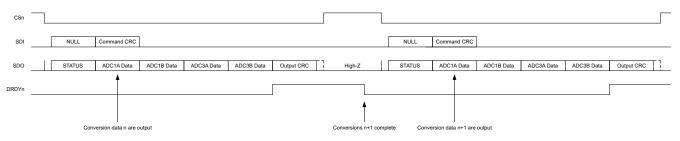
DRDYn transitions low whenever new conversion data complete on ADC1A or ADC1B, depending on which ADC drives the DRDYn signal as configured in the DRDY\_CTRL bit. If DRDYn is low when a new conversion completes on ADC1y, then DRDYn drives high  $t_{w(DRH)}$  before the DRDYn falling edge (see Figure 9-40 and Figure 9-42).

DRDYn transitions high after the conversion data for ADC3B are retrieved on SDO (Figure 9-39). If CSn is driven high before the ADC3B conversion data are retrieved, then DRDYn stays low, indicating that not all conversion data were read (Figure 9-40 and Figure 9-41).

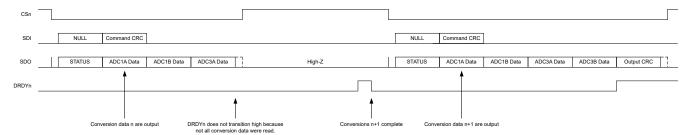
Figure 9-41 shows that the same conversion data can be read multiple times until new conversions complete. The ADC1y conversion counters indicate if the same data were read again or if new data were read.

The device avoids data corruption if new conversions n+1 complete while conversion data n are being read. Conversion data n+1 are held in an internal buffer until the read of conversion data n is complete. In the following frame, conversion data n+1 are loaded into the SDO output buffer. DRDYn does not transition high after conversion data n have been read in this case to indicate that new conversion data n+1 are available for readout (see Figure 9-42).

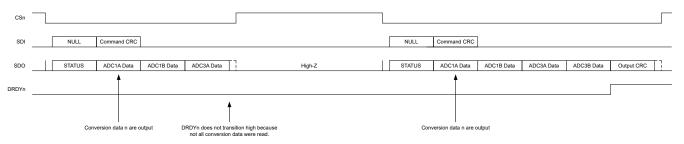
Figure 9-43 illustrates that conversion data n+1 are lost when the host does not read the data before conversions n+2 complete. The ADC1y conversion counters are helpful in this situation to detect if the host missed reading the intermediate conversion results.



#### Figure 9-39. DRDYn Pin Behavior: Reading All Conversion Data Before New Conversions Complete







# Figure 9-41. DRDYn Pin Behavior: Incomplete Read of Conversion Data Followed by Complete Read of Same Conversion Data



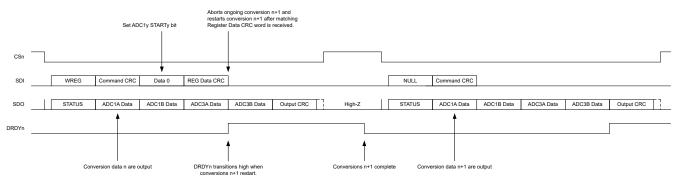
				Conversion d are not corru										
- CSn														
SDI	NULL	Command CRC						NULL	Command CRC	]				
SDO	STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	High-Z	STATUS	ADC1A Data	ADC1B Data	ADC3A Data	ADC3B Data	Output CRC	T]
DRDYn	 								<b>A</b>					
-				t t		t								
	Con	version data n are o	output	Conversions n+1		RDYn does not transi		Conv	ersion data n+1 are	output				

Figure 9-42. DRDYn Pin Behavior: Reading Conversion Data While New Conversions Complete

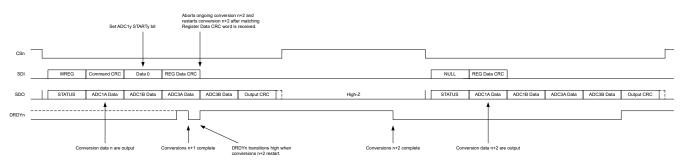


Figure 9-43. DRDYn Pin Behavior: Missed Reading Intermediate Conversion Results

Setting the STARTy bit drives the DRDYn pin high at the last SCLK falling edge of the register data CRC word within the SPI frame where the CONVERSION\_CTRL register is written. However, the old conversion data can still be read until the new conversions become available. Figure 9-44 shows the device behavior when setting the STARTy bit to abort an ongoing conversion and to restart new conversions while reading out conversion data. Figure 9-45 shows a scenario where new conversions complete while setting the STARTy bit and reading out conversion data.











# 9.6 Register Map

The ADS131B26-Q1 register map spans across the address space from 00h to FEh and is divided into four general sections:

- Section 0 (address space: 00h to 2Fh): Only includes read-only bits (such as ID, status, GPIO input data, ADC2y conversion data, and the conversion and sequence control bits)
- Section 1 (address space: 40h to 7Eh): Includes global device configuration bits that are not specific to section A or B of the device
- · Section 2 (address space: 80h to BEh): Includes device configuration bits that are specific to section A
- Section 3 (address space: C0h to FEh): Includes device configuration bits that are specific to section B



#### 9.6.1 Registers

 Table 9-26 lists the memory-mapped registers for the Registers registers. All register offset addresses not listed in Table 9-26 should be considered as reserved locations and the register contents should not be modified.

Address	Aoranim	Basst	Dit 45		9-26. Reg			Dif 40	DHO	Dit 0		
Address	Acronym	Reset	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
0507161			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
SECTION			1									
00h	ID	Х				REV	V[7:0]					
0.41		75.001		ADC_COUNT[2:0]				DEVICE_ID[4:0]				
01h	STATUS_MSB	7FC8h	RESETn	SUPPLY_FAUL Tn	CLOCK_FAULT n	DIGITAL_FAUL Tn	OCC_FAULTn	SPI_CRC_FAU LTn	SPI_TIMEOUT n	SCLK_COUNT _FAULTn		
			REG_ACCESS _FAULTn		COMMAND_R	ESPONSE[3:0]		LOCK	CLOCK	MODE		
02h	STATUS_LSB	0000h	SEQ2A_C	OUNT[1:0]	SEQ2B_C	OUNT[1:0]	CONV1A_0	COUNT[1:0]	CONV1B_0	COUNT[1:0]		
					RESE	RVED			SEQ2A_ACTIV E	SEQ2B_ACTIV E		
03h	SUPPLY_STATUS	FFFFh	AVDD_OVn	AVDD_UVn	IOVDD_OVn	IOVDD_UVn	DVDD_OVn	DVDD_UVn	AVDD_OSCn	IOVDD_OSCn		
			DVDD_OSCn	AVDD_OTWn	IOVDD_OTWn	AVDD_CLn	IOVDD_CLn	AGNDA_DISCn	AGNDB_DISCn	DGND_DISCn		
04h	CLOCK_STATUS	FC07h				RESE	ERVED					
					RESERVED			MCLK_FAULTn	OSCD_WDn	MCLK_WDn		
05h	DIGITAL_STATUS	EC00h	REG_MAP1_C RC_FAULTn	REG_MAP2_C RC_FAULTn	REG_MAP3_C RC_FAULTn	RESERVED	MEM_MAP_CR C_FAULTn	OTP_BANK	RESE	RVED		
						RESE	ERVED		L			
06h	OCC_STATUS	000Fh				RESE	ERVED					
				RESE	RVED		OCCA_HTn	OCCA_LTn	OCCB_HTn	OCCB_LTn		
07h	GPI_DATA	0000h			RESE	RVED			GPI4_E	DAT[1:0]		
			GPI3_E	DAT[1:0]	GPI2_E	DAT[1:0]	GPI1_E	DAT[1:0]	GPI0_E	DAT[1:0]		
08h	GPIA_GPIB_DATA	0000h	RESERVED GPI1A_C				DAT[1:0]	GPI0A_DAT[1:0]				
				RESE	RVED		GPI1B_	DAT[1:0]	GPI0B_	DAT[1:0]		
09h	CONVERSION_CTR	0000h	RESERVED	STARTA	RESERVED	STARTB	RESERVED	STOPA	RESERVED	STOPB		
			RESERVED	SEQ2A_START	RESERVED	SEQ2B_START		SEQ2A_STOP	RESERVED	SEQ2B_STOP		
10h         SEQ2A_STEP0_DAT         0000h         SEQ2A_STEP0_DAT[15:0]           A         0000h         0000h<												
11h	SEQ2A STEP1 DAT	0000h				_	P0_DAT[15:0]					
1111	A	000011					EP1_DAT[15:0]					
12h	SEQ2A STEP2 DAT	0000h					EP2_DAT[15:0]					
1211	A	000011					EP2_DAT[15:0]					
13h	SEQ2A STEP3 DAT	0000h					EP3_DAT[15:0]					
	_ A _						EP3_DAT[15:0]					
14h	SEQ2A_STEP4_DAT	0000h				SEQ2A_STE	P4_DAT[15:0]					
	A					SEQ2A_STE	P4_DAT[15:0]					
15h	SEQ2A_STEP5_DAT	0000h				SEQ2A_STE	P5_DAT[15:0]					
	A					SEQ2A_STE	EP5_DAT[15:0]					
16h	SEQ2A_STEP6_DAT	0000h				SEQ2A_STE	P6_DAT[15:0]					
	A					SEQ2A_STE	P6_DAT[15:0]					
17h	SEQ2A_STEP7_DAT A	0000h					P7_DAT[15:0]					
						-	P7_DAT[15:0]					
18h	SEQ2A_STEP8_DAT A	0000h					EP8_DAT[15:0]					
19h	SEQ2A_STEP9_DAT	0000h					EP9_DAT[15:0]					
	A		SEQ2A_STEP9_DAT[15:0]									
1Ah	SEQ2A_STEP10_DA	0000h	SEQ2A_STEP10_DAT[15:0]									
	TA TA					_	P10_DAT[15:0]					
1Bh	SEQ2A_STEP11_DA	0000h					P11_DAT[15:0]					
	TA		SEQ2A_STEP11_DAT[15:0]									
1Ch	SEQ2A_STEP12_DA	0000h				SEQ2A_STE	P12_DAT[15:0]					
	TA					SEQ2A_STE	P12_DAT[15:0]					

Table 9-26 Register Man

#### ADS131B26-Q1 SBASA22A – SEPTEMBER 2022 – REVISED JULY 2023



			7	Table 9-26.	Register	Map (conti	nued)				
Address	Acronym	Reset	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1Dh	SEQ2A_STEP13_DA	0000h				SEQ2A_STER	P13_DAT[15:0]				
	ТА			SEQ2A_STEP13_DAT[15:0]							
1Eh	SEQ2A_STEP14_DA	0000h		SEQ2A_STEP14_DAT[15:0]							
	ТА			SEQ2A_STEP14_DAT[15:0]							
1Fh	SEQ2A_STEP15_DA TA	0000h		SEQ2A_STEP15_DAT[15:0]							
	14					SEQ2A_STEF	P15_DAT[15:0]				
20h	SEQ2B_STEP0_DAT A	0000h				SEQ2B_STE	P0_DAT[15:0]				
						SEQ2B_STE	P0_DAT[15:0]				
21h	SEQ2B_STEP1_DAT A	0000h					P1_DAT[15:0]				
							P1_DAT[15:0]				
22h	SEQ2B_STEP2_DAT A	0000h					P2_DAT[15:0]				
							P2_DAT[15:0]				
23h	SEQ2B_STEP3_DAT A	0000h				_	P3_DAT[15:0]				
246	SEQ2B STEP4 DAT	00005					P3_DAT[15:0]				
24h	A	0000h					P4_DAT[15:0]				
25h	SEQ2B_STEP5_DAT	0000h					P4_DAT[15:0]				
250	A	000011					P5_DAT[15:0] P5_DAT[15:0]				
26h	SEQ2B_STEP6_DAT	0000h				_	P6_DAT[15:0]				
2011	A	000011					P6 DAT[15:0]				
27h	SEQ2B_STEP7_DAT	0000h				-	P7 DAT[15:0]				
	A						P7_DAT[15:0]				
28h	SEQ2B_STEP8_DAT	0000h	SEQ2B_STEP8_DAT[15:0]								
	A		SEQ2B_STEP8_DAT[15:0]								
29h	SEQ2B_STEP9_DAT	0000h	SEQ2B_STEP9_DAT[15:0]								
	A		SEQ2B_STEP9_DAT[15:0]								
2Ah	SEQ2B_STEP10_DA	0000h	SEQ2B_STEP10_DAT[15:0]								
	ТА					SEQ2B_STEF	P10_DAT[15:0]				
2Bh	SEQ2B_STEP11_DA TA	0000h				SEQ2B_STE	P11_DAT[15:0]				
	IA					SEQ2B_STER	P11_DAT[15:0]				
2Ch	SEQ2B_STEP12_DA TA	0000h				SEQ2B_STER	P12_DAT[15:0]				
						SEQ2B_STER	P12_DAT[15:0]				
2Dh	SEQ2B_STEP13_DA TA	0000h					P13_DAT[15:0]				
							P13_DAT[15:0]				
2Eh	SEQ2B_STEP14_DA TA	0000h					P14_DAT[15:0]				
2Fh	SEQ2B STEP15 DA	0000h					P14_DAT[15:0]				
2F11	TA	000011				_	P15 DAT[15:0]				
SECTION							13_DAI[13.0]				
40h	DEVICE_MONITOR_	0000h	REG_MAP1_C	CRC_TYPE	SCLK_COUNT	TIMEOUT_EN		RESERVED		FAULT_POL	
	CFG		RC_EN	_	ER_EN			1	1		
					RESERVED	1		MHD_POL		CFG[1:0]	
41h	SUPPLY_MONITOR _CFG1	0000h	AVDD_OV_EN	AVDD_UV_EN	IOVDD_OV_EN	IOVDD_UV_EN	DVDD_OV_EN	DVDD_UV_EN	AVDD_OSC_E N	IOVDD_OSC_E N	
			DVDD_OSC_E N	AVDD_OTW_E N	IOVDD_OTW_ EN	AVDD_CL_EN	IOVDD_CL_EN	AGNDA_DISC_ EN	AGNDB_DISC_ EN	DGND_DISC_E N	
42h	SUPPLY_MONITOR	10F0h	RESE	RVED	IOVDD_OV_TH	IOVDD_UV_TH	TH RESERVED				
	_CFG2		AVDD_OTV	V_CFG[1:0]	IOVDD_OT	W_CFG[1:0]	RESERVED				
43h	CLOCK_MONITOR_	0000h				RESE	RESERVED				
	CFG				RESERVED		MCLK_MON_E OSCD_WD_EN MCLK_W		MCLK_WD_EN		
44h	SUPPLY_MONITOR	0000h	AVDD_OV_DIA	AVDD_UV_DIA			DVDD_OV_DIA	DVDD_UV_DIA			
	_DIAGNOSTIC_CFG		G_EN DVDD_OSC_DI	G_EN	AG_EN RESE	AG_EN RVED	G_EN	G_EN AGNDA_DISC_	AG_EN	IAG_EN	
			AG_EN					DIAG_EN	DIAG_EN	IAG_EN	

				able 9-26.	Register	Map (cont	inued)				
Address	Acronym	Reset	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
45h	CLOCK_MONITOR_ DIAGNOSTIC CFG	0000h				SPAR	E[11:0]				
	DIAGNOSTIC_CFG			SPAR	E[11:0]		MCLK_HI_DIA G_EN	MCLK_LO_DIA G EN	OSCD_WD_DI AG EN	MCLK_WD_DI AG EN	
46h	DIGITAL MONITOR	0000h			RESE	RVED	G_LIN	G_LN	_	RC_DIAG[1:0]	
4011	_DIAGNOSTIC_CFG	000011			RESERVED			GPIOA DIAG	GPIOB DIAG	GPIO DIAG	
					RESERVED			EN	EN	N	
47h	SUPPLY_FAULT_MA SK	0000h	AVDD_OV_MA SK	AVDD_UV_MA SK	IOVDD_OV_M ASK	IOVDD_UV_MA SK	DVDD_OV_MA SK	DVDD_UV_MA SK	AVDD_OSC_M ASK	IOVDD_OSC_ MASK	
			DVDD_OSC_M ASK	AVDD_OTW_M ASK	IOVDD_OTW_ MASK	AVDD_CL_MA SK	IOVDD_CL_MA SK	AGNDA_DISC_ MASK	AGNDB_DISC_ MASK	DGND_DISC_ MASK	
48h	CLOCK_FAULT_MA SK	0000h				RESE	RVED				
	U.V.				RESERVED			MCLK_FAULT_ MASK	OSCD_WD_MA SK	MCLK_WD_M/ SK	
49h	DIGITAL_FAULT_MA SK	0000h	REG_MAP1_C RC_FAULT_MA SK	REG_MAP2_C RC_FAULT_MA SK	REG_MAP3_C RC_FAULT_MA SK	RESERVED	MEM_MAP_CR C_FAULT_MAS K		RESERVED		
						RESE	RVED				
4Ah	OCC_FAULT_MASK	0000h				RESE	RVED				
				RESE	RVED		OCCA_HT_MA SK	OCCA_LT_MA SK	OCCB_HT_MA SK	OCCB_LT_MA	
4Bh	FAULT_PIN_MASK	0780h	RESERVED	SUPPLY_FAUL T_MASK	CLOCK_FAULT _MASK	DIGITAL_FAUL T_MASK	OCC_FAULT_ MASK	SPI_CRC_FAU LT_MASK	SPI_TIMEOUT _MASK	SCLK_COUNT _FAULT_MASH	
			REG_ACCESS _FAULT_MASK		1		RESERVED	1	1		
4Ch	4Ch DEVICE_CFG		RESERVED	DRDY_CTRL	RESERVED	CLK_SOURCE	WORD_LENGT H	RESERVED	OP_MC	DE[1:0]	
						RESE	RVED				
4Dh	GPIO CFG	0000h	RESERVED	GPIO4 FMT	GPIO3_FMT	GPIO2_FMT	GPIO1_FMT	GPIO0_FMT	GPIO4_DIR	GPIO3 DIR	
			GPIO2 DIR	GPIO1 DIR	GPIO0 DIR	GPIO4 SRC	GPIO3 SRC	GPIO2 SRC	RESERVED	GPIO0 SRC	
4Eh	GPO_DATA	0000h			_	 SPAR	E[10:0]	_			
				SPARE[10:0]		GPO4_DAT	GPO3_DAT	GPO2_DAT	GPO1_DAT	GPO0_DAT	
4Fh	GPIO0_LL_PWM_C	007Fh	GPIO0_PV	/M_TB[1:0]	GPIO0_LL_PWM_HC[6:0]						
	FG		GPIO0_LL_PW			GP	IO0_LL_PWM_LC	2[6:0]			
501		05001	M_HC[6:0]	D) (5D)			GPIO0_LH_PWM_HC[6:0]				
50h	GPIO0_LH_PWM_C FG	3F80h	RESE	RVED							
			M_HC[6:0]			GPI	IO0_LH_PWM_LC	[0:0]			
51h	GPIO1_LL_PWM_C	007Fh	GPIO1_PV	/M_TB[1:0]			GPIO1_LL_F	PWM_HC[6:0]			
	FG		GPIO1_LL_PW			GP	IO1_LL_PWM_LC	[6:0]			
501		05001	M_HC[6:0]	0) (50)							
52h	GPIO1_LH_PWM_C FG	3F80h	RESE GPIO1 LH PW	RVED		CD	IO1 LH PWM LC	PWM_HC[6:0]			
			M_HC[6:0]			GFI		[0.0]			
53h	GPIO2_LL_PWM_C	007Fh	GPIO2_PV	/M_TB[1:0]			GPIO2_LL_F	PWM_HC[6:0]			
	FG		GPIO2_LL_PW M_HC[6:0]			GP	IO2_LL_PWM_LC	[6:0]			
54h	GPIO2_LH_PWM_C FG	3F80h	RESE	RVED			GPIO2_LH_F	PWM_HC[6:0]			
	10		GPIO2_LH_PW M HC[6:0]			GPI	IO2_LH_PWM_LC	[6:0]			
55h	GPIO3 LL PWM C	007Fh		/M_TB[1:0]							
0011	FG		GPIO3_LL_PW M_HC[6:0]								
56h	GPIO3_LH_PWM_C	3F80h	RESE	RVED	/ED GPIO3_LH_PWM_HC[6:0]						
	FG		GPIO3_LH_PW M_HC[6:0] GPIO3_LH_PWM_LC[6:0]								
57h	GPIO4_LL_PWM_C	007Fh	GPIO4_PWM_TB[1:0]		GPIO4_LL_PWM_HC[6:0]						
	FG		GPIO4_LL_PW M_HC[6:0]		GPIO4_LL_PWM_LC[6:0]						
58h	GPIO4_LH_PWM_C	3F80h	RESE	RVED	GPIO4_LH_PWM_HC[6:0]						
	FG		GPIO4_LH_PW GPIO4_LH_PWM_LC[6:0] M_HC[6:0]								



#### Table 9-26. Register Map (continued) Address Acronym Reset Bit 15 Bit 14 Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8 Bit 7 Bit 6 Bit 5 Bit 3 Bit 2 Bit 0 Bit 4 Bit 1 59h SPARE\_59h 5555h SPARE[15:0] SPARE[15:0] REGISTER MAP1 7Fh 0000h REG\_MAP1\_CRC\_VALUE[15:0] CRC REG\_MAP1\_CRC\_VALUE[15:0] SECTION 2 REGMAP2\_TDACA\_ CFG REG\_MAP2\_C RC\_EN RESERVED 80h 0000h RESERVED TDACA\_VALUE[2:0] GPIOA\_CFG SPARE[2:0] GPIO1A\_DIR GPIO0A\_DIR 81h 0000h GPIOA\_PIN\_C GPIO1A\_FMT GPIO0A\_FMT FG GPIO1A\_PWM\_TB[1:0] GPIO0A\_PWM\_TB[1:0] SPARE[1:0] GPO1A\_DAT GPO0A\_DAT CONV\_MODE1 3A 82h ADC1A\_ADC3A\_CF 0400h RESERVED OSR13A[2:0] G RESERVED GC13A\_EN GC13A\_DELAY[2:0] 83h ADC1A\_CFG 8010h ADC1A EN RESERVED GAIN1A[1:0] MUX1A[1:0] OWD1A\_SOUR CE\_MUX OWD1A\_SINK\_ RESERVED OWD1A\_SOURCE\_VALUE[1:0] OWD1A\_SINK\_VALUE[1:0] MUX 84h ADC1A\_OCAL\_MSB 0000h OCAL1A[23:8] OCAL1A[23:8] ADC1A\_OCAL\_LSB OCAL1A[7:0] 85h 0000h RESERVED 86h ADC1A\_GCAL 0000h GCAL1A[15:0] GCAL1A[15:0] 87h OCCA\_CFG 0000h OCCA EN OCCA POL RESERVED OCCA\_NUM[4:0] RESERVED OCCA\_HIGH\_THRE SHOLD 7FFFh OCCA\_HIGH\_TH[15:0] 88h OCCA\_HIGH\_TH[15:0] OCCA\_LOW\_THRE SHOLD 89h 8000h OCCA\_LOW\_TH[15:0] OCCA\_LOW\_TH[15:0] 8Ah SPARE\_8Ah 5555h SPARE[15:0] SPARE[15:0] ADC2A\_CFG1 8Bh 8010h ADC2A\_EN RESERVED VCMA EN OWD2A\_SOURCE\_MUX[2:0] OWD2A\_SOUR OWD2A\_SOURCE\_VALUE[1:0] OWD2A\_SINK\_VALUE[1:0] OWD2A\_SINK\_MUX[2:0] CE\_MUX[2:0] 8Ch ADC2A\_CFG2 0000h SEQ2A\_MODE[1:0] RESERVED MUX2A\_DELAY[2:0] OSR2A[1:0] RESERVED 8Dh SPARE\_8Dh 0000h RESERVED SPARE[7:0] ADC2A\_OCAL OCAL2A[15:0] 8Eh 0000h OCAL2A[15:0] ADC2A GCAL GCAL2A[15:0] 8Fh 0000h GCAL2A[15:0] SEQ2A\_STEP0\_CF 0000h SEQ2A\_STEP0 SEQ2A STEP0 GAIN[1:0] RESERVED 90h ĒN SEQ2A\_STEP0 RESERVED SEQ2A\_STEP0\_CH\_P[3:0] \_CH\_N SEQ2A\_STEP1 \_EN RESERVED 91h SEQ2A\_STEP1\_CF 0001h SEQ2A\_STEP1\_GAIN[1:0] G RESERVED SEQ2A\_STEP1 SEQ2A\_STEP1\_CH\_P[3:0] \_CH\_N SEQ2A\_STEP2 EN 92h SEQ2A\_STEP2\_CF 0002h SEQ2A\_STEP2\_GAIN[1:0] RESERVED G RESERVED SEQ2A STEP2 SEQ2A\_STEP2\_CH\_P[3:0] CH\_N 93h SEQ2A\_STEP3\_CF 0003h SEQ2A\_STEP3 SEQ2A\_STEP3\_GAIN[1:0] RESERVED G \_EN RESERVED SEQ2A\_STEP3 SEQ2A\_STEP3\_CH\_P[3:0] \_CH\_N



			T	able 9-26	. Register	Map (cont	inued)				
Address	Acronym	Reset	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
94h	SEQ2A_STEP4_CF G	0004h	SEQ2A_STEP4 _EN	SEQ2A_STE	EP4_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2A_STEP4 _CH_N		SEQ2A_STEF	P4_CH_P[3:0]		
95h	SEQ2A_STEP5_CF G	0005h	SEQ2A_STEP5 _EN	SEQ2A_STE	EP5_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2A_STEP5 _CH_N		SEQ2A_STEP5_CH_P[3:0]			
96h	SEQ2A_STEP6_CF G	0006h	SEQ2A_STEP6 _EN	SEQ2A_STE	EP6_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2A_STEP6 _CH_N		SEQ2A_STEP6_CH_P[3:0]			
97h	SEQ2A_STEP7_CF G	0007h	SEQ2A_STEP7 _EN	SEQ2A_STE	P7_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2A_STEP7 _CH_N		SEQ2A_STEF	P7_CH_P[3:0]		
98h	SEQ2A_STEP8_CF G	0008h	SEQ2A_STEP8 _EN	N				RESERVED			
				RESERVED SEQ2A_STEP8 _CH_N			SEQ2A_STEF	P8_CH_P[3:0]			
99h	SEQ2A_STEP9_CF G	0009h	SEQ2A_STEP9 _EN	ĒN				RESERVED			
				RESERVED		SEQ2A_STEP9 _CH_N		SEQ2A_STEF	P9_CH_P[3:0]		
9Ah	SEQ2A_STEP10_CF G	000Ah	SEQ2A_STEP1 0_EN	1 SEQ2A_STEP10_GAIN[1:0]				RESERVED			
				RESERVED		SEQ2A_STEP1 0_CH_N		SEQ2A_STEP	10_CH_P[3:0]		
9Bh	SEQ2A_STEP11_CF G	000Bh	SEQ2A_STEP1 1_EN	ĒN				RESERVED			
				RESERVED		SEQ2A_STEP1 1_CH_N		SEQ2A_STEP	11_CH_P[3:0]		
9Ch	SEQ2A_STEP12_CF G	000Ch	SEQ2A_STEP1 2_EN	SEQ2A_STE	P12_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2A_STEP1 2_CH_N		SEQ2A_STEP	12_CH_P[3:0]		
9Dh	SEQ2A_STEP13_CF G	000Dh	SEQ2A_STEP1 3_EN	SEQ2A_STE	P13_GAIN[1:0]		1	RESERVED			
				RESERVED		SEQ2A_STEP1 3_CH_N		SEQ2A_STEP13_CH_P[3:0]			
9Eh	SEQ2A_STEP14_CF G	000Eh	SEQ2A_STEP1 4_EN	SEQ2A_STE	P14_GAIN[1:0]		1	RESERVED			
				RESERVED		SEQ2A_STEP1 4_CH_N		SEQ2A_STEP14_CH_P[3:0]			
9Fh	SEQ2A_STEP15_CF G	000Fh	SEQ2A_STEP1 5_EN	SEQ2A_STE	P15_GAIN[1:0]		1	RESERVED			
				RESERVED		SEQ2A_STEP1 5_CH_N		SEQ2A_STEP	15_CH_P[3:0]		
A0h	ADC3A_CFG	8010h	ADC3A_EN		RESERVED		GAIN	I3A[1:0]	MUX3	A[1:0]	
			RESE	RVED	OWD3A_SOUR CE_MUX	OWD3A_SINK_ MUX	OWD3A_SOU	RCE_VALUE[1:0]	OWD3A_SIN	K_VALUE[1:0]	
A1h	ADC3A_OCAL_MSB	0000h					3A[23:8] 3A[23:8]				
A2h	ADC3A_OCAL_LSB	0000h		OCAL3A[7:0]							
				RESERVED							
A3h	ADC3A_GCAL	0000h		GCAL3A[15:0] GCAL3A[15:0]							
BEh	REGISTER_MAP2_ CRC	0000h				REG_MAP2_CF	RC_VALUE[15:0]				
						REG_MAP2_CF	RC_VALUE[15:0]				
SECTION		0.000	<b>DE0</b>				DE0.55				
C0h	REGMAP3_TDACB_ CFG	0000h	REG_MAP3_C RC_EN			RESERVED					
					RESERVED	D TDACB_VALUE[2:0]				ון	



			I	able 5-20.	. Register	Map (conti	inueu)				
Address	Acronym	Reset	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
C1h	GPIOB_CFG	0000h	GPIOB_PIN_C FG		SPARE[2:0]		GPIO1B_FMT	GPIO0B_FMT	GPIO1B_DIR	GPIO0B_DIF	
			GPIO1B_PV		_	WM_TB[1:0]		RE[1:0]	GPO1B_DAT	GPO0B_DA	
C2h	ADC1B_ADC3B_CF G	0400h			ERVED		CONV_MODE1 3B		OSR13B[2:0]		
				RESE	ERVED		GC13B_EN		GC13B_DELAY[2:0	-	
C3h	ADC1B_CFG	8010h	ADC1B_EN		RESERVED			1B[1:0]		B[1:0]	
0.45	ADC1B OCAL MSB	00001	RESE	RVED	OWD1B_SOUR CE_MUX	MUX		RCE_VALUE[1:0]	OWD1B_SIN	K_VALUE[1:0]	
C4h	ADCID_OCAL_WISD	0000h					1B[23:8]				
OFh		00005					1B[23:8]				
C5h	ADC1B_OCAL_LSB	0000h					1B[7:0]				
C6h		0000h									
COIL	ADC1B_GCAL	000011					IB[15:0] IB[15:0]				
C7h	OCCB_CFG	0000h	OCCB_EN	OCCB_POL	RESERVED		10[10.0]	OCCB_NUM[4:0]	1		
0/11	0000_010	000011		0000_101	REGERVED	RESE	RVED				
C8h	OCCB HIGH THRE	7FFFh					GH_TH[15:0]				
	SHOLD			OCCB_HIGH_TH[15:0]							
C9h	OCCB_LOW_THRE	8000h					W_TH[15:0]				
	SHOLD			OCCB_LOW_TH[15:0]							
CAh	SPARE_CAh	5555h					SPARE[15:0]				
			SPARE[15:0]								
CBh	ADC2B CFG1	8010h	ADC2B EN		RESE	ERVED		VCMB_EN	OWD2B_SOU	RCE MUXI2:0	
			OWD2B SOUR	OV	VD2B_SINK_MUX		OWD2B SOUF	RCE_VALUE[1:0]		K_VALUE[1:0]	
			CE_MUX[2:0]				-		_		
CCh	ADC2B_CFG2	0000h	SEQ2B_N	IODE[1:0]		RESERVED		N	/UX2B_DELAY[2:	0]	
					RESE	ERVED	OSR2B[1:0]				
CDh	SPARE_CDh	0000h				RESE	ERVED				
							RE[7:0]				
CEh	ADC2B_OCAL	0000h					2B[15:0]				
							2B[15:0]				
CFh	ADC2B_GCAL	0000h					2B[15:0]				
						GCAL2	2B[15:0]				
D0h	SEQ2B_STEP0_CF G	0000h	SEQ2B_STEP0 _EN	SEQ2B_STE	P0_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2B_STEP0 _CH_N		SEQ2B_STE	P0_CH_P[3:0]		
D1h	SEQ2B_STEP1_CF G	0001h	SEQ2B_STEP1 _EN	SEQ2B_STE	P1_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2B_STEP1 _CH_N		SEQ2B_STE	P1_CH_P[3:0]		
D2h	SEQ2B_STEP2_CF G	0002h	SEQ2B_STEP2 _EN	SEQ2B_STE	P2_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2B_STEP2 _CH_N		SEQ2B_STE	P2_CH_P[3:0]		
D3h	SEQ2B_STEP3_CF G	0003h	SEQ2B_STEP3 _EN		P3_GAIN[1:0]			RESERVED			
			RESERVED SEQ2B_STEP3 SEQ2B_STEP3 CH_N		P3_CH_P[3:0]						
D4h	SEQ2B_STEP4_CF G	0004h	SEQ2B_STEP4 _EN		Q2B_STEP4_GAIN[1:0] RESERVED						
			RESERVED SEQ2B_STEP4 SEQ2B_STEP4_CH_P[3:0] CH_N								
D5h	SEQ2B_STEP5_CF G	0005h	SEQ2B_STEP5 _EN		P5_GAIN[1:0]			RESERVED			
			RESERVED			SEQ2B_STEP5 SEQ2B_STEP5_CH_P[3:0]					



				able 9-26.	Register	Map (conti	nuea)				
Address	Acronym	Reset	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
D6h	SEQ2B_STEP6_CF G	0006h	SEQ2B_STEP6 _EN	SEQ2B_STE	P6_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2B_STEP6 _CH_N		SEQ2B_STEF	P6_CH_P[3:0]		
D7h	SEQ2B_STEP7_CF G	0007h	SEQ2B_STEP7 _EN	SEQ2B_STE	P7_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2B_STEP7 _CH_N	SEQ2B_STEP7_CH_P[3:0]				
D8h	SEQ2B_STEP8_CF G	0008h	SEQ2B_STEP8 _EN	SEQ2B_STE	P8_GAIN[1:0]		RESERVED				
				RESERVED		SEQ2B_STEP8 _CH_N		SEQ2B_STEF	P8_CH_P[3:0]		
D9h	SEQ2B_STEP9_CF G	0009h	SEQ2B_STEP9 _EN	SEQ2B_STE	P9_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2B_STEP9 _CH_N		SEQ2B_STEP	P9_CH_P[3:0]		
DAh	SEQ2B_STEP10_CF G	000Ah	SEQ2B_STEP1 0_EN	SEQ2B_STEP10_GAIN[1:0]			RESERVED				
				RESERVED		SEQ2B_STEP1 0_CH_N	SEQ2B_STEP10_CH_P[3:0]				
DBh	SEQ2B_STEP11_CF G	000Bh	SEQ2B_STEP1 1_EN				I	RESERVED SEQ2B STEP11 CH P[3:0]			
				RESERVED		SEQ2B_STEP1 1_CH_N			211_CH_P[3:0]		
DCh	SEQ2B_STEP12_CF G	000Ch	SEQ2B_STEP1 2_EN					RESERVED			
				RESERVED		SEQ2B_STEP1 2_CH_N		SEQ2B_STEP	12_CH_P[3:0]		
DDh	SEQ2B_STEP13_CF G	000Dh	SEQ2B_STEP1 3_EN		P13_GAIN[1:0]		RESERVED				
				RESERVED		SEQ2B_STEP1 3_CH_N	SEQ2B_STEP13_CH_P[3:0]				
DEh	SEQ2B_STEP14_CF G	000Eh	SEQ2B_STEP1 4_EN		P14_GAIN[1:0]			RESERVED			
				RESERVED		SEQ2B_STEP1 4_CH_N			14_CH_P[3:0]		
DFh	SEQ2B_STEP15_CF G	000Fh	SEQ2B_STEP1 5_EN		P15_GAIN[1:0]		I	RESERVED			
				RESERVED		SEQ2B_STEP1 5_CH_N			15_CH_P[3:0]		
E0h	ADC3B_CFG	8010h	ADC3B_EN RESEI	RVED	RESERVED			I3B[1:0] RCE_VALUE[1:0]	MUX3E OWD3B_SINK		
E1h	ADC3B_OCAL_MSB	0000h			CE_MUX	MUX OCAL3	B[23:8]				
			OCAL3B[23:8]								
E2h	ADC3B_OCAL_LSB	0000h	OCAL3B[7:0] RESERVED								
E3h		0000h									
⊏ວN	ADC3B_GCAL	UUUUN					B[15:0] B[15:0]				
FEh	REGISTER_MAP3_	0000h				REG_MAP3_CF	RC_VALUE[15:0]				
	CRC					REG_MAP3_CRC_VALUE[15:0]					



# 9.6.1.1 ID Register (Address = 00h) [Reset = X]

Return to the Summary Table.

	Figure 9-46. ID Register										
15	14	13	12	11	10	9	8				
	REV[7:0]										
	R-X										
7	6	5	4	3	2	1	0				
	ADC_COUNT[2:0]		DEVICE_ID[4:0]								
	R-110b		R-X								

# Table 9-27. ID Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:8	REV[7:0]	R	х	Revision ID Values are subject to change without notice
7:5	ADC_COUNT[2:0]	R	110b	ADC count 110b = 6 (ADC1A, ADC1B, ADC2A, ADC2B, ADC3A, ADC3B)
4:0	DEVICE_ID[4:0]	R	х	Device ID Values are subject to change without notice



# 9.6.1.2 STATUS\_MSB Register (Address = 01h) [Reset = 7FC8h]

Return to the Summary Table.

		i iyu	16 J-47. STAT	03_MISD Reg	ISLEI		
15	14	13	12	11	10	9	8
RESETn	SUPPLY_FAULTn	CLOCK_FAULTn	DIGITAL_FAULTn	OCC_FAULTn	SPI_CRC_FAULTn	SPI_TIMEOUTn	SCLK_COUNT_FAU LTn
R/W-0b	R/W-1b	R/W-1b	R/W-1b	R/W-1b	R-1b	R-1b	R-1b
7	6	5	4	3	2	1	0
REG_ACCESS_FAU LTn		COMMAND_R	ESPONSE[3:0]		LOCK	CLOCK	MODE
R-1b		R-10	)01b		R-0b	R-0b	R-0b

#### Figure 9-47. STATUS\_MSB Register

# Table 9-28. STATUS\_MSB Register Field Descriptions Type Reset Description

Bit	Field	Туре	Reset	Description
15	RESETn	R/W	0b	RESET flag Indicates a device reset occurred. Write 1b to clear this bit to 1b. 0b = Reset occurred 1b = No reset occurred
14	SUPPLY_FAULTn	R/W	1b	Supply fault flag Indicates that one or more of the unmasked supply fault flags in the SUPPLY_STATUS register is set. Write 1b to clear this bit to 1b after all set unmasked supply fault flags are cleared. 0b = One or more of the unmasked supply fault flags is set 1b = None of the unmasked supply fault flags are set
13	CLOCK_FAULTn	R/W	1b	Clock fault flag Indicates that one or more of the unmasked clock fault flags in the CLOCK_STATUS register is set. Write 1b to clear this bit to 1b after all set unmasked clock fault flags are cleared. 0b = One or more of the unmasked clock fault flags is set 1b = None of the unmasked supply clock fault flags are set
12	DIGITAL_FAULTn	R/W	1b	Digital fault flag Indicates that one or more of the unmasked digital fault flags in the DIGITAL_STATUS register is set. Write 1b to clear this bit to 1b after all set unmasked digital fault flags are cleared. 0b = One or more of the unmasked digital fault flags is set 1b = None of the unmasked digital fault flags are set
11	OCC_FAULTn	R/W	1b	Overcurrent comparator fault flag Indicates that one or more of the unmasked overcurrent comparator fault flags in the OCC_STATUS register is set. Write 1b to clear this bit to 1b after all set unmasked overcurrent comparator fault flags are cleared. 0b = One or more of the unmasked overcurrent comparator fault flags is set 1b = None of the unmasked overcurrent comparator fault flags are set
10	SPI_CRC_FAULTn	R	1b	SPI CRC fault flag Indicates an SPI CRC fault occurred in the previous SPI frame. This bit clears automatically to 1b in each new SPI frame. 0b = SPI CRC fault occurred 1b = No SPI CRC fault occurred
9	SPI_TIMEOUTn	R	1b	SPI timeout fault flag Indicates an SPI timeout fault occurred in the previous SPI frame. This bit clears automatically to 1b in each new SPI frame. 0b = SPI timeout fault occurred 1b = No SPI timeout fault occurred
8	SCLK_COUNT_FAULTn	R	1b	SCLK counter fault flag Indicates an SCLK counter fault occurred in the previous SPI frame (that is, fewer or more SCLKs than required for the previous frame were sent). This bit clears automatically to 1b in each new SPI frame. 0b = SCLK counter fault occurred 1b = No SCLK counter fault occurred
7	REG_ACCESS_FAULTn	R	1b	Register access fault flag Indicates a read or write access to an invalid register address (register address FFh or beyond) occurred. This flag sets to 0b in the subsequent frame following the frame where a read or write operation to a register with an invalid register address was attempted. This bit clears automatically to 1b in each new SPI frame. 0b = Register access fault occurred 1b = No register access fault occurred





# Table 9-28. STATUS\_MSB Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
6:3	COMMAND_RESPONSE[3:0]	R	1001b	Command response indication Indicates which command was executed in the previous SPI frame. 0000b = Invalid response that does not occur under normal circumstances. Can indicate a stuck-at SDO signal or that the device is held in reset. 0001b = NULL command 0010b = LOCK command 0010b = REG command 0100b = REG command 0101b = NULL command (because a NULL command was correctly sent as the second frame after a RREG command). This response serves as the frame counter for the two- frame RREG command. 0110b = WREG command. 0110b = WREG command. 0110b = WREG command. 0110b = NULL command (first frame after power-up or reset). This response is only sent in the first frame after reset or power-up, the second frame has the response based on the command sent in the first frame. 1010b = NULL command (Resulting from one of the following errors: a timeout occurred before a complete command CRC was received, insufficient SCLKs were sent to complete a command, a CRC mismatch between the command word and command CRC word, or a CRC mismatch between data words and the data CRC word in a WREG command). For the NULL, RREG, LOCK, and UNLOCK command, the CSM vord in a WREG command. For the NULL, RREG, LOCK, and UNLOCK command CRC words, as well as the data and data CRC words must be sent to complete the command. For the RESET command, the STATUS word, all ADC data words, and the output CRC word must be read to complete the command. For the WREG command (resulting from an invalid command word with a matching CRC between the command and command CRC word). 1100b = NULL command (resulting from a command other than the NULL command was sent in the second frame after the RREG command. 1011b = NULL command (the RESET or WREG commands are ignored because the device is locked). 110b = Invalid response that does not occur under normal circumstances. 111b = Invalid response that does not occur under normal circumstances. 1111b = Invalid response that does not occur under normal circumstances.
2	LOCK	R	0b	Lock state indication Indicates if the device is locked or unlocked. 0b = Device is unlocked 1b = Device is locked
1	CLOCK	R	0ь	Clock source indication Indicates which clock source the device is currently using. 0b = Internal oscillator 1b = External clock
0	MODE	R	Ob	Operating mode indication Indicates which operating mode the device is currently in. 0b = Active mode 1b = Standby or power-down mode



# 9.6.1.3 STATUS\_LSB Register (Address = 02h) [Reset = 0000h]

Return to the Summary Table.

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	Figure 9-48. STATUS_LSB Register									
15	14	13	12	11	10	9	8			
SEQ2A_C	OUNT[1:0]	SEQ2B_C	COUNT[1:0]	CONV1A_C	OUNT[1:0]	CONV1B_	COUNT[1:0]			
R-0	R-00b		R-00b		R-00b		00b			
7	6	5	4	3	2	1	0			
		SEQ2A_ACTIVE	SEQ2B_ACTIVE							
	R-000000b R-0b R-0b									

#### Table 9-29. STATUS\_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description			
15:14	SEQ2A_COUNT[1:0]	R	00b	ADC2A sequence counter Circular counter that increments each time a new sequence on ADC2A completes. This counter resets to 00b when ADC2A is disabled, when the device is put in standby or power-down mode, or after a device reset.			
13:12	SEQ2B_COUNT[1:0]	R	00b	ADC2B sequence counter Circular counter that increments each time a new sequence on ADC2B completes. This counter resets to 00b when ADC2B is disabled, when the device is put in standby or power-down mode, or after a device reset.			
11:10	CONV1A_COUNT[1:0]	R	00b	power-down mode, or after a device reset. ADC1A and ADC3A conversion counter Circular counter that increments each time a new conversion on ADC1A and ADC3A completes. This counter resets to 00b when ADC1A and ADC3A are disabled, when device is put in standby or power-down mode, or after a device reset.			
9:8	CONV1B_COUNT[1:0]	R	00ь	ADC1B and ADC3B conversion counter Circular counter that increments each time a new conversion on ADC1B and ADC3B completes. This counter resets to 00b when ADC1B and ADC3B are disabled, when the device is put in standby or power-down mode, or after a device reset.			
7:2	RESERVED	R	000000b	Reserved Always reads 000000b.			
1	SEQ2A_ACTIVE	R	ОЬ	ADC2A sequence in progress indication Indicates that a sequence on ADC2A is currently in progress. Changes to registers from address 8Ch to 9Fh of ADC2A must only be made when ADC2A is disabled. Ob = No sequence in progress 1b = Sequence in progress			
0	SEQ2B_ACTIVE	R	0b	ADC2B sequence in progress indication Indicates that a sequence on ADC2B is currently in progress. Changes to registers from address CCh to DFh of ADC2B must only be made when ADC2B is disabled. Ob = No sequence in progress 1b = Sequence in progress			

# 9.6.1.4 SUPPLY\_STATUS Register (Address = 03h) [Reset = FFFh]

Return to the Summary Table.

#### Figure 9-49. SUPPLY\_STATUS Register

		U U			•		
15	14	13	12	11	10	9	8
AVDD_OVn	AVDD_UVn	IOVDD_OVn	IOVDD_UVn	DVDD_OVn	DVDD_UVn	AVDD_OSCn	IOVDD_OSCn
R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b
7	6	5	4	3	2	1	0
DVDD_OSCn	AVDD_OTWn	IOVDD_OTWn	AVDD_CLn	IOVDD_CLn	AGNDA_DISCn	AGNDB_DISCn	DGND_DISCn
R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b	R/W-1b

#### Table 9-30. SUPPLY\_STATUS Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	AVDD_OVn	R/W	1b	AVDD overvoltage fault flag Indicates the AVDD supply voltage exceeded the AVDD overvoltage threshold. See the AVDD monitor description for details regarding the AVDD LDO shutdown during overvoltage. Write 1b to clear this bit to 1b. 0b = Overvoltage fault occurred 1b = No overvoltage fault occurred
14	AVDD_UVn	R/W	1b	AVDD undervoltage fault flag Indicates the AVDD supply voltage dropped below the AVDD undervoltage threshold. Write 1b to clear this bit to 1b. 0b = Undervoltage fault occurred 1b = No undervoltage fault occurred
13	IOVDD_OVn	R/W	1b	IOVDD overvoltage fault flag Indicates the IOVDD supply voltage exceeded the IOVDD overvoltage threshold. See the IOVDD monitor description for details regarding the IOVDD LDO shutdown during overvoltage. Write 1b to clear this bit to 1b. 0b = Overvoltage fault occurred 1b = No overvoltage fault occurred
12	IOVDD_UVn	R/W	1b	IOVDD undervoltage fault flag Indicates the IOVDD supply voltage dropped below the IOVDD undervoltage threshold. Write 1b to clear this bit to 1b. 0b = Undervoltage fault occurred 1b = No undervoltage fault occurred
11	DVDD_OVn	R/W	1b	DVDD overvoltage fault flag Indicates the DVDD supply voltage exceeded the DVDD overvoltage threshold. See the DVDD monitor description for details regarding the DVDD LDO shutdown during overvoltage. Write 1b to clear this bit to 1b. 0b = Overvoltage fault occurred 1b = No overvoltage fault occurred
10	DVDD_UVn	R/W	1b	DVDD undervoltage fault flag Indicates the DVDD supply voltage dropped below the DVDD undervoltage threshold. Write 1b to clear this bit to 1b. 0b = Undervoltage fault occurred 1b = No undervoltage fault occurred
9	AVDD_OSCn	R/W	1b	AVDD oscillation fault flag Indicates the AVDD supply voltage is oscillating. Write 1b to clear this bit to 1b. 0b = Oscillation fault occurred 1b = No oscillation fault occurred
8	IOVDD_OSCn	R/W	1b	IOVDD oscillation fault flag Indicates the IOVDD supply voltage is oscillating. Write 1b to clear this bit to 1b. 0b = Oscillation fault occurred 1b = No oscillation fault occurred
7	DVDD_OSCn	R/W	1b	DVDD oscillation fault flag Indicates the DVDD supply voltage is oscillating. Write 1b to clear this bit to 1b. 0b = Oscillation fault occurred 1b = No oscillation fault occurred
6	AVDD_OTWn	R/W	1b	AVDD overtemperature warning flag Indicates the AVDD LDO temperature exceeded the AVDD overtemperature warning threshold. Write 1b to clear this bit to 1b. 0b = Overtemperature warning 1b = No overtemperature warning
5	IOVDD_OTWn	R/W	1b	IOVDD overtemperature warning flag Indicates the IOVDD LDO temperature exceeded the IOVDD overtemperature warning threshold. Write 1b to clear this bit to 1b. 0b = Overtemperature warning 1b = No overtemperature warning
4	AVDD_CLn	R/W	1b	AVDD current limit flag Indicates the AVDD LDO current limit is active. Write 1b to clear this bit to 1b. 0b = Current limit 1b = No current limit



#### Table 9-30. SUPPLY\_STATUS Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
3	IOVDD_CLn	R/W	1b	IOVDD current limit flag Indicates the IOVDD LDO current limit is active. Write 1b to clear this bit to 1b. 0b = Current limit 1b = No current limit
2	AGNDA_DISCn	R/W	1b	AGNDA pin disconnect detection flag Indicates the AGNDA pin is disconnected. Write 1b to clear this bit to 1b. 0b = AGNDA pin disconnected 1b = AGNDA pin connected
1	AGNDB_DISCn	R/W	1b	AGNDB pin disconnect detection flag Indicates the AGNDB pin is disconnected. Write 1b to clear this bit to 1b. 0b = AGNDB pin disconnected 1b = AGNDB pin connected
0	DGND_DISCn	R/W	1b	DGND pin disconnect detection flag Indicates the DGND pin is disconnected. Write 1b to clear this bit to 1b. 0b = DGND pin disconnected 1b = DGND pin connected



# 9.6.1.5 CLOCK\_STATUS Register (Address = 04h) [Reset = FC07h]

Return to the Summary Table.

# Figure 9-50. CLOCK\_STATUS Register

15	14	13	12	11	10	9	8		
	RESERVED								
			R-111111	000000b					
7	6	5	4	3	2	1	0		
		RESERVED	MCLK_FAULTn	OSCD_WDn	MCLK_WDn				
		R-111111000000b			R/W-1b	R/W-1b	R/W-1b		

#### Table 9-31. CLOCK\_STATUS Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:3	RESERVED	R	111111000000b	Reserved Always reads 1111110000000b.
2	MCLK_FAULTn	R/W	1b	MCLK frequency too high or too low fault flag Indicates the main clock frequency of the selected clock source either exceeded the clock frequency high threshold or dropped below the clock frequency low threshold. Write 1b to clear this bit to 1b. 0b = MCLK frequency too high or too low fault occurred 1b = No MCLK frequency too high or too low fault occurred
1	OSCD_WDn	R/W	1b	Diagnostic oscillator watchdog fault flag Indicates a diagnostic oscillator watchdog fault occurred. Write 1b to clear this bit to 1b. 0b = Watchdog fault occurred 1b = No watchdog fault occurred
0	MCLK_WDn	R/W	1b	Main clock watchdog fault flag Indicates a main clock watchdog fault occurred. Write 1b to clear this bit to 1b. 0b = Watchdog fault occurred 1b = No watchdog fault occurred



# 9.6.1.6 DIGITAL\_STATUS Register (Address = 05h) [Reset = EC00h]

Return to the Summary Table.

	Figure 9-51. DIGITAL_STATUS Register									
15	14	13	12	11	10	9	8			
REG_MAP1_CRC_F AULTn										
R/W-1b	R/W-1b	R/W-1b	R-0b	R/W-1b	R-1b	R-00000	00000b			
7	6	5	4	3	2	1	0			
RESERVED										
			R-0000	00000b						

# Table 9-32. DIGITAL\_STATUS Register Field Descriptions

Bit	Field	Туре	Reset	Description			
15	REG_MAP1_CRC_FAULTn	R/W	1b	Register map section 1 CRC fault flag Indicates a register map CRC fault in section 1 (register address space from 40h to 59h) occurred. Write 1b to clear this bit to 1b. 0b = Register map CRC fault occurred 1b = No register map CRC fault occurred			
14	REG_MAP2_CRC_FAULTn	R/W	1b	Register map section 2 CRC fault flag Indicates a register map CRC fault in section 2 (register address space from 80h to A3h) occurred. Write 1b to clear this bit to 1b. 0b = Register map CRC fault occurred 1b = No register map CRC fault occurred			
13	REG_MAP3_CRC_FAULTn	R/W	1b	No register map CRC fault occurred           Register map section 3 CRC fault flag           Indicates a register map CRC fault in section 3 (register address space from C0h to E3)           occurred. Write 1b to clear this bit to 1b.           0b = Register map CRC fault occurred           1b = No register map CRC fault occurred			
12	RESERVED	R	0b	Reserved Always reads 0b.			
11	MEM_MAP_CRC_FAULTn	R/W	1b	Memory map CRC fault flag Indicates a memory map CRC fault in the internal memory occurred. Write 1b to clear this bit to 1b. Reset the device in case the flag continues to set to 0b. 0b = Memory map CRC fault occurred 1b = No memory map CRC fault occurred			
10	OTP_BANK	R	1b	OTP bank indication Indicates which OTP bank the device selected after reset. The OTP_BANK bit does not trigger the DIGITAL_FAULTn bit in the STATUS_MSB register. Reset the device in case the flag indicates that the backup OTP bank is used. 0b = Backup OTP bank (bank 1) 1b = Primary OTP bank (bank 0)			
9:0	RESERVED	R	000000000b	Reserved Always reads 000000000b.			



# 9.6.1.7 OCC\_STATUS Register (Address = 06h) [Reset = 000Fh]

Return to the Summary Table.

# Figure 9-52. OCC\_STATUS Register

15	14	13	12	11	10	9	8		
	RESERVED								
	R-000000000b								
7	6	5	4	3	2	1	0		
	RESE	RVED		OCCA_HTn	OCCA_LTn	OCCB_HTn	OCCB_LTn		
	R-00000	000000b		R/W-1b	R/W-1b	R/W-1b	R/W-1b		

#### Table 9-33. OCC\_STATUS Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:4	RESERVED	R	000000000000	Reserved Always reads 0000000000b.
3	OCCA_HTn	R/W	1b	ADC1A overcurrent comparator high threshold fault flag Indicates the ADC1A digital fast filter output exceeded the set high threshold for the set amount of conversions. Write 1b to clear this bit to 1b. 0b = High threshold fault occurred 1b = No high threshold fault occurred
2	OCCA_LTn	R/W	1b	ADC1A overcurrent comparator low threshold fault flag Indicates the ADC1A digital fast filter output dropped below the set low threshold for the set amount of conversions. Write 1b to clear this bit to 1b. 0b = Low threshold fault occurred 1b = No low threshold fault occurred
1	OCCB_HTn	R/W	1b	ADC1B overcurrent comparator high threshold fault flag Indicates the ADC1B digital fast filter output exceeded the set high threshold for the set amount of conversions. Write 1b to clear this bit to 1b. 0b = High threshold fault occurred 1b = No high threshold fault occurred
0	OCCB_LTn	R/W	1b	ADC1B overcurrent comparator low threshold fault flag Indicates the ADC1B digital fast filter output dropped below the set low threshold for the set amount of conversions. Write 1b to clear this bit to 1b. 0b = Low threshold fault occurred 1b = No low threshold fault occurred



# 9.6.1.8 GPI\_DATA Register (Address = 07h) [Reset = 0000h]

Return to the Summary Table.

Figure 9-53. GPI_DATA Register										
15	14	13	12	11	10	9	8			
	RESERVED GPI4_DAT[1:0]									
	R-000000b R-00b									
7	6	5	4	3	2	1	0			
GPI3_I	GPI3_DAT[1:0]         GPI2_DAT[1:0]         GPI1_DAT[1:0]         GPI0_DAT[1:0]									
R-	-00b	R	-00b	R-0	0b	R-0	00b			

Bit	Field	Туре	Reset	Description
15:10	RESERVED	R	000000b	Reserved Always reads 000000b.
9:8	GPI4_DAT[1:0]	R	00ь	GPIO4 data readback Readback value of GPIO4 when configured as a digital input or output. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period >50% but ≤66.6%) 10b = Weak high (PWM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)
7:6	GPI3_DAT[1:0]	R	GPIO3 data readback Readback value of GPIO3 when configured as a digital input or output. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period >50% but ≤66.6%) 10b = Weak high (PWM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)	
5:4	GPI2_DAT[1:0]	R	00ь	GPIO2 data readback Readback value of GPIO2 when configured as a digital input or output. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period >50% but ≤66.6%) 10b = Weak high (PWM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)
3:2	GPI1_DAT[1:0]	R	006	GPI01 data readback Readback value of GPI01 when configured as a digital input or output. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period >50% but ≤66.6%) 10b = Weak high (PWM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)
1:0	GPI0_DAT[1:0]	R	00Ь	GPI00 data readback Readback value of GPI00 when configured as a digital input or output. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period ≥50% but ≤66.6%) 10b = Weak high (PWM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)

#### Table 9-34. GPI\_DATA Register Field Descriptions

# 9.6.1.9 GPIA\_GPIB\_DATA Register (Address = 08h) [Reset = 0000h]

Return to the Summary Table.

Figure 9-54. GPIA_GPIB_DATA Register										
15	14	13	12	11	10	9	8			
	RESE	RVED	GPI1A_DAT[1:0] GPI0A_DAT[1:0]							
R-0000b				R-00b		R-00b				
7	6	5	4	3	2	1	0			
	RESERVED				DAT[1:0]	GPI0B_DAT[1:0]				
	R-00	000b		R-	00b	R-0	0b			

#### Table 9-35. GPIA\_GPIB\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:12	RESERVED	R	0000ь	Reserved Always reads 0000b.
11:10	GPI1A_DAT[1:0]	R	00ь	GPI01A data readback Readback value of GPI01A when configured as a digital input or output. Reads back 00b when GPI01A is configured as an analog input. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period >50% but <66.6%) 10b = Weak high (PWM with a high period >50% but <66.6%) 11b = High (static high or PWM with a high period >66.6%)
9:8	GPI0A_DAT[1:0]	R	00Ь	GPIO0A data readback Readback value of GPIO0A when configured as a digital input or output. Reads back 00b when GPIO0A is configured as an analog input. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period >50% but ≤66.6%) 10b = Weak high (PWM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)
7:4	RESERVED	R	0000b	Reserved Always reads 0000b.
3:2	GPI1B_DAT[1:0]	R	00b	GPI01B data readback Readback value of GPI01B when configured as a digital input or output. Reads back 00b when GPI01B is configured as an analog input. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period ≥50% but ≤66.6%) 10b = Weak high (PVM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)
1:0	GPI0B_DAT[1:0]	R	00b	GPIO0B data readback Readback value of GPIO0B when configured as a digital input or output. Reads back 00b when GPIO0B is configured as an analog input. 00b = Low (static low or PWM with a low period >66.6%) 01b = Weak low (PWM with a low period >50% but ≤66.6%) 10b = Weak high (PWM with a high period >50% but ≤66.6%) 11b = High (static high or PWM with a high period >66.6%)



# 9.6.1.10 CONVERSION\_CTRL Register (Address = 09h) [Reset = 0000h]

Return to the Summary Table.

Figure 9-55. CONVERSION_CTRL Register										
15	14	13	12	11	10	9	8			
RESERVED	STARTA	RESERVED	STARTB	RESERVED	STOPA	RESERVED	STOPB			
R-0b	R/W-0b	R-0b	R/W-0b	R-0b	R/W-0b	R-0b	R/W-0b			
7	6	5	4	3	2	1	0			
RESERVED	SEQ2A_START	RESERVED	SEQ2B_START	RESERVED	SEQ2A_STOP	RESERVED	SEQ2B_STOP			
R-0b	R/W-0b	R-0b	R/W-0b	R-0b	R/W-0b	R-0b	R/W-0b			

#### Table 9-36. CONVERSION\_CTRL Register Field Descriptions

Bit	Field	Туре	Reset	Description		
15	RESERVED	R	0b	Reserved Always reads 0b.		
14	STARTA	R/W	Ob	Start or restart ADC1A and ADC3A conversions Write 1b to start or restart simultaneous conversions of enabled ADC1A and ADC3A. Always reads back 0b.		
13	RESERVED	R	0b	Reserved Always reads 0b.		
12	STARTB	R/W	0b	Start or restart ADC1B and ADC3B conversions Write 1b to start or restart simultaneous conversions of enabled ADC1B and ADC3B. Always reads back 0b.		
11	RESERVED	R	0b	Reserved Always reads 0b.		
10	STOPA	R/W	Ob	Stop ADC1A and ADC3A conversions Write 1b to stop conversions of enabled ADC1A and ADC3A in continuous-conversion mode. Ongoing conversions are allowed to complete. The STOPA bit has no effect in single-shot conversion mode. The STARTA bit takes priority over the STOPA bit if bot are set during the same WREG command frame. The STOPA bit clears to 0b after th ongoing conversion finishes or when the STARTA bit is set before the ongoing conver- finishes, which aborts the ongoing conversion and restarts new conversions.		
9	RESERVED	R	0b	Reserved Always reads 0b.		
8	STOPB	R/W	Ob	Stop ADC1B and ADC3B conversions Write 1b to stop conversions of enabled ADC1B and ADC3B in continuous-conversion mode. Ongoing conversions are allowed to complete. The STOPB bit has no effect in single-shot conversion mode. The STARTB bit takes priority over the STOPB bit if both bits are set during the same WREG command frame. The STOPB bit clears to 0b after the ongoing conversion finishes or when the STARTB bit is set before the ongoing conversion finishes, which aborts the ongoing conversion and restarts new conversions.		
7	RESERVED	R	0b	Reserved Always reads 0b.		
6	SEQ2A_START	R/W	0b	Start ADC2A sequence Write 1b to start or restart sequence of ADC2A. Always reads back 0b.		
5	RESERVED	R	0b	Reserved Always reads 0b.		
4	SEQ2B_START	R/W	0b	Start ADC2B sequence Write 1b to start or restart sequence of ADC2B. Always reads back 0b.		
3	RESERVED	R	0b	Reserved Always reads 0b.		
2	SEQ2A_STOP	R/W	0b	Stop ADC2A sequence Write 1b to stop ADC2A sequence. A sequence in progress is allowed to finish. The SEQ2A_START bit takes priority over the SEQ2A_STOP bit if both bits are set during the same WREG command frame. The SEQ2A_STOP bit clears to 0b after the ongoing sequence finishes or when the SEQ2A_START bit is set before the ongoing sequence finishes, which aborts the ongoing sequence and restarts a new sequence.		
1	RESERVED	R	0b	Reserved Always reads 0b.		
0	SEQ2B_STOP	R/W	Ob	Stop ADC2B sequence Write 1b to stop ADC2B sequence. A sequence in progress is allowed to finish. The SEQ2B_START bit takes priority over the SEQ2B_STOP bit if both bits are set during the same WREG command frame. The SEQ2B_STOP bit clears to 0b after the ongoin sequence finishes or when the SEQ2B_START bit is set before the ongoing sequence finishes, which aborts the ongoing sequence and restarts a new sequence.		



# 9.6.1.11 SEQ2A\_STEP0\_DATA Register (Address = 10h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-56. SEQ2A\_STEP0\_DATA Register

15	14	13	12	11	10	9	8				
SEQ2A_STEP0_DAT[15:0]											
R-000000000000000											
7	6	5	4	3	2	1	0				
	SEQ2A_STEP0_DAT[15:0]										
	R-0000000000000b										

# Table 9-37. SEQ2A\_STEP0\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP0_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 0 conversion data Value provided in two's complement format.



# 9.6.1.12 SEQ2A\_STEP1\_DATA Register (Address = 11h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-57. SEQ2A\_STEP1\_DATA Register

15	14	13	12	11	10	9	8			
SEQ2A_STEP1_DAT[15:0]										
R-000000000000b										
7	6	5	4	3	2	1	0			
	SEQ2A_STEP1_DAT[15:0]									
			R-0000000	00000000b						

# Table 9-38. SEQ2A\_STEP1\_DATA Register Field Descriptions

В	Bit	Field	Туре	Reset	Description
15	5:0	SEQ2A_STEP1_DAT[15:0]	R	000000000000 000b	ADC2A sequence step 1 conversion data Value provided in two's complement format.

# 9.6.1.13 SEQ2A\_STEP2\_DATA Register (Address = 12h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-58. SEQ2A\_STEP2\_DATA Register

15	14	13	12	11	10	9	8			
SEQ2A_STEP2_DAT[15:0]										
R-000000000000000										
7	6	5	4	3	2	1	0			
	SEQ2A_STEP2_DAT[15:0]									
	R-000000000000b									

# Table 9-39. SEQ2A\_STEP2\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP2_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 2 conversion data Value provided in two's complement format.



# 9.6.1.14 SEQ2A\_STEP3\_DATA Register (Address = 13h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-59. SEQ2A\_STEP3\_DATA Register

15	14	13	12	11	10	9	8			
SEQ2A_STEP3_DAT[15:0]										
R-000000000000000000000000000000000000										
7	6	5	4	3	2	1	0			
	SEQ2A_STEP3_DAT[15:0]									
			R-0000000	00000000b						

# Table 9-40. SEQ2A\_STEP3\_DATA Register Field Descriptions

Bit	Field	Type Reset Description		Description
15:0	SEQ2A_STEP3_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 3 conversion data Value provided in two's complement format.

# 9.6.1.15 SEQ2A\_STEP4\_DATA Register (Address = 14h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-60. SEQ2A\_STEP4\_DATA Register

15	14	13	12	11	10	9	8				
SEQ2A_STEP4_DAT[15:0]											
	R-0000000000000b										
7	6	5	4	3	2	1	0				
	SEQ2A_STEP4_DAT[15:0]										
	R-0000000000000b										

# Table 9-41. SEQ2A\_STEP4\_DATA Register Field Descriptions

Bi	it	Field	Туре	Reset	Description
15:	i:0	SEQ2A_STEP4_DAT[15:0]	R		ADC2A sequence step 4 conversion data Value provided in two's complement format.



# 9.6.1.16 SEQ2A\_STEP5\_DATA Register (Address = 15h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-61. SEQ2A\_STEP5\_DATA Register

15	14	13	12	11	10	9	8			
SEQ2A_STEP5_DAT[15:0]										
R-0000000000000000										
7	6	5	4	3	2	1	0			
SEQ2A_STEP5_DAT[15:0]										
			R-0000000	00000000b						

# Table 9-42. SEQ2A\_STEP5\_DATA Register Field Descriptions

Bit	Field	Type Reset Description		Description
15:0	SEQ2A_STEP5_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 5 conversion data Value provided in two's complement format.

# 9.6.1.17 SEQ2A\_STEP6\_DATA Register (Address = 16h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-62. SEQ2A\_STEP6\_DATA Register

15	14	13	12	11	10	9	8				
	SEQ2A_STEP6_DAT[15:0] R-000000000000b										
7	7 6 5 4 3 2 1 0										
	SEQ2A_STEP6_DAT[15:0]										
	R-000000000000b										

# Table 9-43. SEQ2A\_STEP6\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP6_DAT[15:0]	R		ADC2A sequence step 6 conversion data Value provided in two's complement format.



# 9.6.1.18 SEQ2A\_STEP7\_DATA Register (Address = 17h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-63. SEQ2A\_STEP7\_DATA Register

15	14	13	12	11	10	9	8				
	SEQ2A_STEP7_DAT[15:0]										
	R-00000000000000b										
7	7 6 5 4 3 2 1 0										
	SEQ2A_STEP7_DAT[15:0]										
	R-00000000000000										

# Table 9-44. SEQ2A\_STEP7\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP7_DAT[15:0]	R	000000000000 000b	ADC2A sequence step 7 conversion data Value provided in two's complement format.

# 9.6.1.19 SEQ2A\_STEP8\_DATA Register (Address = 18h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-64. SEQ2A\_STEP8\_DATA Register

15	14	13	12	11	10	9	8				
	SEQ2A_STEP8_DAT[15:0]										
R-000000000000000000000000000000000000											
7	7 6 5 4 3 2 1 0										
	SEQ2A_STEP8_DAT[15:0]										
	R-000000000000b										

# Table 9-45. SEQ2A\_STEP8\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP8_DAT[15:0]	R		ADC2A sequence step 8 conversion data Value provided in two's complement format.



# 9.6.1.20 SEQ2A\_STEP9\_DATA Register (Address = 19h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-65. SEQ2A\_STEP9\_DATA Register

15	14	13	12	11	10	9	8			
SEQ2A_STEP9_DAT[15:0]										
R-0000000000000b										
7	6	5	4	3	2	1	0			
SEQ2A_STEP9_DAT[15:0]										
			R-0000000	00000000b						

# Table 9-46. SEQ2A\_STEP9\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP9_DAT[15:0]	R	000000000000 000b	ADC2A sequence step 9 conversion data Value provided in two's complement format.

# 9.6.1.21 SEQ2A\_STEP10\_DATA Register (Address = 1Ah) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-66. SEQ2A\_STEP10\_DATA Register

15	14	13	12	11	10	9	8	
SEQ2A_STEP10_DAT[15:0]								
R-0000000000000b								
7	6	5	4	3	2	1	0	
	SEQ2A_STEP10_DAT[15:0]							
	R-000000000000b							

#### Table 9-47. SEQ2A\_STEP10\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP10_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 10 conversion data Value provided in two's complement format.



# 9.6.1.22 SEQ2A\_STEP11\_DATA Register (Address = 1Bh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-67. SEQ2A\_STEP11\_DATA Register

	15	14	13	12	11	10	9	8		
	SEQ2A_STEP11_DAT[15:0]									
R-000000000000b										
	7	6	5	4	3	2	1	0		
	SEQ2A_STEP11_DAT[15:0]									
		R-0000000000000b								

#### Table 9-48. SEQ2A\_STEP11\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP11_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 11 conversion data Value provided in two's complement format.

# 9.6.1.23 SEQ2A\_STEP12\_DATA Register (Address = 1Ch) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-68. SEQ2A\_STEP12\_DATA Register

15	14	13	12	11	10	9	8	
SEQ2A_STEP12_DAT[15:0]								
R-000000000000b								
7	6	5	4	3	2	1	0	
	SEQ2A_STEP12_DAT[15:0]							
	R-000000000000b							

#### Table 9-49. SEQ2A\_STEP12\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP12_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 12 conversion data Value provided in two's complement format.



# 9.6.1.24 SEQ2A\_STEP13\_DATA Register (Address = 1Dh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-69. SEQ2A\_STEP13\_DATA Register

14	13	12	11	10	9	8			
SEQ2A_STEP13_DAT[15:0]									
R-00000000000000b									
6	5	4	3	2	1	0			
SEQ2A_STEP13_DAT[15:0]									
R-0000000000000b									
	6	14 13 6 5	6 5 4 SEQ2A_STEF	SEQ2A_STEP13_DAT[15:0]           R-00000000000000b           6         5         4         3           SEQ2A_STEP13_DAT[15:0]	SEQ2A_STEP13_DAT[15:0]           R-000000000000000000000000000000000000	Image: Non-State         Image: Non-State<			

#### Table 9-50. SEQ2A\_STEP13\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP13_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 13 conversion data Value provided in two's complement format.

# 9.6.1.25 SEQ2A\_STEP14\_DATA Register (Address = 1Eh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-70. SEQ2A\_STEP14\_DATA Register

15	14	13	12	11	10	9	8			
	SEQ2A_STEP14_DAT[15:0]									
	R-00000000000000b									
7	6	5	4	3	2	1	0			
	SEQ2A_STEP14_DAT[15:0]									
	R-000000000000b									

#### Table 9-51. SEQ2A\_STEP14\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP14_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 14 conversion data Value provided in two's complement format.



# 9.6.1.26 SEQ2A\_STEP15\_DATA Register (Address = 1Fh) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-71. SEQ2A\_STEP15\_DATA Register

15	14	13	12	11	10	9	8			
	SEQ2A_STEP15_DAT[15:0]									
	R-00000000000000b									
7	6	5	4	3	2	1	0			
	SEQ2A_STEP15_DAT[15:0]									
	R-0000000000000b									

#### Table 9-52. SEQ2A\_STEP15\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2A_STEP15_DAT[15:0]	R	0000000000000 000b	ADC2A sequence step 15 conversion data Value provided in two's complement format.

# 9.6.1.27 SEQ2B\_STEP0\_DATA Register (Address = 20h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-72. SEQ2B\_STEP0\_DATA Register

15	14	13	12	11	10	9	8		
SEQ2B_STEP0_DAT[15:0]									
	R-00000000000000b								
7	6	5	4	3	2	1	0		
	SEQ2B_STEP0_DAT[15:0]								
	R-000000000000b								

#### Table 9-53. SEQ2B\_STEP0\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP0_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 0 conversion data Value provided in two's complement format.



# 9.6.1.28 SEQ2B\_STEP1\_DATA Register (Address = 21h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-73. SEQ2B\_STEP1\_DATA Register

15	14	13	12	11	10	9	8			
	SEQ2B_STEP1_DAT[15:0]									
	R-00000000000000b									
7	6	5	4	3	2	1	0			
	SEQ2B_STEP1_DAT[15:0]									
	R-000000000000b									

# Table 9-54. SEQ2B\_STEP1\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP1_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 1 conversion data Value provided in two's complement format.

# 9.6.1.29 SEQ2B\_STEP2\_DATA Register (Address = 22h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-74. SEQ2B\_STEP2\_DATA Register

15	14	13	12	11	10	9	8		
SEQ2B_STEP2_DAT[15:0]									
	R-0000000000000b								
7	6	5	4	3	2	1	0		
SEQ2B_STEP2_DAT[15:0]									
	R-000000000000b								

### Table 9-55. SEQ2B\_STEP2\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP2_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 2 conversion data Value provided in two's complement format.



# 9.6.1.30 SEQ2B\_STEP3\_DATA Register (Address = 23h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-75. SEQ2B\_STEP3\_DATA Register

15	14	13	12	11	10	9	8			
	SEQ2B_STEP3_DAT[15:0]									
	R-0000000000000b									
7	6	5	4	3	2	1	0			
	SEQ2B_STEP3_DAT[15:0]									
	R-0000000000000b									

# Table 9-56. SEQ2B\_STEP3\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP3_DAT[15:0]	R	000000000000 000b	ADC2B sequence step 3 conversion data Value provided in two's complement format.

# 9.6.1.31 SEQ2B\_STEP4\_DATA Register (Address = 24h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-76. SEQ2B\_STEP4\_DATA Register

15	14	13	12	11	10	9	8		
SEQ2B_STEP4_DAT[15:0]									
R-00000000000000b									
7	6	5	4	3	2	1	0		
SEQ2B_STEP4_DAT[15:0]									
R-0000000000000b									

#### Table 9-57. SEQ2B\_STEP4\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP4_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 4 conversion data Value provided in two's complement format.



# 9.6.1.32 SEQ2B\_STEP5\_DATA Register (Address = 25h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-77. SEQ2B\_STEP5\_DATA Register

15	14	13	12	11	10	9	8			
	SEQ2B_STEP5_DAT[15:0]									
	R-0000000000000b									
7	6	5	4	3	2	1	0			
	SEQ2B_STEP5_DAT[15:0]									
	R-0000000000000b									

# Table 9-58. SEQ2B\_STEP5\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP5_DAT[15:0]	R	000000000000 000b	ADC2B sequence step 5 conversion data Value provided in two's complement format.

# 9.6.1.33 SEQ2B\_STEP6\_DATA Register (Address = 26h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-78. SEQ2B\_STEP6\_DATA Register

15	14	13	12	11	10	9	8		
SEQ2B_STEP6_DAT[15:0]									
R-000000000000b									
7	6	5	4	3	2	1	0		
SEQ2B_STEP6_DAT[15:0]									
R-0000000000000b									

### Table 9-59. SEQ2B\_STEP6\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP6_DAT[15:0]	R	000000000000 000b	ADC2B sequence step 6 conversion data Value provided in two's complement format.



# 9.6.1.34 SEQ2B\_STEP7\_DATA Register (Address = 27h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-79. SEQ2B\_STEP7\_DATA Register

		•	_	_	•				
15	14	13	12	11	10	9	8		
SEQ2B_STEP7_DAT[15:0]									
R-0000000000000b									
7	6	5	4	3	2	1	0		
SEQ2B_STEP7_DAT[15:0]									
R-0000000000000b									

#### Table 9-60. SEQ2B\_STEP7\_DATA Register Field Descriptions

Bi	it	Field	Туре	Reset	Description
15:	5:0	SEQ2B_STEP7_DAT[15:0]	R	000000000000 000b	ADC2B sequence step 7 conversion data Value provided in two's complement format.

# 9.6.1.35 SEQ2B\_STEP8\_DATA Register (Address = 28h) [Reset = 0000h]

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# Figure 9-80. SEQ2B\_STEP8\_DATA Register

15	14	13	12	11	10	9	8			
	SEQ2B_STEP8_DAT[15:0]									
	R-0000000000000b									
7	6	5	4	3	2	1	0			
	SEQ2B_STEP8_DAT[15:0]									
	R-000000000000b									

### Table 9-61. SEQ2B\_STEP8\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP8_DAT[15:0]	R	000000000000 000b	ADC2B sequence step 8 conversion data Value provided in two's complement format.



# 9.6.1.36 SEQ2B\_STEP9\_DATA Register (Address = 29h) [Reset = 0000h]

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#### Figure 9-81. SEQ2B\_STEP9\_DATA Register

15 14 13 12 11 10 9 8							
SEQ2B_STEP9_DAT[15:0]							
R-0000000000000b							
7 6 5 4 3 2 1 0							
SEQ2B_STEP9_DAT[15:0]							
R-000000000000b							

### Table 9-62. SEQ2B\_STEP9\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP9_DAT[15:0]	R	000000000000 000b	ADC2B sequence step 9 conversion data Value provided in two's complement format.

# 9.6.1.37 SEQ2B\_STEP10\_DATA Register (Address = 2Ah) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-82. SEQ2B\_STEP10\_DATA Register

15	14	13	12	11	10	9	8	
	SEQ2B_STEP10_DAT[15:0]							
R-000000000000000000000000000000000000								
7	6	5	4	3	2	1	0	
	SEQ2B_STEP10_DAT[15:0]							
	R-000000000000b							

#### Table 9-63. SEQ2B\_STEP10\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP10_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 10 conversion data Value provided in two's complement format.



# 9.6.1.38 SEQ2B\_STEP11\_DATA Register (Address = 2Bh) [Reset = 0000h]

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#### Figure 9-83. SEQ2B\_STEP11\_DATA Register

15	14	13	12	11	10	9	8
SEQ2B_STEP11_DAT[15:0]							
			R-0000000	00000000b			
7	6	5	4	3	2	1	0
SEQ2B_STEP11_DAT[15:0]							
			R-0000000	0000000b			

#### Table 9-64. SEQ2B\_STEP11\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP11_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 11 conversion data Value provided in two's complement format.

# 9.6.1.39 SEQ2B\_STEP12\_DATA Register (Address = 2Ch) [Reset = 0000h]

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# Figure 9-84. SEQ2B\_STEP12\_DATA Register

15	14	13	12	11	10	9	8	
	SEQ2B_STEP12_DAT[15:0]							
	R-000000000000000000000000000000000000							
7	6	5	4	3	2	1	0	
	SEQ2B_STEP12_DAT[15:0]							
	R-000000000000b							

#### Table 9-65. SEQ2B\_STEP12\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP12_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 12 conversion data Value provided in two's complement format.



# 9.6.1.40 SEQ2B\_STEP13\_DATA Register (Address = 2Dh) [Reset = 0000h]

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#### Figure 9-85. SEQ2B\_STEP13\_DATA Register

15	14	13	12	11	10	9	8		
	SEQ2B_STEP13_DAT[15:0]								
			R-0000000	00000000Ь					
7	6	5	4	3	2	1	0		
	SEQ2B_STEP13_DAT[15:0]								
			R-0000000	00000000b					

# Table 9-66. SEQ2B\_STEP13\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP13_DAT[15:0]	R	000000000000 000b	ADC2B sequence step 13 conversion data Value provided in two's complement format.

# 9.6.1.41 SEQ2B\_STEP14\_DATA Register (Address = 2Eh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-86. SEQ2B\_STEP14\_DATA Register

15	14	13	12	11	10	9	8		
	SEQ2B_STEP14_DAT[15:0]								
	R-000000000000000000000000000000000000								
7	6	5	4	3	2	1	0		
	SEQ2B_STEP14_DAT[15:0]								
	R-000000000000b								

#### Table 9-67. SEQ2B\_STEP14\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP14_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 14 conversion data Value provided in two's complement format.



# 9.6.1.42 SEQ2B\_STEP15\_DATA Register (Address = 2Fh) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-87. SEQ2B\_STEP15\_DATA Register

15	14	13	12	11	10	9	8				
SEQ2B_STEP15_DAT[15:0]											
R-00000000000000b											
7	6	5	4	3	2	1	0				
SEQ2B_STEP15_DAT[15:0]											
			R-0000000	00000000b							

#### Table 9-68. SEQ2B\_STEP15\_DATA Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SEQ2B_STEP15_DAT[15:0]	R	0000000000000 000b	ADC2B sequence step 15 conversion data Value provided in two's complement format.



# 9.6.1.43 DEVICE\_MONITOR\_CFG Register (Address = 40h) [Reset = 0000h]

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#### Figure 9-88. DEVICE\_MONITOR\_CFG Register

15	14	13	12	11	10	9	8
REG_MAP1_CRC_E N	CRC_TYPE	SCLK_COUNTER_E	TIMEOUT_EN		RESERVED		FAULT_POL
R/W-0b	R/W-0b	R/W-0b	R/W-0b		R-000b		R/W-0b
7	6	5	4	3	2	1	0
		RESERVED		MHD_POL	MHD_C	FG[1:0]	
		R-00000b			R/W-0b	R/W	-00b

#### Table 9-69. DEVICE\_MONITOR\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	
15	REG_MAP1_CRC_EN	R/W	Ob	Register map section 1 CRC enable Enables the register map CRC for section 1 (register address space from 40h to 59h). Ob = Disabled 1b = Enabled
14	CRC_TYPE	R/W	ОЬ	CRC type selection Selects the CRC polynomial that is used for the SPI and register map CRC calculation. 0b = 16-bit CCITT 1b = 16-bit ANSI
13	SCLK_COUNTER_EN	R/W	0b	SCLK counter enable Enables the SCLK counter. 0b = Disabled 1b = Enabled
12	TIMEOUT_EN	R/W	Ob	SPI timeout enable Enables the SPI timeout. When enabled the timeout checks that a rising edge of CSn happens within $2^{14}$ t <sub>OSCD</sub> cycles after a CSn falling edge. When a timeout occurs, the remainder of the SPI frame on SDI is ignored before the rising edge of CSn. A new SPI transaction starts at the next CSn falling edge. 0b = Disabled 1b = Enabled
11:9	RESERVED	R	000b	Reserved Always reads back 000b.
8	FAULT_POL	R/W	Ob	FAULT pin polarity selection Selects the polarity of the FAULT pin. The actual output behavior of the GPIO2/FAULT pin, when configured as a FAULT output in the GPIO2_SRC bit, depends on the GPIO2_FMT setting. A FAULT is active when any of the non-masked STATUS_MSB[14:7] bits are active. Ob = Active low. In case of a fault a logic low level is driven. 1b = Active high. In case of a fault a logic high level is driven.
7:3	RESERVED	R	00000ь	Reserved Always reads back 00000b.
2	MHD_POL	R/W	Ob	Missing host detection fault pin polarity selection Selects the polarity of the MHD pin. The actual output behavior of the GPIO0/MHD pin, when configured as an MHD output in the GPIO0_SRC bit, depends on the GPIO0_FMT setting. Ob = Active low. In case of a fault a logic low level is driven. 1b = Active high. In case of a fault a logic high level is driven.
1:0	MHD_CFG[1:0]	R/W	00Ь	Missing host detection configuration Detects when the host is not communicating with the device anymore. A watchdog timer checks the time between two valid commands with a valid CRC. If a valid command with a valid CRC is not received within the watchdog time window, the host is considered missing. When the watchdog times out, the GPIO0/MHD pin is set to active. To use the missing host detection mode, configure the GPIO0/MHD pin as an output using the GPIO0_DIR bit and the source for missing host detection mode using the GPIO0_SRC bit. To reset the GPIO0/MHD output after a missing host was detected, disable the missing host detection mode by setting MHD_CFG = 00b. 00b = Disabled 01b = 10240 x t <sub>OSCD</sub> (= 0.625 ms for f <sub>OSCD</sub> = 8.192 MHz) 10b = 10240 x t <sub>OSCD</sub> (= 2.5 ms for f <sub>OSCD</sub> = 8.192 MHz) 11b = 20480 x t <sub>OSCD</sub> (= 2.5 ms for f <sub>OSCD</sub> = 8.192 MHz)



# 9.6.1.44 SUPPLY\_MONITOR\_CFG1 Register (Address = 41h) [Reset = 0000h]

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#### Figure 9-89. SUPPLY\_MONITOR\_CFG1 Register

				_			
15	14	13	12	11	10	9	8
AVDD_OV_EN	AVDD_UV_EN	IOVDD_OV_EN	IOVDD_UV_EN	DVDD_OV_EN	DVDD_UV_EN	AVDD_OSC_EN	IOVDD_OSC_EN
R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b
7	6	5	4	3	2	1	0
DVDD_OSC_EN	AVDD_OTW_EN	IOVDD_OTW_EN	AVDD_CL_EN	IOVDD_CL_EN	AGNDA_DISC_EN	AGNDB_DISC_EN	DGND_DISC_EN
R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b

# Table 9-70. SUPPLY\_MONITOR\_CFG1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	AVDD_OV_EN	R/W	Ob	AVDD LDO overvoltage monitor enable Enables the AVDD LDO output overvoltage monitor. 0b = Disabled 1b = Enabled
14	AVDD_UV_EN	R/W	Ob	AVDD LDO undervoltage monitor enable Enables the AVDD LDO output undervoltage monitor. 0b = Disabled 1b = Enabled
13	IOVDD_OV_EN	R/W	ОЬ	IOVDD LDO overvoltage monitor enable Enables the IOVDD LDO output overvoltage monitor. 0b = Disabled 1b = Enabled
12	IOVDD_UV_EN	R/W	0b	IOVDD LDO undervoltage monitor enable Enables the IOVDD LDO output undervoltage monitor. 0b = Disabled 1b = Enabled
11	DVDD_OV_EN	R/W	0b	DVDD LDO overvoltage monitor enable Enables the DVDD LDO output overvoltage monitor. 0b = Disabled 1b = Enabled
10	DVDD_UV_EN	R/W	0b	DVDD LDO undervoltage monitor enable Enables the DVDD LDO output undervoltage monitor. 0b = Disabled 1b = Enabled
9	AVDD_OSC_EN	R/W	0b	AVDD LDO oscillation monitor enable Enables the AVDD LDO output oscillation monitor. 0b = Disabled 1b = Enabled
8	IOVDD_OSC_EN	R/W	0b	IOVDD LDO oscillation monitor enable Enables the IOVDD LDO output oscillation monitor. 0b = Disabled 1b = Enabled
7	DVDD_OSC_EN	R/W	0b	DVDD LDO oscillation monitor enable Enables the DVDD LDO output oscillation monitor. 0b = Disabled 1b = Enabled
6	AVDD_OTW_EN	R/W	Ob	AVDD LDO overtemperature warning monitor enable Enables the AVDD LDO overtemperature warning monitor. 0b = Disabled 1b = Enabled
5	IOVDD_OTW_EN	R/W	0b	IOVDD LDO overtemperature warning monitor enable Enables the IOVDD LDO overtemperature warning monitor. 0b = Disabled 1b = Enabled
4	AVDD_CL_EN	R/W	0b	AVDD LDO current limit enable Enables the AVDD LDO current limit. 0b = Disabled 1b = Enabled
3	IOVDD_CL_EN	R/W	Ob	IOVDD LDO current limit enable Enables the IOVDD LDO current limit. 0b = Disabled 1b = Enabled
2	AGNDA_DISC_EN	R/W	Ob	AGNDA disconnect monitor enable Enables the AGNDA disconnect monitor. 0b = Disabled 1b = Enabled
1	AGNDB_DISC_EN	R/W	Ob	AGNDB disconnect monitor enable Enables the AGNDB disconnect monitor. 0b = Disabled 1b = Enabled





#### Table 9-70. SUPPLY\_MONITOR\_CFG1 Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
0	DGND_DISC_EN	R/W		DGND disconnect monitor enable Enables the DGND disconnect monitor. 0b = Disabled 1b = Enabled



# 9.6.1.45 SUPPLY\_MONITOR\_CFG2 Register (Address = 42h) [Reset = 10F0h]

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#### Figure 9-90. SUPPLY\_MONITOR\_CFG2 Register

15	14	13	12	11	10	9	8
RESERVED		IOVDD_OV_TH	IOVDD_UV_TH	RESERVED			
R-00b		R/W-0b	R/W-1b	R-0000b			
7	6	5	4	3	2	1	0
AVDD_OTW_CFG[1:0]		IOVDD_OT	W_CFG[1:0]		RESI	ERVED	
R/W-11b		R/W	'-11b		R-0	000b	

#### Table 9-71. SUPPLY\_MONITOR\_CFG2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	RESERVED	R	00b	Reserved Always reads back 00b.
13	IOVDD_OV_TH	R/W	0b	IOVDD overvoltage threshold selection Selects the threshold for the IOVDD LDO output overvoltage monitor. 0b = 5.7 V 1b = 3.9 V
12	IOVDD_UV_TH	R/W	1b	IOVDD undervoltage threshold selection Selects the threshold for the IOVDD LDO output undervoltage monitor. 0b = 4.3 V 1b = 2.95 V
11:8	RESERVED	R	0000Ь	Reserved Always reads back 0000b.
7:6	AVDD_OTW_CFG[1:0]	R/W	11b	AVDD LDO overtemperature warning threshold selection Selects the threshold for AVDD LDO overtemperature warning. 00b = #dash <deg#c 01b = 100°C 10b = 120°C 11b = 140°C</deg#c 
5:4	IOVDD_OTW_CFG[1:0]	R/W	11b	IOVDD LDO overtemperature warning threshold selection Selects the threshold for IOVDD LDO overtemperature warning. 00b = #dash-deg#C 01b = 100°C 10b = 120°C 11b = 140°C
3:0	RESERVED	R	0000Ь	Reserved Always reads back 0000b.



# 9.6.1.46 CLOCK\_MONITOR\_CFG Register (Address = 43h) [Reset = 0000h]

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#### Figure 9-91. CLOCK\_MONITOR\_CFG Register

15	14	13	12	11	10	9	8
			RESE	RVED			
		R/W-00		R-000	0000b		
7	6	5	4	3	2	1	0
		RESERVED	MCLK_MON_EN	OSCD_WD_EN	MCLK_WD_EN		
		R-0000000b	R/W-0b	R/W-0b	R/W-0b		

#### Table 9-72. CLOCK\_MONITOR\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:10	RESERVED	Always write 000000b.		
9:3	RESERVED			
2	MCLK_MON_EN	R/W	Ob	MCLK monitor enable Enables the main clock frequency monitor. 0b = Disabled 1b = Enabled
1	OSCD_WD_EN	R/W	0b	Diagnostic oscillator watchdog enable Enables the diagnostic oscillator watchdog. 0b = Disabled 1b = Enabled
0	MCLK_WD_EN	R/W	Ob	Main clock watchdog enable Enables the main clock watchdog. 0b = Disabled 1b = Enabled



# 9.6.1.47 SUPPLY\_MONITOR\_DIAGNOSTIC\_CFG Register (Address = 44h) [Reset = 0000h]

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#### Figure 9-92. SUPPLY\_MONITOR\_DIAGNOSTIC\_CFG Register

	0		_		- 0		
15	14	13	12	11	10	9	8
AVDD_OV_DIAG_EN	AVDD_UV_DIAG_EN	IOVDD_OV_DIAG_E N	IOVDD_UV_DIAG_E N	DVDD_OV_DIAG_E N	DVDD_UV_DIAG_E N	AVDD_OSC_DIAG_E N	IOVDD_OSC_DIAG_ EN
R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b
7	6	5	4	3	2	1	0
DVDD_OSC_DIAG_ EN		RESE	RVED	AGNDA_DISC_DIAG _EN	AGNDB_DISC_DIAG _EN	DGND_DISC_DIAG_ EN	
R/W-0b		R-00	000b		R/W-0b	R/W-0b	R/W-0b

#### Table 9-73. SUPPLY\_MONITOR\_DIAGNOSTIC\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description		
15	AVDD_OV_DIAG_EN	R/W	ОЬ	AVDD LDO overvoltage monitor diagnostic enable Enables the AVDD LDO output overvoltage monitor diagnostic. AVDD_OV_EN must be set for the diagnostic to work. The AVDD_OVn fault flag sets within t <sub>p(AVDD_OV)</sub> when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
14	AVDD_UV_DIAG_EN	R/W	ОЬ	AVDD LDO undervoltage monitor diagnostic enable Enables the AVDD LDO output undervoltage monitor diagnostic. AVDD_UV_EN must be set for the diagnostic to work. The AVDD_UVn fault flag sets within t <sub>p(AVDD_UV)</sub> when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
13	IOVDD_OV_DIAG_EN	R/W	Ob	IOVDD LDO overvoltage monitor diagnostic enable Enables the IOVDD LDO output overvoltage monitor diagnostic. IOVDD_OV_EN must be set for the diagnostic to work. The IOVDD_OVn fault flag sets within $t_{p(IOVDD_OV)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
12	IOVDD_UV_DIAG_EN	R/W	Ob	IOVDD LDO undervoltage monitor diagnostic enable Enables the IOVDD LDO output undervoltage monitor diagnostic. IOVDD_UV_EN must be set for the diagnostic to work. The IOVDD_UVn fault flag sets within $t_{p(IOVDD_UV)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
11	DVDD_OV_DIAG_EN	R/W	Ob	DVDD LDO overvoltage monitor diagnostic enable Enables the DVDD LDO output overvoltage monitor diagnostic. DVDD_OV_EN must be set for the diagnostic to work. The DVDD_OVn fault flag sets within $t_{p(DVDD_OV)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
10	DVDD_UV_DIAG_EN	R/W	Ob	DVDD LDO undervoltage monitor diagnostic enable Enables the DVDD LDO output undervoltage monitor diagnostic. DVDD_UV_EN must be set for the diagnostic to work. The DVDD_UVn fault flag sets within $t_{p(DVDD_UV)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
9	AVDD_OSC_DIAG_EN	R/W	Ob	AVDD LDO oscillation monitor diagnostic enable Enables the AVDD LDO output oscillation monitor diagnostic. AVDD_OSC_EN must be set for the diagnostic to work. The AVDD_OSCn fault flag sets within t <sub>p(AVDD_OSC)</sub> when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
8	IOVDD_OSC_DIAG_EN	R/W	ОЬ	IOVDD LDO oscillation monitor diagnostic enable Enables the IOVDD LDO output oscillation monitor diagnostic. IOVDD_OSC_EN must be set for the diagnostic to work. The IOVDD_OSCn fault flag sets within $t_{p(IOVDD_OSC)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
7	DVDD_OSC_DIAG_EN	R/W	ОЬ	DVDD LDO oscillation monitor diagnostic enable Enables the DVDD LDO output oscillation monitor diagnostic. DVDD_OSC_EN must be set for the diagnostic to work. The DVDD_OSCn fault flag sets within $t_{p(DVDD_OSC)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled		
6:3	RESERVED	R	0000Ь	Reserved Always reads back 0000b.		



#### Table 9-73. SUPPLY\_MONITOR\_DIAGNOSTIC\_CFG Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
2	AGNDA_DISC_DIAG_EN	R/W	0b	AGNDA disconnect monitor diagnostic enable Enables the AGNDA disconnect monitor diagnostic. AGNDA_DISC_EN must be set for the diagnostic to work. The AGNDA_DISCn fault flag sets within $t_{p(AGNDA_OPEN)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled
1	AGNDB_DISC_DIAG_EN	R/W	0b	AGNDB disconnect monitor diagnostic enable Enables the AGNDB disconnect monitor diagnostic. AGNDB_DISC_EN must be set for the diagnostic to work. The AGNDB_DISCn fault flag sets within $t_{p(AGNDB_OPEN)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled
0	DGND_DISC_DIAG_EN	R/W	0b	DGND disconnect monitor diagnostic enable Enables the DGND disconnect monitor diagnostic. DGND_DISC_EN must be set for the diagnostic to work. The DGND_DISC fault flag sets within $t_{p(DGND_OPEN)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled



# 9.6.1.48 CLOCK\_MONITOR\_DIAGNOSTIC\_CFG Register (Address = 45h) [Reset = 0000h]

#### Return to the Summary Table.

#### Figure 9-93. CLOCK\_MONITOR\_DIAGNOSTIC\_CFG Register

	J -		_	_	_ 3		
15	14	13	12	11	10	9	8
			SPAR	E[11:0]			
			R/W-0000	0000000b			
7	6	5	4	3	2	1	0
SPARE[11:0]				MCLK_HI_DIAG_EN	MCLK_LO_DIAG_EN	OSCD_WD_DIAG_E N	MCLK_WD_DIAG_E N
	R/W-00000	000000b		R/W-0b	R/W-0b	R/W-0b	R/W-0b

#### Table 9-74. CLOCK\_MONITOR\_DIAGNOSTIC\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description			
15:4	SPARE[11:0]	R/W	0000000000000	Spare bits Provided as R/W bits as a means to check the register map section 1 CRC. Bit settings have no effect.			
3	MCLK_HI_DIAG_EN	R/W	Ob	MCLK frequency too high monitor diagnostic enable Enables the main clock frequency too high monitor diagnostic. MCLK_MON_EN must be set for the diagnostic to work. The MCLK_FAULTn fault flag sets within t <sub>P(MCLK_FAULT)</sub> wh the diagnostic completed successfully. Do not enable the MCLK_LO_DIAG_EN at the sa time. Execute the MCLK_HI_DIAG_EN and MCLK_LO_DIAG_EN sequentially. 0b = Disabled 1b = Enabled MCLK frequency too low monitor diagnostic enable			
2	MCLK_LO_DIAG_EN	R/W	Ob	MCLK frequency too low monitor diagnostic enable Enables the main clock frequency too low monitor diagnostic. MCLK_MON_EN must be set for the diagnostic to work. The MCLK_FAULTn fault flag sets within $t_{p(MCLK_FAULT)}$ when the diagnostic completed successfully. Do not enable the MCLK_HI_DIAG_EN at the same time. Execute the MCLK_HI_DIAG_EN and MCLK_LO_DIAG_EN sequentially. 0b = Disabled 1b = Enabled			
1	OSCD_WD_DIAG_EN	R/W	Ob	Diagnostic oscillator watchdog diagnostic enable Enables the diagnostic oscillator watchdog diagnostic. OSCD_WD_EN must be set for the diagnostic to work. The OSCD_WDn fault flag sets within $t_{p(OSCD_WD)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled			
0	MCLK_WD_DIAG_EN	R/W	Ob	Main clock watchdog diagnostic enable Enables the main clock watchdog diagnostic. MCLK_WD_EN must be set for the diagnostic to work. The MCLK_WDn fault flag sets within $t_{p(MCLK_WD)}$ when the diagnostic completed successfully. 0b = Disabled 1b = Enabled			



# 9.6.1.49 DIGITAL\_MONITOR\_DIAGNOSTIC\_CFG Register (Address = 46h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-94. DIGITAL\_MONITOR\_DIAGNOSTIC\_CFG Register

	0		_				
15	14	13	12	11	10	9	8
		RESE		MEM_MAP_C	RC_DIAG[1:0]		
		R-000		R/W	-00b		
7	6	5	4	3	2	1	0
		RESERVED	GPIOA_DIAG_EN	GPIOB_DIAG_EN	GPIO_DIAG_EN		
		R-00000b			R/W-0b	R/W-0b	R/W-0b

#### Table 9-75. DIGITAL\_MONITOR\_DIAGNOSTIC\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description		
15:10	RESERVED	R	000000ь	Reserved Always reads back 000000b.		
9:8	MEM_MAP_CRC_DIAG[1:0]	R/W	00Ь	Memory map CRC diagnostic bit pattern selection Selects the bit pattern to use for the memory map CRC diagnostic. The MEM_MAP_CRC_FAULTn fault flag sets within f <sub>p(MEM_MAP_CRC)</sub> when the diagnostic completed successfully. Any of the three available bit patterns can be used for the diagnostic. 00b = Disabled 01b = Pattern 1 10b = Pattern 2 11b = Pattern 3		
7:3	RESERVED	R	00000ь	Reserved Always reads back 00000b.		
2	GPIOA_DIAG_EN	R/W	0b	GPIOA readback diagnostic enable Inverts the readback value of the GPIxA_DAT[1:0] bits if GPIOxA_DIR is configured as a digital output. 0b = Disabled 1b = Enabled		
1	GPIOB_DIAG_EN	R/W	Ob	GPIOB readback diagnostic enable Inverts the readback value of the GPIxB_DAT[1:0] bits if GPIOxB_DIR is configured as a digital output. 0b = Disabled 1b = Enabled		
0	GPIO_DIAG_EN	R/W	Ob	GPIO readback diagnostic enable Inverts the readback value of the GPIx_DAT[1:0] bits if GPIOx_DIR is configured as a digital output. 0b = Disabled 1b = Enabled		



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# 9.6.1.50 SUPPLY\_FAULT\_MASK Register (Address = 47h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-95. SUPPLY\_FAULT\_MASK Register

		•			•		
15	14	13	12	11	10	9	8
AVDD_OV_MASK	AVDD_UV_MASK	IOVDD_OV_MASK	IOVDD_UV_MASK	DVDD_OV_MASK	DVDD_UV_MASK	AVDD_OSC_MASK	IOVDD_OSC_MASK
R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b
7	6	5	4	3	2	1	0
DVDD_OSC_MASK	AVDD_OTW_MASK	IOVDD_OTW_MASK	AVDD_CL_MASK	IOVDD_CL_MASK	AGNDA_DISC_MAS K	AGNDB_DISC_MAS K	DGND_DISC_MASK
R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b

# Table 9-76. SUPPLY\_FAULT\_MASK Register Field Descriptions

Bit	Field	Туре	Reset	Description		
15	AVDD_OV_MASK	R/W	Ob	AVDD overvoltage fault flag mask Masks the AVDD overvoltage fault flag (AVDD_OVn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
14	AVDD_UV_MASK	R/W	Ob	AVDD undervoltage fault flag mask Masks the AVDD undervoltage fault flag (AVDD_UVn) from triggering the SUPPLY_FAULT flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
13	IOVDD_OV_MASK	R/W	Ob	IOVDD overvoltage fault flag mask Masks the IOVDD overvoltage fault flag (IOVDD_OVn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
12	IOVDD_UV_MASK	R/W	Ob	IOVDD undervoltage fault flag mask Masks the IOVDD undervoltage fault flag (IOVDD_UVn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
11	DVDD_OV_MASK	R/W	Ob	DVDD overvoltage fault flag mask Masks the DVDD overvoltage fault flag (DVDD_OVn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
10	DVDD_UV_MASK	R/W	Ob	DVDD undervoltage fault flag mask Masks the DVDD undervoltage fault flag (DVDD_UVn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
9	AVDD_OSC_MASK	R/W	Ob	AVDD oscillation fault flag mask Masks the AVDD oscillation fault flag (AVDD_OSCn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
8	IOVDD_OSC_MASK	R/W	Ob	IOVDD oscillation fault flag mask Masks the IOVDD oscillation fault flag (IOVDD_OSCn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
7	DVDD_OSC_MASK	R/W	Ob	DVDD oscillation fault flag mask Masks the DVDD oscillation fault flag (DVDD_OSCn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
6	AVDD_OTW_MASK	R/W	Ob	AVDD overtemperature warning flag mask Masks the AVDD LDO overtemperature warning flag (AVDD_OTWn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
5	IOVDD_OTW_MASK	R/W	Ob	IOVDD overtemperature warning flag mask Masks the IOVDD LDO overtemperature warning flag (IOVDD_OTWn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		
4	AVDD_CL_MASK	R/W	Ob	AVDD current limit flag mask Masks the AVDD LDO current limit flag (AVDD_CLn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked		



#### Table 9-76. SUPPLY\_FAULT\_MASK Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description			
3	IOVDD_CL_MASK	R/W	0b	IOVDD current limit flag mask Masks the IOVDD LDO current limit flag (IOVDD_CLn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked			
2	AGNDA_DISC_MASK	R/W	0b	AGNDA pin disconnect detection flag mask Masks the AGNDA pin disconnect detection flag (AGNDA_DISCn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked			
1	AGNDB_DISC_MASK	R/W	0b	AGNDB pin disconnect detection flag mask Masks the AGNDB pin disconnect detection flag (AGNDB_DISCn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked			
0	DGND_DISC_MASK	R/W	0b	DGND pin disconnect detection flag mask Masks the DGND pin disconnect detection flag (DGND_DISCn) from triggering the SUPPLY_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked			



# 9.6.1.51 CLOCK\_FAULT\_MASK Register (Address = 48h) [Reset = 0000h]

Return to the Summary Table.

	Figure 9-96. CLOCK_FAULT_MASK Register										
15	14	13	12	11	10	9	8				
	RESERVED RESERVED										
	R/W-000000b R-000000b										
7	6	5	4	3	2	1	0				
	RESERVED MCLK_FAULT_MAS OSCD_WD_MASK MCLK_WD_MASK										
		R-0000000b			R/W-0b	R/W-0b	R/W-0b				

#### Table 9-77. CLOCK\_FAULT\_MASK Register Field Descriptions

Bit	Field	Туре	Reset	Description			
15:10	RESERVED	R/W	000000b	Reserved Always write 000000b.			
9:3	RESERVED	R	000000ь	Reserved Always reads back 0000000b.			
2	MCLK_FAULT_MASK	R/W	Ob	MCLK frequency too high or too low fault flag mask Masks the MCLK frequency too high or too low fault flag (MCLK_FAULTn) from triggerin the CLOCK_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked			
1	OSCD_WD_MASK	R/W	0Ь	Diagnostic oscillator watchdog fault flag mask Masks the diagnostic oscillator watchdog fault flag (OSCD_WDn) from triggering the CLOCK_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked			
0	MCLK_WD_MASK	R/W	Ob	Main clock watchdog fault flag mask Masks the main clock watchdog fault flag (MCLK_WDn) from triggering the CLOCK_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked			



# 9.6.1.52 DIGITAL\_FAULT\_MASK Register (Address = 49h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-97. DIGITAL\_FAULT\_MASK Register

		•			•			
15	14	13	12	11	10	9	8	
REG_MAP1_CRC_F AULT_MASK	REG_MAP2_CRC_F AULT_MASK	REG_MAP3_CRC_F AULT_MASK	RESERVED	MEM_MAP_CRC_FA ULT_MASK		RESERVED		
R/W-0b	R/W-0b	R/W-0b	R-0b	R/W-0b	R-000000000b			
7	6	5	4	3	2	1	0	
	RESERVED							
			R-00000	000000b				

#### Table 9-78. DIGITAL\_FAULT\_MASK Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	REG_MAP1_CRC_FAULT_MASK	R/W	Ob	Register map section 1 CRC fault flag mask Masks the register map section 1 CRC fault flag (REG_MAP1_CRC_FAULTn) from triggering the DIGITAL_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked
14	REG_MAP2_CRC_FAULT_MASK	R/W	Ob	Register map section 2 CRC fault flag mask Masks the register map section 2 CRC fault flag (REG_MAP2_CRC_FAULTn) from triggering the DIGITAL_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked
13	REG_MAP3_CRC_FAULT_MASK	R/W	Ob	Register map section 3 CRC fault flag mask Masks the register map section 3 CRC fault flag (REG_MAP3_CRC_FAULTn) from triggering the DIGITAL_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked
12	RESERVED	R	Ob	Reserved Always reads back 0b.
11	MEM_MAP_CRC_FAULT_MASK	R/W	Ob	Memory map CRC fault flag mask Masks the memory map CRC fault flag (MEM_MAP_CRC_FAULTn) from triggering the DIGITAL_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked
10:0	RESERVED	R	0000000000b	Reserved Always reads back 0000000000b.



# 9.6.1.53 OCC\_FAULT\_MASK Register (Address = 4Ah) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-98. OCC\_FAULT\_MASK Register

				_	•		
15	14	13	12	11	10	9	8
			RESE	RVED			
			R-00000	000000b			
7	6	5	4	3	2	1	0
RESERVED			OCCA_HT_MASK	OCCA_LT_MASK	OCCB_HT_MASK	OCCB_LT_MASK	
R-0000000000b				R/W-0b	R/W-0b	R/W-0b	R/W-0b

#### Table 9-79. OCC\_FAULT\_MASK Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:4	RESERVED	R	00000000000b	Reserved Always reads back 00000000000b.
3	OCCA_HT_MASK	R/W	0b ADC1A overcurrent comparator high threshold fault flag mask Masks the ADC1A overcurrent comparator high threshold fault flag (OCCA_H triggering the OCC_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked	
2	OCCA_LT_MASK	R/W	Ob	ADC1A overcurrent comparator low threshold fault flag mask Masks the ADC1A overcurrent comparator low threshold fault flag (OCCA_LTn) from triggering the OCC_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked
1	OCCB_HT_MASK	R/W	0b	ADC1B overcurrent comparator high threshold fault flag mask Masks the ADC1B overcurrent comparator high threshold fault flag (OCCB_HTn) from triggering the OCC_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked
0	OCCB_LT_MASK	R/W	0b	ADC1B overcurrent comparator low threshold fault flag mask Masks the ADC1B overcurrent comparator low threshold fault flag (OCCB_LTn) from triggering the OCC_FAULTn flag in the STATUS_MSB register. 0b = Unmasked 1b = Masked



# 9.6.1.54 FAULT\_PIN\_MASK Register (Address = 4Bh) [Reset = 0780h]

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# Figure 9-99. FAULT\_PIN\_MASK Register

15	14	13	12	11	10	9	8
RESERVED	SUPPLY_FAULT_MA SK	CLOCK_FAULT_MA SK	DIGITAL_FAULT_MA SK	OCC_FAULT_MASK	SPI_CRC_FAULT_M ASK	SPI_TIMEOUT_MAS K	SCLK_COUNT_FAU LT_MASK
R-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-1b	R/W-1b	R/W-1b
7	6	5	4	3	2	1	0
REG_ACCESS_FAU LT_MASK				RESERVED			
R/W-1b				R-0000000b			

#### Table 9-80. FAULT\_PIN\_MASK Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	RESERVED	R	Ob	Reserved Always reads back 0b.
14	SUPPLY_FAULT_MASK	R/W	Ob	Supply fault flag mask Masks the supply fault flag (SUPPLY_FAULTn) in the STATUS_MSB register from triggering the FAULT pin when the GPIO2/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
13	CLOCK_FAULT_MASK	R/W	0b	Clock fault flag mask Masks the clock fault flag (CLOCK_FAULTn) in the STATUS_MSB register from triggering the FAULT pin when the GPIO2/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
12	DIGITAL_FAULT_MASK	R/W	06	Digital fault flag mask Masks the digital fault flag (DIGITAL_FAULTn) in the STATUS_MSB register from triggering the FAULT pin when the GPIO2/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
11	OCC_FAULT_MASK	R/W	0b	Overcurrent comparator fault flag mask Masks the overcurrent comparator fault flag (OCC_FAULTn) in the STATUS_MSB register from triggering the FAULT pin when the GPIO2/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
10	SPI_CRC_FAULT_MASK	R/W	1b	SPI CRC fault flag mask Masks the SPI CRC fault flag (SPI_CRC_FAULTn) in the STATUS_MSB register from triggering the FAULT pin when the GPIO2/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
9	SPI_TIMEOUT_MASK	R/W	1b	SPI timeout fault flag mask Masks the SPI timeout fault flag (SPI_TIMEOUTn) in the STATUS_MSB register from triggering the FAULT pin when the GPIO2/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
8	SCLK_COUNT_FAULT_MASK	R/W	1b	SCLK counter fault flag mask Masks the SCLK counter fault flag (SCLK_COUNT_FAULTn) in the STATUS_MSB register from triggering the FAULT pin when the GPI02/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
7	REG_ACCESS_FAULT_MASK	R/W	1b	Register access fault flag mask Masks the register access fault flag (REG_ACCESS_FAULTn) in the STATUS_MSB register from triggering the FAULT pin when the GPIO2/FAULT pin is configured as a FAULT output. 0b = Unmasked 1b = Masked
6:0	RESERVED	R	000000b	Reserved Always reads back 0000000b.



# 9.6.1.55 DEVICE\_CFG Register (Address = 4Ch) [Reset = 0000h]

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	Figure 9-100. DEVICE_CFG Register								
15	14	13	12	11	10	9	8		
RESERVED	DRDY_CTRL	RESERVED	CLK_SOURCE	WORD_LENGTH	RESERVED	OP_MC	DE[1:0]		
R-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R-0b	R/W	-00b		
7	6	5	4	3	2	1	0		
	RESERVED								
			R-000	00000Ь					

#### Table 9-81. DEVICE\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	RESERVED	R	Ob	Reserved Always reads back 0b.
14	DRDY_CTRL	R/W	ОЬ	DRDYn pin control selection Selects which ADC controls the DRDYn pin indication. 0b = ADC1A and ADC3A 1b = ADC1B and ADC3B
13	RESERVED	R/W	Ob	Reserved Always write 0b.
12	CLK_SOURCE	R/W	Ob	MCLK clock source selection Selects the main clock source of the device. Before changing this bit, all ADCs must be disabled or the device placed in standby or power-down mode. When switching from an external clock to the internal oscillator, the external clock must be provided until after the switch-over is complete. 0b = Internal oscillator 1b = External clock
11	WORD_LENGTH	R/W	ОЬ	Data word length selection Selects the length of every word in the SPI frame. 0b = 24 bits 1b = 32 bits; LSB zero padding
10	RESERVED	R	Ob	Reserved Always reads back 0b.
9:8	OP_MODE[1:0]	R/W	00Ь	Operating mode selection Selects the operating mode for the device. 00b = Active mode 01b = Standby mode (Disables all ADCs) 10b = Power-down mode 11b = Power-down mode
7:0	RESERVED	R	0000000ь	Reserved Always reads back 0000000b.



# 9.6.1.56 GPIO\_CFG Register (Address = 4Dh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-101. GPIO\_CFG Register

		•					
15	14	13	12	11	10	9	8
RESERVED	GPIO4_FMT	GPIO3_FMT	GPIO2_FMT	GPIO1_FMT	GPIO0_FMT	GPIO4_DIR	GPIO3_DIR
R-0b	R/W-0b						
7	6	5	4	3	2	1	0
GPIO2_DIR	GPIO1_DIR	GPIO0_DIR	GPIO4_SRC	GPIO3_SRC	GPIO2_SRC	RESERVED	GPIO0_SRC
R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	R-0b	R/W-0b

#### Table 9-82. GPIO\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	RESERVED	R	Ob	Reserved Always reads back 0b.
14	GPIO4_FMT	R/W	Ob	GPIO4 format Configures GPIO4 for static input and output levels or for PWM input and output levels 0b = When GPIO4 is configured as a digital input: Logic levels are based on static input levels. When GPIO4 is configured as a digital output: Output with static output levels. (GPIO4_LL_PWM_CFG and GPIO4_LH_PWM_CFG registers are ignored in this case). For parallel GPO readback purposes the readback path is configured for logic levels based on static input levels in this case. 1b = When GPIO4 is configured as a digital input: Logic levels are based on PWM input decoding. When GPIO4 is configured as a digital output: Output with PWM output defined by the GPIO4_LL_PWM_CFG and GPIO4_LH_PWM_CFG registers. For parallel GPO readback purposes the readback path is configured for logic levels based on PWM decoding using the time base configured in GPIO4_PWM_TB in this case.
13	GPIO3_FMT	R/W	Ob	GPI03 format Configures GPI03 for static input and output levels or for PWM input and output levels 0b = When GPI03 is configured as a digital input: Logic levels are based on static input levels. When GPI03 is configured as a digital output: Output with static output levels. (GPI03_LL_PWM_CFG and GPI03_LH_PWM_CFG registers are ignored in this case). For parallel GPO readback purposes the readback path is configured for logic levels based on static input levels in this case. 1b = When GPI03 is configured as a digital input: Logic levels are based on PWM input decoding. When GPI03 is configured as a digital output: Output with PWM output defined by the GPI03_LL_PWM_CFG and GPI03_LH_PWM_CFG registers. For parallel GPO readback purposes the readback path is configured for logic levels based on PWM decoding using the time base configured in GPI03_PWM_TB in this case.
12	GPIO2_FMT	R/W	ОЬ	GPIO2 format Configures GPIO2 for static input and output levels or for PWM input and output levels 0b = When GPIO2 is configured as a digital input: Logic levels are based on static input levels. When GPIO2 is configured as a digital output: Output with static output levels. (GPIO2_LL_PWM_CFG and GPIO2_LH_PWM_CFG registers are ignored in this case). For parallel GPO readback purposes the readback path is configured for logic levels based on static input levels in this case. 1b = When GPIO2 is configured as a digital input: Logic levels are based on PWM input decoding. When GPIO2 is configured as a digital output: Output with PWM output defined by the GPIO2_L_PWM_CFG and GPIO2_LH_PWM_CFG registers. For parallel GPO readback purposes the readback path is configured for logic levels based on PWM decoding using the time base configured in GPIO2_PWM_TB in this case.
11	GPIO1_FMT	R/W	ОЬ	GPI01 format Configures GPI01 for static input and output levels or for PWM input and output levels 0b = When GPI01 is configured as a digital input: Logic levels are based on static input levels. When GPI01 is configured as a digital output: Output with static output levels. (GPI01_LL_PWM_CFG and GPI01_LH_PWM_CFG registers are ignored in this case). For parallel GPO readback purposes the readback path is configured for logic levels based on static input levels in this case. 1b = When GPI01 is configured as a digital input: Logic levels are based on PWM input decoding. When GPI01 is configured as a digital output: Output with PWM output defined by the GPI01_LL_PWM_CFG and GPI01_LH_PWM_CFG registers. For parallel GPO readback purposes the readback path is configured for logic levels based on PWM decoding using the time base configured in GPI01_PWM_TB in this case.
10	GPIO0_FMT	R/W	Ob	GPI00 format Configures GPI00 for static input and output levels or for PWM input and output levels 0b = When GPI00 is configured as a digital input: Logic levels are based on static input levels. When GPI00 is configured as a digital output: Output with static output levels. (GPI0_LL_PWM_CFG and GPI00_LH_PWM_CFG registers are ignored in this case). For parallel GPO readback purposes the readback path is configured for logic levels based on static input levels in this case. 1b = When GPI00 is configured as a digital input: Logic levels are based on PWM input decoding. When GPI00 is configured as a digital output: Output with PWM output defined by the GPI00_LL_PWM_CFG and GPI00_LH_PWM_CFG registers. For parallel GPO readback purposes the readback path is configured for logic levels based on PWM decoding using the time base configured in GPI00_PWM_TB in this case.



## Table 9-82. GPIO\_CFG Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
9	GPI04_DIR	R/W	Ob	GPIO4 direction Configures GPIO4 as a digital input or output. Configure as a digital output when used as OCCB output. 0b = Digital input 1b = Digital output
8	GPI03_DIR	R/W	Ob	GPIO3 direction Configures GPIO3 as a digital input or output. Configure as a digital output when used as OCCA output. 0b = Digital input 1b = Digital output
7	GPI02_DIR	R/W	Ob	GPIO2 direction Configures GPIO2 as a digital input or output. Configure as a digital output when used as FAULT output. 0b = Digital input 1b = Digital output
6	GPIO1_DIR	R/W	ОЬ	GPIO1 direction Configures GPIO1 as a digital input or output. 0b = Digital input 1b = Digital output
5	GPI00_DIR	R/W	Ob	GPIO0 direction Configures GPIO0 as a digital input or output. Configure as a digital output when used as MHD output. 0b = Digital input 1b = Digital output
4	GPIO4_SRC	R/W	ОЬ	GPIO4 data source selection Selects the data source of the GPIO4/OCCB pin when GPIO4 is configured as an output. 0b = OCCB 1b = GPIO
3	GPIO3_SRC	R/W	ОЬ	GPIO3 data source selection Selects the data source of the GPIO3/OCCA pin when GPIO3 is configured as an output. 0b = OCCA 1b = GPIO
2	GPIO2_SRC	R/W	ОЬ	GPIO2 data source selection Selects the data source of the GPIO2/FAULT pin when GPIO2 is configured as an output. 0b = FAULT 1b = GPIO
1	RESERVED	R	Ob	Reserved Always reads back 0b.
0	GPIO0_SRC	R/W	Ob	GPIO0 data source selection Selects the data source of the GPIO0/MHD pin when GPIO0 is configured as an output. 0b = Missing host detection (MHD) 1b = GPIO



# 9.6.1.57 GPO\_DATA Register (Address = 4Eh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-102. GPO\_DATA Register

	15	14	13	12	11	10	9	8	
SPARE[10:0]									
	R/W-000000000b								
	7	6	5	4	3	2	1	0	
		SPARE[10:0]		GPO4_DAT	GPO3_DAT	GPO2_DAT	GPO1_DAT	GPO0_DAT	
		R/W-0000000000b		R/W-0b	R/W-0b	R/W-0b	R/W-0b	R/W-0b	

Bit	Field	Туре	Reset	Description
15:5	SPARE[10:0]	R/W	00000000000	Spare bits Provided as R/W bits as a means to check the register map section 1 CRC. Bit settings have no effect.
4	GPO4_DAT	R/W	ОЬ	GPIO4 output data Output value of GPIO4 when configured as a digital output. Bit setting has not effect when GPIO4 is configured as an input or as OCCB output. Ob = Low 1b = High
3	GPO3_DAT	R/W	Ob	GPI03 output data Output value of GPI03 when configured as a digital output. Bit setting has not effect when GPI03 is configured as an input or as OCCA output. 0b = Low 1b = High
2	GPO2_DAT	R/W	Ob	GPIO2 output data Output value of GPIO2 when configured as a digital output. Bit setting has not effect when GPIO2 is configured as an input or as FAULT output. 0b = Low 1b = High
1	GPO1_DAT	R/W	Ob	GPIO1 output data Output value of GPIO1 when configured as a digital output. Bit setting has not effect when GPIO1 is configured as an input. 0b = Low 1b = High
0	GPO0_DAT	R/W	Ob	GPIO0 output data Output value of GPIO0 when configured as a digital output. Bit setting has not effect when GPIO0 is configured as an input or as MHD output. 0b = Low 1b = High

#### Table 9-83. GPO\_DATA Register Field Descriptions



# 9.6.1.58 GPIO0\_LL\_PWM\_CFG Register (Address = 4Fh) [Reset = 007Fh]

#### Return to the Summary Table.

Figure 9-103. GPIO0_LL_PWM_CFG Register									
15	14	13	12	11	10	9	8		
GPIO0_PW	/M_TB[1:0]			GPIO0_LL_F	PWM_HC[6:0]				
R/W-00b			R/W-000000b						
7	6	5	4	3	2	1	0		
GPIO0_LL_PWM_H C[6:0]		GPIO0_LL_PWM_LC[6:0]							
R/W-0000000b	R/W-0000000b R/W-1111111b								

#### Table 9-84. GPIO0\_LL\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	GPIO0_PWM_TB[1:0]	R/W	00b	$ \begin{array}{l} \label{eq:GPIO0/MHD PWM time base selection} \\ \mbox{Selects the time base used for the GPIO0/MHD PWM generation when the GPIO0/MHD pin} is configured as an output as well as the time base used for the PWM encoder. \\ \mbox{00b} = 16 x t_{MCLK} (= 1/512 \ \text{kHz} \ for f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{01b} = 64 x t_{MCLK} (= 1/32 \ \text{kHz} \ for f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{10b} = 256 x t_{MCLK} (= 1/32 \ \text{kHz} \ for f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{11b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz} \ for f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{11b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz} \ for f_{MCLK} = 8.192 \ \text{MHz}) \\ \end{tabular} $
13:7	GPIO0_LL_PWM_HC[6:0]	R/W	0000006	GPI00/MHD logic low level PWM high counter Sets the high period of the PWM for a logic low level of GPI00/MHD. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PVM high counter value to 0000000b configures the GPI00/MHD logic low level as static low. Setting both the PWM high and low counter values to 0000000b configures the GPI00/MHD logic low level as static low.
6:0	GPIO0_LL_PWM_LC[6:0]	R/W	1111111b	GPI00/MHD logic low level PWM low counter Sets the low period of the PWM for a logic low level of GPI00/MHD. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 0000000b configures the GPI00/MHD logic low level as static high. Setting both the PWM high and low counter values to 000000b configures the GPI00/MHD logic low level as static low.



# 9.6.1.59 GPIO0\_LH\_PWM\_CFG Register (Address = 50h) [Reset = 3F80h]

Return to the Summary Table.

Figure 9-104. GPIO0_LH_PWM_CFG Register									
15	14	13	12	11	10	9	8		
RESERVED GPIO0_LH_PWM_HC[6:0]									
R-00	b		R/W-111111b						
7	6	5	4	3	2	1	0		
GPIO0_LH_PWM_H C[6:0]			GPIO0_LH_PWM_LC[6:0]						
R/W-1111111b				R/W-0000000b					

#### Table 9-85. GPIO0\_LH\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	RESERVED	R	00b	Reserved Always reads 00b.
13:7	GPIO0_LH_PWM_HC[6:0]	R/W	1111111b	GPI00/MHD logic high level PWM high counter Sets the high period of the PWM for a logic high level of GPI00/MHD. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PWM high counter value to 0000000b configures the GPI00/MHD logic high level as static low. Setting both the PWM high and low counter values to 000000b configures the GPI00/MHD logic high level as static low.
6:0	GPIO0_LH_PWM_LC[6:0]	R/W	000000ь	GPI00/MHD logic high level PWM low counter Sets the low period of the PWM for a logic high level of GPI00/MHD. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 0000000b configures the GPI00/MHD logic high level as static high. Setting both the PWM high and low counter values to 000000bb configures the GPI00/MHD logic high level as static low.



# 9.6.1.60 GPIO1\_LL\_PWM\_CFG Register (Address = 51h) [Reset = 007Fh]

#### Return to the Summary Table.

Figure 9-105. GPIO1_LL_PWM_CFG Register									
15	14	13	12	11	10	9	8		
GPIO1_PWM_TB[1:0] GPIO1_LL_PWM_HC[6:0]									
R/W	-00b		R/W-000000b						
7	6	5	4	3	2	1	0		
GPIO1_LL_PWM_H C[6:0]		GPIO1_LL_PWM_LC[6:0]							
R/W-0000000b									

#### Table 9-86. GPIO1\_LL\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	GPIO1_PWM_TB[1:0]	R/W	00Ь	$ \begin{array}{l} \label{eq:GPIO1} \mbox{PWM time base selection} \\ \mbox{Selects the time base used for the GPIO1 PWM generation when the GPIO1 pin is} \\ \mbox{configured as an output as well as the time base used for the PWM encoder.} \\ \mbox{00b} = 16 x t_{MCLK} (= 1/512 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{01b} = 64 x t_{MCLK} (= 1/128 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{10b} = 256 x t_{MCLK} (= 1/32 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ KHz for } t_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ Hz for } t_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \mbox{ x } t_{MCLK} (= 1/8 \mbox{ Hz for } t_{MCLK} = 8.192  Hz for$
13:7	GPIO1_LL_PWM_HC[6:0]	R/W	000000ь	GPIO1 logic low level PWM high counter Sets the high period of the PWM for a logic low level of GPIO1. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PWM high counter value to 0000000b configures the GPIO1 logic low level as static low. Setting both the PWM high and low counter values to 0000000b configures the GPIO1 logic low level as static low.
6:0	GPIO1_LL_PWM_LC[6:0]	R/W	1111111Ь	GPIO1 logic low level PWM low counter Sets the low period of the PWM for a logic low level of GPIO1. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 0000000b configures the GPIO1 logic low level as static high. Setting both the PWM high and low counter values to 0000000b configures the GPIO1 logic low level as static low.



# 9.6.1.61 GPIO1\_LH\_PWM\_CFG Register (Address = 52h) [Reset = 3F80h]

Return to the Summary Table.

Figure 9-106. GPIO1_LH_PWM_CFG Register										
15	14	13	12	11	10	9	8			
RESE	RVED			GPIO1_LH_I	PWM_HC[6:0]					
R-C	00b	R/W-111111b								
7	6	5	4	3	2	1	0			
GPIO1_LH_PWM_H C[6:0]			GPIO1_LH_PWM_LC[6:0]							
R/W-1111111b										

#### Table 9-87. GPIO1\_LH\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	RESERVED	R	00b	Reserved Always reads 00b.
13:7	GPIO1_LH_PWM_HC[6:0]	R/W	1111111b	GPI01 logic high level PWM high counter Sets the high period of the PWM for a logic high level of GPI01. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PWM high counter value to 0000000b configures the GPI01 logic high level as static low. Setting both the PWM high and low counter values to 000000b configures the GPI01 logic high level as static low.
6:0	GPIO1_LH_PWM_LC[6:0]	R/W	0000006	GPI01 logic high level PWM low counter Sets the low period of the PWM for a logic high level of GPI01. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 0000000b configures the GPI01 logic high level as static high. Setting both the PWM high and low counter values to 0000000b configures the GPI01 logic high level as static low.



# 9.6.1.62 GPIO2\_LL\_PWM\_CFG Register (Address = 53h) [Reset = 007Fh]

#### Return to the Summary Table.

Figure 9-107. GPIO2_LL_PWM_CFG Register									
15	14	13	12	11	10	9	8		
GPIO2_PWM_TB[1:0] GPIO2_LL_PWM_HC[6:0]									
R/W	-00b		R/W-000000b						
7	6	5	4	3	2	1	0		
GPIO2_LL_PWM_H C[6:0]		GPIO2_LL_PWM_LC[6:0]							
R/W-0000000b									

#### Table 9-88. GPIO2\_LL\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	GPIO2_PWM_TB[1:0]	R/W	00Ь	$ \begin{array}{l} \label{eq:GPIO2/FAULT PWM time base selection} \\ \mbox{Selects the time base used for the GPIO2/FAULT PWM generation when the GPIO2/FAULT} \\ \mbox{pin is configured as an output as well as the time base used for the PWM encoder.} \\ \mbox{O0b} = 16 \ x \ t_{MCLK} \ (= 1/512 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 64 \ x \ t_{MCLK} \ (= 1/32 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T0b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{kHz} \ for \ f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{T1b} = 1024 \ x \ t_{MCLK} \ (= 1/8 \ \text{KHz} \ for \ t_{MCLK} \$
13:7	GPIO2_LL_PWM_HC[6:0]	R/W	000000ь	GPIO2/FAULT logic low level PWM high counter Sets the high period of the PWM for a logic low level of GPIO2/FAULT. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PVM high counter value to 0000000 configures the GPIO2/FAULT logic low level as static low. Setting both the PWM high and low counter values to 0000000b configures the GPIO2/FAULT logic low level as static low.
6:0	GPIO2_LL_PWM_LC[6:0]	R/W	1111111Ь	GPIO2/FAULT logic low level PWM low counter Sets the low period of the PWM for a logic low level of GPIO2/FAULT. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 000000b configures the GPIO2/FAULT logic low level as static high. Setting both the PWM high and low counter values to 000000b configures the GPIO2/FAULT logic low level as static low.



# 9.6.1.63 GPIO2\_LH\_PWM\_CFG Register (Address = 54h) [Reset = 3F80h]

Return to the Summary Table.

#### Figure 9-108. GPIO2\_LH\_PWM\_CFG Register 15 14 13 12 11 10 9 8 RESERVED GPIO2\_LH\_PWM\_HC[6:0] R-00b R/W-1111111b 6 5 4 3 2 0 7 1 GPIO2\_LH\_PWM\_H C[6:0] GPIO2\_LH\_PWM\_LC[6:0] R/W-000000b R/W-1111111b

#### Table 9-89. GPIO2\_LH\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	RESERVED	R	00b	Reserved Always reads 00b.
13:7	GPIO2_LH_PWM_HC[6:0]	R/W	1111111b	GPIO2/FAULT logic high level PWM high counter Sets the high period of the PWM for a logic high level of GPIO2/FAULT. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PWM high counter value to 0000000b configures the GPIO2/FAULT logic high level as static low. Setting both the PWM high and low counter values to 000000b configures the GPIO2/FAULT logic high level as static low.
6:0	GPIO2_LH_PWM_LC[6:0]	R/W	0000006	GPIO2/FAULT logic high level PWM low counter Sets the low period of the PWM for a logic high level of GPIO2/FAULT. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 000000b configures the GPIO2/FAULT logic high level as static high. Setting both the PWM high and low counter values to 000000b configures the GPIO2/FAULT logic high level as static low.



# 9.6.1.64 GPIO3\_LL\_PWM\_CFG Register (Address = 55h) [Reset = 007Fh]

#### Return to the Summary Table.

		Figure 9-	109. GPIO3_L	L_PWM_CFG	i Register		
15	14	13	12	11	10	9	8
GPIO3_PW	/M_TB[1:0]			GPIO3_LL_F	WM_HC[6:0]		
R/W	-00b			R/W-00	00000b		
7	6	5	4	3	2	1	0
GPIO3_LL_PWM_H C[6:0]			G	PIO3_LL_PWM_LC[6:	0]		
R/W-0000000b				R/W-1111111b			

#### Table 9-90. GPIO3\_LL\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	GPIO3_PWM_TB[1:0]	R/W	00Ь	$ \begin{array}{l} \label{eq:GPIO3/OCCA PWM time base selection} \\ \mbox{Selects the time base used for the GPIO3/OCCA PWM generation when the GPIO3/OCCA} \\ \mbox{pin is configured as an output as well as the time base used for the PWM encoder.} \\ \mbox{O0b} = 16 x t_{MCLK} (= 1/512 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{O1b} = 64 x t_{MCLK} (= 1/128 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{O1b} = 256 x t_{MCLK} (= 1/32 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ KHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ KHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ KHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ KHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ KHz for } f_{MCLK} = 8.192 \mbox{ KHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} = 1024 \ x t_{MCLK} (= 1/8 \mbox{ KHz for } f_{MCLK} = 8.192 \mbox{ KHz}) \\ \mbox{I1b} = 1024 \ x t_{MCLK} = 1024 \ x $
13:7	GPIO3_LL_PWM_HC[6:0]	R/W	000000ь	GPI03/OCCA logic low level PWM high counter Sets the high period of the PWM for a logic low level of GPI03/OCCA. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PWM high counter value to 000000b configures the GPI03/OCCA logic low level as static low. Setting both the PWM high and low counter values to 000000b configures the GPI03/OCCA logic low level as static low.
6:0	GPIO3_LL_PWM_LC[6:0]	R/W	1111111b	GPI03/OCCA logic low level PWM low counter Sets the low period of the PWM for a logic low level of GPI03/OCCA. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 000000b configures the GPI03/OCCA logic low level as static high. Setting both the PWM high and low counter values to 000000b configures the GPI03/OCCA logic low level as static low.



# 9.6.1.65 GPIO3\_LH\_PWM\_CFG Register (Address = 56h) [Reset = 3F80h]

Return to the Summary Table.

#### Figure 9-110. GPIO3\_LH\_PWM\_CFG Register 15 14 13 12 11 10 9 8 RESERVED GPIO3\_LH\_PWM\_HC[6:0] R-00b R/W-1111111b 6 5 4 3 2 0 7 1 GPIO3\_LH\_PWM\_H C[6:0] GPIO3\_LH\_PWM\_LC[6:0] R/W-000000b R/W-1111111b

#### Table 9-91. GPIO3\_LH\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	RESERVED	R	00b	Reserved Always reads 00b.
13:7	GPIO3_LH_PWM_HC[6:0]	R/W	1111111b	GPI03/OCCA logic high level PWM high counter Sets the high period of the PWM for a logic high level of GPI03/OCCA. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PWM high counter value to 0000000b configures the GPI03/OCCA logic high level as static low. Setting both the PWM high and low counter values to 000000b configures the GPI02/OCCA logic high level as static low.
6:0	GPIO3_LH_PWM_LC[6:0]	R/W	000000ь	GPI03/OCCA logic high level PWM low counter Sets the low period of the PWM for a logic high level of GPI03/OCCA. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 0000000b configures the GPI03/OCCA logic high level as static high. Setting both the PWM high and low counter values to 000000b configures the GPI02/OCCA logic high level as static low.



# 9.6.1.66 GPIO4\_LL\_PWM\_CFG Register (Address = 57h) [Reset = 007Fh]

#### Return to the Summary Table.

		Figure 9-	111. GPIO4_L	L_PWM_CFG	i Register		
15	14	13	12	11	10	9	8
GPIO4_PW	/M_TB[1:0]			GPIO4_LL_F	PWM_HC[6:0]		
R/W	-00b			R/W-00	00000b		
7	6	5	4	3	2	1	0
GPIO4_LL_PWM_H C[6:0]			G	PIO4_LL_PWM_LC[6:	0]		
R/W-0000000b				R/W-1111111b			

#### Table 9-92. GPIO4\_LL\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	GPIO4_PWM_TB[1:0]	R/W	00Ь	$ \begin{array}{l} \label{eq:GPIO4/OCCB PWM time base selection} \\ \mbox{Selects the time base used for the GPIO4/OCCB PWM generation when the GPIO4/OCCB} \\ \mbox{pin is configured as an output as well as the time base used for the PWM encoder} \\ \mbox{O0b} = 16 x t_{MCLK} (= 1/512 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 64 x t_{MCLK} (= 1/128 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 568 x t_{MCLK} (= 1/32 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{MHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{kHz for } f_{MCLK} = 8.192 \ \text{Mz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{KHz for } f_{MCLK} = 8.192 \ \text{Mz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{KHz for } f_{MCLK} = 8.192 \ \text{Mz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{KHz for } f_{MCLK} = 8.192 \ \text{Mz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{KHz for } f_{MCLK} = 8.192 \ \text{KHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{KHz for } f_{MCLK} = 8.192 \ \text{KHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} (= 1/8 \ \text{KHz for } f_{MCLK} = 8.192 \ \text{KHz}) \\ \mbox{O1b} = 1024 \ x t_{MCLK} = 1024 $
13:7	GPIO4_LL_PWM_HC[6:0]	R/W	0000006	GPI04/OCCB logic low level PWM high counter Sets the high period of the PWM for a logic low level of GPI04/OOCB. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PVM high counter value to 0000000 configures the GPI04/OCCB logic low level as static low. Setting both the PWM high and low counter values to 0000000b configures the GPI04/OCCB logic low level as static low.
6:0	GPIO4_LL_PWM_LC[6:0]	R/W	1111111b	GPI04/OCCB logic low level PWM low counter Sets the low period of the PWM for a logic low level of GPI04/OCCB. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PVM low counter value to 000000b configures the GPI04/OCCB logic low level as static high. Setting both the PWM high and low counter values to 000000b configures the GPI04/OCCB logic low level as static low.



# 9.6.1.67 GPIO4\_LH\_PWM\_CFG Register (Address = 58h) [Reset = 3F80h]

Return to the Summary Table.

		Figure 9-	112. GPIO4_L	H_PWM_CFG	6 Register		
15	14	13	12	11	10	9	8
RESER	VED			GPIO4_LH_I	PWM_HC[6:0]		
R-00	)b			R/W-1	111111b		
7	6	5	4	3	2	1	0
GPIO4_LH_PWM_H C[6:0]			G	PIO4_LH_PWM_LC[6:	0]		
R/W-1111111b				R/W-0000000b			

#### Table 9-93. GPIO4\_LH\_PWM\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:14	RESERVED	R	00b	Reserved Always reads 00b.
13:7	GPIO4_LH_PWM_HC[6:0]	R/W	1111111b	GPI04BOCCB logic high level PWM high counter Sets the high period of the PWM for a logic high level of GPI04. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM high time = (PWM high counter value x PWM time base) Setting the PWM high counter value to 0000000b configures the GPI04 logic high level as static low. Setting both the PWM high and low counter values to 0000000b configures the GPI04/OCCB logic high level as static low.
6:0	GPIO4_LH_PWM_LC[6:0]	R/W	000000ь	GPI04/OCCB logic high level PWM low counter Sets the low period of the PWM for a logic high level of GPI04/OCCB. PWM period = (PWM high counter value + PWM low counter value) x PWM time base PWM low time = (PWM low counter value x PWM time base) Setting the PWM low counter value to 000000b configures the GPI04/OCCB logic high level as static high. Setting both the PWM high and low counter values to 000000b configures the GPI04/OCCB logic high level as static low.



# 9.6.1.68 SPARE\_59h Register (Address = 59h) [Reset = 5555h]

Return to the Summary Table.

#### Figure 9-113. SPARE\_59h Register

15	14	13	12	11	10	9	8
			SPAF	E[15:0]			
			R/W-010101	0101010101b			
7	6	5	4	3	2	1	0
			SPAR	E[15:0]			
			R/W-010101	0101010101b			

#### Table 9-94. SPARE\_59h Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SPARE[15:0]	R/W	0101010101010 101b	Spare bits Provided as R/W bits as a means to check the register map section 1 CRC. Bit settings have no effect.

# 9.6.1.69 REGISTER\_MAP1\_CRC Register (Address = 7Eh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-114. REGISTER\_MAP1\_CRC Register

15         14         13         12         11         10         9         8           REG_MAP1_CRC_VALUE[15:0]           R/W-000000000000000000000000000000000000
R/W-000000000000b
7 6 5 4 3 2 1 0
REG_MAP1_CRC_VALUE[15:0]
R/W-0000000000000b

## Table 9-95. REGISTER\_MAP1\_CRC Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	REG_MAP1_CRC_VALUE[15:0]	R/W	000000000000 000b	Register map CRC value for section 1 Register map CRC value for section 1.



# 9.6.1.70 REGMAP2\_TDACA\_CFG Register (Address = 80h) [Reset = 0000h]

#### Return to the Summary Table.

#### Figure 9-115. REGMAP2\_TDACA\_CFG Register

15	14	13	12	11	10	9	8
REG_MAP2_CRC_E N				RESERVED			
R/W-0b				R-00000000000b			
7	6	5	4	3	2	1	0
		RESERVED				TDACA_VALUE[2:0]	
		R-00000000000b				R/W-000b	

#### Table 9-96. REGMAP2\_TDACA\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	REG_MAP2_CRC_EN	R/W	0ь	Register map section 2 CRC enable Enables the register map CRC for section 2 (register address space from 80h to A3h). 0b = Disabled 1b = Enabled
14:3	RESERVED	R	00000000000b	Reserved Always reads 0000000000b.
2:0	TDACA_VALUE[2:0]	R/W	000ь	Test DAC A output value Selects the output value of Test DAC A. 000b = 1 x VREFA/40 001b = 2 x VREFA/40 010b = 4 x VREFA/40 100b = 18 x VREFA/40 100b = 18 x VREFA/40 110b = -4 x VREFA/40 110b = -4 x VREFA/40 111b = -9 x VREFA/40

# 9.6.1.71 GPIOA\_CFG Register (Address = 81h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-116. GPIOA\_CFG Register

15	14	13	12	11	10	9	8
GPIOA_PIN_CFG		SPARE[2:0]		GPIO1A_FMT	GPIO0A_FMT	GPIO1A_DIR	GPIO0A_DIR
R/W-0b		R/W-000b		R/W-0b	R/W-0b	R/W-0b	R/W-0b
7	6	5	4	3	2	1	0
GPIO1A_P	GPIO1A_PWM_TB[1:0] GPIO0A_PWM_TB[1:0]		SPARE[1:0]		GPO1A_DAT	GPO0A_DAT	
R/W	-00b	R/W-	00b R/W		-00b	R/W-0b	R/W-0b

Bit	Field	Туре	Reset	Description	
15	GPIOA_PIN_CFG	RW	0b	VPA/GPIO0A and VNA/GPIO1A pin function selection Configures both the VPA/GPIO0A and VNA/GPIO1A pins as analog inputs or GPIOs. Disable ADC3A (ADC3A_EN = 0b) when these pins are configured as GPIOs. Setting of the GPIOA_PIN_CFG bit is ignored and inputs are forced to analog inputs when ADC3A_EN = 1b. 0b = Analog input 1b = GPIO	
14:12	SPARE[2:0]	R/W	000Ь	Spare bits Provided as R/W bits as a means to check the register map section 2 CRC. Bit settings have no effect.	
11	GPI01A_FMT	R/W	Ob	GPI01A format Configures GPI01A for static input and output levels or for PWM input levels. 0b = When GPI01A is configured as a digital input: Logic levels are based on static input levels. When GPI01A is configured as a digital output: Output with static output levels. 1b = When GPI01A is configured as a digital input: Logic levels are based on PWM input decoding. When GPI01A is configured as a digital output: Output with static output levels. GPI01A does not have PWM output capability.	
10	GPIO0A_FMT	R/W	Ob		
9	GPIO1A_DIR	R/W	0b	GPI01A direction Configures GPI01A as a digital input or digital output. 0b = Digital input 1b = Digital output	
8	GPIO0A_DIR	R/W	Ob	GPIO0A direction Configures GPIO0A as a digital input or digital output. 0b = Digital input 1b = Digital output	
7:6	GPIO1A_PWM_TB[1:0]	R/W	00Ь	GPIO1A PWM time base selection Selects the time base used for the PWM encoder when GPIO1A is configured as a digital input. 00b = 16 x t <sub>MCLK</sub> (= 1/512 kHz for f <sub>MCLK</sub> = 8.192 MHz) 01b = 64 x t <sub>MCLK</sub> (= 1/128 kHz for f <sub>MCLK</sub> = 8.192 MHz) 10b = 256 x t <sub>MCLK</sub> (= 1/32 kHz for f <sub>MCLK</sub> = 8.192 MHz) 11b = 1024 x t <sub>MCLK</sub> (= 1/8 kHz for f <sub>MCLK</sub> = 8.192 MHz)	
5:4	GPIO0A_PWM_TB[1:0]	R/W	00b	GPI00A PWM time base selection         Selects the time base used for the PWM encoder when GPI00A is configured as a digital input.         00b = 16 x t <sub>MCLK</sub> (= 1/512 kHz for f <sub>MCLK</sub> = 8.192 MHz)         01b = 64 x t <sub>MCLK</sub> (= 1/128 kHz for f <sub>MCLK</sub> = 8.192 MHz)         10b = 256 x t <sub>MCLK</sub> (= 1/32 kHz for f <sub>MCLK</sub> = 8.192 MHz)         10b = 1024 x t <sub>MCLK</sub> (= 1/8 kHz for f <sub>MCLK</sub> = 8.192 MHz)	
3:2	SPARE[1:0]	R/W	00b	Spare bits Provided as R/W bits as a means to check the register map section 2 CRC. Bit settings have no effect.	
1	GP01A_DAT	R/W	Ob	GPIO1A output data Output value of GPIO1A when configured as a digital output. Bit setting has not effect when GPIO1A is configured as a digital or analog input. 0b = Low 1b = High	
0	GPO0A_DAT	R/W	Ob	GPIO0A output data Output value of GPIO0A when configured as a digital output. Bit setting has not effect when GPIO0A is configured as a digital or analog input. 0b = Low 1b = High	

#### Table 9-97. GPIOA\_CFG Register Field Descriptions



# 9.6.1.72 ADC1A\_ADC3A\_CFG Register (Address = 82h) [Reset = 0400h]

Return to the Summary Table.

	Figure 9-117. ADC1A_ADC3A_CFG Register										
15	14	13	12	11	10	9	8				
RESERVED CONV_MODE13A OSR13A[2:0]											
	R-0	000b		R/W-0b	R/W-100b						
7	6	5	4	3	2	1	0				
	RESE	RVED		GC13A_EN	GC13A_DELAY[2:0]						
	R-0	000b		R/W-0b		R/W-000b					

#### Table 9-98. ADC1A\_ADC3A\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:12	RESERVED	R	0000b	Reserved Always reads 0000b.
11	CONV_MODE13A	R/W	ОЬ	Conversion mode selection Selects the conversion mode for ADC1A and ADC3A. 0b = Continuous-conversion mode 1b = Single-shot conversion mode
10:8	OSR13A[2:0]	R/W	100Ь	$\label{eq:second} \begin{array}{l} Oversampling ratio selection\\ Selects the oversampling ratio for ADC1A and ADC3A. The data rate calculates to f_{MOD} / OSR.O00b=64001b=128010b=256011b=512100b=1024101b=2048110b=4096111b=8192$
7:4	RESERVED	R	0000b	Reserved Always reads 0000b.
3	GC13A_EN	R/W	Ob	Global-chop mode enable Enables the global-chop mode for ADC1A and ADC3A. 0b = Disabled 1b = Enabled
2:0	GC13A_DELAY[2:0]	R/W	000b	

# 9.6.1.73 ADC1A\_CFG Register (Address = 83h) [Reset = 8010h]

Return to the Summary Table.

# Figure 9-118. ADC1A\_CFG Register

15	14	13	12	11	10	9	8
ADC1A_EN	DC1A_EN RESERVED			GAIN1A[1:0]		MUX1A[1:0]	
R/W-1b		R-000b	R-000b		R/W-00b		-00b
7	6	5	4	3	2	1	0
RESERVED		OWD1A_SOURCE_ MUX	OWD1A_SINK_MUX	OWD1A_SOURCE_VALUE[1:0]		OWD1A_SINK_VALUE[1:0]	
R-00b		R/W-0b	R/W-1b	R/W	/-00b	R/W-00b	

#### Table 9-99. ADC1A\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description	
15	ADC1A_EN	R/W	1b	ADC1A enable Enables ADC1A. The conversion data of ADC1A reset to 000000h when ADC1A is disabled or when the device is put in standby or power-down mode. If both ADC1A and ADC3A are disabled, then the conversion counter CONV1A_COUNT[1:0] resets to 00b. 0b = Disabled 1b = Enabled	
14:12	RESERVED	R	000b	Reserved Always reads 000b.	
11:10	GAIN1A[1:0]	R/W	00Ь	ADC1A gain selection Selects the gain (FSR = full scale range) of ADC1A. Gains 16 and 32 are digital gains using analog gain = 8. 00b = 4 01b = 8 10b = 16 11b = 32	
9:8	MUX1A[1:0]	R/W	00Ь	ADC1A multiplexer channel selection Selects the multiplexer channel for ADC1A. 00b = AINp = CPA, AINn = CNA 01b = AINp = CNA, AINn = CPA 10b = Internal short to AGNDA. Analog inputs CPA, CNA disconnected from ADC1A. 11b = Test DAC B output	
7:6	RESERVED	R	00ь	Reserved Always reads 00b.	
5	OWD1A_SOURCE_MUX	R/W	Ob	ADC1A current source multiplexer selection Selects the multiplexer channel for the ADC1A current source. 0b = CPA 1b = CNA	
4	OWD1A_SINK_MUX	R/W	1b	ADC1A current sink multiplexer selection Selects the multiplexer channel for the ADC1A current sink. 0b = CPA 1b = CNA	
3:2	OWD1A_SOURCE_VALUE[1:0]	R/W	00ь	ADC1A current source value selection Selects the current value for the ADC1A current source. 00b = Off 01b = 4 µA 10b = 40 µA 11b = 240 µA	
1:0	OWD1A_SINK_VALUE[1:0]	R/W	00Ь	ADC1A current sink value selection Selects the current value for the ADC1A current sink. 00b = Off 01b = 4 $\mu$ A 10b = 40 $\mu$ A 11b = 240 $\mu$ A	



# 9.6.1.74 ADC1A\_OCAL\_MSB Register (Address = 84h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-119. ADC1A\_OCAL\_MSB Register

15	14	13	12	11	10	9	8				
OCAL1A[23:8]											
R/W-000000000000b											
7	6	5	4	3	2	1	0				
OCAL1A[23:8]											
	R/W-000000000000000000000000000000000000										

#### Table 9-100. ADC1A\_OCAL\_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCAL1A[23:8]	R/W	000b	ADC1A offset calibration bits [23:8] Value provided in two's complement format. LSB size = $(2 \times VREFA) / (GAIN1A \times 2^{24})$

# 9.6.1.75 ADC1A\_OCAL\_LSB Register (Address = 85h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-120. ADC1A\_OCAL\_LSB Register

15	14	13	12	11	10	9	8				
	OCAL1A[7:0]										
	R/W-0000000b										
7	6	5	4	3	2	1	0				
	RESERVED										
	R-0000000b										

#### Table 9-101. ADC1A\_OCAL\_LSB Register Field Descriptions

Bit	Field	Type Reset Description		Description
15:8	OCAL1A[7:0]	R/W	0000000ь	ADC1A offset calibration bits [7:0] Value provided in two's complement format. LSB size = (2 x VREFA) / (GAIN1A x 2 <sup>24</sup> )
7:0	RESERVED	R	0000000ь	Reserved Always reads 0000000b.



# 9.6.1.76 ADC1A\_GCAL Register (Address = 86h) [Reset = 0000h]

Return to the Summary Table.

## Figure 9-121. ADC1A\_GCAL Register

15 14	13	12	11	10	9	8					
GCAL1A[15:0]											
R/W-000000000000000000000000000000000000											
7 6	5	4	3	2	1	0					
GCAL1A[15:0]											
		R/W-000000	0000000000b								

# Table 9-102. ADC1A\_GCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	GCAL1A[15:0]	R/W	00000000000000000000000000000000000000	ADC1A gain calibration bits [15:0] Value provided in two's complement format. LSB size = 1/2 <sup>16</sup> = 0.000015 Mapping: 0111111111111111 = 1.499985 000000000000000 = 1 = 1.000015 000000000000000 = 1 1111111111111111 = 0.999985 100000000000000 = 0.5



# 9.6.1.77 OCCA\_CFG Register (Address = 87h) [Reset = 0000h]

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## Figure 9-122. OCCA\_CFG Register

15	14	13	12	11	10	9	8	
OCCA_EN	OCCA_POL	RESERVED			OCCA_NUM[4:0]			
R/W-0b	R/W-0b	R/W-0b	R/W-00000b					
7	6	5	4	3	2	1	0	
			RESE	RVED				
			R-000	0000b				

			_	
Bit	Field	Туре	Reset	Description
15	OCCA_EN	R/W	ОЬ	ADC1A overcurrent comparator enable Enables the digital fast filter and digital comparator on ADC1A. ADC1A must be enabled to use the overcurrent comparator. The fast filter is not affected by the STARTA and STOPA bits. 0b = Disabled 1b = Enabled
14	OCCA_POL	R/W	ОЬ	OCCA pin polarity selection Selects the polarity of the OCCA pin. The actual output behavior of the GPIO3/OCCA pin, when configured as OCCA output in the GPIO3_SRC bit, depends on the GPIO3_FMT setting. An OCCA fault is active when any of the OCCA_HTn or OCCA_LTn bits are active. 0b = Active low. In case of a fault a logic low level is driven. 1b = Active high. In case of a fault a logic high level is driven.
13	RESERVED	R/W	Ob	Reserved Always write 0b.
12:8	OCCA_NUM[4:0]	R/W	00006	ADC1A overcurrent comparator deglitch filter selection Selects the number of conversions the output of the ADC1A digital fast filter must exceed the set high or low thresholds to trip the OCCA_HTn or OCCA_LTn comparator output. The fast filter path uses a SINC3 filter with a fixed OSR = 64. The counter starts again whenever the digital fast filter output falls below the threshold, means there is no hysteresis. 00000b = 1 00001b = 2 00010b = 3 00011b = 4 00100b = 5 00101b = 6 00110b = 7 00111b = 8 01000b = 9 01001b = 10 01101b = 12 01011b = 14 01100b = 16 01111b = 20 01111b = 22 10000b = 24 10001b = 26 10011b = 32 10011b = 56 10111b = 56 10111b = 64 11010b = 72 11001b = 88 11011b = 96 11111b = 120 11111b = 120
7:0	RESERVED	R	0000000ь	Reserved Always reads 0000000b

#### Table 9-103. OCCA\_CFG Register Field Descriptions



# 9.6.1.78 OCCA\_HIGH\_THRESHOLD Register (Address = 88h) [Reset = 7FFFh]

Return to the Summary Table.

# Figure 9-123. OCCA\_HIGH\_THRESHOLD Register

15	14	13	12	11	10	9	8					
	OCCA_HIGH_TH[15:0]											
R/W-01111111111111												
7	6	5	4	3	2	1	0					
OCCA_HIGH_TH[15:0]												
			R/W-011111	111111111b								

#### Table 9-104. OCCA\_HIGH\_THRESHOLD Register Field Descriptions

Bit	t	Field	Туре	Reset	Description
15:0	0	OCCA_HIGH_TH[15:0]	R/W	011111111111111 1b	ADC1A overcurrent comparator high threshold bits [15:0] Value provided in two's complement format. LSB size = (2 x VREFA) / (GAIN1A x 2 <sup>16</sup> ) Values larger than the high threshold trigger an OCCA_HTn event. Setting the value to +FS (= 7FFFh) disables the high threshold detection.



# 9.6.1.79 OCCA\_LOW\_THRESHOLD Register (Address = 89h) [Reset = 8000h]

Return to the Summary Table.

# Figure 9-124. OCCA\_LOW\_THRESHOLD Register

15	14	13	12	11	10	9	8				
OCCA_LOW_TH[15:0]											
	R/W-10000000000000b										
7	6	5	4	3	2	1	0				
	OCCA_LOW_TH[15:0]										
			R/W-100000	000000000b							

# Table 9-105. OCCA\_LOW\_THRESHOLD Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCCA_LOW_TH[15:0]	R/W	100000000000 000b	ADC1A overcurrent comparator low threshold bits [15:0] Value provided in two's complement format. LSB size = (2 x VREFA) / (GAIN1A x 2 <sup>16</sup> ) Values smaller than the low threshold trigger an OCCA_LTn event. Setting the value to –FS (= 8000h) disables the low threshold detection.



# 9.6.1.80 SPARE\_8Ah Register (Address = 8Ah) [Reset = 5555h]

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#### Figure 9-125. SPARE\_8Ah Register

15	14	13	12	11	10	9	8				
SPARE[15:0]											
R/W-01010101010101b											
7	6	5	4	3	2	1	0				
SPARE[15:0]											
			R/W-010101	0101010101b							

#### Table 9-106. SPARE\_8Ah Register Field Descriptions

Bit	t	Field	Туре	Reset	Description
15:0	:0	SPARE[15:0]	R/W	0101010101010 101b	Spare bits Provided as R/W bits as a means to check the register map section 2 CRC. Bit settings have no effect.



# 9.6.1.81 ADC2A\_CFG1 Register (Address = 8Bh) [Reset = 8010h]

Return to the Summary Table.

# Figure 9-126. ADC2A\_CFG1 Register

15	14	13	12	11	10	9	8	
ADC2A_EN		RESE	RVED	VCMA_EN OWD2A_SOURCE_MU			RCE_MUX[2:0]	
R/W-1b	R-0000b				R/W-0b	R/W-000b		
7	6	5	4	3	2	1	0	
OWD2A_SOURCE_ MUX[2:0]	_ OWD2A_SINK_MUX[2:0]			OWD2A_SOURC	CE_VALUE[1:0]	OWD2A_SINK_VALUE[1:0]		
R/W-000b		R/W-001b			R/W-00b		R/W-00b	

Bit	Field	Туре	Reset	Description			
15	ADC2A_EN	R/W	1b	ADC2A enable Enables ADC2A. Only change settings of registers from address 8Ch to 9Fh of ADC2A when ADC2A is disabled. The conversion data of ADC2A reset to 0000h and the sequence counter SEQ2A_COUNT[1:0] resets to 00b when ADC2A is disabled or when the device is put in standby or power-down mode. 0b = Disabled 1b = Enabled			
14:11	RESERVED	R	0000Ь	Reserved Always reads 0000b.			
10	VCMA_EN	R/W	0b	Aways reads 0000b. Common-mode output buffer VCMA enable Enables the common-mode output buffer VCMA on analog input V7A. 0b = Disabled 1b = Enabled			
9:7	OWD2A_SOURCE_MUX[2:0]	R/W	000b	ADC2A current source multiplexer selection Selects the multiplexer channel for the ADC2A current source. 000b = V0A 010b = V1A 010b = V2A 011b = V3A 100b = V4A 101b = V5A 110b = V6A 111b = V7A			
6:4	OWD2A_SINK_MUX[2:0]	R/W	001b	ADC2A current sink multiplexer selection Selects the multiplexer channel for the ADC2A current sink. 000b = V0A 010b = V1A 010b = V2A 011b = V2A 100b = V4A 101b = V5A 110b = V6A 111b = V7A			
3:2	OWD2A_SOURCE_VALUE[1:0]	R/W	00Ь	ADC2A current source value selection Selects the current value for the ADC2A current source. 00b = 0ff $01b = 4 \mu A$ $10b = 40 \mu A$ $11b = 240 \mu A$			
1:0	OWD2A_SINK_VALUE[1:0]	R/W	00ь	$\begin{array}{l} \text{ADC2A current sink value selection} \\ \text{Selects the current value for the ADC2A current sink.} \\ 00b = Off \\ 01b = 4 \ \mu\text{A} \\ 10b = 40 \ \mu\text{A} \\ 11b = 240 \ \mu\text{A} \end{array}$			

#### Table 9-107. ADC2A\_CFG1 Register Field Descriptions



# 9.6.1.82 ADC2A\_CFG2 Register (Address = 8Ch) [Reset = 0000h]

Return to the Summary Table.

Figure 9-127. ADC2A_CFG2 Register										
15	14	13	12	11	10	9	8			
SEQ2A_M	SEQ2A_MODE[1:0] RESERVED MUX2A_DELAY[2:0]									
R/W	-00b	R-000b			R/W-000b					
7	6	5 4 3 2 1 0					0			
			OSR2	A[1:0]						
		R-00		R/W-	00b					

# Table 9-108. ADC2A\_CFG2 Register Field Descriptions Type Reset Description

Bit	Field	Туре	Reset	Description
15:14	SEQ2A_MODE[1:0]	R/W	00ь	ADC2A sequencer mode selection Selects the way the ADC2A sequencer starts a new sequence. Setting the SEQ2A_START bit always aborts and restarts an ongoing sequence in all modes. 00b = Single-shot sequence mode based on SEQ2A_START bit (ADC2A runs one time through the sequence after the SEQ2A_START bit is set) 01b = Single-shot sequence mode based on ADC1A conversion starts or SEQ2A_START bit. This setting is only useful when ADC1A is configured for continuous-conversion mode. Sequences are started at the falling edge of DRDYAn or when the SEQ2A_START bit is set. Conversion starts triggered by the DRDYAn signal are ignored, that is do not abort and restart a sequence, while a sequence is ongoing. 10b = Continuous sequence mode based on SEQ2A_START bit 11b = Continuous sequence mode based on SEQ2A_START bit
13:11	RESERVED	R	000b	Reserved Always reads 00b.
10:8	MUX2A_DELAY[2:0]	R/W	000Ь	ADC2A multiplexer delay time selection Selects the delay time before starting conversion on the next sequence step. 000b = 16 x $t_{MCLK}$ (= 2 µs for $f_{MCLK}$ = 8.192 MHz) 001b = 64 x $t_{MCLK}$ (= 7.8 µs for $f_{MCLK}$ = 8.192 MHz) 010b = 128 x $t_{MCLK}$ (= 15.6 µs for $f_{MCLK}$ = 8.192 MHz) 011b = 256 x $t_{MCLK}$ (= 31.2 µs for $f_{MCLK}$ = 8.192 MHz) 100b = 512 x $t_{MCLK}$ (= 62.5 µs for $f_{MCLK}$ = 8.192 MHz) 101b = 1024 x $t_{MCLK}$ (= 124.9 µs for $f_{MCLK}$ = 8.192 MHz) 110b = 2048 x $t_{MCLK}$ (= 249.9 µs for $f_{MCLK}$ = 8.192 MHz) 111b = 4096 x $t_{MCLK}$ (= 499.7 µs for $f_{MCLK}$ = 8.192 MHz)
7:2	RESERVED	R	000000b	Reserved Always reads 000000b.
1:0	OSR2A[1:0]	Selects the oversampling ratio for ADC2/           00b = 64 (SINC3 OSR = 64, conversion t           01b = 128 (SINC3 OSR = 64, SINC1 OSI           10b = 256 (SINC3 OSR = 64, SINC1 OSI		$      ADC2A oversampling ratio selection \\       Selects the oversampling ratio for ADC2A. \\       00b = 64 (SINC3 OSR = 64, conversion time = 384 x t_{MCLK}) \\       01b = 128 (SINC3 OSR = 64, SINC1 OSR = 2, conversion time = 512 x t_{MCLK}) \\       10b = 256 (SINC3 OSR = 64, SINC1 OSR = 4, conversion time = 768 x t_{MCLK}) \\       11b = 512 (SINC3 OSR = 64, SINC1 OSR = 8, conversion time = 1280 x t_{MCLK}) \\       $

# 9.6.1.83 SPARE\_8Dh Register (Address = 8Dh) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-128. SPARE\_8Dh Register

15     14     13     12     11     10     9     8       RESERVED       R-0000000b       7     6     5     4     3     2     1     0       SPARE[7:0]       RW-0000000b												
R-0000000b           7         6         5         4         3         2         1         0           SPARE[7:0]		15	14	13	12	11	10	9	8			
7         6         5         4         3         2         1         0           SPARE[7:0]		RESERVED										
		R-0000000b										
	7 6 5 4 3 2 1 0							0				
PAN 0000000b		SPARE[7:0]										
144-0000000					R/W-000	00000b						

#### Table 9-109. SPARE\_8Dh Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:8	RESERVED	R	0000000b	Reserved Always reads 0000000b.
7:0	SPARE[7:0]	R/W	0000000b	Spare bits Provided as R/W bits as a means to check the register map section 2 CRC. Bit settings have no effect.



# 9.6.1.84 ADC2A\_OCAL Register (Address = 8Eh) [Reset = 0000h]

Return to the Summary Table.

## Figure 9-129. ADC2A\_OCAL Register

15	14	13	12	11	10	9	8		
OCAL2A[15:0]									
R/W-00000000000000b									
7 6 5 4 3 2 1 0							0		
OCAL2A[15:0]									
	R/W-0000000000000b								

#### Table 9-110. ADC2A\_OCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description		
15:0	OCAL2A[15:0]	R/W	000b	ADC2A offset calibration bits [15:0] Value provided in two's complement format. GAIN2A = 1: LSB size = (2 x VREFA) / 2 <sup>16</sup> GAIN2A = 2, 4: LSB size = (2 x VREFA) / (2 x 2 <sup>16</sup> )		



# 9.6.1.85 ADC2A\_GCAL Register (Address = 8Fh) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-130. ADC2A\_GCAL Register

15	14	13	12	11	10	9	8			
GCAL2A[15:0]										
R/W-0000000000000b										
7 6 5 4 3 2 1 0										
GCAL2A[15:0]										
	R/W-000000000000b									

#### Table 9-111. ADC2A\_GCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	GCAL2A[15:0]	R/W	00000000000000000000000000000000000000	ADC2A gain calibration bits [15:0] Value provided in two's complement format. LSB size = 1/2 <sup>16</sup> = 0.000015 Mapping: 0111111111111111 = 1.499985 000000000000000 = 1 = 1.000015 000000000000000 = 1 1111111111111111 = 0.999985 100000000000000 = 0.5



# 9.6.1.86 SEQ2A\_STEP0\_CFG Register (Address = 90h) [Reset = 0000h]

Return to the Summary Table.

Figure 9-131. SEQ2A_STEP0_CFG Register										
15	14	13	12	11	10	9	8			
SEQ2A_STEP0_EN	SEQ2A_STEF	0_GAIN[1:0]			RESERVED					
R/W-0b	R/W-0b R/W-00b			R-0000000b						
7	6	5	4	3	2	1	0			
	RESERVED		SEQ2A_STEP0_CH_ N	STEP0_CH_ SEQ2A_STEP0_CH_P[3:0] N						
	R-0000000b		R/W-0b		R/W-0	000b				

# Table 9-112. SEQ2A\_STEP0\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description			
15	SEQ2A_STEP0_EN	R/W	Ob	ADC2A sequence step 0 enable Enables sequence step 0 of the ADC2A sequencer. 0b = Disabled 1b = Enabled			
14:13	SEQ2A_STEP0_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 0 gain selection Selects the gain of ADC2A for sequence step 0. 00b = 1 01b = 2 10b = 4 11b = 4			
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.			
4	SEQ2A_STEP0_CH_N	R/W	Ob	ADC2A sequence step 0 negative input channel selection Selects the negative ADC2A analog input for sequence step 0. 0b = AGNDA 1b = V7A			
3:0	SEQ2A_STEP0_CH_P[3:0]	RW	0000b	ADC2A sequence step 0 positive input channel selection Selects the positive ADC2A analog input for sequence step 0. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP0_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V1A 0010b = V2A 0011b = V3A 0100b = V4A 0101b = V5A 0100b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1100b = AVDD/4 (negative ADC input is automatically selected) 1110b = AVDD/4 (negative ADC input is automatically selected) 1110b = AVVRP/103 (negative ADC input is automatically selected) 1111b = DVWR/103 (negative ADC input is automatically selected)			



# 9.6.1.87 SEQ2A\_STEP1\_CFG Register (Address = 91h) [Reset = 0001h]

Return to the Summary Table.

# Figure 9-132. SEQ2A\_STEP1\_CFG Register

15	14	13	12	11	10	9	8			
SEQ2A_STEP1_EN	SEQ2A_STEP	21_GAIN[1:0]		RESERVED						
R/W-0b	R/W-0b R/W-00b			R-0000000b						
7	6	5	4	3	2	1	0			
RESERVED			SEQ2A_STEP1_CH_ N	. SEQ2A_STEP1_CH_P[3:0]						
R-0000000b			R/W-0b	R/W-0001b						

#### Table 9-113. SEQ2A\_STEP1\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP1_EN	R/W	ОЬ	ADC2A sequence step 1 enable Enables sequence step 1 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP1_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 1 gain selection Selects the gain of ADC2A for sequence step 1. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP1_CH_N	R/W	ОЬ	ADC2A sequence step 1 negative input channel selection Selects the negative ADC2A analog input for sequence step 1. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP1_CH_P[3:0]	RW	0001b	ADC2A sequence step 1 positive input channel selection Selects the positive ADC2A analog input for sequence step 1. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP1_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0100b = V2A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Temperature sensor A (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1101b = IVDD/4 (negative ADC input is automatically selected) 1101b = DVDD/2 (negative ADC input is automatically selected) 1110b = DPWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.88 SEQ2A\_STEP2\_CFG Register (Address = 92h) [Reset = 0002h]

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Figure 9-133. SEQ2A_STEP2_CFG Register							
15	14	13	12	11	10	9	8
SEQ2A_STEP2_EN	SEQ2A_STEP2_GAIN[1:0]				RESERVED		·
R/W-0b	R/W-00b				R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2A_STEP2_CH_ N		SEQ2A_STEP	2_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-0	010b	

#### Table 9-114. SEQ2A\_STEP2\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP2_EN	R/W	Ob	ADC2A sequence step 2 enable Enables sequence step 2 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP2_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 2 gain selection Selects the gain of ADC2A for sequence step 2. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP2_CH_N	R/W	Ob	ADC2A sequence step 2 negative input channel selection Selects the negative ADC2A analog input for sequence step 2. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP2_CH_P[3:0]	R/W	0010Ь	ADC2A sequence step 2 positive input channel selection Selects the positive ADC2A analog input for sequence step 2. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP2_CH_N bit has no effect. 0000b = V0A 001b = V1A 0010b = V2A 0010b = V2A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1101b = DVDD/2 (negative ADC input is automatically selected) 1101b = DVDD/2 (negative ADC input is automatically selected) 1110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.89 SEQ2A\_STEP3\_CFG Register (Address = 93h) [Reset = 0003h]

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## Figure 9-134. SEQ2A\_STEP3\_CFG Register

15	14	13	12	11	10	9	8		
SEQ2A_STEP3_EN	SEQ2A_STEP	3_GAIN[1:0]		RESERVED					
R/W-0b	R/W-00b				R-0000000b				
7	6 5		4	3	2	1	0		
	RESERVED				SEQ2A_STEP:	3_CH_P[3:0]			
	R-0000000b	R/W-0b		R/W-00	)11b				

#### Table 9-115. SEQ2A\_STEP3\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP3_EN	R/W	Ob	ADC2A sequence step 3 enable Enables sequence step 3 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP3_GAIN[1:0]	R/W	00b	ADC2A sequence step 3 gain selection Selects the gain of ADC2A for sequence step 3. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP3_CH_N	R/W	Ob	ADC2A sequence step 3 negative input channel selection Selects the negative ADC2A analog input for sequence step 3. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP3_CH_P[3:0]	R/W	00116	ADC2A sequence step 3 positive input channel selection Selects the positive ADC2A analog input for sequence step 3. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP3_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V1A 0010b = V4A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1001b = Test DAC B (negative ADC input is automatically selected) 1001b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1100b = APWR/103 (negative ADC input is automatically selected) 1111b = DVDM/103 (negative ADC input is automatically selected)



# 9.6.1.90 SEQ2A\_STEP4\_CFG Register (Address = 94h) [Reset = 0004h]

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Figure 9-135. SEQ2A_STEP4_CFG Register								
15	14	13	12	11	10	9	8	
SEQ2A_STEP4_EN	SEQ2A_STEP4_GAIN[1:0]			RESERVED				
R/W-0b	R/W-00b				R-0000000b			
7	6	5	4	3	2	1	0	
RESERVED		SEQ2A_STEP4_CH_ N		SEQ2A_STEP	4_CH_P[3:0]			
	R-0000000b		R/W-0b		R/W-0	100b		

# Table 9-116. SEQ2A\_STEP4\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP4_EN	R/W	ОЬ	ADC2A sequence step 4 enable Enables sequence step 4 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP4_GAIN[1:0]	R/W	00b	ADC2A sequence step 4 gain selection Selects the gain of ADC2A for sequence step 4. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP4_CH_N	R/W	ОЬ	ADC2A sequence step 4 negative input channel selection Selects the negative ADC2A analog input for sequence step 4. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP4_CH_P[3:0]	R/W	01005	ADC2A sequence step 4 positive input channel selection Selects the positive ADC2A analog input for sequence step 4. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP4_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0010b = V2A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1110b = DVDD/2 (negative ADC input is automatically selected) 1110b = DPWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.91 SEQ2A\_STEP5\_CFG Register (Address = 95h) [Reset = 0005h]

Return to the Summary Table.

# Figure 9-136. SEQ2A\_STEP5\_CFG Register

15	14	13	12	11	10	9	8	
SEQ2A_STEP5_EN	SEQ2A_STEP	25_GAIN[1:0]	RESERVED					
R/W-0b	R/W-	00b	R-0000000b					
7	6 5		4	3	2	1	0	
	RESERVED				SEQ2A_STEP	25_CH_P[3:0]		
	R-0000000b				R/W-0	101b		

#### Table 9-117. SEQ2A\_STEP5\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP5_EN	R/W	Ob	ADC2A sequence step 5 enable Enables sequence step 5 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP5_GAIN[1:0]	R/W	00b	ADC2A sequence step 5 gain selection Selects the gain of ADC2A for sequence step 5. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 00000000b.
4	SEQ2A_STEP5_CH_N	R/W	0b	ADC2A sequence step 5 negative input channel selection Selects the negative ADC2A analog input for sequence step 5. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP5_CH_P[3:0]	R/W	0101Ь	ADC2A sequence step 5 positive input channel selection Selects the positive ADC2A analog input for sequence step 5. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP5_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V1A 0010b = V4A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1001b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1100b = APWR/103 (negative ADC input is automatically selected) 1111b = DVDM/103 (negative ADC input is automatically selected)



# 9.6.1.92 SEQ2A\_STEP6\_CFG Register (Address = 96h) [Reset = 0006h]

Return to the Summary Table.

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		i iguio e			rtogiotoi		
15	14 13		12	11	10	9	8
SEQ2A_STEP6_EN	SEQ2A_STEP	SEQ2A_STEP6_GAIN[1:0]		RESERVED			
R/W-0b	R/W-	R/W-00b			R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2A_STEP6_CH_ N		SEQ2A_STEF	P6_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-0	110b	

# Figure 9-137. SEQ2A\_STEP6\_CFG Register

#### Table 9-118. SEQ2A\_STEP6\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP6_EN	R/W	0b	ADC2A sequence step 6 enable Enables sequence step 6 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP6_GAIN[1:0]	R/W	00ь	ADC2A sequence step 6 gain selection Selects the gain of ADC2A for sequence step 6. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP6_CH_N	R/W	Ob	ADC2A sequence step 6 negative input channel selection Selects the negative ADC2A analog input for sequence step 6. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP6_CH_P[3:0]	RW	0110b	ADC2A sequence step 6 positive input channel selection Selects the positive ADC2A analog input for sequence step 6. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP6_CH_N bit has no effect. 0000b = V0A 001b = V1A 001b = V2A 001b = V2A 010b = V4A 010b = V4A 010b = V4A 010b = Temperature sensor A (negative ADC input is automatically selected) 100b = Temperature sensor A (negative ADC input is automatically selected) 100b = Temperature sensor A (negative ADC input is automatically selected) 100b = Test DAC B (negative ADC input is automatically selected) 101b = Test DAC B (negative ADC input is automatically selected) 101b = Test DAC B (negative ADC input is automatically selected) 101b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 111b = DVDD/2 (negative ADC input is automatically selected) 111b = DPWR/103 (negative ADC input is automatically selected) 111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.93 SEQ2A\_STEP7\_CFG Register (Address = 97h) [Reset = 0007h]

Return to the Summary Table.

#### Figure 9-138. SEQ2A\_STEP7\_CFG Register

15	14	13	12	11	10	9	8	
SEQ2A_STEP7_EN	SEQ2A_STEP	97_GAIN[1:0]	RESERVED					
R/W-0b	R/W-	00b			R-0000000b			
7	6	6 5		3	2	1	0	
	RESERVED	SEQ2A_STEP7_CH_ N		SEQ2A_STEP	7_CH_P[3:0]			
	R-0000000b		R/W-0b	R/W-0111b				

#### Table 9-119. SEQ2A\_STEP7\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP7_EN	R/W	Ob	ADC2A sequence step 7 enable Enables sequence step 7 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP7_GAIN[1:0]	R/W	00ь	ADC2A sequence step 7 gain selection Selects the gain of ADC2A for sequence step 7. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP7_CH_N	R/W	Ob	ADC2A sequence step 7 negative input channel selection Selects the negative ADC2A analog input for sequence step 7. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP7_CH_P[3:0]	R/W	0111Ь	ADC2A sequence step 7 positive input channel selection Selects the positive ADC2A analog input for sequence step 7. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP7_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V1A 0010b = V4A 0100b = V4A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1011b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1110b = AVPWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.94 SEQ2A\_STEP8\_CFG Register (Address = 98h) [Reset = 0008h]

Return to the Summary Table.

		i iguio o			rtogiotoi		
15	14	13	12	11	10	9	8
SEQ2A_STEP8_EN	SEQ2A_STEP	SEQ2A_STEP8_GAIN[1:0]		RESERVED			
R/W-0b	R/W-	R/W-00b			R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2A_STEP8_CH_ N		SEQ2A_STEF	28_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-1	000b	

# Figure 9-139. SEQ2A\_STEP8\_CFG Register

#### Table 9-120. SEQ2A\_STEP8\_CFG Register Field Descriptions

		-120. 010		CFG Register Field Descriptions
Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP8_EN	R/W	Ob	ADC2A sequence step 8 enable Enables sequence step 8 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP8_GAIN[1:0]	R/W	00ь	ADC2A sequence step 8 gain selection Selects the gain of ADC2A for sequence step 8. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP8_CH_N	R/W	Ob	ADC2A sequence step 8 negative input channel selection Selects the negative ADC2A analog input for sequence step 8. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP8_CH_P[3:0]	R/W	1000Ь	ADC2A sequence step 8 positive input channel selection Selects the positive ADC2A analog input for sequence step 8. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP8_CH_N bit has no effect. 0000b = V0A 001b = V1A 0010b = V2A 0011b = V3A 0101b = V3A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1011b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 110b = IOVDD/4 (negative ADC input is automatically selected) 1101b = DVDD/2 (negative ADC input is automatically selected) 1110b = APWR/103 (negative ADC input is automatically selected) 1111b = DVDR/103 (negative ADC input is automatically selected)



#### 9.6.1.95 SEQ2A\_STEP9\_CFG Register (Address = 99h) [Reset = 0009h]

Return to the Summary Table.

#### Figure 9-140. SEQ2A\_STEP9\_CFG Register

15	14	13	12	11	10	9	8	
SEQ2A_STEP9_EN	SEQ2A_STEP	P9_GAIN[1:0]	RESERVED					
R/W-0b	R/W-	-00b			R-0000000b			
7	6	6 5		3	2	1	0	
	RESERVED		SEQ2A_STEP9_CH_ N		SEQ2A_STEP	9_CH_P[3:0]		
	R-0000000b		R/W-0b		R/W-1	001b		

#### Table 9-121. SEQ2A\_STEP9\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP9_EN	R/W	ОЬ	ADC2A sequence step 9 enable Enables sequence step 9 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP9_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 9 gain selection Selects the gain of ADC2A for sequence step 9. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP9_CH_N	R/W	ОЬ	ADC2A sequence step 9 negative input channel selection Selects the negative ADC2A analog input for sequence step 9. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP9_CH_P[3:0]	R/W	1001b	ADC2A sequence step 9 positive input channel selection Selects the positive ADC2A analog input for sequence step 9. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP9_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0010b = V2A 0010b = V3A 0100b = V4A 0100b = V4A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 1110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.96 SEQ2A\_STEP10\_CFG Register (Address = 9Ah) [Reset = 000Ah]

Return to the Summary Table.

Figure 9-141. SEQ2A_STEP10_CFG Register								
15	14	13	12	11	10	9	8	
SEQ2A_STEP10_EN	SEQ2A_STEP10_GAIN[1:0]			RESERVED				
R/W-0b	R/W-	R/W-00b			R-0000000b			
7	6	5	4	3	2	1	0	
RESERVED		SEQ2A_STEP10_CH _N		SEQ2A_STEP	10_CH_P[3:0]			
	R-0000000b		R/W-0b		R/W-1	010b		

#### Table 9-122. SEQ2A\_STEP10\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP10_EN	R/W	Ob	ADC2A sequence step 10 enable Enables sequence step 10 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP10_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 10 gain selection Selects the gain of ADC2A for sequence step 10. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP10_CH_N	R/W	Ob	ADC2A sequence step 10 negative input channel selection Selects the negative ADC2A analog input for sequence step 10. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP10_CH_P[3:0]	R/W	1010Ь	ADC2A sequence step 10 positive input channel selection Selects the positive ADC2A analog input for sequence step 10. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP10_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0011b = V3A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 110b = IOVDD/4 (negative ADC input is automatically selected) 110b = AVVDD/4 (negative ADC input is automatically selected) 110b = AVVDD/4 (negative ADC input is automatically selected) 1110b = AVWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.97 SEQ2A\_STEP11\_CFG Register (Address = 9Bh) [Reset = 000Bh]

Return to the Summary Table.

Figure 9-142. SEQ2A_STEP11_CFG Register								
15	14	13	12	11	10	9	8	
SEQ2A_STEP11_EN	SEQ2A_STEP11_GAIN[1:0]				RESERVED			
R/W-0b	R/W-	R/W-00b			R-0000000b			
7	6	5	4	3	2	1	0	
RESERVED		SEQ2A_STEP11_CH _N		SEQ2A_STEP	11_CH_P[3:0]			
	R-0000000b		R/W-0b		R/W-1	011b		

#### Table 9-123. SEQ2A\_STEP11\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP11_EN	R/W	Ob	ADC2A sequence step 11 enable Enables sequence step 11 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP11_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 11 gain selection Selects the gain of ADC2A for sequence step 11. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP11_CH_N	R/W	Ob	ADC2A sequence step 11 negative input channel selection Selects the negative ADC2A analog input for sequence step 11. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP11_CH_P[3:0]	R/W	1011b	ADC2A sequence step 11 positive input channel selection Selects the positive ADC2A analog input for sequence step 11. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP11_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0011b = V3A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1001b = Test DAC B (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1101b = AVDD/4 (negative ADC input is automatically selected) 1110b = AVWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.98 SEQ2A\_STEP12\_CFG Register (Address = 9Ch) [Reset = 000Ch]

Return to the Summary Table.

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	Figure 9-143. SEQ2A_STEP12_CFG Register						
15	14	13	12	11	10	9	8
SEQ2A_STEP12_EN	SEQ2A_STEP	12_GAIN[1:0]			RESERVED		
R/W-0b	R/W-	00b			R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2A_STEP12_CH _N		SEQ2A_STEP	12_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-1	100b	

#### Table 9-124. SEQ2A\_STEP12\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP12_EN	R/W	Ob	ADC2A sequence step 12 enable Enables sequence step 12 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP12_GAIN[1:0]	R/W	00b	ADC2A sequence step 12 gain selection Selects the gain of ADC2A for sequence step 12. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP12_CH_N	R/W	Ob	ADC2A sequence step 12 negative input channel selection Selects the negative ADC2A analog input for sequence step 12. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP12_CH_P[3:0]	R/W	1100b	ADC2A sequence step 12 positive input channel selection Selects the positive ADC2A analog input for sequence step 12. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP12_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0011b = V3A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 110b = IOVDD/4 (negative ADC input is automatically selected) 110b = AVVD/4 (negative ADC input is automatically selected) 110b = AVVD/4 (negative ADC input is automatically selected) 1110b = AVVD/4 (negative ADC input is automatically selected) 1110b = AVWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.99 SEQ2A\_STEP13\_CFG Register (Address = 9Dh) [Reset = 000Dh]

Return to the Summary Table.

Figure 9-144. SEQ2A_STEP13_CFG Register							
15	14	13	12	11	10	9	8
SEQ2A_STEP13_EN	SEQ2A_STER	P13_GAIN[1:0]			RESERVED		
R/W-0b	R/W-00b				R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2A_STEP13_CH _N		SEQ2A_STEP	13_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-1	101b	

#### Table 9-125. SEQ2A\_STEP13\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP13_EN	R/W	Ob	ADC2A sequence step 13 enable Enables sequence step 13 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP13_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 13 gain selection Selects the gain of ADC2A for sequence step 13. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP13_CH_N	R/W	ОЬ	ADC2A sequence step 13 negative input channel selection Selects the negative ADC2A analog input for sequence step 13. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP13_CH_P[3:0]	R/W	1101b	ADC2A sequence step 13 positive input channel selection Selects the positive ADC2A analog input for sequence step 13. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP13_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V4A 0010b = V4A 0101b = V5A 0110b = V6A 0110b = V6A 0110b = V6A 0111b = V7A 1000b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1100b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



### 9.6.1.100 SEQ2A\_STEP14\_CFG Register (Address = 9Eh) [Reset = 000Eh]

Return to the Summary Table.

	Figure 9-145. SEQ2A_STEP14_CFG Register						
15	14	13	12	11	10	9	8
SEQ2A_STEP14_EN	SEQ2A_STEP	14_GAIN[1:0]			RESERVED		
R/W-0b	R/W-	00b			R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2A_STEP14_CH _N		SEQ2A_STEP	14_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-1	110b	

#### Table 9-126. SEQ2A\_STEP14\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP14_EN	R/W	Ob	ADC2A sequence step 14 enable Enables sequence step 14 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP14_GAIN[1:0]	R/W	00b	ADC2A sequence step 14 gain selection Selects the gain of ADC2A for sequence step 14. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000ь	Reserved Always reads 0000000b.
4	SEQ2A_STEP14_CH_N	R/W	Ob	ADC2A sequence step 14 negative input channel selection Selects the negative ADC2A analog input for sequence step 14. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP14_CH_P[3:0]	R/W	1110b	ADC2A sequence step 14 positive input channel selection Selects the positive ADC2A analog input for sequence step 14. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP14_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0011b = V3A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1011b = Test DAC B (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1101b = AVDD/4 (negative ADC input is automatically selected) 1110b = AVWR/103 (negative ADC input is automatically selected) 1111b = DVWR/103 (negative ADC input is automatically selected)



# 9.6.1.101 SEQ2A\_STEP15\_CFG Register (Address = 9Fh) [Reset = 000Fh]

Return to the Summary Table.

#### Figure 9-146. SEQ2A\_STEP15\_CFG Register

15	14	13	12	11	10	9	8		
SEQ2A_STEP15_EN	SEQ2A_STEF	SEQ2A_STEP15_GAIN[1:0]		RESERVED					
R/W-0b	R/W	R/W-00b			R-0000000b				
7	6	5	4	3	2	1	0		
	RESERVED		SEQ2A_STEP15_CH _N		SEQ2A_STEP	15_CH_P[3:0]			
	R-0000000b		R/W-0b		R/W-1	111b			

#### Table 9-127. SEQ2A\_STEP15\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2A_STEP15_EN	R/W	ОЬ	ADC2A sequence step 15 enable Enables sequence step 15 of the ADC2A sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2A_STEP15_GAIN[1:0]	R/W	00Ь	ADC2A sequence step 15 gain selection Selects the gain of ADC2A for sequence step 15. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2A_STEP15_CH_N	R/W	ОЬ	ADC2A sequence step 15 negative input channel selection Selects the negative ADC2A analog input for sequence step 15. 0b = AGNDA 1b = V7A
3:0	SEQ2A_STEP15_CH_P[3:0]	RW	1111b	ADC2A sequence step 15 positive input channel selection Selects the positive ADC2A analog input for sequence step 15. For settings where the negative ADC input is automatically selected, the SEQ2A_STEP15_CH_N bit has no effect. 0000b = V0A 0001b = V1A 0010b = V2A 0100b = V4A 0101b = V3A 0100b = V4A 0101b = V5A 0110b = V6A 0111b = V7A 1000b = Temperature sensor A (negative ADC input is automatically selected) 1001b = Internal short to AGNDA, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = Test DAC B (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 1110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



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# 9.6.1.102 ADC3A\_CFG Register (Address = A0h) [Reset = 8010h]

Return to the Summary Table.

	Figure 9-147. ADC3A_CFG Register							
15	14	13	12	11	10	9	8	
ADC3A_EN	ADC3A_EN RESERVED				A[1:0]	MUX34	<b>\</b> [1:0]	
R/W-1b	R/W-1b R-000b		R/W-	-00b	R/W-	00b		
7	6	5	4	3	2	1	0	
RESERVED		OWD3A_SOURCE_ MUX	OWD3A_SINK_MUX	OWD3A_SOUR	CE_VALUE[1:0]	OWD3A_SINK	_VALUE[1:0]	
R-0	00b	R/W-0b	R/W-1b	R/W-	-00b	R/W-	00b	

# Table 9-128. ADC3A\_CFG Register Field Descriptions Type Reset Description

Bit	Field	Туре	Reset	Description
15	ADC3A_EN	R/W	1b	ADC3A enable Enables ADC3A. The conversion data of ADC3A reset to 000000h when ADC3A is disabled or when the device is put in standby or power-down mode. If both ADC1A and ADC3A are disabled, then the conversion counter CONV1A_COUNT[1:0] resets to 00b. 0b = Disabled 1b = Enabled
14:12	RESERVED	R	000b Reserved Always reads 000b.	
11:10	GAIN3A[1:0]	R/W	00b	ADC3A gain selection Selects the gain (FSR = full scale range) of ADC3A. 00b = 1 01b = 2 10b = 4 11b = 4
9:8	MUX3A[1:0]	R/W	00Ь	ADC3A multiplexer channel selection Selects the multiplexer channel for ADC3A. 00b = AINp = VPA, AINn = VNA 01b = AINp = VNA, AINn = VPA 10b = Internal short to AGNDA. Analog inputs VPA, VNA disconnected from ADC3A. 11b = Test DAC B output
7:6	RESERVED	R	00Ь	Reserved Always reads 00b.
5	OWD3A_SOURCE_MUX	R/W	0ь	ADC3A current source multiplexer selection Selects the multiplexer channel for the ADC3A current source. 0b = VPA 1b = VNA
4	OWD3A_SINK_MUX	R/W	1b	ADC3A current sink multiplexer selection Selects the multiplexer channel for the ADC3A current sink. 0b = VPA 1b = VNA
3:2	OWD3A_SOURCE_VALUE[1:0]	R/W	00b	ADC3A current source value selection Selects the current value for the ADC3A current source. 00b = Off 01b = 4 µA 10b = 40 µA 11b = 240 µA
1:0	OWD3A_SINK_VALUE[1:0]	R/W	00ь	ADC3A current sink value selection Selects the current value for the ADC3A current sink. 00b = Off 01b = 4 µA 10b = 40 µA 11b = 240 µA

# 9.6.1.103 ADC3A\_OCAL\_MSB Register (Address = A1h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-148. ADC3A\_OCAL\_MSB Register

15	14	13	12	11	10	9	8	
			OCAL	3A[23:8]				
			R/W-000000	000000000b				
7	6	5	4	3	2	1	0	
	OCAL3A[23:8]							
	R/W-000000000000000000000000000000000000							

#### Table 9-129. ADC3A\_OCAL\_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCAL3A[23:8]	R/W	000b	ADC3A offset calibration bits [23:8] Value provided in two's complement format. LSB size = (2 x VREFA) / (GAIN3A x 2 <sup>24</sup> )



# 9.6.1.104 ADC3A\_OCAL\_LSB Register (Address = A2h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-149. ADC3A\_OCAL\_LSB Register

15	14	13	12	11	10	9	8
	OCAL3A[7:0]						
	R/W-0000000b						
7	6	5	4	3	2	1	0
	RESERVED						
	R-0000000b						

# Table 9-130. ADC3A\_OCAL\_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:8	OCAL3A[7:0]	R/W	0000000ь	ADC3A offset calibration bits [7:0] Value provided in two's complement format. LSB size = (2 x VREFA) / (GAIN3A x 2 <sup>24</sup> )
7:0	RESERVED	R	0000000ь	Reserved Always reads 0000000b.

# 9.6.1.105 ADC3A\_GCAL Register (Address = A3h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-150. ADC3A\_GCAL Register

15	14	13	12	11	10	9	8	
	GCAL3A[15:0]							
	R/W-000000000000b							
7	6	5	4	3	2	1	0	
	GCAL3A[15:0]							
	R/W-0000000000000b							

#### Table 9-131. ADC3A\_GCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	GCAL3A[15:0]	R/W	000b	ADC3A gain calibration bits [15:0] Value provided in two's complement format. LSB size = 1/2 <sup>16</sup> = 0.000015 Mapping: 0111111111111111 = 1.499985 000000000000000 = 1 = 1.000015 000000000000000 = 1 1111111111111111 = 0.999985 100000000000000 = 0.5



# 9.6.1.106 REGISTER\_MAP2\_CRC Register (Address = BEh) [Reset = 0000h]

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#### Figure 9-151. REGISTER\_MAP2\_CRC Register

14	13	12	11	10	9	8	
REG_MAP2_CRC_VALUE[15:0]							
R/W-000000000000000000000000000000000000							
6	5	4	3	2	1	0	
REG_MAP2_CRC_VALUE[15:0]							
		R/W-000000	000000000b				
	6	14 13 6 5	REG_MAP2_Cf           R/W-000000           6         5         4           REG_MAP2_Cf           REG_MAP2_Cf	REG_MAP2_CRC_VALUE[15:0]           RW-000000000000b           6         5         4         3	REG_MAP2_CRC_VALUE[15:0]           RW-0000000000000b           6         5         4         3         2           REG_MAP2_CRC_VALUE[15:0]	REG_MAP2_CRC_VALUE[15:0]           RW-000000000000000000000000000000000000	

#### Table 9-132. REGISTER\_MAP2\_CRC Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	REG_MAP2_CRC_VALUE[15:0]	R/W	000000000000 000b	Register map CRC value for section 2 Register map CRC value for section 2.



### 9.6.1.107 REGMAP3\_TDACB\_CFG Register (Address = C0h) [Reset = 0000h]

#### Return to the Summary Table.

### Figure 9-152. REGMAP3\_TDACB\_CFG Register

15	14	13	12	11	10	9	8
REG_MAP3_CRC_E N				RESERVED			
R/W-0b				R-00000000000b			
7	6	5	4	3	2	1	0
		RESERVED			TDACB_VALUE[2:0]		
		R-00000000000b			R/W-000b		

#### Table 9-133. REGMAP3\_TDACB\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	REG_MAP3_CRC_EN	R/W	0b	Register map section 3 CRC enable Enables the register map CRC for section 3 (register address space from C0h to E3h). 0b = Disabled 1b = Enabled
14:3	RESERVED	R	00000000000b	Reserved Always reads 00000000000b.
2:0	TDACB_VALUE[2:0]	R/W	000b	Test DAC B output value Selects the output value of Test DAC B. 000b = 1 x VREFBI40 001b = 2 x VREFBI40 010b = 4 x VREFBI40 100b = 18 x VREFBI40 100b = 18 x VREFBI40 110b = -4 x VREFBI40 111b = -9 x VREFBI40



# 9.6.1.108 GPIOB\_CFG Register (Address = C1h) [Reset = 0000h]

Return to the Summary Table.

	Figure 9-153. GPIOB_CFG Register						
15	14	13	12	11	10	9	8
GPIOB_PIN_CFG		SPARE[2:0]		GPIO1B_FMT	GPIO0B_FMT	GPIO1B_DIR	GPIO0B_DIR
R/W-0b	·	R/W-000b		R/W-0b	R/W-0b	R/W-0b	R/W-0b
7	6	5	4	3	2	1	0
GPIO1B_P	GPIO1B_PWM_TB[1:0] GPIO0B_PWM_TB[1:0]		SPARE[1:0]		GPO1B_DAT	GPO0B_DAT	
R/W	/-00b	R/W-00b		R/W-00b		R/W-0b	R/W-0b

#### Table 9-134. GPIOB\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	GPIOB_PIN_CFG	R/W	ОЬ	VPB/GPI00B and VNB/GPI01B pin function selection Configures both the VPB/GPI00B and VNB/GPI01B pins as analog inputs or GPI0s. Disable ADC3B (ADC3B_EN = 0b) when these pins are configured as GPI0s. Setting of the GPI0B_PIN_CFG bit is ignored and inputs are forced to analog inputs when ADC3B_EN = 1b. 0b = Analog input 1b = GPI0
14:12	SPARE[2:0]	R/W	000Ь	Spare bits Provided as R/W bits as a means to check the register map section 2 CRC. Bit settings have no effect.
11	GPI01B_FMT	R/W	ОЬ	GPI01B format Configures GPI01B for static input and output levels or for PWM input levels. 0b = When GPI01B is configured as a digital input: Logic levels are based on static input levels. When GPI01B is configured as a digital output: Output with static output levels. 1b = When GPI01B is configured as a digital input: Logic levels are based on PWM input decoding. When GPI01B is configured as a digital output: Output with static output levels. GPI01B does not have PWM output capability.
10	GPIO0B_FMT	R/W	ОЬ	GPIO0B format Configures GPIO0B for static input and output levels or for PWM input levels. 0b = When GPIO0B is configured as a digital input: Logic levels are based on static input levels. When GPIO0B is configured as a digital output: Output with static output levels. 1b = When GPIO0B is configured as a digital input: Logic levels are based on PWM input decoding. When GPIO0B is configured as a digital output: Output with static output levels. GPIO0B does not have PWM output capability.
9	GPIO1B_DIR	R/W	Ob	GPI01B direction Configures GPI01B as a digital input or digital output. 0b = Digital input 1b = Digital output
8	GPIO0B_DIR	R/W	Ob	GPIO0B direction Configures GPIO0B as a digital input or digital output. 0b = Digital input 1b = Digital output
7:6	GPIO1B_PWM_TB[1:0]	R/W	00Ь	$ \begin{array}{l} \label{eq:GPIO1B PWM time base selection} \\ \mbox{Selects the time base used for the PWM encoder when GPIO1B is configured as a digital input. \\ \mbox{00b} = 16 \times t_{MCLK} (= 1/512 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{01b} = 64 \times t_{MCLK} (= 1/128 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{10b} = 256 \times t_{MCLK} (= 1/32 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} = 1.18 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} = 1.18 \mbox{ kHz for } f_{MCLK} $
5:4	GPIO0B_PWM_TB[1:0]	R/W	00Ь	$ \begin{array}{l} \label{eq:GPIO0B PWM time base selection} \\ \mbox{Selects the time base used for the PWM encoder when GPIO0B is configured as a digital input. \\ \mbox{00b} = 16 \times t_{MCLK} (= 1/512 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{01b} = 64 \times t_{MCLK} (= 1/128 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{10b} = 256 \times t_{MCLK} (= 1/32 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} (= 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} = 1/8 \mbox{ kHz for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 1024 \times t_{MCLK} = 1/8 \mbox{ kHz for } f_{MCLK} = 1/8 \mbox{ kHz for } f$
3:2	SPARE[1:0]	R/W	00ь	Spare bits Provided as R/W bits as a means to check the register map section 2 CRC. Bit settings have no effect.
1	GP01B_DAT	R/W	Ob	GPIO1B output data Output value of GPIO1B when configured as an output. Bit setting has not effect when GPIO1B is configured as a digital or analog input. 0b = Low 1b = High
0	GPO0B_DAT	R/W	Ob	GPIO0B output data Output value of GPIO0B when configured as an output. Bit setting has not effect when GPIO0B is configured as a digital or analog input. 0b = Low 1b = High



# 9.6.1.109 ADC1B\_ADC3B\_CFG Register (Address = C2h) [Reset = 0400h]

Return to the Summary Table.

#### Figure 9-154. ADC1B\_ADC3B\_CFG Register

15	14	13	12	11	10	9	8
	RESER	RVED		CONV_MODE13B		OSR13B[2:0]	
	R-00	00b		R/W-0b		R/W-100b	
7	6	5	4	3	2	1	0
RESERVED				GC13B_EN		GC13B_DELAY[2:0]	
	R-00	00b		R/W-0b		R/W-000b	

#### Table 9-135. ADC1B\_ADC3B\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:12	RESERVED	R	0000b	Reserved Always reads 0000b.
11	CONV_MODE13B	R/W	ОЬ	Conversion mode selection Selects the conversion mode for ADC1B and ADC3B. 0b = Continuous-conversion mode 1b = Single-shot conversion mode
10:8	OSR13B[2:0]	R/W	100b	Oversampling ratio selection Selects the oversampling ratio for ADC1B and ADC3B. The data rate calculates to $f_{MOD}$ / OSR. 000b = 64 001b = 128 010b = 256 011b = 512 100b = 1024 110b = 4096 111b = 8192
7:4	RESERVED	R	0000ь	Reserved Always reads 0000b.
3	GC13B_EN	R/W	Ob	Global-chop mode enable Enables the global-chop mode for ADC1B and ADC3B. 0b = Disabled 1b = Enabled
2:0	GC13B_DELAY[2:0]	R/W	000Ь	



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# 9.6.1.110 ADC1B\_CFG Register (Address = C3h) [Reset = 8010h]

Return to the Summary Table.

Figure 9-155. ADC1B_CFG Register									
15	14	13	12	11	10	9	8		
ADC1B_EN	C1B_EN RESERVED				GAIN1B[1:0]		3[1:0]		
R/W-1b		R-000b	R/W-00b		R/W-00b				
7	6	5	4	3	2	1	0		
RESERVED		OWD1B_SOURCE_ MUX	OWD1B_SINK_MUX	OWD1B_SOURCE_VALUE[1:0]		OWD1B_SINK_VALUE[1:0]			
R-I	00b	R/W-0b	R/W-1b	R/W	-00b	R/W-	00b		

#### Table 9-136. ADC1B\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description			
15	ADC1B_EN	R/W	1b	ADC1B enable Enables ADC1B. The conversion data of ADC1B reset to 000000h when ADC1B is disabled or when the device is put in standby or power-down mode. If both ADC1B and ADC3B are disabled, the the conversion counter CONV1B_COUNT[1:0] resets to 00b. 0b = Disabled 1b = Enabled			
14:12	RESERVED	R	000b	Reserved Always reads 000b.			
11:10	GAIN1B[1:0]	R/W	00b	ADC1B gain selection Selects the gain (FSR = full scale range) of ADC1B. Gains 16 and 32 are digital gains u analog gain = 8. 00b = 4 01b = 8 10b = 16 11b = 32 ADC1B multiplexer channel selection Selects the multiplexer channel for ADC1B.			
9:8	MUX1B[1:0]	R/W	00Ь	ADC1B multiplexer channel selection			
7:6	RESERVED	R	00b	Reserved Always reads 00b.			
5	OWD1B_SOURCE_MUX	R/W	Ob	ADC1B current source multiplexer selection Selects the multiplexer channel for the ADC1B current source. 0b = CPB 1b = CNB			
4	OWD1B_SINK_MUX	R/W	1b	ADC1B current sink multiplexer selection Selects the multiplexer channel for the ADC1B current sink. 0b = CPB 1b = CNB			
3:2	OWD1B_SOURCE_VALUE[1:0]	R/W	00Ь	ADC1B current source value selection Selects the current value for the ADC1B current source. 00b = Off 01b = 4 µA 10b = 40 µA 11b = 240 µA			
1:0	OWD1B_SINK_VALUE[1:0]	R/W	00b	ADC1B current sink value selection Selects the current value for the ADC1B current sink. 00b = Off 01b = 4 μA 10b = 40 μA 11b = 240 μA			

# 9.6.1.111 ADC1B\_OCAL\_MSB Register (Address = C4h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-156. ADC1B\_OCAL\_MSB Register

15	14	13	12	11	10	9	8		
OCAL1B[23:8]									
R/W-000000000000b									
7	6	5	4	3	2	1	0		
OCAL1B[23:8]									
	R/W-0000000000000b								

# Table 9-137. ADC1B\_OCAL\_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCAL1B[23:8]		000b	ADC1B offset calibration bits [23:8] Value provided in two's complement format. LSB size = (2 x VREFB) / (GAIN1B x 2 <sup>24</sup> )



#### 9.6.1.112 ADC1B\_OCAL\_LSB Register (Address = C5h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-157. ADC1B\_OCAL\_LSB Register

15	14	13	12	11	10	9	8		
OCAL1B[7:0]									
	R/W-0000000b								
7	6	5	4	3	2	1	0		
RESERVED									
	R-0000000b								

#### Table 9-138. ADC1B\_OCAL\_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:8	OCAL1B[7:0]	R/W	0000000b	ADC1B offset calibration bits [7:0] Value provided in two's complement format. LSB size = (2 x VREFB) / (GAIN1B x $2^{24}$ )
7:0	RESERVED	R	0000000b	Reserved Always reads 0000000b.

# 9.6.1.113 ADC1B\_GCAL Register (Address = C6h) [Reset = 0000h]

Return to the Summary Table.

# Figure 9-158. ADC1B\_GCAL Register

15	14	13	12	11	10	9	8		
GCAL1B[15:0]									
R/W-000000000000b									
7	6	5	4	3	2	1	0		
GCAL1B[15:0]									
	R/W-00000000000000b								

#### Table 9-139. ADC1B\_GCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	GCAL1B[15:0]	R/W	00000000000000000000000000000000000000	ADC1B gain calibration bits [15:0] Value provided in two's complement format. LSB size = 1/2 <sup>16</sup> = 0.000015 Mapping: 0111111111111111 = 1.499985 000000000000000 = 1 = 1.000015 000000000000000 = 1 1111111111111111 = 0.999985 100000000000000 = 0.5



# 9.6.1.114 OCCB\_CFG Register (Address = C7h) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-159. OCCB\_CFG Register 13 15 14 12 11 10 9 8 OCCB\_EN RESERVED OCCB\_NUM[4:0] OCCB\_POL R/W-0b R/W-0b R/W-0b R/W-00000b 7 6 5 3 2 0 4 1 RESERVED R-0000000b

Bit	Field	Туре	Reset	Description
15	OCCB_EN	R/W	ОЬ	ADC1B overcurrent comparator enable Enables the digital fast filter and digital comparator on ADC1B. ADC1B must be enabled to use the overcurrent comparator. The fast filter is not affected by the STARTB and STOPB bits. Ob = Disabled 1b = Enabled
14	OCCB_POL	R/W	Ob	OCCB pin polarity selection Selects the polarity of the OCCB pin. The actual output behavior of the GPIO4/OCCB pin, when configured as OCCB output in the GPIO4_SRC bit, depends on the GPIO4_FMT setting. An OCCB fault is active when any of the OCCB_HTn or OCCB_LTn bits are active. 0b = Active low. In case of a fault a logic low level is driven. 1b = Active high. In case of a fault a logic high level is driven.
13	RESERVED	R/W	0b	Reserved Always write 0b.
12:8	OCCB_NUM[4:0]	R/W	00000b	ADC1B overcurrent comparator deglitch filter selection Selects the number of conversions the output of the ADC1B digital fast filter must exceed the set high or low thresholds to trip the OCCB_ITn or OCCB_LTn comparator output. The fast filter path uses a SINC3 filter with a fixed OSR = 64. The counter starts again whenever the digital fast filter output falls below the threshold, means there is no hysteresis. 00000b = 1 00001b = 2 00010b = 3 00011b = 4 00100b = 5 00101b = 6 00110b = 7 00111b = 8 01000b = 9 01001b = 10 01010b = 12 01011b = 14 01100b = 12 01011b = 14 01100b = 16 01111b = 18 01110b = 20 01111b = 22 10000b = 24 10010b = 28 10011b = 32 10100b = 40 10110b = 56 10111b = 64 11100b = 72 11001b = 88 11011b = 96 11101b = 120 11111b = 128
7:0	RESERVED	R	0000000b	11111b = 128           Reserved           Always reads 0000000b.

#### Table 9-140. OCCB\_CFG Register Field Descriptions



# 9.6.1.115 OCCB\_HIGH\_THRESHOLD Register (Address = C8h) [Reset = 7FFFh]

Return to the Summary Table.

# Figure 9-160. OCCB\_HIGH\_THRESHOLD Register

15	14	13	12	11	10	9	8		
	OCCB_HIGH_TH[15:0]								
	R/W-0111111111111								
7	6	5	4	3	2	1	0		
	OCCB_HIGH_TH[15:0]								
	R/W-0111111111111								

#### Table 9-141. OCCB\_HIGH\_THRESHOLD Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCCB_HIGH_TH[15:0]	R/W	1b	ADC1B overcurrent comparator high threshold bits [15:0] Value provided in two's complement format. LSB size = (2 x VREFB) / (GAIN1B x 2 <sup>16</sup> ) Values larger than the high threshold trigger an OCCB_HTn event. Setting the value to +FS (= 7FFFh) disables the high threshold detection.



# 9.6.1.116 OCCB\_LOW\_THRESHOLD Register (Address = C9h) [Reset = 8000h]

Return to the Summary Table.

#### Figure 9-161. OCCB\_LOW\_THRESHOLD Register

15	14	13	12	11	10	9	8	
OCCB_LOW_TH[15:0]								
	R/W-10000000000b							
7	6	5	4	3	2	1	0	
	OCCB_LOW_TH[15:0]							
			R/W-100000	000000000b				

# Table 9-142. OCCB\_LOW\_THRESHOLD Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCCB_LOW_TH[15:0]	R/W	1000000000000 000b	ADC1B overcurrent comparator low threshold bits [15:0] Value provided in two's complement format. LSB size = (2 x VREFB) / (GAIN1B x 2 <sup>16</sup> ) Values smaller than the low threshold trigger an OCCB_LTn event. Setting the value to –FS (= 8000h) disables the low threshold detection.

# 9.6.1.117 SPARE\_CAh Register (Address = CAh) [Reset = 5555h]

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#### Figure 9-162. SPARE\_CAh Register

15	14	13	12	11	10	9	8			
	SPARE[15:0]									
	R/W-0101010101010101b									
7	6	5	4	3	2	1	0			
	SPARE[15:0]									
			R/W-010101	0101010101b						

#### Table 9-143. SPARE\_CAh Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	SPARE[15:0]	R/W	0101010101010 101b	Spare bits Provided as R/W bits as a means to check the register map section 3 CRC. Bit settings have no effect.



# 9.6.1.118 ADC2B\_CFG1 Register (Address = CBh) [Reset = 8010h]

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Figure 9-163. ADC2B_CFG1 Register										
15	14	13	12	11	10	9	8			
ADC2B_EN		RESE	RVED		VCMB_EN	OWD2B_SOU	RCE_MUX[2:0]			
R/W-1b		R-0	000b		R/W-0b	R/W-	000b			
7	6	5	4	3	2	1	0			
OWD2B_SOURCE_ MUX[2:0]		OWD2B_SINK_MUX[2:0	)]	OWD2B_SOUF	RCE_VALUE[1:0]	OWD2B_SIN	K_VALUE[1:0]			
R/W-000b		R/W-001b		R/M	V-00b	R/W	'-00b			

# Table 9-144. ADC2B\_CFG1 Register Field Descriptions Type Reset Description

Bit	Field	Туре	Reset	Description
15	ADC2B_EN	R/W	16	ADC2B enable Enables ADC2B. Only change settings of registers from address CCh to DFh of ADC2B when ADC2B is disabled. The conversion data of ADC2B reset to 0000h and the sequence counter SEQ2B_COUNT[1:0] resets to 00b when ADC2B is disabled or when the device is put in standby or power-down mode. 0b = Disabled 1b = Enabled
14:11	RESERVED	R	0000b	Reserved Always reads 0000b.
10	VCMB_EN	R/W	Ob	Common-mode output buffer VCMB enable Enables the common-mode output buffer VCMB on analog input V7B. 0b = Disabled 1b = Enabled
9:7	OWD2B_SOURCE_MUX[2:0]	R/W	000b	ADC2B current source multiplexer selection Selects the multiplexer channel for the ADC2B current source. 000b = V0B 010b = V1B 010b = V2B 011b = V3B 100b = V4B 101b = V5B 110b = V6B 111b = V7B
6:4	OWD2B_SINK_MUX[2:0]	R/W	001Ь	ADC2B current sink multiplexer selection Selects the multiplexer channel for the ADC2B current sink. 000b = V0B 010b = V1B 010b = V2B 011b = V3B 100b = V4B 101b = V5B 110b = V6B 111b = V7B
3:2	OWD2B_SOURCE_VALUE[1:0]	R/W	00ь	ADC2B current source value selection Selects the current value for the ADC2B current source. 00b = Off 01b = 4 µA 10b = 40 µA 11b = 240 µA
1:0	OWD2B_SINK_VALUE[1:0]	R/W	00ь	$\begin{array}{l} \text{ADC2B current sink value selection} \\ \text{Selects the current value for the ADC2B current sink.} \\ 00b = Off \\ 01b = 4 \ \mu\text{A} \\ 10b = 40 \ \mu\text{A} \\ 11b = 240 \ \mu\text{A} \end{array}$

# 9.6.1.119 ADC2B\_CFG2 Register (Address = CCh) [Reset = 0000h]

Return to the Summary Table.

### Figure 9-164. ADC2B\_CFG2 Register

15	14	13	12	11	10	9	8		
SEQ2B_	MODE[1:0]		RESERVED			MUX2B_DELAY[2:0]			
R/V	V-00b		R-000b		R/W-000b				
7	6	5	4	3	2	1	0		
	RESERVED OSR2B[1:0]								
R-00000b R/W-00b							-00b		

Bit	Field	Туре	Reset	Description
15:14	SEQ2B_MODE[1:0]	RW	00Ь	ADC2B sequencer mode selection Selects the way the ADC2B sequencer starts a new sequence. Setting the SEQ2B_START bit always aborts and restarts an ongoing sequence in all modes. 00b = Single-shot sequence mode based on SEQ2B_START bit (ADC2B runs one time through sequence after the SEQ2B_START bit is set) 01b = Single-shot sequence mode based on ADC1B conversion starts or SEQ2B_START bit. This setting is only useful when ADC1B is configured for continuous-conversion mode. Sequences are started at the falling edge of DRDYBn or when the SEQ2B_START bit is set. Conversion starts triggered by the DRDYBn signal are ignored, that is do not abort and restart a sequence, while a sequence is ongoing. 10b = Continuous sequence mode based on SEQ2B_START bit 11b = Continuous sequence mode based on SEQ2B_START bit
13:11	RESERVED	R	000Ь	Reserved Always reads 00b.
10:8	MUX2B_DELAY[2:0]	RW	000Ь	$ \begin{array}{l} \mbox{ADC2B multiplexer delay time selection} \\ \mbox{Selects the delay time before starting conversion on the next sequence step.} \\ \mbox{00b} = 16 x t_{MCLK} (= 2 \mbox{ korc}_{K} (= 8.192 \mbox{ MHz}) \\ \mbox{01b} = 64 x t_{MCLK} (= 7.8 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{01b} = 128 x t_{MCLK} (= 15.6 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{01b} = 512 x t_{MCLK} (= 31.2 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{10b} = 512 x t_{MCLK} (= 62.5 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{10b} = 1024 x t_{MCLK} (= 124.9 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 2048 x t_{MCLK} (= 249.9 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4096 x t_{MCLK} (= 499.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4006 x t_{MCLK} (= 409.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4006 x t_{MCLK} (= 409.7 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4006 x t_{MCLK} = 1000 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4006 x t_{MCLK} = 1000 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4000 \mbox{ \mus for } f_{MCLK} = 8.192 \mbox{ MHz}) \\ \mbox{11b} = 4000 \mbox{ ms for } f_{MCLK} = 1000 \mbox{ ms for } f_{MCLK} = 1000 \mbox{ ms for } f_{MCLK} = 1000 \mbox{ ms for } f_{MCLK} = 1000$
7:2	RESERVED	R	000000ь	Reserved Always reads 000000b.
1:0	OSR2B[1:0]	R/W	00Ь	$ \begin{array}{l} \text{ADC2B oversampling ratio selection} \\ \text{Selects the oversampling ratio for ADC2B.} \\ \text{O0b} = 64 (SINC3 OSR = 64, conversion time = 384 \times t_{MCLK}) \\ \text{O1b} = 128 (SINC3 OSR = 64, SINC1 OSR = 2, conversion time = 512 \times t_{MCLK}) \\ \text{10b} = 256 (SINC3 OSR = 64, SINC1 OSR = 4, conversion time = 768 \times t_{MCLK}) \\ \text{11b} = 512 (SINC3 OSR = 64, SINC1 OSR = 8, conversion time = 1280 \times t_{MCLK}) \\ \end{array} $

#### Table 9-145. ADC2B\_CFG2 Register Field Descriptions



# 9.6.1.120 SPARE\_CDh Register (Address = CDh) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-165. SPARE\_CDh Register

15	14	13	12	11	10	9	8		
RESERVED									
	R-0000000b								
7	6	5	4	3	2	1	0		
SPARE[7:0]									
			R/W-000	00000b					

#### Table 9-146. SPARE\_CDh Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:8	RESERVED	R	0000000b	Reserved Always reads 0000000b.
7:0	SPARE[7:0]	R/W	0000000b	Spare bits Provided as R/W bits as a means to check the register map section 3 CRC. Bit settings have no effect.

# 9.6.1.121 ADC2B\_OCAL Register (Address = CEh) [Reset = 0000h]

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# Figure 9-166. ADC2B\_OCAL Register

15	14	13	12	11	10	9	8			
OCAL2B[15:0]										
	R/W-0000000000000b									
7	6	5	4	3	2	1	0			
OCAL2B[15:0]										
			R/W-000000	0000000000b						

#### Table 9-147. ADC2B\_OCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCAL2B[15:0]	R/W	000b	ADC2B offset calibration bits [15:0] Value provided in two's complement format. GAIN2B = 1: LSB size = (2 x VREFB) / 2 <sup>16</sup> GAIN2B = 2, 4: LSB size = (2 x VREFB) / (2 x 2 <sup>16</sup> )



# 9.6.1.122 ADC2B\_GCAL Register (Address = CFh) [Reset = 0000h]

Return to the Summary Table.

#### Figure 9-167. ADC2B\_GCAL Register

15	14	13	12	11	10	9	8		
GCAL2B[15:0]									
R/W-000000000000b									
7	6	5	4	3	2	1	0		
GCAL2B[15:0]									
			R/W-000000	000000000b					
7	6	5	4 GCAL2	3 2B[15:0]	2	1			

# Table 9-148. ADC2B\_GCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	GCAL2B[15:0]	R/W	00000000000000000000000000000000000000	ADC2B gain calibration bits [15:0] Value provided in two's complement format. LSB size = 1/2 <sup>16</sup> = 0.000015 Mapping: 0111111111111111 = 1.499985 000000000000000 = 1 = 1.000015 000000000000000 = 1 1111111111111111 = 0.999985 100000000000000 = 0.5



# 9.6.1.123 SEQ2B\_STEP0\_CFG Register (Address = D0h) [Reset = 0000h]

Return to the Summary Table.

Figure 9-168. SEQ2B_STEP0_CFG Register									
15	14	13	12	11	10	9	8		
SEQ2B_STEP0_EN	SEQ2B_STEP0_GAIN[1:0]			RESERVED					
R/W-0b	R/W-00b			R-0000000b					
7	6	5	4	3	2	1	0		
	RESERVED		SEQ2B_STEP0_CH_ N		SEQ2B_STEP	0_CH_P[3:0]			
	R-0000000b		R/W-0b	R/W-0000b					

# Table 9-149. SEQ2B\_STEP0\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP0_EN	R/W	ОЬ	ADC2B sequence step 0 enable Enables sequence step 0 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP0_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 0 gain selection Selects the gain of ADC2B for sequence step 0. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000ь	Reserved Always reads 0000000b.
4	SEQ2B_STEP0_CH_N	R/W	ОЬ	ADC2B sequence step 0 negative input channel selection Selects the negative ADC2B analog input for sequence step 0. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP0_CH_P[3:0]	RW	0000Ь	ADC2B sequence step 0 positive input channel selection Selects the positive ADC2B analog input for sequence step 0. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP0_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V2B 0011b = V3B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



# 9.6.1.124 SEQ2B\_STEP1\_CFG Register (Address = D1h) [Reset = 0001h]

Return to the Summary Table.

Figure 9-169. SEQ2B_STEP1_CFG Register									
15	14	13	12	11	10	9	8		
SEQ2B_STEP1_EN	SEQ2B_STEP1_GAIN[1:0]			RESERVED					
R/W-0b	R/W-00b			R-0000000b					
7	6	5	4	3	2	1	0		
	RESERVED		SEQ2B_STEP1_CH_ N		SEQ2B_STEP	1_CH_P[3:0]			
	R-0000000b		R/W-0b		R/W-00	001b			

#### Table 9-150. SEQ2B\_STEP1\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP1_EN	R/W	Ob	ADC2B sequence step 1 enable Enables sequence step 1 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP1_GAIN[1:0]	R/W	00ь	ADC2B sequence step 1 gain selection Selects the gain of ADC2B for sequence step 1. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP1_CH_N	R/W	Ob	ADC2B sequence step 1 negative input channel selection Selects the negative ADC2B analog input for sequence step 1. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP1_CH_P[3:0]	R/W	00016	ADC2B sequence step 1 positive input channel selection Selects the positive ADC2B analog input for sequence step 1. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP1_CH_N bit has no effect. 000b = V0B 0001b = V1B 0010b = V4B 0010b = V4B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1001b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1100b = APWR/103 (negative ADC input is automatically selected) 1111b = DVDR/103 (negative ADC input is automatically selected)



# 9.6.1.125 SEQ2B\_STEP2\_CFG Register (Address = D2h) [Reset = 0002h]

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#### Figure 9-170. SEQ2B\_STEP2\_CFG Register

15	14	13	12	11	10	9	8			
SEQ2B_STEP2_EN	SEQ2B_STEP	2_GAIN[1:0]		RESERVED						
R/W-0b	R/W-	00b	R-0000000b							
7	6	5	4	3	2	1	0			
RESERVED			SEQ2B_STEP2_CH_ N		SEQ2B_STEP	2_CH_P[3:0]				
	R-0000000b			R/W-0010b						

#### Table 9-151. SEQ2B\_STEP2\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP2_EN	R/W	Ob	ADC2B sequence step 2 enable Enables sequence step 2 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP2_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 2 gain selection Selects the gain of ADC2B for sequence step 2. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP2_CH_N	R/W	0b	ADC2B sequence step 2 negative input channel selection Selects the negative ADC2B analog input for sequence step 2. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP2_CH_P[3:0]	RW	0010Ь	ADC2B sequence step 2 positive input channel selection Selects the positive ADC2B analog input for sequence step 2. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP2_CH_N bit has no effect. 0000b = V0B 0010b = V1B 0010b = V2B 0010b = V2B 0100b = V4B 0101b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



### 9.6.1.126 SEQ2B\_STEP3\_CFG Register (Address = D3h) [Reset = 0003h]

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Figure 9-171. SEQ2B_STEP3_CFG Register									
15	14	13	12	11	10	9	8		
SEQ2B_STEP3_EN	SEQ2B_STEP3_GAIN[1:0]				RESERVED				
R/W-0b	R/W-00b			R-0000000b					
7	6	5	4	3	2	1	0		
	RESERVED		SEQ2B_STEP3_CH_ N		SEQ2B_STEP	3_CH_P[3:0]			
	R-0000000b		R/W-0b		R/W-0	011b			

#### Table 9-152. SEQ2B\_STEP3\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP3_EN	R/W	0b	ADC2B sequence step 3 enable Enables sequence step 3 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP3_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 3 gain selection Selects the gain of ADC2B for sequence step 3. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP3_CH_N	R/W	Ob	ADC2B sequence step 3 negative input channel selection Selects the negative ADC2B analog input for sequence step 3. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP3_CH_P[3:0]	R/W	0011b	ADC2B sequence step 3 positive input channel selection Selects the positive ADC2B analog input for sequence step 3. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP3_CH_N bit has no effect. 0000b = V0B 0010b = V1B 0010b = V2B 0010b = V2B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1101b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)

# 9.6.1.127 SEQ2B\_STEP4\_CFG Register (Address = D4h) [Reset = 0004h]

Return to the Summary Table.

Figure 9-172. SEQ2B_STEP4_CFG Register									
15	14	13	12	11	10	9	8		
SEQ2B_STEP4_EN	SEQ2B_STEP4_GAIN[1:0]			RESERVED					
R/W-0b	R/W-00b		R-0000000b						
7	6	5	4	3	2	1	0		
	RESERVED		SEQ2B_STEP4_CH_ N		SEQ2B_STEF	4_CH_P[3:0]			
	R-0000000b		R/W-0b	R/W-0100b					

### Table 9-153. SEQ2B\_STEP4\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP4_EN	R/W	Ob	ADC2B sequence step 4 enable Enables sequence step 4 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP4_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 4 gain selection Selects the gain of ADC2B for sequence step 4. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP4_CH_N	R/W	Ob	ADC2B sequence step 4 negative input channel selection Selects the negative ADC2B analog input for sequence step 4. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP4_CH_P[3:0]	R/W	0100Ь	ADC2B sequence step 4 positive input channel selection Selects the positive ADC2B analog input for sequence step 4. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP4_CH_N bit has no effect. 0000b = V0B 001b = V1B 0010b = V2B 0011b = V3B 0100b = V4B 0101b = V5B 0100b = V6B 0101b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DACA (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1101b = AVDD/4 (negative ADC input is automatically selected) 1110b = AVVDP/4 (negative ADC input is automatically selected) 1110b = AVVR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.128 SEQ2B\_STEP5\_CFG Register (Address = D5h) [Reset = 0005h]

Return to the Summary Table.

Figure 9-173. SEQ2B_STEP5_CFG Register							
15	14	13	12	11	10	9	8
SEQ2B_STEP5_EN	SEQ2B_STEP5_GAIN[1:0]				RESERVED		
R/W-0b	R/W	R/W-00b			R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2B_STEP5_CH_ N		SEQ2B_STEP	5_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-0	101b	

# Table 9-154. SEQ2B\_STEP5\_CFG Register Field Descriptions

Table 9-104. SEQ2D_STEP5_CFG Register Field Descriptions					
Bit	Field	Туре	Reset	Description	
15	SEQ2B_STEP5_EN	R/W	Ob	ADC2B sequence step 5 enable Enables sequence step 5 of the ADC2B sequencer. 0b = Disabled 1b = Enabled	
14:13	SEQ2B_STEP5_GAIN[1:0]	R/W	00ь	ADC2B sequence step 5 gain selection Selects the gain of ADC2B for sequence step 5. 00b = 1 01b = 2 10b = 4 11b = 4	
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.	
4	SEQ2B_STEP5_CH_N	R/W	Ob	ADC2B sequence step 5 negative input channel selection Selects the negative ADC2B analog input for sequence step 5. 0b = AGNDB 1b = V7B	
3:0	SEQ2B_STEP5_CH_P[3:0]	R/W	01015	ADC2B sequence step 5 positive input channel selection Selects the positive ADC2B analog input for sequence step 5. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP5_CH_N bit has no effect. 0000b = V0B 001b = V1B 001b = V2B 0011b = V3B 0100b = V4B 0101b = V6B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1001b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1101b = DVDD/2 (negative ADC input is automatically selected) 1110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)	

## 9.6.1.129 SEQ2B\_STEP6\_CFG Register (Address = D6h) [Reset = 0006h]

Return to the Summary Table.

Figure 9-174. SEQ2B_STEP6_CFG Register							
15	14	13	12	11	10	9	8
SEQ2B_STEP6_EN	SEQ2B_STEP6_GAIN[1:0]				RESERVED		
R/W-0b	R/W-00b				R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2B_STEP6_CH_ N		SEQ2B_STEF	P6_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-0	)110b	

## Table 9-155. SEQ2B\_STEP6\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP6_EN	R/W	ОЬ	ADC2B sequence step 6 enable Enables sequence step 6 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP6_GAIN[1:0]	R/W	00b	ADC2B sequence step 6 gain selection Selects the gain of ADC2B for sequence step 6. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000ь	Reserved Always reads 0000000b.
4	SEQ2B_STEP6_CH_N	R/W	ОЬ	ADC2B sequence step 6 negative input channel selection Selects the negative ADC2B analog input for sequence step 6. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP6_CH_P[3:0]	R/W	0110b	ADC2B sequence step 6 positive input channel selection Selects the positive ADC2B analog input for sequence step 6. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP6_CH_N bit has no effect. 0000b = V0B 0001b = V0B 0010b = V2B 0010b = V2B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 1110b = DVDD/2 (negative ADC input is automatically selected) 1110b = DPWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.130 SEQ2B\_STEP7\_CFG Register (Address = D7h) [Reset = 0007h]

Return to the Summary Table.

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Figure 9-175. SEQ2B_STEP7_CFG Register							
15	14	13	12	11	10	9	8
SEQ2B_STEP7_EN	SEQ2B_STEP7_GAIN[1:0]				RESERVED		
R/W-0b	R/W	R/W-00b			R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2B_STEP7_CH_ N		SEQ2B_STEP	P7_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-0	)111b	

## Table 9-156. SEQ2B\_STEP7\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP7_EN	R/W	Ob	ADC2B sequence step 7 enable Enables sequence step 7 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP7_GAIN[1:0]	R/W	00b	ADC2B sequence step 7 gain selection Selects the gain of ADC2B for sequence step 7. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP7_CH_N	R/W	Ob	ADC2B sequence step 7 negative input channel selection Selects the negative ADC2B analog input for sequence step 7. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP7_CH_P[3:0]	R/W	0111Ъ	ADC2B sequence step 7 positive input channel selection Selects the positive ADC2B analog input for sequence step 7. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP7_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V2B 0011b = V3B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)

## 9.6.1.131 SEQ2B\_STEP8\_CFG Register (Address = D8h) [Reset = 0008h]

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Figure 9-176. SEQ2B_STEP8_CFG Register							
15	14	13	12	11	10	9	8
SEQ2B_STEP8_EN	SEQ2B_STEP8_GAIN[1:0]				RESERVED		
R/W-0b	R/W-00b				R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2B_STEP8_CH_ N		SEQ2B_STEF	28_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-1	000b	

# Table 9-157. SEQ2B\_STEP8\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP8_EN	R/W	ОЬ	ADC2B sequence step 8 enable Enables sequence step 8 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP8_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 8 gain selection Selects the gain of ADC2B for sequence step 8. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP8_CH_N	R/W	ОЬ	ADC2B sequence step 8 negative input channel selection Selects the negative ADC2B analog input for sequence step 8. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP8_CH_P[3:0]	R/W	1000b	ADC2B sequence step 8 positive input channel selection Selects the positive ADC2B analog input for sequence step 8. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP8_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V2B 0010b = V4B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = DVDD/4 (negative ADC input is automatically selected) 110b = DVDD/4 (negative ADC input is automatically selected) 1110b = DVDD/2 (negative ADC input is automatically selected) 1110b = DPWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.132 SEQ2B\_STEP9\_CFG Register (Address = D9h) [Reset = 0009h]

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Figure 9-177. SEQ2B_STEP9_CFG Register							
15	14	13	12	11	10	9	8
SEQ2B_STEP9_EN	SEQ2B_STEP9_GAIN[1:0]				RESERVED		
R/W-0b	R/W-0	R/W-00b			R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2B_STEP9_CH_ N		SEQ2B_STEP	9_CH_P[3:0]	
	R-0000000b		R/W-0b		R/W-10	001b	

#### Table 9-158. SEQ2B\_STEP9\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP9_EN	R/W	ОЬ	ADC2B sequence step 9 enable Enables sequence step 9 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP9_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 9 gain selection Selects the gain of ADC2B for sequence step 9. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP9_CH_N	R/W	ОЬ	ADC2B sequence step 9 negative input channel selection Selects the negative ADC2B analog input for sequence step 9. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP9_CH_P[3:0]	R/W	1001b	ADC2B sequence step 9 positive input channel selection Selects the positive ADC2B analog input for sequence step 9. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP9_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V2B 0010b = V4B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Test DAC A (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = DVDD/4 (negative ADC input is automatically selected) 110b = DVDD/4 (negative ADC input is automatically selected) 110b = DVDD/4 (negative ADC input is automatically selected) 1110b = DVWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.133 SEQ2B\_STEP10\_CFG Register (Address = DAh) [Reset = 000Ah]

Return to the Summary Table.

## Figure 9-178. SEQ2B\_STEP10\_CFG Register

15	14	13	12	11	10	9	8	
SEQ2B_STEP10_EN	SEQ2B_STEP10_GAIN[1:0]			RESERVED				
R/W-0b	R/W-	-00b			R-0000000b			
7	6	6 5		3	2	1	0	
	RESERVED				SEQ2B_STEP1	0_CH_P[3:0]		
	R-0000000b		R/W-0b		R/W-10	10b		

#### Table 9-159. SEQ2B\_STEP10\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP10_EN	R/W	ОЬ	ADC2B sequence step 10 enable Enables sequence step 10 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP10_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 10 gain selection Selects the gain of ADC2B for sequence step 10. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP10_CH_N	R/W	ОЬ	ADC2B sequence step 10 negative input channel selection Selects the negative ADC2B analog input for sequence step 10. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP10_CH_P[3:0]	R/W	1010b	ADC2B sequence step 10 positive input channel selection Selects the positive ADC2B analog input for sequence step 10. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP10_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V2B 0011b = V3B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1011b = Tot DAC A (negative ADC input is automatically selected) 1011b = Tot DAC A (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1101b = DVDD/2 (negative ADC input is automatically selected) 1110b = AVWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.134 SEQ2B\_STEP11\_CFG Register (Address = DBh) [Reset = 000Bh]

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	Figure 9-179. SEQ2B_STEP11_CFG Register							
15	14	13	12	11	10	9	8	
SEQ2B_STEP11_EN	SEQ2B_STEP11_GAIN[1:0]			RESERVED				
R/W-0b	R/W-00b			R-0000000b				
7	6	5	4	3	2	1	0	
	RESERVED		SEQ2B_STEP11_CH _N		SEQ2B_STEP	11_CH_P[3:0]		
	R-0000000b		R/W-0b		R/W-1	l011b		

## Table 9-160. SEQ2B\_STEP11\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP11_EN	R/W	0b	ADC2B sequence step 11 enable Enables sequence step 11 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP11_GAIN[1:0]	R/W	006	ADC2B sequence step 11 gain selection Selects the gain of ADC2B for sequence step 11. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP11_CH_N	R/W	0b	ADC2B sequence step 11 negative input channel selection Selects the negative ADC2B analog input for sequence step 11. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP11_CH_P[3:0]	RW	1011b	ADC2B sequence step 11 positive input channel selection Selects the positive ADC2B analog input for sequence step 11. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP11_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V2B 0010b = V4B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 110b = APWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.135 SEQ2B\_STEP12\_CFG Register (Address = DCh) [Reset = 000Ch]

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# Figure 9-180. SEQ2B\_STEP12\_CFG Register

15	14	13	12	11	10	9	8		
SEQ2B_STEP12_EN	SEQ2B_STEP12_GAIN[1:0]		RESERVED						
R/W-0b	R/W-00b			R-0000000b					
7	6	5	4	3	2	1	0		
	RESERVED		SEQ2B_STEP12_CH _N		SEQ2B_STEP	12_CH_P[3:0]			
	R-0000000b		R/W-0b		R/W-1	100b			

#### Table 9-161. SEQ2B\_STEP12\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP12_EN	R/W	Ob	ADC2B sequence step 12 enable Enables sequence step 12 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP12_GAIN[1:0]	R/W	00ь	ADC2B sequence step 12 gain selection Selects the gain of ADC2B for sequence step 12. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	00000006	Reserved Always reads 0000000b
4	SEQ2B_STEP12_CH_N	R/W	Ob	ADC2B sequence step 12 negative input channel selection Selects the negative ADC2B analog input for sequence step 12. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP12_CH_P[3:0]	R/W	1100Ь	ADC2B sequence step 12 positive input channel selection Selects the positive ADC2B analog input for sequence step 12. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP12_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V4B 0100b = V4B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1100b = AVDD/4 (negative ADC input is automatically selected) 1110b = AVWR/103 (negative ADC input is automatically selected) 1111b = DVDD/4 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.136 SEQ2B\_STEP13\_CFG Register (Address = DDh) [Reset = 000Dh]

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	Figure 9-181. SEQ2B_STEP13_CFG Register							
15	14	13	12	11	10	9	8	
SEQ2B_STEP13_EN	P13_EN SEQ2B_STEP13_GAIN[1:0]				RESERVED			
R/W-0b	R/W-00b			R-0000000b				
7	6	5	4	3	2	1	0	
	RESERVED		SEQ2B_STEP13_CH _N		SEQ2B_STEP	13_CH_P[3:0]		
	R-00000000b		R/W-0b		R/W-1	101b		

## Table 9-162. SEQ2B\_STEP13\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP13_EN	R/W	ОЬ	ADC2B sequence step 13 enable Enables sequence step 13 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP13_GAIN[1:0]	R/W	00Ь	ADC2B sequence step 13 gain selection Selects the gain of ADC2B for sequence step 13. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000ь	Reserved Always reads 0000000b.
4	SEQ2B_STEP13_CH_N	R/W	ОЬ	ADC2B sequence step 13 negative input channel selection Selects the negative ADC2B analog input for sequence step 13. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP13_CH_P[3:0]	R/W	1101b	ADC2B sequence step 13 positive input channel selection Selects the positive ADC2B analog input for sequence step 13. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP13_CH_N bit has no effect. 0000b = V0B 0001b = V1B 0010b = V2B 0100b = V4B 0101b = V4B 0101b = V4B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 1101b = DVDD/2 (negative ADC input is automatically selected) 1110b = DVWR/103 (negative ADC input is automatically selected) 1111b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.137 SEQ2B\_STEP14\_CFG Register (Address = DEh) [Reset = 000Eh]

Return to the Summary Table.

Figure 9-182. SEQ2B_STEP14_CFG Register							
15	14	13	12	11	10	9	8
SEQ2B_STEP14_EN	SEQ2B_STEP14_GAIN[1:0]				RESERVED		
R/W-0b	R/W-00b				R-0000000b		
7	6	5	4	3	2	1	0
	RESERVED		SEQ2B_STEP14_CH _N		SEQ2B_STEP	14_CH_P[3:0]	
	R-0000000b		R/W-0b		<b>R/W-</b> 1	110b	

#### Table 9-163. SEQ2B\_STEP14\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP14_EN	R/W	ОЬ	ADC2B sequence step 14 enable Enables sequence step 14 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP14_GAIN[1:0]	R/W	00b	ADC2B sequence step 14 gain selection Selects the gain of ADC2B for sequence step 14. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000ь	Reserved Always reads 0000000b.
4	SEQ2B_STEP14_CH_N	R/W	ОЬ	ADC2B sequence step 14 negative input channel selection Selects the negative ADC2B analog input for sequence step 14. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP14_CH_P[3:0]	R/W	1110b	ADC2B sequence step 14 positive input channel selection Selects the positive ADC2B analog input for sequence step 14. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP14_CH_N bit has no effect. 0000b = V0B 0001b = V0B 0010b = V2B 0010b = V2B 0100b = V4B 0101b = V5B 0110b = V6B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1010b = IOVDD/4 (negative ADC input is automatically selected) 110b = IOVDD/4 (negative ADC input is automatically selected) 110b = DVDD/2 (negative ADC input is automatically selected) 1110b = DPWR/103 (negative ADC input is automatically selected)



## 9.6.1.138 SEQ2B\_STEP15\_CFG Register (Address = DFh) [Reset = 000Fh]

Return to the Summary Table.

	Figure 9-183. SEQ2B_STEP15_CFG Register							
15	14	13	12	11	10	9	8	
SEQ2B_STEP15_EN	EN SEQ2B_STEP15_GAIN[1:0]				RESERVED			
R/W-0b	R/W-00b			R-0000000b				
7	6	5	4	3	2	1	0	
	RESERVED		SEQ2B_STEP15_CH _N		SEQ2B_STEP	15_CH_P[3:0]		
	R-00000000b		R/W-0b		R/W-1	111b		

#### Table 9-164. SEQ2B\_STEP15\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	SEQ2B_STEP15_EN	R/W	Ob	ADC2B sequence step 15 enable Enables sequence step 15 of the ADC2B sequencer. 0b = Disabled 1b = Enabled
14:13	SEQ2B_STEP15_GAIN[1:0]	R/W	00b	ADC2B sequence step 15 gain selection Selects the gain of ADC2B for sequence step 15. 00b = 1 01b = 2 10b = 4 11b = 4
12:5	RESERVED	R	0000000b	Reserved Always reads 0000000b.
4	SEQ2B_STEP15_CH_N	R/W	Ob	ADC2B sequence step 15 negative input channel selection Selects the negative ADC2B analog input for sequence step 15. 0b = AGNDB 1b = V7B
3:0	SEQ2B_STEP15_CH_P[3:0]	R/W	1111b	ADC2B sequence step 15 positive input channel selection Selects the positive ADC2B analog input for sequence step 15. For settings where the negative ADC input is automatically selected, the SEQ2B_STEP15_CH_N bit has no effect. 0000b = V0B 001b = V1B 0010b = V2B 0011b = V3B 0100b = V4B 0101b = V5B 0110b = V6B 0111b = V5B 0110b = V6B 0111b = V7B 1000b = Temperature sensor B (negative ADC input is automatically selected) 1001b = Internal short to AGNDB, disconnected from inputs (negative ADC input is automatically selected) 1010b = Test DAC A (negative ADC input is automatically selected) 1011b = AVDD/4 (negative ADC input is automatically selected) 1100b = IOVDD/4 (negative ADC input is automatically selected) 1101b = DVDD/4 (negative ADC input is automatically selected) 1110b = AVVDP/4 (negative ADC input is automatically selected) 1110b = DVDD/2 (negative ADC input is automatically selected) 1111b = DVWR/103 (negative ADC input is automatically selected)



## 9.6.1.139 ADC3B\_CFG Register (Address = E0h) [Reset = 8010h]

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## Figure 9-184. ADC3B\_CFG Register

15	14	13	12	11	10	9	8	
ADC3B_EN	DC3B_EN RESERVED				GAIN3B[1:0]		MUX3B[1:0]	
R/W-1b		R-000b			R/W-00b		R/W-00b	
7	6	5	4	3	2	1	0	
RESERVED OWD3B_SOURCE_ MUX		OWD3B_SOURCE_ MUX	OWD3B_SINK_MUX	OWD3B_SOUR	CE_VALUE[1:0]	OWD3B_SINK	(_VALUE[1:0]	
R-0	00b	R/W-0b	R/W-1b	R/W	/-00b	R/W-	00b	

#### Table 9-165. ADC3B\_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	ADC3B_EN	R/W	1b	ADC3B enable Enables ADC3B. The conversion data of ADC3B reset to 000000h when ADC3B is disabled or when the device is put in standby or power-down mode. If both ADC1B and ADC3B are disabled, then the conversion counter CONV1B_COUNT[1:0] resets to 00b. 0b = Disabled 1b = Enabled
14:12	RESERVED	R	000b	Reserved Always reads 000b.
11:10	GAIN3B[1:0]	R/W	00ь	ADC3B gain selection Selects the gain (FSR = full scale range) of ADC3B. 00b = 1 01b = 2 10b = 4 11b = 4
9:8	MUX3B[1:0]	R/W	00ь	ADC3B multiplexer channel selection Selects the multiplexer channel for ADC3B. 00b = AINp = VPB, AINn = VNB 01b = AINp = VNB, AINn = VPB 10b = Internal short to AGNDB. Analog inputs VPB, VNB disconnected from ADC3B. 11b = Test DAC A output
7:6	RESERVED	R	00b	Reserved Always reads 00b.
5	OWD3B_SOURCE_MUX	R/W	ОЬ	ADC3B current source multiplexer selection Selects the multiplexer channel for the ADC3B current source. 0b = VPB 1b = VNB
4	OWD3B_SINK_MUX	R/W	1b	ADC3B current sink multiplexer selection Selects the multiplexer channel for the ADC3B current sink. 0b = VPB 1b = VNB
3:2	OWD3B_SOURCE_VALUE[1:0]	R/W	00ь	ADC3B current source value selection Selects the current value for the ADC3B current source. 00b = Off 01b = 4 $\mu$ A 10b = 40 $\mu$ A 11b = 240 $\mu$ A
1:0	OWD3B_SINK_VALUE[1:0]	R/W	00ь	ADC3B current sink value selection Selects the current value for the ADC3B current sink. 00b = Off 01b = 4 $\mu$ A 10b = 40 $\mu$ A 11b = 240 $\mu$ A



## 9.6.1.140 ADC3B\_OCAL\_MSB Register (Address = E1h) [Reset = 0000h]

Return to the Summary Table.

## Figure 9-185. ADC3B\_OCAL\_MSB Register

15	14	13	12	11	10	9	8				
OCAL3B[23:8]											
R/W-000000000000000000000000000000000000											
7	6	5	4	3	2	1	0				
OCAL3B[23:8]											
			R/W-000000	0000000000b							

## Table 9-166. ADC3B\_OCAL\_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	OCAL3B[23:8]	R/W	000b	ADC3B offset calibration bits [23:8] Value provided in two's complement format. LSB size = (2 x VREFB) / (GAIN3B x $2^{24}$ )

## 9.6.1.141 ADC3B\_OCAL\_LSB Register (Address = E2h) [Reset = 0000h]

Return to the Summary Table.

## Figure 9-186. ADC3B\_OCAL\_LSB Register

15	14	13	12	11	10	9	8				
OCAL3B[7:0]											
R/W-0000000b											
7	6	5	4	3	2	1	0				
RESERVED											
			R-0000	00000b							

## Table 9-167. ADC3B\_OCAL\_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:8	OCAL3B[7:0]	R/W	0000000ь	ADC3B offset calibration bits [7:0] Value provided in two's complement format. LSB size = (2 x VREFB) / (GAIN3B x 2 <sup>24</sup> )
7:0	RESERVED	R	0000000b	Reserved Always reads 0x00.



## 9.6.1.142 ADC3B\_GCAL Register (Address = E3h) [Reset = 0000h]

Return to the Summary Table.

## Figure 9-187. ADC3B\_GCAL Register

15	14	13	12	11	10	9	8					
GCAL3B[15:0]												
R/W-000000000000000000000000000000000000												
7	6	5	4	3	2	1	0					
GCAL3B[15:0]												
			R/W-000000	000000000b								

## Table 9-168. ADC3B\_GCAL Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	GCAL3B[15:0]	R/W	00000000000000000000000000000000000000	ADC3B gain calibration bits [15:0] Value provided in two's complement format. LSB size = 1/2 <sup>16</sup> = 0.000015 Mapping: 0111111111111111 = 1.499985 000000000000000 = 1 = 1.000015 000000000000000 = 1 1111111111111111 = 0.999985 100000000000000 = 0.5

## 9.6.1.143 REGISTER\_MAP3\_CRC Register (Address = FEh) [Reset = 0000h]

Return to the Summary Table.

## Figure 9-188. REGISTER\_MAP3\_CRC Register

15	14	13	12	11	10	9	8				
REG_MAP3_CRC_VALUE[15:0]											
R/W-000000000000b											
7	6	5	4	3	2	1	0				
REG_MAP3_CRC_VALUE[15:0]											
			R/W-000000	000000000b							

## Table 9-169. REGISTER\_MAP3\_CRC Register Field Descriptions

Bit	Field	Туре	Reset	Description
15:0	REG_MAP3_CRC_VALUE[15:0]	R/W	0000000000000 000b	Register map CRC value for section 3 Register map CRC value for section 3.



## 10 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

## **10.1 Application Information**

#### 10.1.1 Unused Inputs and Outputs

Follow these guidelines for unused device pin connections:

- Leave any unused ADCxy analog inputs floating or connect the unused analog inputs to AGNDy.
- Tie unused GPIO pins (GPIO0 to GPIO4, GPIO0A, GPIO1A, GPIO0B, and GPIO1B) to DGND when configured as digital inputs because excessive power-supply current can result when digital inputs are left floating.
- Tie the CLK pin to DGND if the internal main oscillator is used.
- Tie the RESETn pin to IOVDD if the host does not drive the RESETn pin. The RESETn pin has an internal pulldown resistor to DGND.
- Leave the DRDYn pin unconnected if unused or connect the pin to IOVDD with a weak pullup resistor.

#### **10.1.2 Minimum Interface Connections**

The ADS131B26-Q1 requires at a minimum four pins for communication with a host microcontroller: CSn, SCLK, SDI, and SDO. CSn cannot be tied low permanently.

The following pins are optional, but connecting these pins to the host helps with device operation:

- DRDYn: Helps determine exactly when new conversion data on ADC1A and ADC3A or ADC1B and ADC3B are available.
- RESETn: If the SPI communication is corrupted (that is, if the RESET command cannot be sent), a *hardware* reset is required to recover the device. Without controlling the RESETn pin, the only way to perform a hardware reset on the device is through cycling the power supplies.
- GPIOs: The different special functions available on the various GPIO pins, such as FAULT, MHD, OCCA, and OCCB, help alert the host of device or system faults.

### **10.2 Typical Application**

This section describes a typical battery management system (BMS) application circuit using the ADS131B26-Q1. The device serves the following primary functions in this BMS:

- Measure battery current redundantly through ADC1A and ADC1B with high resolution and accuracy using a low-side current shunt sensor
- Measure peak battery currents and detect overcurrent or short-circuit conditions
- Redundantly measure battery-pack voltage simultaneously to the battery current through ADC3A and ADC3B using high-voltage resistor dividers
- Measure other voltages in the BMS through ADC2A and ADC2B using high-voltage resistor dividers (for example, voltages before and after the main contactor)
- Measure shunt temperature through ADC2A using a linear positive temperature coefficient (PTC) thermistor, the TMP61-Q1
- Redundantly measure shunt temperature through ADC2B using an analog output temperature sensor, the LMT84-Q1

Figure 10-1 illustrates the front-end for the battery management system circuit design.

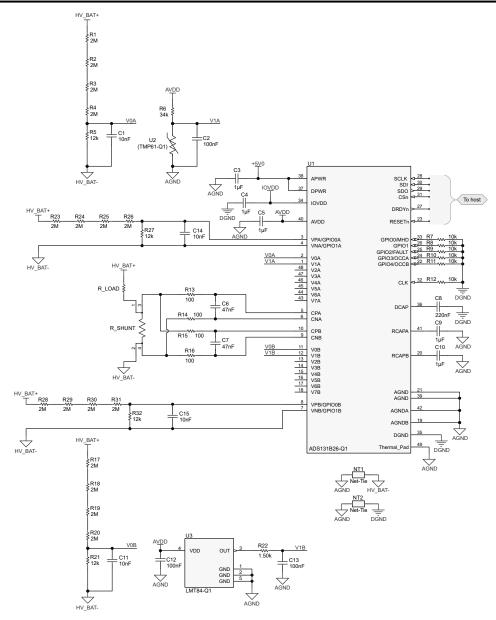


Figure 10-1. The ADS131B26-Q1 in a Typical Battery Management System Application



#### **10.2.1 Design Requirements**

DESIGN PARAMETER	VALUE							
Current Measurement								
Current measurement range	±3 kA							
Current shunt value	50 μΩ							
Update rate	1 ms							
Battery-Pack Voltage Measurement								
Voltage measurement range	0 V to 800 V							
Shunt Temperature Measurement								
Temperature measurement range	–40°C to +125°C							
Thermistor type	TMP61-Q1 (10-kΩ PTC)							

#### Table 10-1. Design Parameters

### 10.2.2 Detailed Design Procedure

The following sections provide guidelines for selecting the external components and the configuration of the ADS131B26-Q1 for the various measurements in this application example.

#### 10.2.2.1 Current Shunt Measurement

In a typical BMS application, the current through the shunt resistor must be measured in both directions for charging and discharging the battery pack. In an overcurrent or short-circuit condition, the current can be as high as  $I_{BAT\_MAX} = \pm 3$  kA in this example application. Therefore, the maximum voltage drop across the shunt is up to  $V_{SHUNT} = R_{SHUNT} \times I_{BAT\_MAX} = 50 \ \mu\Omega \times \pm 3 \ kA = \pm 150 \ mV.$ 

To measure this shunt voltage, ADC1A is configured for gain = 8, which allows differential voltage measurements of  $V_{IN1A} = V_{CPA} - V_{CNA} = \pm V_{REFA} / 8 = \pm 1.25 \text{ V} / 8 = \pm 156 \text{ mV}$ . The integrated charge pump in the device allows voltage measurements 312.5 mV below AGNDA while using a unipolar analog power supply. This bipolar voltage measurement capability is important because one side of the shunt is connected to the same GND potential as the AGNDA pin of the ADS131B26-Q1, which means that the absolute voltage that the device must measure is up to 150 mV below AGNDA.

To enable fast overcurrent detection within 1 ms while providing high accuracy and resolution, the ADS131B26-Q1 is configured to operate at 4 kSPS (OSR = 1024)) using global-chop mode. Global-chop mode enables measurements with minimal offset error over temperature and time. The conversion time using these settings is 0.75 ms according to Equation 21. The input-referred noise is approximately 1.28  $\mu$ V<sub>RMS</sub> /  $\sqrt{2}$  = 0.91  $\mu$ V<sub>RMS</sub> following the explanations in the *Global-Chop Mode* section. Thus, currents as small as 0.91  $\mu$ V<sub>RMS</sub> / 50  $\mu$ Ω = 18 mA can be resolved. The resolution can be further improved by averaging the conversion results over a longer period of time in the microcontroller that interfaces with the ADS131B26-Q1.

The –3-dB corner frequency of the differential antialiasing filter on the analog inputs (R13, R14, and C6) is set to 1 /  $(2 \times \pi \times 2 \times 100 \ \Omega \times 47 \ nF) = 16.9 \ kHz$  to provide more then 40-dB attenuation at the ADC1A modulator frequency. Keep the series resistor values (R13 and R14) small to avoid additional offset errors created by the voltage drop across the resistors because of the ADC1A input currents.

ADC1B is configured identical to ADC1A to allow for simultaneous sampling of the shunt voltage with the same digital filter response.

#### 10.2.2.2 Battery Pack Voltage Measurement

The 800-V battery-pack voltage is divided down to the voltage range of ADC3A using a high-voltage resistor divider consisting of R<sub>23</sub>, R<sub>24</sub>, R<sub>25</sub>, R<sub>26</sub>, and R<sub>27</sub>. Gain = 1 is used for ADC3A in this case to allow differential voltage measurements of V<sub>IN3A</sub> = V<sub>VPA</sub> - V<sub>VNA</sub> =  $\pm$ 1.25 V. The battery-pack voltage measurement is a unipolar, single-ended measurement with VNA connected to HV\_BAT- = AGNDA. Thus, only the voltage range from 0 V to 1.25 V of ADC3A is used. Equation 23 calculates the resistor divider ratio.

$$V_{\text{IN3A}} / V_{\text{BAT MAX}} = 1.25 \text{ V} / 800 \text{ V} = R_{27} / (R_{23} + R_{24} + R_{25} + R_{26} + R_{27})$$
(23)



The leakage current drawn by the resistor divider should be less than 100  $\mu$ A in this example to avoid unnecessarily draining the battery. The resistance of the divider must therefore be larger than R<sub>TOTAL</sub>  $\geq$ 

 $V_{BAT\_MAX}$  /  $I_{LEAKAGE}$  = 800 V / 100 µA = 8 MΩ. The resistor values are chosen as  $R_{23}$  =  $R_{24}$  =  $R_{25}$  =  $R_{26}$  = 2 MΩ and  $R_{27}$  = 12 kΩ. Thus, the maximum voltage across  $R_{27}$  is 1.2 V at  $V_{BAT\_MAX}$  = 800 V, leaving some headroom to the maximum input voltage of 1.25 V of ADC3A.

The maximum resistance of a single resistor that can be used in an automotive circuit design is often limited to a certain value. Also, the maximum voltage a single resistor can withstand is limited. These reasons are why the high-side resistor of the divider is split into multiple resistors ( $R_{23}$ ,  $R_{24}$ ,  $R_{25}$ , and  $R_{26}$ ). Another reason is that if a single resistor has a short-circuit fault, the remaining resistors still limit the current into the ADC3A analog input pins,VPA and VNA, to safe levels.

#### 10.2.2.3 Other Voltage Measurements

Other voltages in the BMS, such as the voltages before and after the main contactor, can be measured using ADC2A and ADC2B. The configuration of the ADCs and the selection of the resistor dividers follows the same guidelines as for the battery-pack voltage measurements using ADC3A and ADC3B.

In this example analog input V0A of ADC2A and analog input V0B of ADC2B are shown for voltage measurements. The negative multiplexer channels of ADC2A and ADC2B are using AGNDA and AGNDB, respectively.

#### 10.2.2.4 Shunt Temperature Measurement

The shunt temperature in this example is measured using the TMP61-Q1, a linear 10-k $\Omega$  PTC, in a typical voltage divider configuration using the analog supply (AVDD) as excitation. The PTC resistance is calculated using Equation 25, which is derived from Equation 24:

$$V_{PTC} = V_{V1A} - V_{AGNDA} = AVDD \times R_{PTC} / (R_6 + R_{PTC})$$
(24)

$$R_{PTC} = R_6 \times V_{PTC} / (AVDD - V_{PTC})$$
(25)

The maximum input voltage on V1A is limited to 1.25 V when using gain = 1 for ADC2A with the negative multiplexer channel of ADC2A internally connected to AGNDA. Therefore, the value of the precision resistor,  $R_6$ , must be chosen so that the voltage on V1A stays below 1.25 V for the value range of the PTC across the temperature range to be measured. The TMP61-Q1 has the largest resistance at the most positive temperature, approximately 18 k $\Omega$  at +125°C. Following Equation 25, that means  $R_6 \ge 29.5 \text{ k}\Omega$ . A value of 34 k $\Omega$  is chosen for  $R_6$  to allow variation in the AVDD supply voltage up to 3.6 V without exceeding the maximum V1A voltage of 1.25 V.

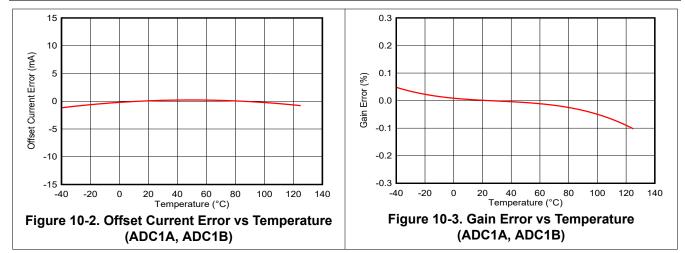
#### 10.2.2.5 Analog Output Temperature Sensor Measurement

This application example shows a redundant shunt temperature measurement using an analog output temperature sensor, LMT84-Q1. The LMT84-Q1 outputs a voltage proportional to temperature, which spans from 1.247 V at  $-40^{\circ}$ C to 0.332 V at  $+125^{\circ}$ C. The temperature sensor output voltage is measured directly with ADC2B on analog input V1B with the negative multiplexer channel of ADC2A internally connected to AGNDB using gain = 1.

#### **10.2.3 Application Curves**

Figure 10-2 depicts the measurement accuracy of the current measurement (ADC1A, ADC1B) over temperature for a 0-A current through the shunt. Figure 10-3 illustrates the gain error of the current measurement (ADC1A, ADC1B) over temperature excluding the error of the shunt. The offset and gain error are calibrated at 25°C.

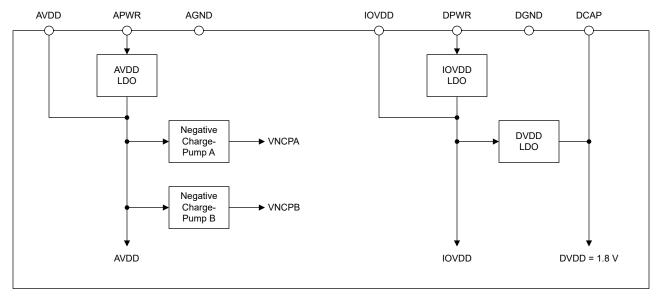


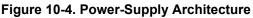


## **10.3 Power Supply Recommendations**

#### 10.3.1 Power-Supply Options

The ADS131B26-Q1 power-supply architecture shown in Figure 10-4 allows multiple ways to power the device to support different application requirements.





The AVDD LDO accepts unregulated voltages between 4 V and 16 V on the APWR pin and outputs a regulated 3.3-V AVDD supply that is available at the AVDD pin to power external circuitry. The AVDD supply powers all analog circuitry in the device. If a regulated 3.3-V supply is available in the application, the AVDD LDO can be bypassed by shorting the APWR and AVDD pins.

The negative charge pumps in section A and section B provide a negative supply voltage for the various gain stages of every ADC to allow input voltage measurements below GND.

The IOVDD LDO accepts unregulated voltages between 4 V and 16 V on the DPWR pin and outputs a regulated 3.3-V IOVDD supply that is available at the IOVDD pin to power external circuitry. The IOVDD supply sets the voltage for the digital I/Os of the device. If a regulated 3.3-V or 5-V supply is available in the application, the IOVDD LDO can be bypassed by shorting the DPWR and IOVDD pins.

The DVDD LDO creates the 1.8-V supply for the digital core of the device.



The following sections show the three most commonly used external power-supply options, however other combinations are possible as well.

#### 10.3.1.1 Single Unregulated External 4-V to 16-V Supply (3.3-V Digital I/O Levels)

A single unregulated 4-V to 16-V supply (as shown in Figure 10-5) connected to both the APWR and DPWR pins can be used to power the device. No external supply is provided at the AVDD and IOVDD pins in this case. The AVDD LDO creates the internal 3.3-V AVDD supply, and the IOVDD LDO creates the 3.3-V I/O supply.

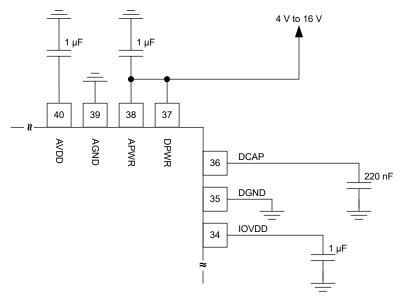


Figure 10-5. Single Unregulated External 4-V to 16-V Supply

#### 10.3.1.2 Single Regulated External 3.3-V Supply (3.3-V Digital IO Levels)

A single regulated 3.3-V supply connected to both the APWR and DPWR pins (as shown in Figure 10-6) can be used to power the device. In this case the APWR and AVDD pins must be shorted externally, as well as the DPWR and IOVDD pins. That way the AVDD and IOVDD LDOs are bypassed. The external 3.3-V supply is directly used as the AVDD and IOVDD supplies.

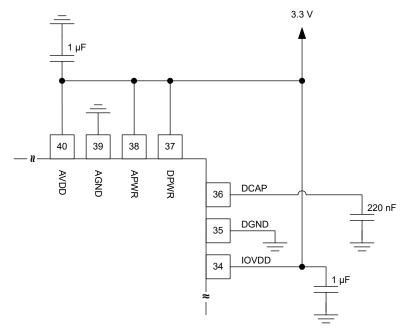


Figure 10-6. Single Regulated External 3.3-V Supply



#### 10.3.1.3 Single Regulated External 5-V Supply (5-V Digital I/O Levels)

To allow operation of the digital I/Os with 5-V levels, a single regulated 5-V supply (shown in Figure 10-7) connected to both the APWR and DPWR pins can be used to power the device. No external supply is provided at the AVDD pin in this case. The AVDD LDO creates the internal 3.3-V AVDD supply. The DPWR and IOVDD pins must be shorted externally. That way the IOVDD LDO is bypassed. The external 5-V supply is directly used as the IOVDD supply.

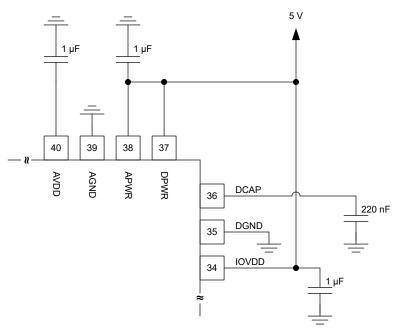


Figure 10-7. Single Regulated External 5-V Supply

#### 10.3.2 Power-Supply Sequencing

The power supplies can be sequenced in any order but the analog and digital inputs must never exceed the respective analog or digital power-supply voltage limits.

#### 10.3.3 Power-Supply Decoupling

Good power-supply decoupling is important to achieve optimum performance.

- APWR and AVDD must each be decoupled with a 1-µF capacitor to AGND.
   If APWR and AVDD are shorted together, a single 1-µF decoupling capacitor placed close to the AVDD pin is sufficient.
- DPWR and IOVDD must each be decoupled with a 1-μF capacitor to DGND.
   If DPWR and IOVDD are shorted together, a single 1-μF decoupling capacitor placed close to the IOVDD pin is sufficient.
- If APWR and DPWR are shorted together, a single 1-µF decoupling capacitor for the two supplies is sufficient.
- The DVDD LDO output at the DCAP pin must be decoupled with a 220-nF capacitor to DGND.

Place the bypass capacitors as close to the power-supply pins of the device as possible with low-impedance connections. Using multilayer ceramic chip capacitors (MLCCs) that offer low equivalent series resistance (ESR) and inductance (ESL) characteristics are recommended for power-supply decoupling purposes. For very sensitive systems, or for systems in harsh noise environments, avoiding the use of vias for connecting the capacitors to the device pins can offer superior noise immunity. The use of multiple vias in parallel lowers the overall inductance and is beneficial for connections to ground planes.



## 10.4 Layout

#### 10.4.1 Layout Guidelines

For best performance, dedicate an entire PCB layer to a ground plane and do not route any other signal traces on this layer. However, depending on restrictions imposed by specific end equipment, a dedicated ground plane may not be practical. If ground plane separation is necessary, make a direct connection of the planes at the device. Do not connect individual ground planes at multiple locations because this configuration creates ground loops.

Route digital traces away from all analog inputs and associated components in order to minimize interference.

Use C0G capacitors on the analog inputs. Use ceramic capacitors (for example, X7R grade) for the powersupply decoupling capacitors. High-K capacitors (Y5V) are not recommended. Place the required capacitors as close as possible to the device pins using short, direct traces. For optimum performance, use low-impedance connections on the ground-side connections of the bypass capacitors.

When applying an external clock, be sure the clock is free of overshoot and glitches. A source-termination resistor placed at the clock buffer often helps reduce overshoot. Glitches present on the clock input can lead to noise within the conversion data.

#### 10.4.2 Layout Example

Figure 10-8 shows an example layout for the ADS131B26-Q1, referencing the components of the circuit in Figure 10-1. In general, analog signals are partitioned to the left and digital signals to the right.

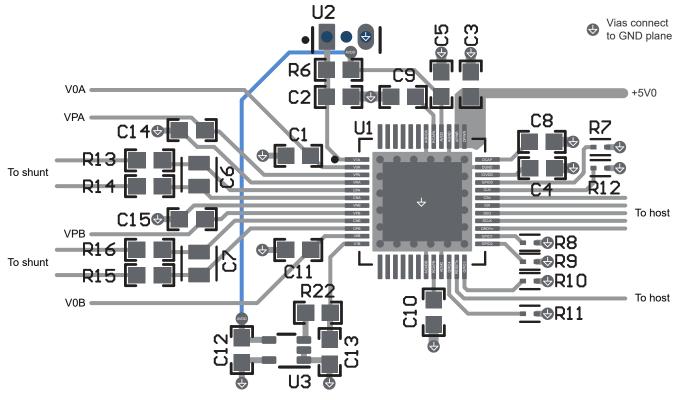


Figure 10-8. Layout Example



## 11 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

### **11.1 Documentation Support**

#### 11.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, TMP61-Q1 Automotive Grade, ±1% 10-kΩ Linear Thermistor data sheet
- Texas Instruments, LMT84-Q1 Automotive Grade, 1.5V-Capable,10 μA Analog Output Temperature Sensor data sheet

### **11.2 Receiving Notification of Documentation Updates**

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### **11.3 Support Resources**

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 11.4 Trademarks

TI E2E<sup>™</sup> is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

### **11.5 Electrostatic Discharge Caution**



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.6 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PADS131B26QPHPRQ1	ACTIVE	HTQFP	PHP	48	1000	TBD	Call TI	Call TI	-40 to 125		Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PHP 48**

7 x 7, 0.5 mm pitch

# **GENERIC PACKAGE VIEW**

**TQFP - 1.2 mm max height** 

QUAD FLATPACK

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





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